

# MSP430FR600x Ultrasonic Sensing MSP430™ Microcontrollers for Water-Metering Applications

## 1 特性

- 具有超低功耗的出色超声波水流量测量
  - 差分飞行时间 (dTOF) 精度小于 100ps
  - 高精度时间测量分辨率为 20ps
  - 能够检测低流速 (4 至 6 升/小时)
  - 在每秒测量一次的频率下总体电流消耗大约为 4μA
- 符合并超出 ISO 4064、OIML R49 和 EN 1434 精度标准
- 能够直接与标准超声波传感器 (高达 2.5MHz) 连接
- 集成模拟前端 – 超声波感应解决方案 (USS)
  - 可在不同频率下生成脉冲的可编程脉冲生成 (PPG)
  - 具有低阻抗 (4Ω) 输出驱动器的集成物理接口 (PHY), 可控制输入和输出通道
  - 具有高达 8Msps 输出数据速率的高性能高速 12 位  $\Sigma$ - $\Delta$  ADC (SDHS)
  - 具有 -6.5dB 至 30.8dB 增益的可编程增益放大器 (PGA)
  - 输出范围为 68MHz 至 80MHz 的高性能锁相环 (PLL)
- 低功耗加速器 (LEA)
  - 独立于 CPU 运行
  - 与 CPU 共享 4KB RAM
  - 高效的 256 点复数 FFT : 比 Arm® Cortex®-M0+ 内核快 40 倍
- 嵌入式微控制器
  - 时钟频率高达 16MHz 的 16 位精简指令集计算机 (RISC) 架构
  - 1.8V 至 3.6V 的宽电源电压范围 (最低电源电压受限于 SVS 电平, 请参阅 [节 8.13.1.2](#))
- 优化的超低功耗模式
  - 激活模式: 大约 120 μA/MHz
  - 具有实时时钟 (RTC) 的待机模式 (LPM3.5): 450nA<sup>1</sup>
  - 关断 (LPM4.5): 30nA
- 铁电随机存取存储器 (FRAM)
  - 非易失性存储器容量高达 256KB
  - 超低功耗写入
  - 以 125ns/字 (4ms 内写入 64KB) 的速度快速写入
  - 统一标准存储器 = 单个空间内的程序 + 数据 + 存储
- 耐写次数达 10<sup>15</sup> 次
- 抗辐射和非磁性
- 智能数字外设
  - 32 位硬件乘法器 (MPY)
  - 6 通道内部 DMA
  - 带有日历和报警功能的 RTC
  - 六个 16 位计时器, 每个计时器具有多达七个捕捉/比较寄存器
  - 32 位和 16 位循环冗余校验 (CRC)
- 高性能模拟
  - 16 通道模拟比较器
  - 12 位 SAR ADC, 具有窗口比较器、内部基准和采样保持功能以及多达 16 条外部输入通道
  - 具有高达 264 段对比度控制的集成 LCD 驱动器
- 多功能输入/输出端口
  - 可按位、字节和字进行访问 (成对访问)
  - 所有端口均可从 LPM 进行边沿可选唤醒
  - 所有端口均具有可设定的上拉电阻或下拉电阻
- 代码安全性和加密
  - 128 位或 256 位 AES 安全加密和解密协处理器
  - 用于随机数生成算法的随机数种子
  - IP 封装可保护存储器免遭外部访问
  - FRAM 可提供固有安全性优势
- 增强型串行通信
  - 多达四个 eUSCI\_A 串行通信端口
    - 支持自动波特率检测的 UART
    - IrDA 编码和解码
  - 多达两个 eUSCI\_B 串行通信端口
    - 支持多从器件寻址的 I<sup>2</sup>C
  - 硬件 UART 或 I<sup>2</sup>C 引导加载程序 (BSL)
- 灵活的时钟系统
  - 具有 10 个可选厂家调整频率的固定频率数控振荡器 (DCO)
  - 低功耗低频内部时钟源 (VLO)
  - 32kHz 晶振 (LFXT)
  - 高频晶振 (HFXT)
- 开发工具和软件 (另请参阅 [节 11.3](#))
  - 超声波感应设计中心图形用户界面
  - 超声波感应软件库
  - [EVM430-FR6047 水表评估模块](#)
  - [用于 100 引脚封装的 MSP-TS430PZ100E 目标插座板](#)
  - 采用 [EnergyTrace++ 技术](#) 的免费专业开发环境

<sup>1</sup> RTC 由 3.7pF 晶振计时。



- 适用于 MSP430™ 微控制器的 MSP430Ware™
- 节 6 汇总了可用的器件型号和封装选项
- 超声波智能热量计
- 液位感应
- 漏水检测器

## 2 应用

- 超声波智能水表

## 3 说明

德州仪器 (TI) MSP430FR600x 系列超声波感应和测量 SoC 是针对水表和热量计进行了优化的强大且高度集成的微控制器 (MCU)。MSP430FR600x MCU 具有集成的超声波感应解决方案 (USS) 模块，该模块可在多种流速条件下提供高精度。USS 模块高度集成，需要的外部组件极少，因而有助于实现超低功耗计量并降低系统成本。MSP430FR600x MCU 采用集成式低功耗加速器 (LEA) 模块，可实现基于高速 ADC 的信号采集以及后续的优化数字信号处理，为电池供电型计量应用提供了一款理想的超低功耗、高精度计量解决方案。

USS 模块包括可编程脉冲发生器 (PPG) 和具有低阻抗输出驱动器的物理接口 (PHY)，可实现最佳传感器激励，从而在零流量漂移 (ZFD) 方面达到出色效果。该模块还包含可编程增益放大器 (PGA) 和高速 12 位 8Msps  $\Sigma$ - $\Delta$  ADC (SDHS)，便于通过业界通用的超声波传感器实现精确的信号采集。

此外，MSP430FR600x MCU 还集成了其他外设，可提高计量系统集成度。MSP430FR600x MCU 还具有片上 8 通道多路复用器 LCD 驱动器、RTC、12 位 SAR ADC、模拟比较器、高级加密加速器 (AES256) 和循环冗余校验 (CRC) 模块。

MSP430FR600x MCU 由一系列由软、硬件组成的生态系统提供支持，并提供有参考设计和代码示例，可帮助您快速开展设计。开发套件包括 [MSP-TS430PZ100E 100 引脚目标开发板](#) 和 [EVM430-FR6047 超声波水流量计 EVM](#)。TI 还提供免费软件，包括超声波感应设计中心、超声波感应软件库和 [MSP430Ware™ 软件](#)。

TI 的 MSP430 超低功耗 (ULP) FRAM 微控制器平台将独特的嵌入式 FRAM 和全面的超低功耗系统架构相结合，从而使系统设计人员能够在降低能耗的同时提升性能。FRAM 技术将 RAM 的低能耗快速写入、灵活性和耐用性与闪存的非易失性相结合。

有关完整的模块说明，请参阅《[MSP430FR58xx](#)、[MSP430FR59xx](#) 和 [MSP430FR6xx 系列用户指南](#)》。

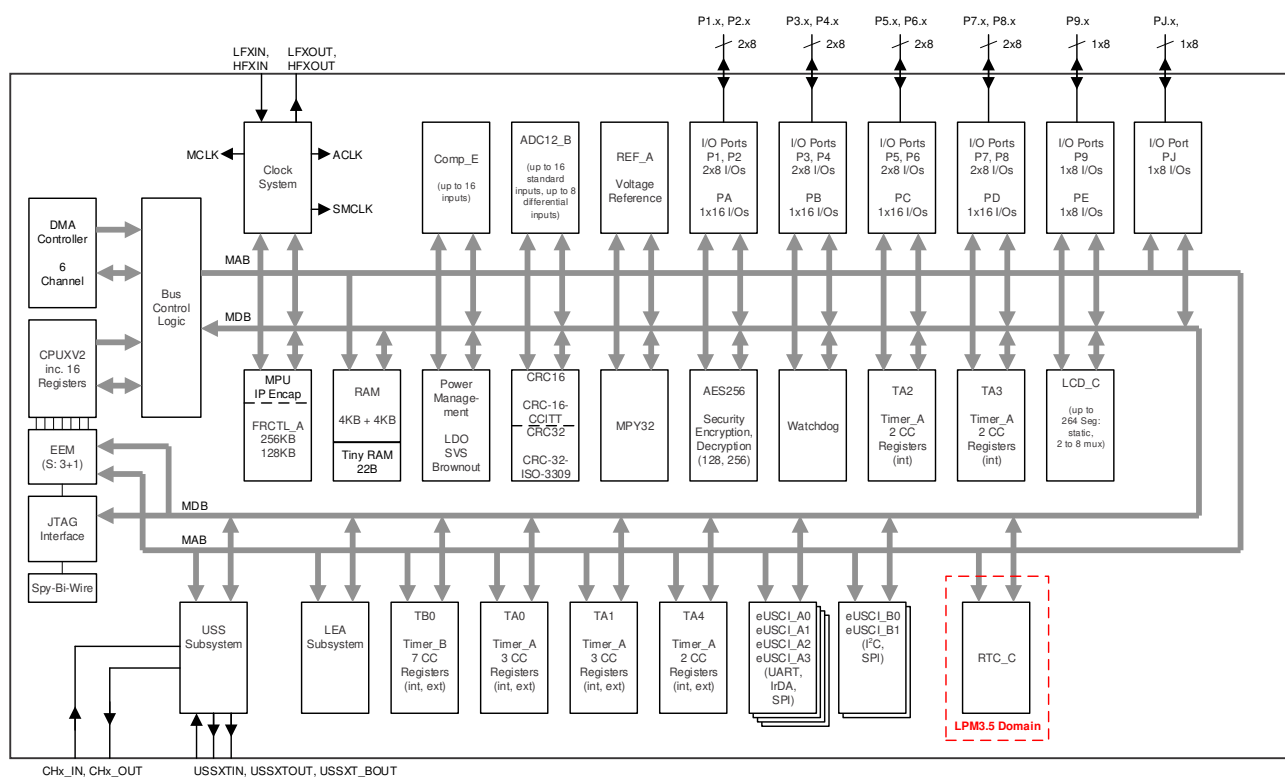
器件信息

| 器件型号 <sup>(1)</sup> (2)            | 封装         | 封装尺寸 <sup>(3)</sup> |
|------------------------------------|------------|---------------------|
| MSP430FR6007IPZ<br>MSP430FR6005IPZ | LQFP (100) | 14mm x 14mm         |

- (1) 如需获得所有可用器件的最新部件、封装和订购信息，请参阅 [封装选项附录](#) (节 12) 或浏览 TI 网站 [www.ti.com.cn](http://www.ti.com.cn)。
- (2) 有关提供的所有器件变型的对比，请参见 [节 6](#)。
- (3) 这里显示的尺寸为近似值。要获得包含误差值的封装尺寸，请参见 [机械数据](#) (节 12)。

## 4 Functional Block Diagrams

图 4-1 show the functional block diagrams of the devices.



NOTE: The device has 8KB of RAM, and 4KB of the RAM is shared with the LEA subsystem.

**图 4-1. MSP430FR600x Functional Block Diagram**

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## 5 Revision History

注：以前版本的页码可能与当前版本的页码不同

| DATE       | REVISION | COMMENTS        |
|------------|----------|-----------------|
| March 2020 | *        | Initial release |

## 6 Device Comparison

表 6-1 summarizes the available family members.

**Table 6-1. Device Comparison**

| DEVICE <sup>(1) (2)</sup> | FRAM<br>(KB) | SRAM<br>(KB) | CLOCK<br>SYSTEM     | LEA | USS<br>USSXT | ADC12_B<br>(Channels)      | Comp_E<br>(Channels) | Timer_A <sup>(3)</sup>                       | Timer_B <sup>(4)</sup> | eUSCI_A <sup>(5)</sup> | eUSCI_B <sup>(6)</sup> | AES | BSL  | I/Os | PACKAGE          |
|---------------------------|--------------|--------------|---------------------|-----|--------------|----------------------------|----------------------|----------------------------------------------|------------------------|------------------------|------------------------|-----|------|------|------------------|
| MSP430FR6007              | 256          | 8            | DCO<br>HFXT<br>LFXT | Yes | Yes          | 16 external,<br>2 internal | 16                   | 3, 3 <sup>(7)</sup><br>2, 2,2 <sup>(8)</sup> | 7                      | 4                      | 2                      | Yes | UART | 76   | 100 PZ<br>(LQFP) |
| MSP430FR6005              | 128          | 8            | DCO<br>HFXT<br>LFXT | Yes | Yes          | 16 external,<br>2 internal | 16                   | 3, 3 <sup>(7)</sup><br>2, 2,2 <sup>(8)</sup> | 7                      | 4                      | 2                      | Yes | UART | 76   | 100 PZ<br>(LQFP) |

- (1) For the most current package and ordering information, see the *Package Option Addendum* in 节 12, or see the TI website at [www.ti.com](http://www.ti.com).
- (2) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/packaging](http://www.ti.com/packaging).
- (3) Each number in the sequence represents an instantiation of Timer\_A with its associated number of capture/compare registers and PWM output generators available. For example, a number sequence of 3, 5 would represent two instantiations of Timer\_A, the first instantiation having three capture/compare registers and PWM output generators and the second instantiation having five capture/compare registers and PWM output generators, respectively.
- (4) Each number in the sequence represents an instantiation of Timer\_B with its associated number of capture/compare registers and PWM output generators available. For example, a number sequence of 3, 5 would represent two instantiations of Timer\_B, the first instantiation having three capture/compare registers and PWM output generators and the second instantiation having five capture/compare registers and PWM output generators, respectively.
- (5) eUSCI\_A supports UART with automatic baud-rate detection, IrDA encode and decode, and SPI.
- (6) eUSCI\_B supports I<sup>2</sup>C with multiple slave addresses and SPI.
- (7) Timers TA0 and TA1 provide internal and external capture/compare inputs and internal and external PWM outputs.
- (8) Timers TA2 and TA3 provide only internal capture/compare inputs and only internal PWM outputs (if any) whereas Timer TA4 provides internal, external capture/compare inputs and internal, external PWM outputs.

## 6.1 Related Products

For information about other devices in this family of products or related products, see the following links.

[TI 16-bit and 32-bit microcontrollers](#)

High-performance, low-power solutions to enable the autonomous future

[Products for MSP430 ultra-low-power sensing & measurement microcontrollers](#)

One platform. One ecosystem. Endless possibilities.

[Companion products for MSP430FR6007](#)

Review products that are frequently purchased or used with this product.

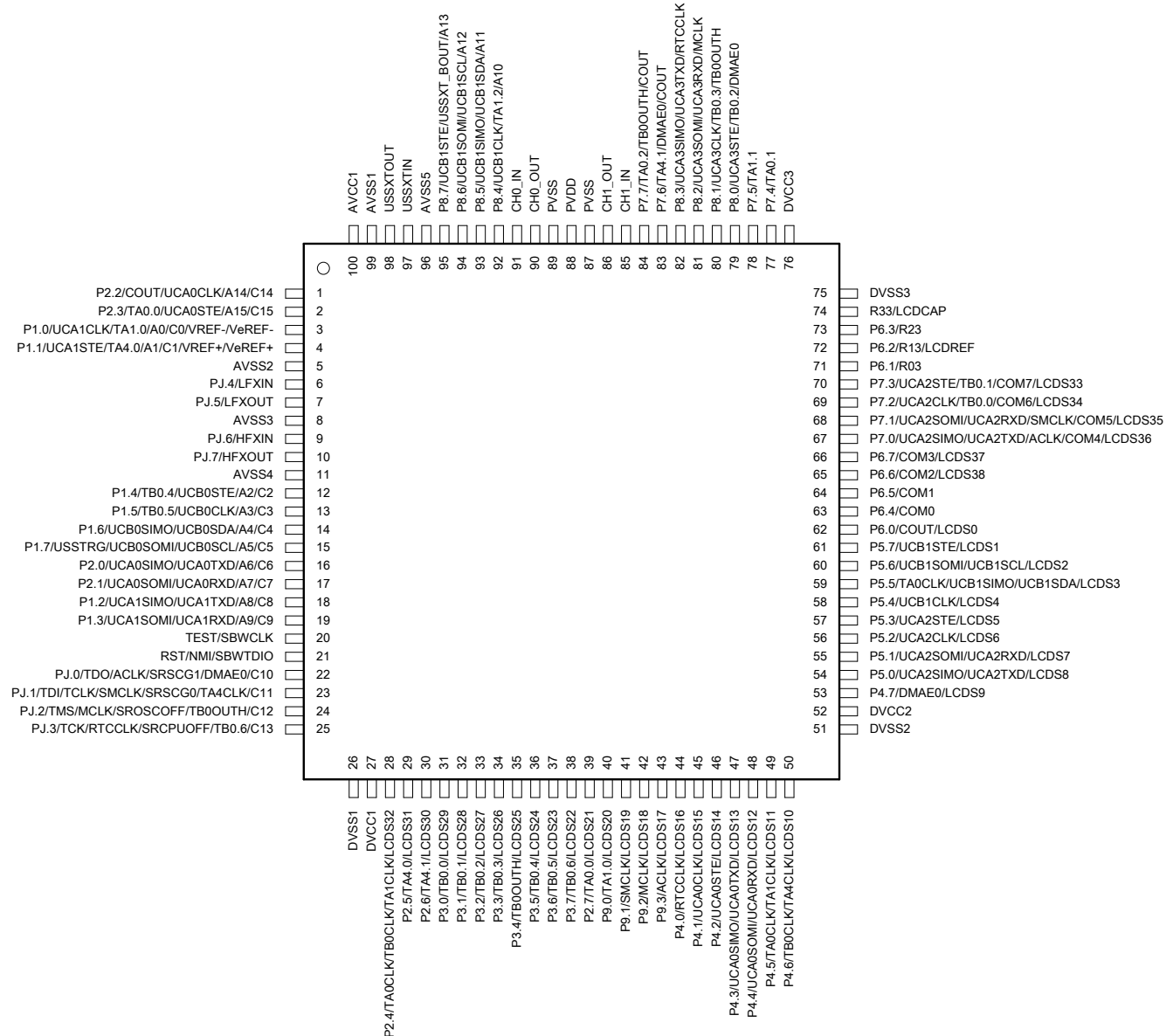
[Reference designs for MSP430FR6007](#)

Find reference designs leveraging the best in TI technology – from analog and power management to embedded processors.

## 7 Terminal Configuration and Functions

### 7.1 Pin Diagram

图 7-1 和 图 7-1 show the pinouts of the 100-pin PZ packages.



On devices with UART BSL: P2.0 is BSLTX, P2.1 is BSLRX  
On devices with I<sup>2</sup>C BSL: P1.6 is BSLSDA, P1.7 is BSLSCL

**图 7-1. MSP430FR600x 100-Pin PZ Package (Top View)**

## 7.2 Pin Attributes

表 7-1 lists the attributes of each pin.

**Table 7-1. Pin Attributes**

| PIN NUMBER | SIGNAL NAME <sup>(1) (4)</sup> | SIGNAL TYPE <sup>(2)</sup> | BUFFER TYPE <sup>(3)</sup> | POWER SOURCE <sup>(5)</sup> | RESET STATE AFTER BOR <sup>(7)</sup> |
|------------|--------------------------------|----------------------------|----------------------------|-----------------------------|--------------------------------------|
| 1          | P2.2                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | CO UT                          | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | UCA0CLK                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | A14                            | I                          | Analog                     | DVCC                        | –                                    |
|            | C14                            | I                          | Analog                     | DVCC                        | –                                    |
| 2          | P2.3                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TA0.0                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | UCA0STE                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | A15                            | I                          | Analog                     | DVCC                        | –                                    |
|            | C15                            | I                          | Analog                     | DVCC                        | –                                    |
| 3          | P1.0                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA1CLK                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | TA1.0                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | A0                             | I                          | Analog                     | DVCC                        | –                                    |
|            | C0                             | I                          | Analog                     | DVCC                        | –                                    |
|            | VREF-                          | O                          | Analog                     | DVCC                        | –                                    |
|            | VeREF-                         | I                          | Analog                     | DVCC                        | –                                    |
| 4          | P1.1                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA1STE                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | TA4.0                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | A1                             | I                          | Analog                     | DVCC                        | –                                    |
|            | C1                             | I                          | Analog                     | DVCC                        | –                                    |
|            | VREF+                          | O                          | Analog                     | DVCC                        | –                                    |
|            | VeREF+                         | I                          | Analog                     | DVCC                        | –                                    |
| 5          | AVSS2                          | P                          | Power                      | –                           | N/A                                  |
| 6          | PJ.4                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | LFXIN                          | I                          | Analog                     | DVCC                        | –                                    |
| 7          | PJ.5                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | LFXOUT                         | O                          | Analog                     | DVCC                        | –                                    |
| 8          | AVSS3                          | P                          | Power                      | –                           | N/A                                  |
| 9          | PJ.6                           | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | HFXIN                          | I                          | Analog                     | DVCC                        | –                                    |
| 10         | PJ.7                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | HFXOUT                         | O                          | Analog                     | DVCC                        | –                                    |
| 11         | AVSS4                          | P                          | Power                      | –                           | N/A                                  |
| 12         | P1.4                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TB0.4                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | UCB0STE                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | A2                             | I                          | Analog                     | DVCC                        | –                                    |
|            | C2                             | I                          | Analog                     | DVCC                        | –                                    |
| 13         | P1.5                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TB0.5                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |



**Table 7-1. Pin Attributes (continued)**

| PIN NUMBER | SIGNAL NAME <sup>(1) (4)</sup> | SIGNAL TYPE <sup>(2)</sup> | BUFFER TYPE <sup>(3)</sup> | POWER SOURCE <sup>(5)</sup> | RESET STATE AFTER BOR <sup>(7)</sup> |
|------------|--------------------------------|----------------------------|----------------------------|-----------------------------|--------------------------------------|
|            | UCB0CLK                        | I/O                        | LVMOS                      | DVCC                        | –                                    |
|            | A3                             | I                          | Analog                     | DVCC                        | –                                    |
|            | C3                             | I                          | Analog                     | DVCC                        | –                                    |
| 14         | P1.6                           | I/O                        | LVMOS                      | DVCC                        | OFF                                  |
|            | UCB0SIMO                       | I/O                        | LVMOS                      | DVCC                        | –                                    |
|            | UCB0SDA                        | I/O                        | LVMOS                      | DVCC                        | –                                    |
|            | A4                             | I                          | Analog                     | DVCC                        | –                                    |
|            | C4                             | I                          | Analog                     | DVCC                        | –                                    |
| 15         | P1.7                           | I/O                        | LVMOS                      | DVCC                        | OFF                                  |
|            | USSTRG                         | I                          | LVMOS                      | DVCC                        | –                                    |
|            | UCB0SOMI                       | I/O                        | LVMOS                      | DVCC                        | –                                    |
|            | UCB0SCL                        | I/O                        | LVMOS                      | DVCC                        | –                                    |
|            | A5                             | I                          | Analog                     | DVCC                        | –                                    |
|            | C5                             | I                          | Analog                     | DVCC                        | –                                    |
| 16         | P2.0                           | I/O                        | LVMOS                      | DVCC                        | OFF                                  |
|            | UCA0TXD                        | O                          | LVMOS                      | DVCC                        | –                                    |
|            | UCA0SIMO                       | I/O                        | LVMOS                      | DVCC                        | –                                    |
|            | A6                             | I                          | Analog                     | DVCC                        | –                                    |
|            | C6                             | I                          | Analog                     | DVCC                        | –                                    |
| 17         | P2.1                           | I/O                        | LVMOS                      | DVCC                        | OFF                                  |
|            | UCA0RXD                        | I                          | LVMOS                      | DVCC                        | –                                    |
|            | UCA0SOMI                       | I/O                        | LVMOS                      | DVCC                        | –                                    |
|            | A7                             | I                          | Analog                     | DVCC                        | –                                    |
|            | C7                             | I                          | Analog                     | DVCC                        | –                                    |
| 18         | P1.2                           | I/O                        | LVMOS                      | DVCC                        | OFF                                  |
|            | UCA1TXD                        | O                          | LVMOS                      | DVCC                        | –                                    |
|            | UCA1SIMO                       | I/O                        | LVMOS                      | DVCC                        | –                                    |
|            | A8                             | I                          | Analog                     | DVCC                        | –                                    |
|            | C8                             | I                          | Analog                     | DVCC                        | –                                    |
| 19         | P1.3                           | I/O                        | LVMOS                      | DVCC                        | OFF                                  |
|            | UCA1RXD                        | I                          | LVMOS                      | DVCC                        | –                                    |
|            | UCA1SOMI                       | I/O                        | LVMOS                      | DVCC                        | –                                    |
|            | A9                             | I                          | Analog                     | DVCC                        | –                                    |
|            | C9                             | I                          | Analog                     | DVCC                        | –                                    |
| 20         | TEST                           | I                          | LVMOS                      | DVCC                        | PD                                   |
|            | SBWTCK                         | I                          | LVMOS                      | DVCC                        | –                                    |
| 21         | RST                            | I/O                        | LVMOS                      | DVCC                        | PU                                   |
|            | NMI                            | I                          | LVMOS                      | DVCC                        | –                                    |
|            | SBWTDIO                        | I/O                        | LVMOS                      | DVCC                        | –                                    |
| 22         | PJ.0                           | I/O                        | LVMOS                      | DVCC                        | OFF                                  |
|            | TDO                            | O                          | LVMOS                      | DVCC                        | –                                    |
|            | ACLK                           | O                          | LVMOS                      | DVCC                        | –                                    |
|            | SRSCG1                         | O                          | LVMOS                      | DVCC                        | –                                    |
|            | DMAE0                          | I                          | LVMOS                      | DVCC                        | –                                    |

Table 7-1. Pin Attributes (continued)

| PIN NUMBER | SIGNAL NAME <sup>(1) (4)</sup> | SIGNAL TYPE <sup>(2)</sup> | BUFFER TYPE <sup>(3)</sup> | POWER SOURCE <sup>(5)</sup> | RESET STATE AFTER BOR <sup>(7)</sup> |
|------------|--------------------------------|----------------------------|----------------------------|-----------------------------|--------------------------------------|
|            | C10                            | I                          | Analog                     | DVCC                        | –                                    |
| 23         | PJ.1                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TDI                            | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | TCLK                           | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | SMCLK                          | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | SRSCG0                         | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | TA4CLK                         | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | C11                            | I                          | Analog                     | DVCC                        | –                                    |
| 24         | PJ.2                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TMS                            | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | MCLK                           | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | SROSCOFF                       | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | TB0OUTH                        | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | C12                            | I                          | Analog                     | DVCC                        | –                                    |
| 25         | PJ.3                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TCK                            | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | RTCCLK                         | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | SRCPUOFF                       | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | TB0.6                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | C13                            | I                          | Analog                     | DVCC                        | –                                    |
| 26         | DVSS1                          | P                          | Power                      | –                           | N/A                                  |
| 27         | DVCC1                          | P                          | Power                      | –                           | N/A                                  |
| 28         | P2.4                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TA0CLK                         | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | TB0CLK                         | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | TA1CLK                         | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | S32                            | O                          | Analog                     | DVCC                        | –                                    |
| 29         | P2.5                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TA4.0                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S31                            | O                          | Analog                     | DVCC                        | –                                    |
| 30         | P2.6                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TA4.1                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S30                            | O                          | Analog                     | DVCC                        | –                                    |
| 31         | P3.0                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TB0.0                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S29                            | O                          | Analog                     | DVCC                        | –                                    |
| 32         | P3.1                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TB0.1                          | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | S28                            | O                          | Analog                     | DVCC                        | –                                    |
| 33         | P3.2                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TB0.2                          | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | S27                            | O                          | Analog                     | DVCC                        | –                                    |
| 34         | P3.3                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TB0.3                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S26                            | O                          | Analog                     | DVCC                        | –                                    |

**Table 7-1. Pin Attributes (continued)**

| PIN NUMBER | SIGNAL NAME <sup>(1) (4)</sup> | SIGNAL TYPE <sup>(2)</sup> | BUFFER TYPE <sup>(3)</sup> | POWER SOURCE <sup>(5)</sup> | RESET STATE AFTER BOR <sup>(7)</sup> |
|------------|--------------------------------|----------------------------|----------------------------|-----------------------------|--------------------------------------|
| 35         | P3.4                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TB0OUTH                        | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | S25                            | O                          | Analog                     | DVCC                        | –                                    |
| 36         | P3.5                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TB0.4                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S24                            | O                          | Analog                     | DVCC                        | –                                    |
| 37         | P3.6                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TB0.5                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S23                            | O                          | Analog                     | DVCC                        | –                                    |
| 38         | P3.7                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TB0.6                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S22                            | O                          | Analog                     | DVCC                        | –                                    |
| 39         | P2.7                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TA0.0                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S21                            | O                          | Analog                     | DVCC                        | –                                    |
| 40         | P9.0                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TA1.0                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S20                            | O                          | Analog                     | DVCC                        | –                                    |
| 41         | P9.1                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | SMCLK                          | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | S19                            | O                          | Analog                     | DVCC                        | –                                    |
| 42         | P9.2                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | MCLK                           | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | S18                            | O                          | Analog                     | DVCC                        | –                                    |
| 43         | P9.3                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | ACLK                           | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | S17                            | O                          | Analog                     | DVCC                        | –                                    |
| 44         | P4.0                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | RTCCLK                         | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | S16                            | O                          | Analog                     | DVCC                        | –                                    |
| 45         | P4.1                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA0CLK                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S15                            | O                          | Analog                     | DVCC                        | –                                    |
| 46         | P4.2                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA0STE                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S14                            | O                          | Analog                     | DVCC                        | –                                    |
| 47         | P4.3                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA0TXD                        | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | UCA0SIMO                       | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S13                            | O                          | Analog                     | DVCC                        | –                                    |
| 48         | P4.4                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA0RXD                        | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | UCA0SOMI                       | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S12                            | O                          | Analog                     | DVCC                        | –                                    |

Table 7-1. Pin Attributes (continued)

| PIN NUMBER | SIGNAL NAME <sup>(1) (4)</sup> | SIGNAL TYPE <sup>(2)</sup> | BUFFER TYPE <sup>(3)</sup> | POWER SOURCE <sup>(5)</sup> | RESET STATE AFTER BOR <sup>(7)</sup> |
|------------|--------------------------------|----------------------------|----------------------------|-----------------------------|--------------------------------------|
| 49         | P4.5                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TA0CLK                         | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | TA1CLK                         | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | S11                            | O                          | Analog                     | DVCC                        | –                                    |
| 50         | P4.6                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TB0CLK                         | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | TA4CLK                         | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | S10                            | O                          | Analog                     | DVCC                        | –                                    |
| 51         | DVSS2                          | P                          | Power                      | –                           | N/A                                  |
| 52         | DVCC2                          | P                          | Power                      | –                           | N/A                                  |
| 53         | P4.7                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | DMAE0                          | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | S9                             | O                          | Analog                     | DVCC                        | –                                    |
| 54         | P5.0                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA2TXD                        | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | UCA2SIMO                       | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S8                             | O                          | Analog                     | DVCC                        | –                                    |
| 55         | P5.1                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA2RXD                        | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | UCA2SOMI                       | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S7                             | O                          | Analog                     | DVCC                        | –                                    |
| 56         | P5.2                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA2CLK                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S6                             | O                          | Analog                     | DVCC                        | –                                    |
| 57         | P5.3                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA2STE                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S5                             | O                          | Analog                     | DVCC                        | –                                    |
| 58         | P5.4                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCB1CLK                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S4                             | O                          | Analog                     | DVCC                        | –                                    |
| 59         | P5.5                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TA0CLK                         | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | UCB1SIMO                       | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | UCB1SDA                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S3                             | O                          | Analog                     | DVCC                        | –                                    |
| 60         | P5.6                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCB1SOMI                       | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | UCB1SCL                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S2                             | O                          | Analog                     | DVCC                        | –                                    |
| 61         | P5.7                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCB1STE                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | S1                             | O                          | Analog                     | DVCC                        | –                                    |
| 62         | P6.0                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | COUT                           | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | S0                             | O                          | Analog                     | DVCC                        | –                                    |

**Table 7-1. Pin Attributes (continued)**

| PIN NUMBER | SIGNAL NAME <sup>(1) (4)</sup> | SIGNAL TYPE <sup>(2)</sup> | BUFFER TYPE <sup>(3)</sup> | POWER SOURCE <sup>(5)</sup> | RESET STATE AFTER BOR <sup>(7)</sup> |
|------------|--------------------------------|----------------------------|----------------------------|-----------------------------|--------------------------------------|
| 63         | P6.4                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | COM0                           | O                          | Analog                     | DVCC                        | –                                    |
| 64         | P6.5                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | COM1                           | O                          | Analog                     | DVCC                        | –                                    |
| 65         | P6.6                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | COM2                           | O                          | Analog                     | DVCC                        | –                                    |
|            | S38                            | O                          | Analog                     | DVCC                        | –                                    |
| 66         | P6.7                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | COM3                           | O                          | Analog                     | DVCC                        | –                                    |
|            | S37                            | O                          | Analog                     | DVCC                        | –                                    |
| 67         | P7.0                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA2TXD                        | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | UCA2SIMO                       | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | ACLK                           | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | COM4                           | O                          | Analog                     | DVCC                        | –                                    |
|            | S36                            | O                          | Analog                     | DVCC                        | –                                    |
| 68         | P7.1                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA2RXD                        | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | UCA2SOMI                       | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | SMCLK                          | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | COM5                           | O                          | Analog                     | DVCC                        | –                                    |
|            | S35                            | O                          | Analog                     | DVCC                        | –                                    |
| 69         | P7.2                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA2CLK                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | TB0.0                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | COM6                           | O                          | Analog                     | DVCC                        | –                                    |
|            | S34                            | O                          | Analog                     | DVCC                        | –                                    |
| 70         | P7.3                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA2STE                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | TB0.1                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | COM7                           | O                          | Analog                     | DVCC                        | –                                    |
|            | S33                            | O                          | Analog                     | DVCC                        | –                                    |
| 71         | P6.1                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | R03                            | I/O                        | Analog                     | DVCC                        | –                                    |
| 72         | P6.2                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | R13                            | I/O                        | Analog                     | DVCC                        | –                                    |
|            | LCDREF                         | I                          | Analog                     | –                           | –                                    |
| 73         | P6.3                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | R23                            | I/O                        | Analog                     | DVCC                        | –                                    |
| 74         | R33                            | I/O                        | Analog                     | DVCC                        | –                                    |
|            | LCD CAP                        | I/O                        | Analog                     | DVCC                        | –                                    |
| 75         | DVSS3                          | P                          | Power                      | –                           | N/A                                  |
| 76         | DVCC3                          | P                          | Power                      | –                           | N/A                                  |
| 77         | P7.4                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |

Table 7-1. Pin Attributes (continued)

| PIN NUMBER | SIGNAL NAME <sup>(1) (4)</sup> | SIGNAL TYPE <sup>(2)</sup> | BUFFER TYPE <sup>(3)</sup> | POWER SOURCE <sup>(5)</sup> | RESET STATE AFTER BOR <sup>(7)</sup> |
|------------|--------------------------------|----------------------------|----------------------------|-----------------------------|--------------------------------------|
|            | TA0.1                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
| 78         | P7.5                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TA1.1                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
| 79         | P8.0                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA3STE                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | TB0.2                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | DMAE0                          | I                          | LVC MOS                    | DVCC                        | –                                    |
| 80         | P8.1                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA3CLK                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | TB0.3                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | TB0OUTH                        | I                          | LVC MOS                    | DVCC                        | –                                    |
| 81         | P8.2                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA3RXD                        | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | UCA3SOMI                       | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | MCLK                           | O                          | LVC MOS                    | DVCC                        | –                                    |
| 82         | P8.3                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCA3TXD                        | O                          | LVC MOS                    | DVCC                        | –                                    |
|            | UCA3SIMO                       | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | RTCCLK                         | O                          | LVC MOS                    | DVCC                        | –                                    |
| 83         | P7.6                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TA4.1                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | DMAE0                          | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | COUT                           | O                          | LVC MOS                    | DVCC                        | –                                    |
| 84         | P7.7                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | TA0.2                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | TB0OUTH                        | I                          | LVC MOS                    | DVCC                        | –                                    |
|            | COUT                           | O                          | LVC MOS                    | DVCC                        | –                                    |
| 85         | CH1_IN                         | I                          | Analog                     | PVCC                        | –                                    |
| 86         | CH1_OUT                        | O                          | Analog                     | PVCC                        | –                                    |
| 87         | PVSS                           | P                          | Power                      | –                           | N/A                                  |
| 88         | PVCC                           | P                          | Power                      | –                           | N/A                                  |
| 89         | PVSS                           | P                          | Power                      | –                           | N/A                                  |
| 90         | CH0_OUT                        | O                          | Analog                     | PVCC                        | –                                    |
| 91         | CH0_IN                         | I                          | Analog                     | PVCC                        | –                                    |
| 92         | P8.4                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCB1CLK                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | TA1.2                          | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | A10                            | I                          | Analog                     | DVCC                        | –                                    |
| 93         | P8.5                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCB1SIMO                       | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | UCB1SDA                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | A11                            | I                          | Analog                     | DVCC                        | –                                    |
| 94         | P8.6                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCB1SOMI                       | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | UCB1SCL                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |

**Table 7-1. Pin Attributes (continued)**

| PIN NUMBER | SIGNAL NAME <sup>(1) (4)</sup> | SIGNAL TYPE <sup>(2)</sup> | BUFFER TYPE <sup>(3)</sup> | POWER SOURCE <sup>(5)</sup> | RESET STATE AFTER BOR <sup>(7)</sup> |
|------------|--------------------------------|----------------------------|----------------------------|-----------------------------|--------------------------------------|
|            | A12                            | I                          | Analog                     | DVCC                        | –                                    |
| 95         | P8.7                           | I/O                        | LVC MOS                    | DVCC                        | OFF                                  |
|            | UCB1STE                        | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | USSXT_BOUT                     | I/O                        | LVC MOS                    | DVCC                        | –                                    |
|            | A13                            | I                          | Analog                     | DVCC                        | –                                    |
| 96         | AVSS5                          | P                          | Power                      | –                           | N/A                                  |
| 97         | USSXTIN <sup>(6)</sup>         | I                          | Analog                     | 1.5 V                       | –                                    |
| 98         | USSXTOUT <sup>(6)</sup>        | O                          | Analog                     | 1.5 V                       | –                                    |
| 99         | AVSS1                          | P                          | Power                      | –                           | N/A                                  |
| 100        | AVCC1                          | P                          | Power                      | –                           | N/A                                  |

- (1) The signal that is listed first for each pin is the reset default pin name.
- (2) Signal Types: I = Input, O = Output, I/O = Input or Output.
- (3) Buffer Types: LVC MOS, Analog, or Power (see 表 7-3 for details)
- (4) To determine the pin mux encodings for each pin, see 节 9.14.
- (5) The power source shown in this table is the I/O power source, which may differ from the module power source.
- (6) Do not connect USSXTIN and USSXTOUT pins to AVCC nor to DVCC. USSXTIN does not support bypass mode, so do not drive an external clock on the USSXTIN pin.
- (7) Reset States:  
 OFF = High impedance with Schmitt-trigger input and pullup or pulldown (if available) disabled  
 PU = Pullup is enabled  
 PD = Pulldown is enabled  
 N/A = Not applicable

## 7.3 Signal Descriptions

表 7-2 describes the signals.

**Table 7-2. Signal Descriptions**

| FUNCTION   | SIGNAL NAME | PIN NO.    | PIN TYPE <sup>(1)</sup> | DESCRIPTION                                                 |
|------------|-------------|------------|-------------------------|-------------------------------------------------------------|
|            |             | PZ         |                         |                                                             |
| ADC        | A0          | 3          | I                       | ADC analog input A0                                         |
|            | A1          | 4          | I                       | ADC analog input A1                                         |
|            | A2          | 12         | I                       | ADC analog input A2                                         |
|            | A3          | 13         | I                       | ADC analog input A3                                         |
|            | A4          | 14         | I                       | ADC analog input A4                                         |
|            | A5          | 15         | I                       | ADC analog input A5                                         |
|            | A6          | 16         | I                       | ADC analog input A6                                         |
|            | A7          | 17         | I                       | ADC analog input A7                                         |
|            | A8          | 18         | I                       | ADC analog input A8                                         |
|            | A9          | 19         | I                       | ADC analog input A9                                         |
|            | A10         | 92         | I                       | ADC analog input A10                                        |
|            | A11         | 93         | I                       | ADC analog input A11                                        |
|            | A12         | 94         | I                       | ADC analog input A12                                        |
|            | A13         | 95         | I                       | ADC analog input A13                                        |
|            | A14         | 1          | I                       | ADC analog input A14                                        |
|            | A15         | 2          | I                       | ADC analog input A15                                        |
|            | VREF+       | 4          | O                       | Output of positive reference voltage                        |
|            | VREF-       | 3          | O                       | Output of negative reference voltage                        |
|            | VeREF+      | 4          | I                       | Input for an external positive reference voltage to the ADC |
|            | VeREF-      | 3          | I                       | Input for an external negative reference voltage to the ADC |
| Clock      | ACLK        | 22, 43, 67 | O                       | ACLK output                                                 |
|            | HFXIN       | 9          | I                       | Input for high-frequency crystal oscillator HFXT            |
|            | HFXOUT      | 10         | O                       | Output for high-frequency crystal oscillator HFXT           |
|            | LFXIN       | 6          | I                       | Input for low-frequency crystal oscillator LFXT             |
|            | LFXOUT      | 7          | O                       | Output of low-frequency crystal oscillator LFXT             |
|            | MCLK        | 24, 42, 81 | O                       | MCLK output                                                 |
|            | SMCLK       | 23, 41, 68 | O                       | SMCLK output                                                |
| Comparator | C0          | 3          | I                       | Comparator input C0                                         |
|            | C1          | 4          | I                       | Comparator input C1                                         |
|            | C2          | 12         | I                       | Comparator input C2                                         |
|            | C3          | 13         | I                       | Comparator input C3                                         |
|            | C4          | 14         | I                       | Comparator input C4                                         |
|            | C5          | 15         | I                       | Comparator input C5                                         |
|            | C6          | 16         | I                       | Comparator input C6                                         |
|            | C7          | 17         | I                       | Comparator input C7                                         |
|            | C8          | 18         | I                       | Comparator input C8                                         |
|            | C9          | 19         | I                       | Comparator input C9                                         |
|            | C10         | 22         | I                       | Comparator input C10                                        |
|            | C11         | 23         | I                       | Comparator input C11                                        |
|            | C12         | 24         | I                       | Comparator input C12                                        |



**Table 7-2. Signal Descriptions (continued)**

| FUNCTION    | SIGNAL NAME | PIN NO.<br>PZ | PIN TYPE <sup>(1)</sup> | DESCRIPTION                                                            |
|-------------|-------------|---------------|-------------------------|------------------------------------------------------------------------|
|             |             |               |                         |                                                                        |
|             | C13         | 25            | I                       | Comparator input C13                                                   |
|             | C14         | 1             | I                       | Comparator input C14                                                   |
|             | C15         | 2             | I                       | Comparator input C15                                                   |
|             | COUT        | 1, 83, 84     | O                       | Comparator output                                                      |
| DMA         | DMAE0       | 22, 79, 83    | I                       | External DMA trigger                                                   |
| Debug       | SBWTCK      | 20            | I                       | Spy-Bi-Wire input clock                                                |
|             | SBWTDIO     | 21            | I/O                     | Spy-Bi-Wire data input/output                                          |
|             | SRCPUOFF    | 25            | O                       | Low-power debug: CPU Status register bit CPUOFF                        |
|             | SROSCOFF    | 24            | O                       | Low-power debug: CPU Status register bit OSCOFF                        |
|             | SRSCG0      | 23            | O                       | Low-power debug: CPU Status register bit SCG0                          |
|             | SRSCG1      | 22            | O                       | Low-power debug: CPU Status register bit SCG1                          |
|             | TCK         | 25            | I                       | Test clock                                                             |
|             | TCLK        | 23            | I                       | Test clock input                                                       |
|             | TDI         | 23            | I                       | Test data input                                                        |
|             | TDO         | 22            | O                       | Test data output port                                                  |
|             | TEST        | 20            | I                       | Test mode pin, selects digital I/O on JTAG pins                        |
|             | TMS         | 24            | I                       | Test mode select                                                       |
| GPIO Port 1 | P1.0        | 3             | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P1.1        | 4             | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P1.2        | 18            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P1.3        | 19            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P1.4        | 12            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P1.5        | 13            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P1.6        | 14            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P1.7        | 15            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
| GPIO Port 2 | P2.0        | 16            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P2.1        | 17            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P2.2        | 1             | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P2.3        | 2             | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P2.4        | 28            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P2.5        | 29            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P2.6        | 30            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P2.7        | 39            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
| GPIO Port 3 | P3.0        | 31            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P3.1        | 32            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P3.2        | 33            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P3.3        | 34            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P3.4        | 35            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P3.5        | 36            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P3.6        | 37            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P3.7        | 38            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
| GPIO Port 4 | P4.0        | 44            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P4.1        | 45            | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |

Table 7-2. Signal Descriptions (continued)

| FUNCTION    | SIGNAL NAME | PIN NO. | PIN TYPE <sup>(1)</sup> | DESCRIPTION                                                            |
|-------------|-------------|---------|-------------------------|------------------------------------------------------------------------|
|             |             | PZ      |                         |                                                                        |
|             | P4.2        | 46      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P4.3        | 47      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P4.4        | 48      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P4.5        | 49      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P4.6        | 50      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P4.7        | 53      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
| GPIO Port 5 | P5.0        | 54      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P5.1        | 55      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P5.2        | 56      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P5.3        | 57      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P5.4        | 58      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P5.5        | 59      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P5.6        | 60      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P5.7        | 61      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
| GPIO Port 6 | P6.0        | 62      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P6.1        | 71      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P6.2        | 72      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P6.3        | 73      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P6.4        | 63      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P6.5        | 64      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P6.6        | 65      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P6.7        | 66      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
| GPIO Port 7 | P7.0        | 67      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P7.1        | 68      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P7.2        | 69      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P7.3        | 70      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P7.4        | 77      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P7.5        | 78      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P7.6        | 83      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P7.7        | 84      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
| GPIO Port 8 | P8.0        | 79      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P8.1        | 80      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P8.2        | 81      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P8.3        | 82      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P8.4        | 92      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P8.5        | 93      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P8.6        | 94      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P8.7        | 95      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
| GPIO Port 9 | P9.0        | 40      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P9.1        | 41      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P9.2        | 42      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
|             | P9.3        | 43      | I/O                     | General-purpose digital I/O with port interrupt and wakeup from LPMx.5 |
| GPIO Port J | PJ.0        | 22      | I/O                     | General-purpose digital I/O                                            |
|             | PJ.1        | 23      | I/O                     | General-purpose digital I/O                                            |

**Table 7-2. Signal Descriptions (continued)**

| FUNCTION         | SIGNAL NAME | PIN NO. | PIN TYPE <sup>(1)</sup> | DESCRIPTION                                                                                                              |
|------------------|-------------|---------|-------------------------|--------------------------------------------------------------------------------------------------------------------------|
|                  |             | PZ      |                         |                                                                                                                          |
|                  | PJ.2        | 24      | I/O                     | General-purpose digital I/O                                                                                              |
|                  | PJ.3        | 25      | I/O                     | General-purpose digital I/O                                                                                              |
|                  | PJ.4        | 6       | I/O                     | General-purpose digital I/O                                                                                              |
|                  | PJ.5        | 7       | I/O                     | General-purpose digital I/O                                                                                              |
|                  | PJ.6        | 9       | I/O                     | General-purpose digital I/O                                                                                              |
|                  | PJ.7        | 10      | I/O                     | General-purpose digital I/O                                                                                              |
| I <sup>2</sup> C | UCB0SCL     | 15      | I/O                     | I <sup>2</sup> C clock for eUSCI_B0 I <sup>2</sup> C mode                                                                |
|                  | UCB0SDA     | 14      | I/O                     | I <sup>2</sup> C data for eUSCI_B0 I <sup>2</sup> C mode                                                                 |
|                  | UCB1SCL     | 94, 60  | I/O                     | I <sup>2</sup> C clock for eUSCI_B1 I <sup>2</sup> C mode                                                                |
|                  | UCB1SDA     | 93, 59  | I/O                     | I <sup>2</sup> C data for eUSCI_B1 I <sup>2</sup> C mode                                                                 |
| LCD              | COM0        | 63      | O                       | LCD common output COM0 for LCD backplane                                                                                 |
|                  | COM1        | 64      | O                       | LCD common output COM1 for LCD backplane                                                                                 |
|                  | COM2        | 65      | O                       | LCD common output COM2 for LCD backplane                                                                                 |
|                  | COM3        | 66      | O                       | LCD common output COM3 for LCD backplane                                                                                 |
|                  | COM4        | 67      | O                       | LCD common output COM4 for LCD backplane                                                                                 |
|                  | COM5        | 68      | O                       | LCD common output COM5 for LCD backplane                                                                                 |
|                  | COM6        | 69      | O                       | LCD common output COM6 for LCD backplane                                                                                 |
|                  | COM7        | 70      | O                       | LCD common output COM7 for LCD backplane                                                                                 |
|                  | LCDCAP      | 74      | I/O                     | LCD capacitor connection<br>CAUTION: LCDCAP/R33 must be connected to DVSS if not used.                                   |
|                  | LCDREF      | 72      | I                       | External reference voltage input for regulated LCD voltage                                                               |
|                  | R03         | 71      | I/O                     | Input/output port of lowest analog LCD voltage (V5)                                                                      |
|                  | R13         | 72      | I/O                     | Input/output port of third most positive analog LCD voltage (V3 or V4)                                                   |
|                  | R23         | 73      | I/O                     | Input/output port of second most positive analog LCD voltage (V2)                                                        |
|                  | R33         | 74      | I/O                     | Input/output port of most positive analog LCD voltage (V1)<br>CAUTION: LCDCAP/R33 must be connected to DVSS if not used. |
|                  | S0          | 62      | O                       | LCD segment output                                                                                                       |
|                  | S1          | 61      | O                       | LCD segment output                                                                                                       |
|                  | S2          | 60      | O                       | LCD segment output                                                                                                       |
|                  | S3          | 59      | O                       | LCD segment output                                                                                                       |
|                  | S4          | 58      | O                       | LCD segment output                                                                                                       |
|                  | S5          | 57      | O                       | LCD segment output                                                                                                       |
|                  | S6          | 56      | O                       | LCD segment output                                                                                                       |
|                  | S7          | 55      | O                       | LCD segment output                                                                                                       |
|                  | S8          | 54      | O                       | LCD segment output                                                                                                       |
|                  | S9          | 53      | O                       | LCD segment output                                                                                                       |
|                  | S10         | 50      | O                       | LCD segment output                                                                                                       |
|                  | S11         | 49      | O                       | LCD segment output                                                                                                       |
|                  | S12         | 48      | O                       | LCD segment output                                                                                                       |
|                  | S13         | 47      | O                       | LCD segment output                                                                                                       |
|                  | S14         | 46      | O                       | LCD segment output                                                                                                       |
|                  | S15         | 45      | O                       | LCD segment output                                                                                                       |
|                  | S16         | 44      | O                       | LCD segment output                                                                                                       |
|                  | S17         | 43      | O                       | LCD segment output                                                                                                       |

Table 7-2. Signal Descriptions (continued)

| FUNCTION | SIGNAL NAME | PIN NO.    | PIN TYPE <sup>(1)</sup> | DESCRIPTION                                                                                        |
|----------|-------------|------------|-------------------------|----------------------------------------------------------------------------------------------------|
|          |             | PZ         |                         |                                                                                                    |
|          | S18         | 42         | O                       | LCD segment output                                                                                 |
|          | S19         | 41         | O                       | LCD segment output                                                                                 |
|          | S20         | 40         | O                       | LCD segment output                                                                                 |
|          | S21         | 39         | O                       | LCD segment output                                                                                 |
|          | S22         | 38         | O                       | LCD segment output                                                                                 |
|          | S23         | 37         | O                       | LCD segment output                                                                                 |
|          | S24         | 36         | O                       | LCD segment output                                                                                 |
|          | S25         | 35         | O                       | LCD segment output                                                                                 |
|          | S26         | 34         | O                       | LCD segment output                                                                                 |
|          | S27         | 33         | O                       | LCD segment output                                                                                 |
|          | S28         | 32         | O                       | LCD segment output                                                                                 |
|          | S29         | 31         | O                       | LCD segment output                                                                                 |
|          | S30         | 30         | O                       | LCD segment output                                                                                 |
|          | S31         | 29         | O                       | LCD segment output                                                                                 |
|          | S32         | 28         | O                       | LCD segment output                                                                                 |
|          | S33         | 70         | O                       | LCD segment output                                                                                 |
|          | S34         | 69         | O                       | LCD segment output                                                                                 |
|          | S35         | 68         | O                       | LCD segment output                                                                                 |
|          | S36         | 67         | O                       | LCD segment output                                                                                 |
|          | S37         | 66         | O                       | LCD segment output                                                                                 |
|          | S38         | 65         | O                       | LCD segment output                                                                                 |
| Power    | AVCC1       | 100        | P                       | Analog power supply                                                                                |
|          | AVSS1       | 99         | P                       | Analog ground supply                                                                               |
|          | AVSS2       | 5          | P                       | Analog ground supply                                                                               |
|          | AVSS3       | 8          | P                       | Analog ground supply                                                                               |
|          | AVSS4       | 11         | P                       | Analog ground supply                                                                               |
|          | AVSS5       | 96         | P                       | Analog ground supply                                                                               |
|          | DVCC1       | 27         | P                       | Digital power supply                                                                               |
|          | DVCC2       | 52         | P                       | Digital power supply                                                                               |
|          | DVCC3       | 76         | P                       | Digital power supply                                                                               |
|          | DVSS1       | 26         | P                       | Digital ground supply                                                                              |
|          | DVSS2       | 51         | P                       | Digital ground supply                                                                              |
|          | DVSS3       | 75         | P                       | Digital ground supply                                                                              |
|          | PVCC        | 88         | P                       | USS power supply                                                                                   |
|          | PVSS        | 87, 89     | P                       | USS ground supply                                                                                  |
| RTC      | RTCCLK      | 25, 44, 82 | O                       | RTC clock calibration output                                                                       |
| SPI      | UCA0CLK     | 1, 45      | I/O                     | Clock signal input for eUSCI_A0 SPI slave mode<br>Clock signal output for eUSCI_A0 SPI master mode |
|          | UCA0SIMO    | 16, 47     | I/O                     | Slave in/master out for eUSCI_A0 SPI mode                                                          |
|          | UCA0SOMI    | 17, 48     | I/O                     | Slave out/master in for eUSCI_A0 SPI mode                                                          |
|          | UCA0STE     | 2, 46      | I/O                     | Slave transmit enable for eUSCI_A0 SPI mode                                                        |
|          | UCA1CLK     | 3          | I/O                     | Clock signal input for eUSCI_A1 SPI slave mode<br>Clock signal output for eUSCI_A1 SPI master mode |
|          | UCA1SIMO    | 18         | I/O                     | Slave in/master out for eUSCI_A1 SPI mode                                                          |

**Table 7-2. Signal Descriptions (continued)**

| FUNCTION | SIGNAL NAME | PIN NO.    | PIN TYPE <sup>(1)</sup> | DESCRIPTION                                                                                        |
|----------|-------------|------------|-------------------------|----------------------------------------------------------------------------------------------------|
|          |             | PZ         |                         |                                                                                                    |
|          | UCA1SOMI    | 19         | I/O                     | Slave out/master in for eUSCI_A1 SPI mode                                                          |
|          | UCA1STE     | 4          | I/O                     | Slave transmit enable for eUSCI_A1 SPI mode                                                        |
|          | UCA2CLK     | 69, 56     | I/O                     | Clock signal input for eUSCI_A2 SPI slave mode<br>Clock signal output for eUSCI_A2 SPI master mode |
|          | UCA2SIMO    | 67, 54     | I/O                     | Slave in/master out for eUSCI_A2 SPI mode                                                          |
|          | UCA2SOMI    | 68, 55     | I/O                     | Slave out/master in for eUSCI_A2 SPI mode                                                          |
|          | UCA2STE     | 70, 57     | I/O                     | Slave transmit enable for eUSCI_A2 SPI mode                                                        |
|          | UCA3CLK     | 80         | I/O                     | Clock signal input for eUSCI_A3 SPI slave mode<br>Clock signal output for eUSCI_A3 SPI master mode |
|          | UCA3SIMO    | 82         | I/O                     | Slave in/master out for eUSCI_A3 SPI mode                                                          |
|          | UCA3SOMI    | 81         | I/O                     | Slave out/master in for eUSCI_A3 SPI mode                                                          |
|          | UCA3STE     | 79         | I/O                     | Slave transmit enable for eUSCI_A3 SPI mode                                                        |
|          | UCB0CLK     | 13         | I/O                     | Clock signal input for eUSCI_B0 SPI slave mode<br>Clock signal output for eUSCI_B0 SPI master mode |
|          | UCB0SIMO    | 14         | I/O                     | Slave in/master out for eUSCI_B0 SPI mode                                                          |
|          | UCB0SOMI    | 15         | I/O                     | Slave out/master in for eUSCI_B0 SPI mode                                                          |
|          | UCB0STE     | 12         | I/O                     | Slave transmit enable for eUSCI_B0 SPI mode                                                        |
|          | UCB1CLK     | 92, 58     | I/O                     | Clock signal input for eUSCI_B1 SPI slave mode<br>Clock signal output for eUSCI_B1 SPI master mode |
|          | UCB1SIMO    | 93, 59     | I/O                     | Slave in/master out for eUSCI_B1 SPI mode                                                          |
|          | UCB1SOMI    | 94, 60     | I/O                     | Slave out/master in for eUSCI_B1 SPI mode                                                          |
|          | UCB1STE     | 95, 61     | I/O                     | Slave transmit enable for eUSCI_B1 SPI mode                                                        |
| System   | NMI         | 21         | I                       | Nonmaskable interrupt input                                                                        |
|          | RST         | 21         | I/O                     | Reset input active low                                                                             |
| Timer    | TA0.0       | 2          | I/O                     | TA0 CCR0 capture: CCI0A input, compare: Out0                                                       |
|          | TA0.0       | 39         | I/O                     | TA0 CCR0 capture: CCI0B input, compare: Out0                                                       |
|          | TA0.1       | 77         | I/O                     | TA0 CCR1 capture: CCI1A input, compare: Out1                                                       |
|          | TA0.2       | 84         | I/O                     | TA0 CCR2 capture: CCI2A input, compare: Out2                                                       |
|          | TA0CLK      | 28, 49, 59 | I                       | TA0 input clock                                                                                    |
|          | TA1.0       | 3          | I/O                     | TA1 CCR0 capture: CCI0A input, compare: Out0                                                       |
|          | TA1.0       | 40         | I/O                     | TA1 CCR0 capture: CCI0B input, compare: Out0                                                       |
|          | TA1.1       | 78         | I/O                     | TA1 CCR1 capture: CCI1A input, compare: Out1                                                       |
|          | TA1.2       | 92         | I/O                     | TA1 CCR2 capture: CCI2A input, compare: Out2                                                       |
|          | TA1CLK      | 28, 49     | I                       | TA1 input clock                                                                                    |
|          | TA4.0       | 4          | I/O                     | TA4 CCR0 capture: CCI0A input, compare: Out0                                                       |
|          | TA4.0       | 29         | I/O                     | TA4 CCR0 capture: CCI0B input, compare: Out0                                                       |
|          | TA4.1       | 30         | I/O                     | TA4 CCR1 capture: CCI1B input, compare: Out1                                                       |
|          | TA4.1       | 83         | I/O                     | TA4 CCR1 capture: CCI1A input, compare: Out1                                                       |
|          | TA4CLK      | 23, 50     | I                       | TA4 input clock                                                                                    |
|          | TB0.0       | 31         | I/O                     | TB0 CCR0 capture: CCI0B input, compare: Out0                                                       |
|          | TB0.0       | 69         | I/O                     | TB0 CCR0 capture: CCI0A input, compare: Out0                                                       |
|          | TB0.1       | 32         | I/O                     | TB0 CCR1 capture: CCI1A input, compare: Out1                                                       |
|          | TB0.1       | 70         | O                       | TB0 CCR1 compare: Out1                                                                             |
|          | TB0.2       | 33         | I/O                     | TB0 CCR2 capture: CCI2A input, compare: Out2                                                       |

**Table 7-2. Signal Descriptions (continued)**

| FUNCTION | SIGNAL NAME | PIN NO.        | PIN TYPE <sup>(1)</sup> | DESCRIPTION                                         |
|----------|-------------|----------------|-------------------------|-----------------------------------------------------|
|          |             | PZ             |                         |                                                     |
|          | TB0.2       | 79             | O                       | TB0 CCR2 compare: Out2                              |
|          | TB0.3       | 34             | I/O                     | TB0 CCR3 capture: CCI3A input, compare: Out3        |
|          | TB0.3       | 80             | I/O                     | TB0 CCR3 capture: CCI3B input, compare: Out3        |
|          | TB0.4       | 12             | I/O                     | TB0 CCR4 capture: CCI4A input, compare: Out4        |
|          | TB0.4       | 36             | I/O                     | TB0 CCR4 capture: CCI4B input, compare: Out4        |
|          | TB0.5       | 13             | I/O                     | TB0 CCR5 capture: CCI5A input, compare: Out5        |
|          | TB0.5       | 37             | I/O                     | TB0CCR5 capture: CCI5B input, compare: Out5         |
|          | TB0.6       | 25             | I/O                     | TB0 CCR6 capture: CCI6B input, compare: Out6        |
|          | TB0.6       | 38             | I/O                     | TB0 CCR6 capture: CCI6A input, compare: Out6        |
|          | TB0CLK      | 28, 50         | I                       | TB0 clock input                                     |
|          | TB0OUTH     | 24, 35, 80, 84 | I                       | Switch all PWM outputs high impedance input – TB0   |
| UART     | UCA0RXD     | 17, 48         | I                       | Receive data for eUSCI_A0 UART mode                 |
|          | UCA0TXD     | 16, 47         | O                       | Transmit data for eUSCI_A0 UART mode                |
|          | UCA1RXD     | 19             | I                       | Receive data for eUSCI_A1 UART mode                 |
|          | UCA1TXD     | 18             | O                       | Transmit data for eUSCI_A1 UART mode                |
|          | UCA2RXD     | 68, 55         | I                       | Receive data for eUSCI_A2 UART mode                 |
|          | UCA2TXD     | 67, 54         | O                       | Transmit data for eUSCI_A2 UART mode                |
|          | UCA3RXD     | 81             | I                       | Receive data for eUSCI_A3 UART mode                 |
|          | UCA3TXD     | 82             | O                       | Transmit data for eUSCI_A3 UART mode                |
| USS      | USSTRG      | 15             | I                       | USS trigger                                         |
|          | USSXTIN     | 97             | I                       | Input for crystal or resonator of oscillator USSXT  |
|          | USSXTOUT    | 98             | O                       | Output for crystal or resonator of oscillator USSXT |
|          | USSXT_BOUT  | 95             | O                       | Buffered output clock of USSXT                      |
|          | CH0_IN      | 91             | I                       | USS channel 0 RX                                    |
|          | CH0_OUT     | 90             | I/O                     | USS channel 0 TX                                    |
|          | CH1_IN      | 85             | I                       | USS channel 1 RX                                    |
|          | CH1_OUT     | 86             | I/O                     | USS channel 1 TX                                    |

(1) I = input, O = output, P = power

## 7.4 Pin Multiplexing

Pin multiplexing for these devices is controlled by both register settings and operating modes (for example, if the device is in test mode). For details of the settings for each pin and diagrams of the multiplexed ports, see [节 9.14](#).

## 7.5 Buffer Type

[表 7-3](#) describes the buffer types that are referenced in [表 7-1](#).

**Table 7-3. Buffer Type**

| BUFFER TYPE (STANDARD)      | NOMINAL VOLTAGE | HYSTERESIS       | PULLUP (PU) OR PULLDOWN (PD) | NOMINAL PU OR PD STRENGTH (μA) | OUTPUT DRIVE STRENGTH (mA)   | OTHER CHARACTERISTICS                                  |
|-----------------------------|-----------------|------------------|------------------------------|--------------------------------|------------------------------|--------------------------------------------------------|
| Analog <sup>(2)</sup>       | 3.0 V           | N                | N/A                          | N/A                            | N/A                          | See analog modules in <a href="#">节 8</a> for details. |
| LVC MOS                     | 3.0 V           | Y <sup>(1)</sup> | Programmable                 | See <a href="#">节 8.13.5</a>   | See <a href="#">节 8.13.5</a> |                                                        |
| Power (DVCC) <sup>(3)</sup> | 3.0 V           | N                | N/A                          | N/A                            | N/A                          | SVS enables hysteresis on DVCC.                        |

**Table 7-3. Buffer Type (continued)**

| BUFFER TYPE<br>(STANDARD)               | NOMINAL<br>VOLTAGE | HYSTERESIS | PULLUP (PU)<br>OR<br>PULLDOWN (PD) | NOMINAL<br>PU OR PD<br>STRENGTH<br>( $\mu$ A) | OUTPUT DRIVE<br>STRENGTH<br>(mA) | OTHER<br>CHARACTERISTICS |
|-----------------------------------------|--------------------|------------|------------------------------------|-----------------------------------------------|----------------------------------|--------------------------|
| Power (AVCC) <sup>(3)</sup>             | 3.0 V              | N          | N/A                                | N/A                                           | N/A                              |                          |
| Power (PVCC) <sup>(3)</sup>             | 3.0 V              | N          | N/A                                | N/A                                           | N/A                              |                          |
| Power (DVSS<br>and AVSS) <sup>(3)</sup> | 0 V                | N          | N/A                                | N/A                                           | N/A                              |                          |

- (1) Only for input pins
- (2) This is a switch, not a buffer.
- (3) This is supply input, not a buffer.

## 7.6 Connection of Unused Pins

表 7-4 lists the correct termination of unused pins.

**Table 7-4. Connection of Unused Pins**

| PIN <sup>(1)</sup>                           | POTENTIAL                           | COMMENT                                                                                                                                                                            |
|----------------------------------------------|-------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AVCC                                         | DV <sub>CC</sub>                    |                                                                                                                                                                                    |
| PVCC                                         | DV <sub>CC</sub>                    |                                                                                                                                                                                    |
| AVSS                                         | DV <sub>SS</sub>                    |                                                                                                                                                                                    |
| PVSS                                         | DV <sub>SS</sub>                    |                                                                                                                                                                                    |
| CHx_IN,<br>CHx_OUT                           | DV <sub>SS</sub>                    |                                                                                                                                                                                    |
| USSXTIN                                      | DV <sub>SS</sub>                    | Do not connect to DVCC, AVCC, or PVCC                                                                                                                                              |
| USSXTOUT                                     | Open                                |                                                                                                                                                                                    |
| Px.0 to Px.7                                 | Open                                | Switched to port function, output direction (PxDIR.n = 1)                                                                                                                          |
| RST/NMI/<br>SBWTDIO                          | DV <sub>CC</sub> or V <sub>CC</sub> | 47-kΩ pullup or internal pullup selected with 10-nF (2.2-nF <sup>(2)</sup> ) pulldown                                                                                              |
| PJ.0/TDO<br>PJ.1/TDI<br>PJ.2/TMS<br>PJ.3/TCK | Open                                | The JTAG pins are shared with general-purpose I/O function (PJ.x). If these pins are not used, set them to port function, output direction. If used as JTAG pins, leave them open. |
| TEST                                         | Open                                | This pin always has an internal pulldown enabled.                                                                                                                                  |

- (1) For any unused pin with a secondary function that is shared with general-purpose I/O, follow the guidelines for the Px.0 to Px.7 pins.
- (2) The pulldown capacitor must not exceed 2.2 nF when using devices with Spy-Bi-Wire interface in Spy-Bi-Wire mode or in 4-wire JTAG mode with TI tools like FET interfaces or GANG programmers.



## 8 Specifications

### 8.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |                                                                   |                                                      | MIN  | MAX                                    | UNIT |
|------------------|-------------------------------------------------------------------|------------------------------------------------------|------|----------------------------------------|------|
| V <sub>CC</sub>  | Supply voltage <sup>(3)</sup>                                     | At DVCC and AVCC pins                                | −0.3 | 4.1                                    | V    |
|                  |                                                                   | At DVCC, AVCC, and PVCC pins                         | −0.3 | 4.1                                    |      |
|                  | Voltage difference between DVCC and AVCC pins <sup>(2)</sup>      |                                                      |      | ±0.3                                   | V    |
|                  | Voltage difference among DVCC, AVCC, and PVCC pins <sup>(2)</sup> |                                                      |      | ±0.3                                   | V    |
| V <sub>I</sub>   | Input voltage <sup>(3)</sup>                                      | Applied to CHx_IN                                    | −0.3 | 1.65                                   | V    |
|                  |                                                                   | Applied to CHx_IN with a duty cycle of 10% over 1 ms | −0.3 | 1.8                                    |      |
|                  |                                                                   | Applied to USSXTIN (USSXTOUT)                        | −0.3 | 1.5                                    |      |
|                  |                                                                   | Applied to any other pin                             | −0.3 | V <sub>CC</sub> + 0.3 V<br>(4.1 V Max) |      |
|                  | Diode current at any device pin                                   |                                                      |      | ±2                                     | mA   |
| T <sub>stg</sub> | Storage temperature <sup>(4)</sup>                                |                                                      | −40  | 125                                    | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Voltage differences between DVCC and AVCC that exceed the specified limits can cause malfunction of the device including erroneous writes to RAM and FRAM.
- (3) Voltages are referenced to V<sub>SS</sub>.
- (4) Higher temperature may be applied during board soldering according to the current JEDEC J-STD-020 specification with peak reflow temperatures not higher than classified on the device label on the shipping boxes or reels.

### 8.2 ESD Ratings

|                    |                                                        |                                                                                | VALUE | UNIT |
|--------------------|--------------------------------------------------------|--------------------------------------------------------------------------------|-------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge (all except CHx_OUT terminals) | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±1000 | V    |
|                    |                                                        | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±250  |      |
| V <sub>(ESD)</sub> | Electrostatic discharge (on CHx_OUT terminals)         | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±1000 | V    |
|                    |                                                        | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±250  |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. Pins listed as ±1000 V may actually have higher performance.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process. Pins listed as ±250 V may actually have higher performance.

### 8.3 Recommended Operating Conditions

TYP data are based on  $V_{CC} = 3.0\text{ V}$  and  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

|              |                                                                                   | MIN                                                | NOM | MAX                | UNIT               |
|--------------|-----------------------------------------------------------------------------------|----------------------------------------------------|-----|--------------------|--------------------|
| $V_{CC}$     | Supply voltage range applied at all DVCC and AVCC pins <sup>(1) (3) (4) (2)</sup> | 1.8 <sup>(7)</sup>                                 |     | 3.6                | V                  |
| $V_{CC}$     | Supply voltage range applied at PVCC pin <sup>(1)</sup>                           | 2.2                                                |     | 3.6                | V                  |
| $V_{SS}$     | Supply voltage applied at all DVSS, AVSS, and PVSS pins                           |                                                    | 0   |                    | V                  |
| $T_A$        | Operating free-air temperature                                                    | -40                                                |     | 85                 | °C                 |
| $C_{DVCC}$   | Capacitor value at DVCC <sup>(5)</sup>                                            | 1 – 20%                                            |     |                    | μF                 |
| $f_{SYSTEM}$ | Processor frequency (maximum MCLK frequency) <sup>(6)</sup>                       | No FRAM wait states (NWAITSx = 0)                  |     | 0                  | 8 <sup>(9)</sup>   |
|              |                                                                                   | With FRAM wait states (NWAITSx = 1) <sup>(8)</sup> |     | 0                  | 16 <sup>(10)</sup> |
| $f_{LEA}$    | LEA processor frequency                                                           |                                                    |     | 0                  | 16 <sup>(10)</sup> |
| $f_{ACLK}$   | Maximum ACLK frequency                                                            |                                                    |     | 50                 | kHz                |
| $f_{SMCLK}$  | Maximum SMCLK frequency                                                           |                                                    |     | 16 <sup>(10)</sup> | MHz                |

- (1) TI recommends powering the AVCC, DVCC, PVCC pins from the same source. At a minimum, during power up, power down, and device operation, the voltage difference among AVCC, DVCC, PVCC must not exceed the limits specified in *Absolute Maximum Ratings*. Exceeding the specified limits can cause malfunction of the device including erroneous writes to RAM and FRAM.
- (2) The USS module must be disabled if AVCC and DVCC are lower than 2.2 V.
- (3) Fast supply voltage changes can trigger a BOR reset even within the recommended supply voltage range. To avoid unwanted BOR resets, the supply voltage must change by less than 0.05 V per microsecond ( $\pm 0.05\text{ V}/\mu\text{s}$ ). Following the recommendation for capacitor  $C_{DVCC}$  should limit the slopes accordingly.
- (4) Modules may have a different supply voltage range specification. See the specification of the respective module in this data sheet.
- (5) As a decoupling capacitor for each supply pin pair (DVCC and DVSS or AVCC and AVSS), place a low-ESR 100-nF (minimum) ceramic capacitor as close as possible (within a few millimeters) to the respective pin pairs. For the PVCC and PVSS pair, place a low-ESR 22-μF (minimum) ceramic capacitor as close as possible (within a few millimeters) to the pin pair.
- (6) Modules may have a different maximum input clock specification. See the specification of each module in this data sheet.
- (7) The minimum supply voltage is defined by the supervisor SVS levels. See the PMM SVS threshold parameters for the exact values.
- (8) Wait states occur only on actual FRAM accesses; that is, on FRAM cache misses. RAM and peripheral accesses are always executed without wait states.
- (9) DCO settings and HF crystals with a typical value less than or equal to the specified MAX value are permitted.
- (10) DCO settings and HF crystals with a typical value less than or equal to the specified MAX value are permitted. If a clock source with a higher typical value is used, the clock must be divided in the clock system.

## 8.4 Active Mode Supply Current Into $V_{CC}$ Excluding External Current

over recommended operating free-air temperature (unless otherwise noted)<sup>(1) (2)</sup>

| PARAMETER                                                    | EXECUTION MEMORY             | V <sub>CC</sub> | FREQUENCY (f <sub>MCLK</sub> = f <sub>SMCLK</sub> ) |     |                                                     |      |                                                     |      |                                                     |      | UNIT |                                                     |     |
|--------------------------------------------------------------|------------------------------|-----------------|-----------------------------------------------------|-----|-----------------------------------------------------|------|-----------------------------------------------------|------|-----------------------------------------------------|------|------|-----------------------------------------------------|-----|
|                                                              |                              |                 | 1 MHz<br>0 WAIT STATES<br>(NWAITS <sub>x</sub> = 0) |     | 4 MHz<br>0 WAIT STATES<br>(NWAITS <sub>x</sub> = 0) |      | 8 MHz<br>0 WAIT STATES<br>(NWAITS <sub>x</sub> = 0) |      | 12 MHz<br>1 WAIT STATE<br>(NWAITS <sub>x</sub> = 1) |      |      | 16 MHz<br>1 WAIT STATE<br>(NWAITS <sub>x</sub> = 1) |     |
|                                                              |                              |                 | TYP                                                 | MAX | TYP                                                 | MAX  | TYP                                                 | MAX  | TYP                                                 | MAX  |      | TYP                                                 | MAX |
| I <sub>AM, FRAM_UNI</sub><br>(Unified memory) <sup>(3)</sup> | FRAM                         | 3.0 V           | 225                                                 |     | 665                                                 |      | 1275                                                |      | 1550                                                |      | 1970 |                                                     | μA  |
| I <sub>AM, FRAM</sub><br>(0%) <sup>(4) (5)</sup>             | FRAM<br>0% cache hit ratio   | 3.0 V           | 420                                                 |     | 1455                                                |      | 2850                                                |      | 2330                                                |      | 3000 |                                                     | μA  |
| I <sub>AM, FRAM</sub><br>(50%) <sup>(4) (5)</sup>            | FRAM<br>50% cache hit ratio  | 3.0 V           | 275                                                 |     | 855                                                 | 1022 | 1650                                                | 1888 | 1770                                                | 2041 | 2265 | 2606                                                | μA  |
| I <sub>AM, FRAM</sub><br>(66%) <sup>(4) (5)</sup>            | FRAM<br>66% cache hit ratio  | 3.0 V           | 220                                                 |     | 650                                                 |      | 1240                                                | 1443 | 1490                                                | 1735 | 1880 | 2197                                                | μA  |
| I <sub>AM, FRAM</sub><br>(75%) <sup>(4) (5)</sup>            | FRAM<br>75% cache hit ratio  | 3.0 V           | 192                                                 | 261 | 535                                                 |      | 1015                                                | 1170 | 1290                                                | 1490 | 1620 | 1870                                                | μA  |
| I <sub>AM, FRAM</sub><br>(100%) <sup>(4) (5)</sup>           | FRAM<br>100% cache hit ratio | 3.0 V           | 125                                                 |     | 237                                                 |      | 450                                                 |      | 670                                                 |      | 790  |                                                     | μA  |
| I <sub>AM, RAM</sub> <sup>(6) (5)</sup>                      | RAM                          | 3.0 V           | 140                                                 |     | 323                                                 |      | 590                                                 |      | 880                                                 |      | 1070 |                                                     | μA  |
| I <sub>AM, RAM only</sub><br>(7) <sup>(5)</sup>              | RAM                          | 3.0 V           | 90                                                  | 182 | 292                                                 |      | 540                                                 |      | 830                                                 |      | 1020 | 1313                                                | μA  |

(1) All inputs are tied to 0 V or to  $V_{CC}$ . Outputs do not source or sink any current.

(2) Characterized with program executing typical data processing.

$f_{ACLK} = 32768$  Hz,  $f_{MCLK} = f_{SMCLK} = f_{DCO}$  at specified frequency, except for 12 MHz. For 12 MHz,  $f_{DCO} = 24$  MHz and  $f_{MCLK} = f_{SMCLK} = f_{DCO}/2$ .

At MCLK frequencies above 8 MHz, the FRAM requires wait states. When wait states are required, the effective MCLK frequency ( $f_{MCLK,eff}$ ) decreases. The effective MCLK frequency also depends on the cache hit ratio. SMCLK is not affected by the number of wait states or the cache hit ratio.

The following equation can be used to compute  $f_{MCLK,eff}$ :

$$f_{MCLK,eff} = f_{MCLK} / [\text{wait states} \times (1 - \text{cache hit ratio}) + 1]$$

For example, with 1 wait state and 75% cache hit ratio,  $f_{MCLK,eff} = f_{MCLK} / [1 \times (1 - 0.75) + 1] = f_{MCLK} / 1.25$ .

(3) Represents typical program execution. Program and data reside entirely in FRAM. All execution is from FRAM.

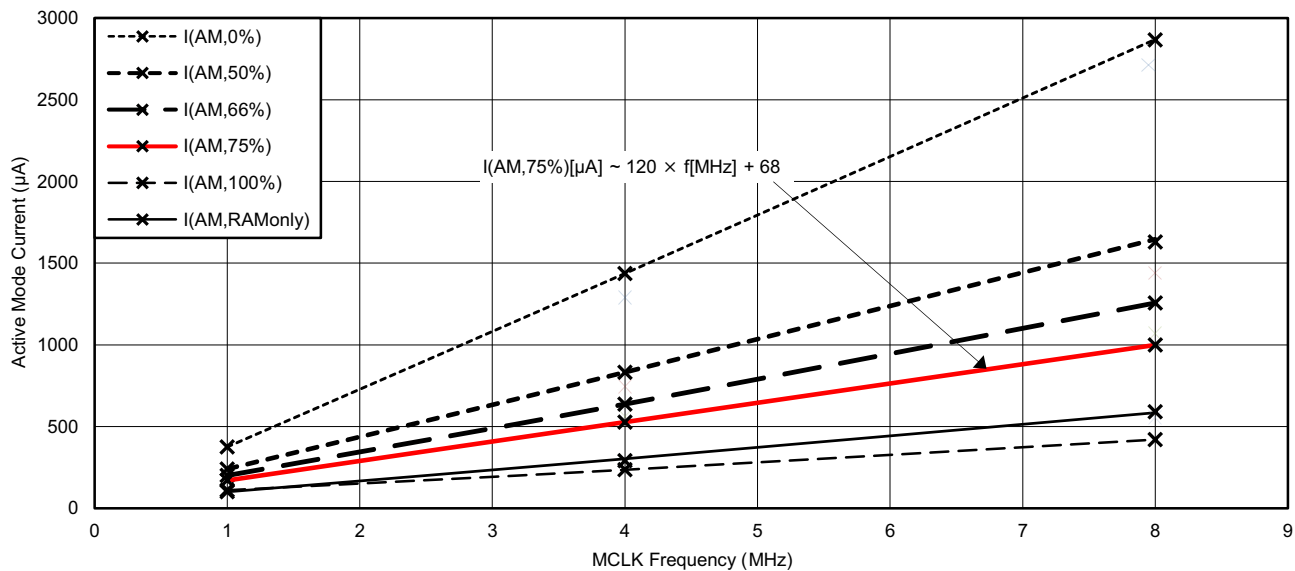
(4) Program resides in FRAM. Data resides in SRAM. Average current dissipation varies with cache hit-to-miss ratio as specified. Cache hit ratio represents number cache accesses divided by the total number of FRAM accesses. For example, a 75% ratio implies three of every four accesses is from cache, and the remaining are FRAM accesses.

(5) See [§ 8.5](#) for typical curves. Each characteristic equation shown in the graph is computed using the least squares method for best linear fit using the typical data shown in [§ 8.4](#).

(6) Program and data reside entirely in RAM. All execution is from RAM.

(7) Program and data reside entirely in RAM. All execution is from RAM. FRAM is off.

## 8.5 Typical Characteristics, Active Mode Supply Currents



- A.  $I(\text{AM},\text{cache hit ratio})$ : Program resides in FRAM. Data resides in SRAM. Average current dissipation varies with cache hit-to-miss ratio as specified. Cache hit ratio represents number cache accesses divided by the total number of FRAM accesses. For example, a 75% ratio implies three of every four accesses is from cache, and the remaining are FRAM accesses.
- B.  $I(\text{AM},\text{RAMOnly})$ : Program and data reside entirely in RAM. All execution is from RAM. FRAM is off.

图 8-1. Typical Active Mode Supply Currents, No Wait States

## 8.6 Low-Power Mode (LPM0, LPM1) Supply Currents Into $V_{CC}$ Excluding External Current

over recommended operating free-air temperature (unless otherwise noted)<sup>(1) (2)</sup>

| PARAMETER         | V <sub>CC</sub> | FREQUENCY (f <sub>SMCLK</sub> ) |     |       |     |       |     |        |     |        |     | UNIT |
|-------------------|-----------------|---------------------------------|-----|-------|-----|-------|-----|--------|-----|--------|-----|------|
|                   |                 | 1 MHz                           |     | 4 MHz |     | 8 MHz |     | 12 MHz |     | 16 MHz |     |      |
|                   |                 | TYP                             | MAX | TYP   | MAX | TYP   | MAX | TYP    | MAX | TYP    | MAX |      |
| I <sub>LPM0</sub> | 2.2 V           | 80                              |     | 115   |     | 180   |     | 276    |     | 250    |     | μA   |
|                   | 3.0 V           | 95                              | 148 | 125   | 178 | 190   | 245 | 286    | 340 | 265    | 316 |      |
| I <sub>LPM1</sub> | 2.2 V           | 40                              |     | 70    |     | 136   |     | 230    |     | 205    |     | μA   |
|                   | 3.0 V           | 40                              | 70  | 70    |     | 136   |     | 235    |     | 210    | 250 |      |

- (1) All inputs are tied to 0 V or to  $V_{CC}$ . Outputs do not source or sink any current.
- (2) Current for watchdog timer clocked by SMCLK included.  
 $f_{\text{ACLK}} = 32768 \text{ Hz}$ ,  $f_{\text{MCLK}} = 0 \text{ MHz}$ ,  $f_{\text{SMCLK}} = f_{\text{DCO}}$  at specified frequency, except for 12 MHz. For 12 MHz,  $f_{\text{DCO}} = 24 \text{ MHz}$  and  $f_{\text{MCLK}} = f_{\text{SMCLK}} = f_{\text{DCO}} / 2$ .

## 8.7 Low-Power Mode (LPM2, LPM3, LPM4) Supply Currents (Into V<sub>CC</sub>) Excluding External Current

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [图 8-2](#) and [图 8-3](#))

| PARAMETER                     |                                                                                                       | V <sub>CC</sub> | TEMPERATURE |     |      |     |      |     |      |      | UNIT |
|-------------------------------|-------------------------------------------------------------------------------------------------------|-----------------|-------------|-----|------|-----|------|-----|------|------|------|
|                               |                                                                                                       |                 | –40°C       |     | 25°C |     | 60°C |     | 85°C |      |      |
|                               |                                                                                                       |                 | TYP         | MAX | TYP  | MAX | TYP  | MAX | TYP  | MAX  |      |
| I <sub>LPM2,XT12</sub>        | Low-power mode 2, 12-pF crystal <sup>(1) (3) (4)</sup>                                                | 2.2 V           | 0.8         |     | 1.3  |     | 4.1  |     | 10.8 |      | μA   |
|                               |                                                                                                       | 3 V             | 0.8         |     | 1.3  |     | 4.1  |     | 10.8 |      |      |
| I <sub>LPM2,XT3.7</sub>       | Low-power mode 2, 3.7-pF crystal <sup>(1) (2) (4)</sup>                                               | 2.2 V           | 0.6         |     | 1.2  |     | 4.0  |     | 10.7 |      | μA   |
|                               |                                                                                                       | 3 V             | 0.6         |     | 1.2  |     | 4.0  |     | 10.7 |      |      |
| I <sub>LPM2,VLO</sub>         | Low-power mode 2, VLO, includes SVS <sup>(5)</sup>                                                    | 2.2 V           | 0.5         |     | 1.0  |     | 3.8  |     | 10.5 |      | μA   |
|                               |                                                                                                       | 3 V             | 0.5         |     | 1.0  |     | 3.8  |     | 10.5 |      |      |
| I <sub>LPM3,XT12</sub>        | Low-power mode 3, 12-pF crystal, includes SVS <sup>(1) (3) (6)</sup>                                  | 2.2 V           | 0.8         | 1.1 | 1.0  |     | 2.2  |     | 4.5  | 10.1 | μA   |
|                               |                                                                                                       | 3 V             | 0.8         |     | 1.0  |     | 2.2  |     | 4.5  |      |      |
| I <sub>LPM3,XT3.7</sub>       | Low-power mode 3, 3.7-pF crystal, excludes SVS <sup>(1) (2) (7)</sup>                                 | 2.2 V           | 0.5         |     | 0.7  |     | 2.1  |     | 4.4  | 9.8  | μA   |
|                               |                                                                                                       | 3 V             | 0.5         |     | 0.7  |     | 2.1  |     | 4.4  | 9.8  |      |
| I <sub>LPM3,VLO</sub>         | Low-power mode 3, VLO, excludes SVS <sup>(8)</sup>                                                    | 2.2 V           | 0.4         |     | 0.5  | 1.2 | 1.9  |     | 4.2  | 9.6  | μA   |
|                               |                                                                                                       | 3 V             | 0.4         |     | 0.5  |     | 1.9  |     | 4.2  |      |      |
| I <sub>LPM3,VLO, RAMoff</sub> | Low-power mode 3, VLO, excludes SVS, RAM powered-down completely <sup>(8)</sup>                       | 2.2 V           | 0.36        |     | 0.47 | 1.1 | 1.4  | 2.9 | 2.6  | 8.2  | μA   |
|                               |                                                                                                       | 3 V             | 0.36        |     | 0.47 |     | 1.4  |     | 2.6  |      |      |
| I <sub>LPM4,SVS</sub>         | Low-power mode 4, includes SVS <sup>(9)</sup>                                                         | 2.2 V           | 0.5         |     | 0.6  | 1.2 | 1.9  |     | 4.3  | 9.7  | μA   |
|                               |                                                                                                       | 3 V             | 0.5         | 0.8 | 0.6  |     | 1.9  |     | 4.3  |      |      |
| I <sub>LPM4</sub>             | Low-power mode 4, excludes SVS <sup>(10)</sup>                                                        | 2.2 V           | 0.3         |     | 0.4  | 1.1 | 1.7  |     | 4.0  | 9.4  | μA   |
|                               |                                                                                                       | 3 V             | 0.3         |     | 0.4  |     | 1.7  |     | 4.0  |      |      |
| I <sub>LPM4,RAMoff</sub>      | Low-power mode 4, excludes SVS, RAM powered-down completely <sup>(10)</sup>                           | 2.2 V           | 0.3         |     | 0.37 | 1.0 | 1.2  | 2.8 | 2.5  | 8    | μA   |
|                               |                                                                                                       | 3 V             | 0.3         |     | 0.37 |     | 1.2  |     | 2.5  |      |      |
| I <sub>IDLE,GroupA</sub>      | Additional idle current if one or more modules from Group A (see 表 9-3) are activated in LPM3 or LPM4 | 3 V             |             |     | 0.02 |     |      |     | 0.3  |      | μA   |
| I <sub>IDLE,GroupB</sub>      | Additional idle current if one or more modules from Group B (see 表 9-3) are activated in LPM3 or LPM4 | 3 V             |             |     | 0.02 |     |      |     | 0.35 |      | μA   |
| I <sub>IDLE,GroupC</sub>      | Additional idle current if one or more modules from Group C (see 表 9-3) are activated in LPM3 or LPM4 | 3 V             |             |     | 0.02 |     |      |     | 0.38 |      | μA   |

- (1) Not applicable for devices with HF crystal oscillator only.
- (2) Characterized with a Seiko SSP-T7-FL (SMD) crystal with a load capacitance of 3.7 pF. The internal and external load capacitance are chosen to closely match the required 3.7-pF load.
- (3) Characterized with a Micro Crystal MS1V-T1K crystal with a load capacitance of 12.5 pF. The internal and external load capacitance are chosen to closely match the required 12.5-pF load.
- (4) Low-power mode 2, crystal oscillator test conditions:  
Current for watchdog timer clocked by ACLK and RTC clocked by XT1 included. Current for brownout and SVS included.  
CPUOFF = 1, SCG0 = 0 SCG1 = 1, OSCOFF = 0 (LPM2), f<sub>XT1</sub> = 32768 Hz, f<sub>ACLK</sub> = f<sub>XT1</sub>, f<sub>MCLK</sub> = f<sub>SMCLK</sub> = 0 MHz
- (5) Low-power mode 2, VLO test conditions:  
Current for watchdog timer clocked by ACLK included. RTC disabled (RTCHOLD = 1). Current for brownout and SVS included.

- CPUOFF = 1, SCG0 = 0 SCG1 = 1, OSCOFF = 0 (LPM2),  $f_{XT1} = 0$  Hz,  $f_{ACLK} = f_{VLO}$ ,  $f_{MCLK} = f_{SMCLK} = 0$  MHz
- (6) Low-power mode 3, 12-pF crystal including SVS test conditions:  
 Current for watchdog timer clocked by ACLK and RTC clocked by XT1 included. Current for brownout and SVS included (SVSHE = 1).  
 CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 0 (LPM3),  $f_{XT1} = 32768$  Hz,  $f_{ACLK} = f_{XT1}$ ,  $f_{MCLK} = f_{SMCLK} = 0$  MHz  
 Activating additional peripherals increases the current consumption due to active supply current contribution as well as due to additional idle current. Refer to the idle currents specified for the respective peripheral groups.
- (7) Low-power mode 3, 3.7-pF crystal excluding SVS test conditions:  
 Current for watchdog timer clocked by ACLK and RTC clocked by XT1 included. Current for brownout included. SVS disabled (SVSHE = 0).  
 CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 0 (LPM3),  $f_{XT1} = 32768$  Hz,  $f_{ACLK} = f_{XT1}$ ,  $f_{MCLK} = f_{SMCLK} = 0$  MHz  
 Activating additional peripherals increases the current consumption due to active supply current contribution as well as due to additional idle current. Refer to the idle currents specified for the respective peripheral groups.
- (8) Low-power mode 3, VLO excluding SVS test conditions:  
 Current for watchdog timer clocked by ACLK included. RTC disabled (RTCHOLD = 1). RAM disabled (RCCTL0 = 5A55h). Current for brownout included. SVS disabled (SVSHE = 0).  
 CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 0 (LPM3),  $f_{XT1} = 0$  Hz,  $f_{ACLK} = f_{VLO}$ ,  $f_{MCLK} = f_{SMCLK} = 0$  MHz  
 Activating additional peripherals increases the current consumption due to active supply current contribution as well as due to additional idle current. Refer to the idle currents specified for the respective peripheral groups.
- (9) Low-power mode 4 including SVS test conditions:  
 Current for brownout and SVS included (SVSHE = 1).  
 CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 1 (LPM4),  $f_{XT1} = 0$  Hz,  $f_{ACLK} = 0$  Hz,  $f_{MCLK} = f_{SMCLK} = 0$  MHz  
 Activating additional peripherals increases the current consumption due to active supply current contribution as well as due to additional idle current. Refer to the idle currents specified for the respective peripheral groups.
- (10) Low-power mode 4 excluding SVS test conditions:  
 Current for brownout included. SVS disabled (SVSHE = 0). RAM disabled (RCCTL0 = 5A55h).  
 CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 1 (LPM4),  $f_{XT1} = 0$  Hz,  $f_{ACLK} = 0$  Hz,  $f_{MCLK} = f_{SMCLK} = 0$  MHz  
 Activating additional peripherals increases the current consumption due to active supply current contribution as well as due to additional idle current. Refer to the idle currents specified for the respective peripheral groups.

## 8.8 Low-Power Mode With LCD Supply Currents (Into $V_{CC}$ ) Excluding External Current

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                   |                                                                                                                                                      | V <sub>CC</sub> | TEMPERATURE (T <sub>A</sub> ) |     |      |     |      |     |      |      | UNIT |
|---------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-------------------------------|-----|------|-----|------|-----|------|------|------|
|                                             |                                                                                                                                                      |                 | −40°C                         |     | 25°C |     | 60°C |     | 85°C |      |      |
|                                             |                                                                                                                                                      |                 | TYP                           | MAX | TYP  | MAX | TYP  | MAX | TYP  | MAX  |      |
| I <sub>LPM3,XT12</sub><br>LCD,<br>ext. bias | Low-power mode 3 (LPM3)<br>current, 12 pF crystal, LCD 4-<br>mux mode, external biasing,<br>excludes SVS <sup>(1)</sup> (2)                          | 3.0 V           | 0.9                           |     | 1.1  |     | 2.5  |     | 5.1  |      | μA   |
| I <sub>LPM3,XT12</sub><br>LCD,<br>int. bias | Low-power mode 3 (LPM3)<br>current, 12 pF crystal, LCD 4-<br>mux mode, internal biasing,<br>charge pump disabled,<br>excludes SVS <sup>(1)</sup> (3) | 3.0 V           | 1.3                           |     | 1.4  | 2.0 | 2.2  | 4.5 | 4.9  | 12.5 | μA   |
| I <sub>LPM3,XT12</sub><br>LCD,CP            | Low-power mode 3 (LPM3)<br>current, 12 pF crystal, LCD 4-<br>mux mode, internal biasing,                                                             | 2.2 V           | 3.6                           |     | 4    |     | 5.1  |     | 8.1  |      | μA   |
|                                             | charge pump enabled, 1/3 bias,<br>excludes SVS <sup>(1)</sup> (4)                                                                                    | 3.0 V           | 3.4                           |     | 3.7  |     | 4.9  |     | 8.1  |      | μA   |

- (1) Current for watchdog timer clocked by ACLK and RTC clocked by XT1 included. Current for brownout included. SVS disabled (SVSHE = 0).  
CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 0 (LPM3),  
 $f_{XT1} = 32768$  Hz,  $f_{ACLK} = f_{XT1}$ ,  $f_{MCLK} = f_{SMCLK} = 0$  MHz  
Activating additional peripherals increases the current consumption due to active supply current contribution as well as due to additional idle current - idle current of Group containing LCD module already included. Refer to the idle currents specified for the respective peripheral groups.
- (2) LCDMx = 11 (4-mux mode), LCDREXT = 1, LCDEXTBIAS = 1 (external biasing), LCD2B = 0 (1/3 bias), LCDCPEN = 0 (charge pump disabled), LCDSSEL = 0, LCDPREx = 101, LCDDIVx = 00011 ( $f_{LCD} = 32768$  Hz / 32 / 4 = 256 Hz)  
Current through external resistors not included (voltage levels are supplied by test equipment).  
Even segments S0, S2,... = 0, odd segments S1, S3,... = 1. No LCD panel load.
- (3) LCDMx = 11 (4-mux mode), LCDREXT = 0, LCDEXTBIAS = 0 (internal biasing), LCD2B = 0 (1/3 bias), LCDCPEN = 0 (charge pump disabled), LCDSSEL = 0, LCDPREx = 101, LCDDIVx = 00011 ( $f_{LCD} = 32768$  Hz / 32 / 4 = 256 Hz)  
Even segments S0, S2,... = 0, odd segments S1, S3,... = 1. No LCD panel load.
- (4) LCDMx = 11 (4-mux mode), LCDREXT = 0, LCDEXTBIAS = 0 (internal biasing), LCD2B = 0 (1/3 bias), LCDCPEN = 1 (charge pump enabled), VLCDx = 1000 ( $V_{LCD} = 3$  V typical), LCDSSEL = 0, LCDPREx = 101, LCDDIVx = 00011 ( $f_{LCD} = 32768$  Hz / 32 / 4 = 256 Hz)  
Even segments S0, S2,... = 0, odd segments S1, S3,... = 1. No LCD panel load.

## 8.9 Low-Power Mode (LPMx.5) Supply Currents (Into $V_{CC}$ ) Excluding External Current

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [图 8-4](#) and [图 8-5](#))

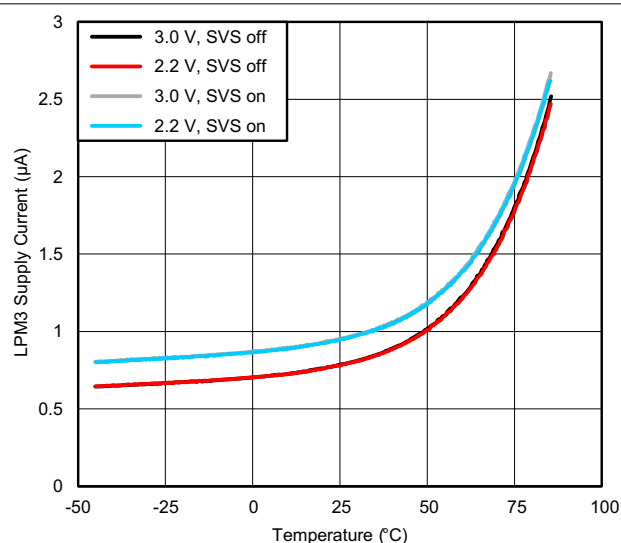
| PARAMETER                 |                                                                         | V <sub>CC</sub> | TEMPERATURE (T <sub>A</sub> ) |     |       |     |       |     |      |     | UNIT |
|---------------------------|-------------------------------------------------------------------------|-----------------|-------------------------------|-----|-------|-----|-------|-----|------|-----|------|
|                           |                                                                         |                 | −40°C                         |     | 25°C  |     | 60°C  |     | 85°C |     |      |
|                           |                                                                         |                 | TYP                           | MAX | TYP   | MAX | TYP   | MAX | TYP  | MAX |      |
| I <sub>LPM3.5,XT12</sub>  | Low-power mode 3.5, 12-pF crystal including SVS <sup>(1) (3) (4)</sup>  | 2.2 V           | 0.45                          |     | 0.5   |     | 0.55  |     | 0.75 |     | μA   |
|                           |                                                                         | 3.0 V           | 0.45                          |     | 0.5   |     | 0.55  |     | 0.75 |     |      |
| I <sub>LPM3.5,XT3.7</sub> | Low-power mode 3.5, 3.7-pF crystal excluding SVS <sup>(1) (2) (5)</sup> | 2.2 V           | 0.3                           |     | 0.35  |     | 0.4   |     | 0.65 |     | μA   |
|                           |                                                                         | 3.0 V           | 0.3                           |     | 0.35  |     | 0.4   |     | 0.65 |     |      |
| I <sub>LPM4.5,SVS</sub>   | Low-power mode 4.5, including SVS <sup>(6)</sup>                        | 2.2 V           | 0.23                          |     | 0.2   |     | 0.28  |     | 0.4  |     | μA   |
|                           |                                                                         | 3.0 V           | 0.23                          |     | 0.2   |     | 0.28  |     | 0.4  |     |      |
| I <sub>LPM4.5</sub>       | Low-power mode 4.5, excluding SVS <sup>(7)</sup>                        | 2.2 V           | 0.035                         |     | 0.045 |     | 0.075 |     | 0.15 |     | μA   |
|                           |                                                                         | 3.0 V           | 0.035                         |     | 0.045 |     | 0.075 |     | 0.15 |     |      |

- (1) Not applicable for devices with HF crystal oscillator only.
- (2) Characterized with a Seiko SSP-T7-FL (SMD) crystal with a load capacitance of 3.7 pF. The internal and external load capacitance are chosen to closely match the required 3.7-pF load.
- (3) Characterized with a Micro Crystal MS1V-T1K crystal with a load capacitance of 12.5 pF. The internal and external load capacitance are chosen to closely match the required 12.5-pF load.

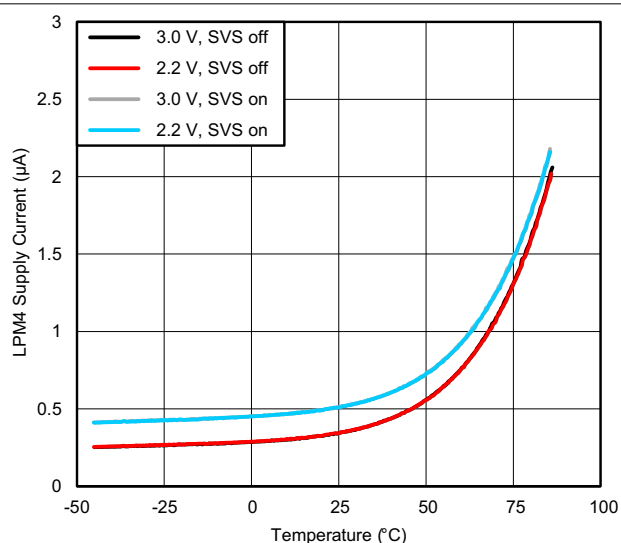
- (4) Low-power mode 3.5, 1-pF crystal including SVS test conditions:  
 Current for RTC clocked by XT1 included. Current for brownout and SVS included (SVSHE = 1). Core regulator disabled.  
 PMMREGOFF = 1, CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 1 (LPMx.5),  
 $f_{XT1} = 32768 \text{ Hz}$ ,  $f_{ACLK} = f_{XT1}$ ,  $f_{MCLK} = f_{SMCLK} = 0 \text{ MHz}$
- (5) Low-power mode 3.5, 3.7-pF crystal excluding SVS test conditions:  
 Current for RTC clocked by XT1 included. Current for brownout included. SVS disabled (SVSHE = 0). Core regulator disabled.  
 PMMREGOFF = 1, CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 1 (LPMx.5),  
 $f_{XT1} = 32768 \text{ Hz}$ ,  $f_{ACLK} = f_{XT1}$ ,  $f_{MCLK} = f_{SMCLK} = 0 \text{ MHz}$
- (6) Low-power mode 4.5 including SVS test conditions:  
 Current for brownout and SVS included (SVSHE = 1). Core regulator disabled.  
 PMMREGOFF = 1, CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 1 (LPMx.5),  
 $f_{XT1} = 0 \text{ Hz}$ ,  $f_{ACLK} = 0 \text{ Hz}$ ,  $f_{MCLK} = f_{SMCLK} = 0 \text{ MHz}$
- (7) Low-power mode 4.5 excluding SVS test conditions:  
 Current for brownout included. SVS disabled (SVSHE = 0). Core regulator disabled.  
 PMMREGOFF = 1, CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 1 (LPMx.5),  
 $f_{XT1} = 0 \text{ Hz}$ ,  $f_{ACLK} = 0 \text{ Hz}$ ,  $f_{MCLK} = f_{SMCLK} = 0 \text{ MHz}$



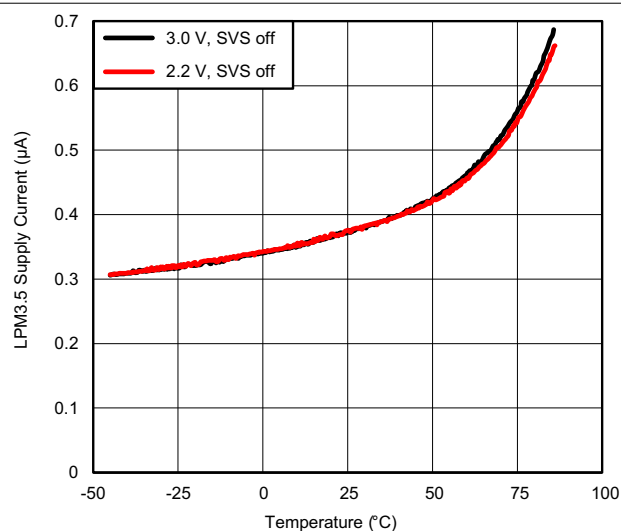
## 8.10 Typical Characteristics, Low-Power Mode Supply Currents



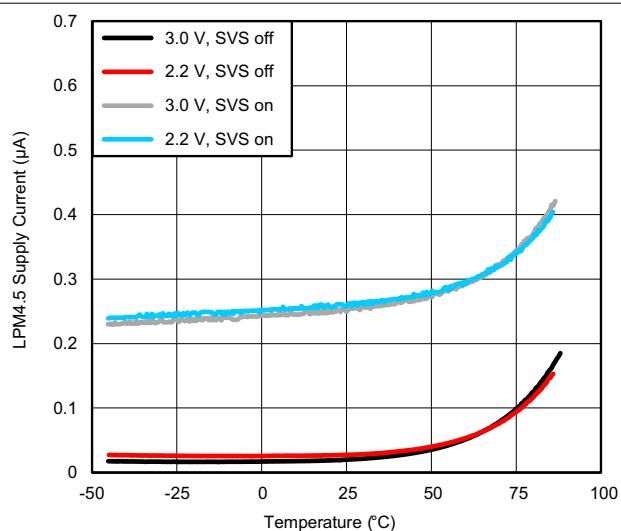
**图 8-2. LPM3 Supply Current ( $I_{LPM3,XT3.7}$ ) vs Temperature**



**图 8-3. LPM4 Supply Current ( $I_{LPM4,SVS}$ ) vs Temperature**



**图 8-4. LPM3.5 Supply Current ( $I_{LPM3.5,XT3.7}$ ) vs Temperature**



**图 8-5. LPM4.5 Supply Current ( $I_{LPM4.5}$ ) vs Temperature**

## 8.11 Typical Characteristics, Current Consumption per Module

| MODULE <sup>(1)</sup> | TEST CONDITIONS                       | REFERENCE CLOCK    | MIN | TYP | MAX | UNIT   |
|-----------------------|---------------------------------------|--------------------|-----|-----|-----|--------|
| Timer_A               |                                       | Module input clock |     | 2.5 |     | μA/MHz |
| Timer_B               |                                       | Module input clock |     | 3.8 |     | μA/MHz |
| eUSCI_A               | UART mode                             | Module input clock |     | 6.3 | 7.0 | μA/MHz |
|                       | SPI mode                              |                    |     | 4.4 | 4.8 |        |
| eUSCI_B               | SPI mode                              | Module input clock |     | 4.4 |     | μA/MHz |
|                       | I <sup>2</sup> C mode, 100 kbaud      |                    |     | 4.4 |     |        |
| RTC_C                 |                                       | 32 kHz             |     | 100 |     | nA     |
| MPY                   | Only from start to end of operation   | MCLK               |     | 28  |     | μA/MHz |
| CRC16                 | Only from start to end of operation   | MCLK               |     | 3.3 |     | μA/MHz |
| CRC32                 | Only from start to end of operation   | MCLK               |     | 3.3 |     | μA/MHz |
| LEA                   | 256-point complex FFT, data = nonzero | MCLK               | 68  | 86  |     | μA/MHz |
|                       | 256-point complex FFT, data = zero    |                    |     | 66  |     |        |

(1) For other module currents not listed here, see the module-specific parameter sections.

## 8.12 Thermal Resistance Characteristics for 100-Pin LQFP (PZ) Package

| THERMAL METRIC <sup>(1) (2)</sup> |                                                      | VALUE <sup>(3)</sup> | UNIT |
|-----------------------------------|------------------------------------------------------|----------------------|------|
| R <sub>θJA</sub>                  | Junction-to-ambient thermal resistance, still air    | 57.6                 | °C/W |
| R <sub>θJC(TOP)</sub>             | Junction-to-case (top) thermal resistance            | 14.9                 | °C/W |
| R <sub>θJB</sub>                  | Junction-to-board thermal resistance                 | 35.6                 | °C/W |
| Ψ <sub>JB</sub>                   | Junction-to-board thermal characterization parameter | 35.0                 | °C/W |
| Ψ <sub>JT</sub>                   | Junction-to-top thermal characterization parameter   | 0.6                  | °C/W |
| R <sub>θJC(BOTTOM)</sub>          | Junction-to-case (bottom) thermal resistance         | N/A                  | °C/W |

(1) N/A = not applicable

(2) For more information about traditional and new thermal metrics, see [Semiconductor and IC Package Thermal Metrics](#).

(3) These values are based on a JEDEC-defined 2S2P system (with the exception of the Theta JC (R<sub>θJC</sub>) value, which is based on a JEDEC-defined 1S0P system) and will change based on environment and application. For more information, see these EIA/JEDEC standards:

- JESD51-2, *Integrated Circuits Thermal Test Method Environmental Conditions - Natural Convection (Still Air)*
- JESD51-3, *Low Effective Thermal Conductivity Test Board for Leaded Surface Mount Packages*
- JESD51-7, *High Effective Thermal Conductivity Test Board for Leaded Surface Mount Packages*
- JESD51-9, *Test Boards for Area Array Surface Mount Package Thermal Measurements*

## 8.13 Timing and Switching Characteristics

### 8.13.1 Power Supply Sequencing

TI recommends powering the AVCC, DVCC, and PVCC pins from the same source. At a minimum, during power up, power down, and device operation, the voltage difference among AVCC, DVCC, and PVCC must not exceed the limits specified in [节 8.1](#). Exceeding the specified limits can cause malfunction of the device including erroneous writes to RAM and FRAM.

#### 8.13.1.1 Brownout and Device Reset Power Ramp Requirements

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER             |                                          | TEST CONDITIONS                                | MIN  | MAX  | UNIT |
|-----------------------|------------------------------------------|------------------------------------------------|------|------|------|
| V <sub>VCC_BOR-</sub> | Brownout power-down level <sup>(1)</sup> | dV <sub>VCC</sub> /dt   < 3 V/s                | 0.7  | 1.66 | V    |
| V <sub>VCC_BOR+</sub> | Brownout power-up level <sup>(1)</sup>   | dV <sub>VCC</sub> /dt   < 3 V/s <sup>(2)</sup> | 0.79 | 1.68 | V    |

- (1) Fast supply voltage changes can trigger a BOR reset even within the recommended supply voltage range. To avoid unwanted BOR resets, the supply voltage must change by less than 0.05 V per microsecond ( $\pm 0.05$  V/ $\mu$ s). Following the recommendation for capacitor C<sub>DVCC</sub> should limit the slopes accordingly.
- (2) The brownout levels are measured with a slowly changing supply.

#### 8.13.1.2 SVS

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                |                                                       | TEST CONDITIONS                         | MIN  | TYP  | MAX  | UNIT    |
|--------------------------|-------------------------------------------------------|-----------------------------------------|------|------|------|---------|
| I <sub>SVSH,LPM</sub>    | SVS <sub>H</sub> current consumption, low-power modes |                                         |      | 170  | 300  | nA      |
| V <sub>SVSH-</sub>       | SVS <sub>H</sub> power-down level <sup>(1)</sup>      |                                         | 1.75 | 1.80 | 1.85 | V       |
| V <sub>SVSH+</sub>       | SVS <sub>H</sub> power-up level <sup>(1)</sup>        |                                         | 1.77 | 1.88 | 1.99 | V       |
| V <sub>SVSH_hys</sub>    | SVS <sub>H</sub> hysteresis                           |                                         | 40   |      | 120  | mV      |
| t <sub>PD,SVSH, AM</sub> | SVS <sub>H</sub> propagation delay, active mode       | dV <sub>VCC</sub> /dt = -10 mV/ $\mu$ s |      |      | 10   | $\mu$ s |

- (1) For additional information, see the [Dynamic Voltage Scaling Power Solution for MSP430 Devices With Single-Channel LDO Reference Design](#).

## 8.13.2 Reset Timing

### 8.13.2.1 Reset Input

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                                  | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|--------------------------------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| t <sub>(RST)</sub> External reset pulse duration on $\overline{\text{RST}}$ <sup>(1)</sup> | 2.2 V, 3.0 V    | 2   |     |     | μs   |

(1) Not applicable if the  $\overline{\text{RST}}$ /NMI pin is configured as NMI.

## 8.13.3 Clock Specifications

节 8.13.3.1 lists the characteristics of the low-frequency oscillator.

### 8.13.3.1 Low-Frequency Crystal Oscillator, LFXT

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(4)</sup>

| PARAMETER               | TEST CONDITIONS                                                                                                                      | V <sub>CC</sub> | MIN  | TYP    | MAX  | UNIT |
|-------------------------|--------------------------------------------------------------------------------------------------------------------------------------|-----------------|------|--------|------|------|
| I <sub>VCC,LFXT</sub>   | f <sub>OSC</sub> = 32768 Hz,<br>LFXTBYPASS = 0, LFXTDRIVE = {0},<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 3.7 pF, ESR ≈ 44 kΩ  | 3.0 V           |      | 180    |      | nA   |
|                         | f <sub>OSC</sub> = 32768 Hz,<br>LFXTBYPASS = 0, LFXTDRIVE = {1},<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 6 pF, ESR ≈ 40 kΩ    |                 |      | 185    |      |      |
|                         | f <sub>OSC</sub> = 32768 Hz,<br>LFXTBYPASS = 0, LFXTDRIVE = {2},<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 9 pF, ESR ≈ 40 kΩ    |                 |      | 225    |      |      |
|                         | f <sub>OSC</sub> = 32768 Hz,<br>LFXTBYPASS = 0, LFXTDRIVE = {3},<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 12.5 pF, ESR ≈ 40 kΩ |                 |      | 330    |      |      |
| f <sub>LFXT</sub>       | LFXTBYPASS = 0                                                                                                                       |                 |      | 32768  |      | Hz   |
| DC <sub>LFXT</sub>      | Measured at ACLK,<br>f <sub>LFXT</sub> = 32768 Hz                                                                                    |                 | 30%  |        | 70%  |      |
| f <sub>LFXT,SW</sub>    | LFXTBYPASS = 1 <sup>(5) (8)</sup>                                                                                                    |                 | 10.5 | 32.768 | 50   | kHz  |
| DC <sub>LFXT, SW</sub>  | LFXTBYPASS = 1                                                                                                                       |                 | 30%  |        | 70%  |      |
| OA <sub>LFXT</sub>      | LFXTBYPASS = 0, LFXTDRIVE = {1},<br>f <sub>LFXT</sub> = 32768 Hz, C <sub>L,eff</sub> = 6 pF                                          |                 |      | 210    |      | kΩ   |
|                         | LFXTBYPASS = 0, LFXTDRIVE = {3},<br>f <sub>LFXT</sub> = 32768 Hz, C <sub>L,eff</sub> = 12.5 pF                                       |                 |      | 300    |      |      |
| C <sub>LFXIN</sub>      | Integrated load capacitance at LFXIN terminal <sup>(6) (7)</sup>                                                                     |                 |      | 2      |      | pF   |
| C <sub>LFXOUT</sub>     | Integrated load capacitance at LFXOUT terminal <sup>(6) (7)</sup>                                                                    |                 |      | 2      |      | pF   |
| t <sub>START,LFXT</sub> | f <sub>OSC</sub> = 32768 Hz,<br>LFXTBYPASS = 0, LFXTDRIVE = {0},<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 3.7 pF               | 3.0 V           |      | 800    |      | ms   |
|                         | f <sub>OSC</sub> = 32768 Hz,<br>LFXTBYPASS = 0, LFXTDRIVE = {3},<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 12.5 pF              | 3.0 V           |      | 1000   |      |      |
| f <sub>Fault,LFXT</sub> | Oscillator fault frequency <sup>(3) (1)</sup>                                                                                        |                 | 0    |        | 3500 | Hz   |

(1) Measured with logic-level input frequency but also applies to operation with crystals.

(2) Includes start-up counter of 1024 clock cycles.

(3) Frequencies above the MAX specification do not set the fault flag. Frequencies between the MIN and MAX specifications may set the flag. A static condition or stuck at fault condition will set the flag.

(4) To improve EMI on the LFXT oscillator, observe the following guidelines:

- Keep the trace between the device and the crystal as short as possible.
- Design a good ground plane around the oscillator pins.
- Prevent crosstalk from other clock or data lines into oscillator pins LFXIN and LFXOUT.
- Avoid running PCB traces underneath or adjacent to the LFXIN and LFXOUT pins.
- Use assembly materials and processes that avoid any parasitic load on the oscillator LFXIN and LFXOUT pins.
- If conformal coating is used, ensure that it does not induce capacitive or resistive leakage between the oscillator pins.

- (5) When LFXTBYPASS is set, LFXT circuits are automatically powered down. Input signal is a digital square wave with parametrics defined in the Schmitt-trigger Inputs section of this data sheet. Duty cycle requirements are defined by  $DC_{LFXT, SW}$ .
- (6) This represents all the parasitic capacitance present at the LFXIN and LFXOUT terminals, respectively, including parasitic bond and package capacitance. The effective load capacitance,  $C_{L,eff}$  can be computed as  $C_{IN} \times C_{OUT} / (C_{IN} + C_{OUT})$ , where  $C_{IN}$  and  $C_{OUT}$  is the total capacitance at the LFXIN and LFXOUT terminals, respectively.
- (7) Requires external capacitors at both terminals to meet the effective load capacitance specified by crystal manufacturers. Recommended effective load capacitance values supported are 3.7 pF, 6 pF, 9 pF, and 12.5 pF. Maximum shunt capacitance of 1.6 pF. The PCB adds additional capacitance, so it must also be considered in the overall capacitance. Verify that the recommended effective load capacitance of the selected crystal is met.
- (8) Maximum frequency of operation of the entire device cannot be exceeded.
- (9) Oscillation allowance is based on a safety factor of 5 for recommended crystals. The oscillation allowance is a function of the LFXTDRIVE settings and the effective load. In general, comparable oscillator allowance can be achieved based on the following guidelines, but should be evaluated based on the actual crystal selected for the application:
  - For LFXTDRIVE = {0},  $C_{L,eff} = 3.7$  pF
  - For LFXTDRIVE = {1},  $C_{L,eff} = 6$  pF
  - For LFXTDRIVE = {2},  $6 \text{ pF} \leq C_{L,eff} \leq 9$  pF
  - For LFXTDRIVE = {3},  $9 \text{ pF} \leq C_{L,eff} \leq 12.5$  pF

### 8.13.3.2 High-Frequency Crystal Oscillator, HFXT

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(5)</sup>

| PARAMETER       | TEST CONDITIONS                                                                                                                                                 | V <sub>CC</sub> | MIN | TYP   | MAX     | UNIT          |
|-----------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-----|-------|---------|---------------|
| $I_{DVCC,HFXT}$ | $f_{OSC} = 4$ MHz,<br>HFXTBYPASS = 0, HFXTDRIVE = 0, HFFREQ = 1 <sup>(8)</sup> ,<br>$T_A = 25^\circ\text{C}$ , $C_{L,eff} = 18$ pF,<br>typical ESR, $C_{shunt}$ | 3.0 V           |     | 75    |         | $\mu\text{A}$ |
|                 | $f_{OSC} = 8$ MHz,<br>HFXTBYPASS = 0, HFXTDRIVE = 1, HFFREQ = 1,<br>$T_A = 25^\circ\text{C}$ , $C_{L,eff} = 18$ pF,<br>typical ESR, $C_{shunt}$                 |                 |     | 120   |         |               |
|                 | $f_{OSC} = 16$ MHz,<br>HFXTBYPASS = 0, HFXTDRIVE = 2, HFFREQ = 2,<br>$T_A = 25^\circ\text{C}$ , $C_{L,eff} = 18$ pF,<br>typical ESR, $C_{shunt}$                |                 |     | 190   |         |               |
|                 | $f_{OSC} = 24$ MHz,<br>HFXTBYPASS = 0, HFXTDRIVE = 3, HFFREQ = 3,<br>$T_A = 25^\circ\text{C}$ , $C_{L,eff} = 18$ pF,<br>typical ESR, $C_{shunt}$                |                 |     | 250   |         |               |
| $f_{HFXT}$      | HFXT oscillator crystal frequency,<br>crystal mode                                                                                                              |                 |     | 4     | 8       | MHz           |
|                 |                                                                                                                                                                 |                 |     | 8.01  | 16      |               |
|                 |                                                                                                                                                                 |                 |     | 16.01 | 24      |               |
| $DC_{HFXT}$     | HFXT oscillator duty cycle                                                                                                                                      |                 |     | 40%   | 50% 60% |               |
| $f_{HFXT,SW}$   | HFXT oscillator logic-level square-wave input frequency, bypass mode                                                                                            |                 |     | 0.9   | 4       | MHz           |
|                 |                                                                                                                                                                 |                 |     | 4.01  | 8       |               |
|                 |                                                                                                                                                                 |                 |     | 8.01  | 16      |               |
|                 |                                                                                                                                                                 |                 |     | 16.01 | 24      |               |
| $DC_{HFXT, SW}$ | HFXT oscillator logic-level square-wave input duty cycle                                                                                                        |                 |     | 40%   | 60%     |               |
| $OA_{HFXT}$     | Oscillation allowance for HFXT crystals <sup>(9)</sup>                                                                                                          |                 |     | 450   |         | $\Omega$      |
|                 |                                                                                                                                                                 |                 |     | 320   |         |               |
|                 |                                                                                                                                                                 |                 |     | 200   |         |               |
|                 |                                                                                                                                                                 |                 |     | 200   |         |               |

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(5)</sup>

| PARAMETER               |                                                                   | TEST CONDITIONS                                                                                                               | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|-------------------------|-------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| t <sub>START,HFXT</sub> | Start-up time <sup>(10)</sup>                                     | f <sub>OSC</sub> = 4 MHz,<br>HFXTBYPASS = 0, HFXTDRIVE = 0, HFFREQ = 1,<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 16 pF  | 3.0 V           |     | 1.6 |     | ms   |
|                         |                                                                   | f <sub>OSC</sub> = 24 MHz,<br>HFXTBYPASS = 0, HFXTDRIVE = 3, HFFREQ = 3,<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 16 pF | 3.0 V           |     | 0.6 |     |      |
| C <sub>HFXIN</sub>      | Integrated load capacitance at HFXIN terminal <sup>(1) (2)</sup>  |                                                                                                                               |                 |     | 2   |     | pF   |
| C <sub>HFXOUT</sub>     | Integrated load capacitance at HFXOUT terminal <sup>(1) (2)</sup> |                                                                                                                               |                 |     | 2   |     | pF   |
| f <sub>Fault,HFXT</sub> | Oscillator fault frequency <sup>(4) (3)</sup>                     |                                                                                                                               |                 | 0   |     | 800 | kHz  |

- (1) This represents all the parasitic capacitance present at the HFXIN and HFXOUT terminals, respectively, including parasitic bond and package capacitance. The effective load capacitance, C<sub>L,eff</sub> can be computed as C<sub>IN</sub> × C<sub>OUT</sub> / (C<sub>IN</sub> + C<sub>OUT</sub>), where C<sub>IN</sub> and C<sub>OUT</sub> is the total capacitance at the HFXIN and HFXOUT terminals, respectively.
- (2) Requires external capacitors at both terminals to meet the effective load capacitance specified by crystal manufacturers. Recommended effective load capacitance values supported are 14 pF, 16 pF, and 18 pF. Maximum shunt capacitance of 7 pF. The PCB adds additional capacitance, so it must also be considered in the overall capacitance. Verify that the recommended effective load capacitance of the selected crystal is met.
- (3) Measured with logic-level input frequency but also applies to operation with crystals.
- (4) Frequencies above the MAX specification do not set the fault flag. Frequencies between the MIN and MAX specifications might set the flag. A static condition or stuck at fault condition will set the flag.
- (5) To improve EMI on the HFXT oscillator the following guidelines should be observed.
  - Keep the traces between the device and the crystal as short as possible.
  - Design a good ground plane around the oscillator pins.
  - Prevent crosstalk from other clock or data lines into oscillator pins HFXIN and HFXOUT.
  - Avoid running PCB traces underneath or adjacent to the HFXIN and HFXOUT pins.
  - Use assembly materials and processes that avoid any parasitic load on the oscillator LFXIN and LFXOUT pins.
  - If conformal coating is used, ensure that it does not induce capacitive or resistive leakage between the oscillator pins.
- (6) When HFXTBYPASS is set, HFXT circuits are automatically powered down. Input signal is a digital square wave with parametrics defined in the Schmitt-trigger Inputs section of this datasheet. Duty cycle requirements are defined by DC<sub>HFXT, SW</sub>.
- (7) Maximum frequency of operation of the entire device cannot be exceeded.
- (8) HFFREQ = {0} is not supported for HFXT crystal mode of operation.
- (9) Oscillation allowance is based on a safety factor of 5 for recommended crystals.
- (10) Includes start-up counter of 1024 clock cycles.

### 8.13.3.3 DCO

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER           |                                      | TEST CONDITIONS                                                                    | V <sub>CC</sub> | MIN | TYP   | MAX                  | UNIT |
|---------------------|--------------------------------------|------------------------------------------------------------------------------------|-----------------|-----|-------|----------------------|------|
| f <sub>DC01</sub>   | DCO frequency range 1 MHz, trimmed   | Measured at SMCLK, divide by 1, DCORSEL = 0, DCOFSEL = 0, DCORSEL = 1, DCOFSEL = 0 |                 |     | 1     | ±3.5%                | MHz  |
| f <sub>DC02.7</sub> | DCO frequency range 2.7 MHz, trimmed | Measured at SMCLK, divide by 1, DCORSEL = 0, DCOFSEL = 1                           |                 |     | 2.667 | ±3.5%                | MHz  |
| f <sub>DC03.5</sub> | DCO frequency range 3.5 MHz, trimmed | Measured at SMCLK, divide by 1, DCORSEL = 0, DCOFSEL = 2                           |                 |     | 3.5   | ±3.5%                | MHz  |
| f <sub>DC04</sub>   | DCO frequency range 4 MHz, trimmed   | Measured at SMCLK, divide by 1, DCORSEL = 0, DCOFSEL = 3                           |                 |     | 4     | ±3.5%                | MHz  |
| f <sub>DC05.3</sub> | DCO frequency range 5.3 MHz, trimmed | Measured at SMCLK, divide by 1, DCORSEL = 0, DCOFSEL = 4, DCORSEL = 1, DCOFSEL = 1 |                 |     | 5.333 | ±3.5%                | MHz  |
| f <sub>DC07</sub>   | DCO frequency range 7 MHz, trimmed   | Measured at SMCLK, divide by 1, DCORSEL = 0, DCOFSEL = 5, DCORSEL = 1, DCOFSEL = 2 |                 |     | 7     | ±3.5%                | MHz  |
| f <sub>DC08</sub>   | DCO frequency range 8 MHz, trimmed   | Measured at SMCLK, divide by 1, DCORSEL = 0, DCOFSEL = 6, DCORSEL = 1, DCOFSEL = 3 |                 |     | 8     | ±3.5%                | MHz  |
| f <sub>DC016</sub>  | DCO frequency range 16 MHz, trimmed  | Measured at SMCLK, divide by 1, DCORSEL = 1, DCOFSEL = 4                           |                 |     | 16    | ±3.5% <sup>(2)</sup> | MHz  |

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                |                                      | TEST CONDITIONS                                                                                                                                                     | V <sub>CC</sub> | MIN  | TYP                  | MAX | UNIT |
|--------------------------|--------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|------|----------------------|-----|------|
| f <sub>DCO21</sub>       | DCO frequency range 21 MHz, trimmed  | Measured at SMCLK, divide by 2, DCOSEL = 1, DCOFSEL = 5                                                                                                             |                 | 21   | ±3.5% <sup>(2)</sup> |     | MHz  |
| f <sub>DCO24</sub>       | DCO frequency range 24 MHz, trimmed  | Measured at SMCLK, divide by 2, DCOSEL = 1, DCOFSEL = 6                                                                                                             |                 | 24   | ±3.5% <sup>(2)</sup> |     | MHz  |
| f <sub>DCO,DC</sub>      | Duty cycle                           | Measured at SMCLK, divide by 1, No external divide, all DCOSEL and DCOFSEL settings except DCOSEL = 1, DCOFSEL = 5 and DCOSEL = 1, DCOFSEL = 6                      |                 | 48%  | 50%                  | 52% |      |
| t <sub>DCO, JITTER</sub> | DCO jitter                           | Based on f <sub>signal</sub> = 10 kHz and DCO used for 12-bit SAR ADC sampling source. This achieves >74-dB SNR due to jitter; that is, limited by ADC performance. |                 | 2    |                      | 3   | ns   |
| df <sub>DCO</sub> /dT    | DCO temperature drift <sup>(1)</sup> |                                                                                                                                                                     | 3.0 V           | 0.01 |                      |     | %/°C |

(1) Calculated using the box method: (MAX(–40°C to 85°C) – MIN(–40°C to 85°C)) / MIN(–40°C to 85°C) / (85°C – (–40°C))

(2) After a wakeup from LPM1, LPM2, LPM3, or LPM4, the DCO frequency f<sub>DCO</sub> might exceed the specified frequency range for a few clock cycles by up to 5% before settling to the specified steady state frequency range.

#### 8.13.3.4 Internal Very-Low-Power Low-Frequency Oscillator (VLO)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                           |                                    | TEST CONDITIONS                 | MIN | TYP | MAX | UNIT |
|-------------------------------------|------------------------------------|---------------------------------|-----|-----|-----|------|
| I <sub>VLO</sub>                    | Current consumption                |                                 |     | 100 |     | nA   |
| f <sub>VLO</sub>                    | VLO frequency                      | Measured at ACLK                | 6   | 9.4 | 14  | kHz  |
| df <sub>VLO</sub> /dT               | VLO frequency temperature drift    | Measured at ACLK <sup>(1)</sup> |     | 0.2 |     | %/°C |
| df <sub>VLO</sub> /dV <sub>CC</sub> | VLO frequency supply voltage drift | Measured at ACLK <sup>(2)</sup> |     | 0.7 |     | %/V  |
| f <sub>VLO,DC</sub>                 | Duty cycle                         | Measured at ACLK                | 40% | 50% | 60% |      |

(1) Calculated using the box method: (MAX(–40°C to 85°C) – MIN(–40°C to 85°C)) / MIN(–40°C to 85°C) / (85°C – (–40°C))

(2) Calculated using the box method: (MAX(1.8 V to 3.6 V) – MIN(1.8 V to 3.6 V)) / MIN(1.8 V to 3.6 V) / (3.6 V – 1.8 V)

#### 8.13.3.5 Module Oscillator (MODOSC)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                             |                                                      | TEST CONDITIONS                | MIN | TYP  | MAX | UNIT |
|---------------------------------------|------------------------------------------------------|--------------------------------|-----|------|-----|------|
| I <sub>MODOSC</sub>                   | Current consumption                                  | Enabled                        |     | 25   |     | μA   |
| f <sub>MODOSC</sub>                   | MODOSC frequency                                     |                                | 4.0 | 4.8  | 5.4 | MHz  |
| f <sub>MODOSC</sub> /dT               | MODOSC frequency temperature drift <sup>(1)</sup>    |                                |     | 0.08 |     | %/°C |
| f <sub>MODOSC</sub> /dV <sub>CC</sub> | MODOSC frequency supply voltage drift <sup>(2)</sup> |                                |     | 1.4  |     | %/V  |
| DC <sub>MODOSC</sub>                  | Duty cycle                                           | Measured at SMCLK, divide by 1 | 40% | 50%  | 60% |      |

(1) Calculated using the box method: (MAX(–40°C to 85°C) – MIN(–40°C to 85°C)) / MIN(–40°C to 85°C) / (85°C – (–40°C))

(2) Calculated using the box method: (MAX(1.8 V to 3.6 V) – MIN(1.8 V to 3.6 V)) / MIN(1.8 V to 3.6 V) / (3.6 V – 1.8 V)

### 8.13.4 Wake-up Characteristics

#### 8.13.4.1 Wake-up Times From Low-Power Modes and Reset

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                   |                                                                                                                                                                  | TEST CONDITIONS | V <sub>CC</sub> | MIN | TYP                          | MAX                          | UNIT |
|-----------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-----------------|-----|------------------------------|------------------------------|------|
| t <sub>WAKE-UP FRAM</sub>   | (Additional) wake-up time to activate the FRAM in AM if previously disabled by the FRAM controller or from an LPM if immediate activation is selected for wakeup |                 |                 |     | 6                            | 10                           | μs   |
| t <sub>WAKE-UP LPM0</sub>   | Wake-up time from LPM0 to active mode <sup>(1)</sup>                                                                                                             |                 | 2.2 V, 3.0 V    |     | 400 + 1.5 / f <sub>DCO</sub> |                              | ns   |
| t <sub>WAKE-UP LPM1</sub>   | Wake-up time from LPM1 to active mode <sup>(1)</sup>                                                                                                             |                 | 2.2 V, 3.0 V    |     | 6                            |                              | μs   |
| t <sub>WAKE-UP LPM2</sub>   | Wake-up time from LPM2 to active mode <sup>(1)</sup>                                                                                                             |                 | 2.2 V, 3.0 V    |     | 6                            |                              | μs   |
| t <sub>WAKE-UP LPM3</sub>   | Wake-up time from LPM3 to active mode <sup>(1)</sup>                                                                                                             |                 | 2.2 V, 3.0 V    |     | 6.6 + 2.0 / f <sub>DCO</sub> | 9.6 + 2.5 / f <sub>DCO</sub> | μs   |
| t <sub>WAKE-UP LPM4</sub>   | Wake-up time from LPM4 to active mode <sup>(1)</sup>                                                                                                             |                 | 2.2 V, 3.0 V    |     | 6.6 + 2.0 / f <sub>DCO</sub> | 9.6 + 2.5 / f <sub>DCO</sub> | μs   |
| t <sub>WAKE-UP LPM3.5</sub> | Wake-up time from LPM3.5 to active mode <sup>(2)</sup>                                                                                                           |                 | 2.2 V, 3.0 V    |     | 350                          | 450                          | μs   |
| t <sub>WAKE-UP LPM4.5</sub> | Wake-up time from LPM4.5 to active mode <sup>(2)</sup>                                                                                                           | SVSHE = 1       | 2.2 V, 3.0 V    |     | 350                          | 450                          | μs   |
|                             |                                                                                                                                                                  | SVSHE = 0       | 2.2 V, 3.0 V    |     | 0.4                          | 0.8                          | ms   |
| t <sub>WAKE-UP-RST</sub>    | Wake-up time from a RST pin triggered reset to active mode <sup>(2)</sup>                                                                                        |                 | 2.2 V, 3.0 V    |     | 480                          | 596                          | μs   |
| t <sub>WAKE-UP-BOR</sub>    | Wake-up time from power-up to active mode <sup>(2)</sup>                                                                                                         |                 | 2.2 V, 3.0 V    |     | 0.5                          | 1                            | ms   |

- (1) The wake-up time is measured from the edge of an external wake-up signal (for example, port interrupt or wake-up event) to the first externally observable MCLK clock edge with MCLKREQEN = 1. This time includes the activation of the FRAM during wakeup. With MCLKREQEN = 0, the externally observable MCLK clock is gated one additional cycle.
- (2) The wake-up time is measured from the edge of an external wake-up signal (for example, port interrupt or wake-up event) until the first instruction of the user program is executed.

#### 8.13.4.2 Typical Wake-up Charges

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

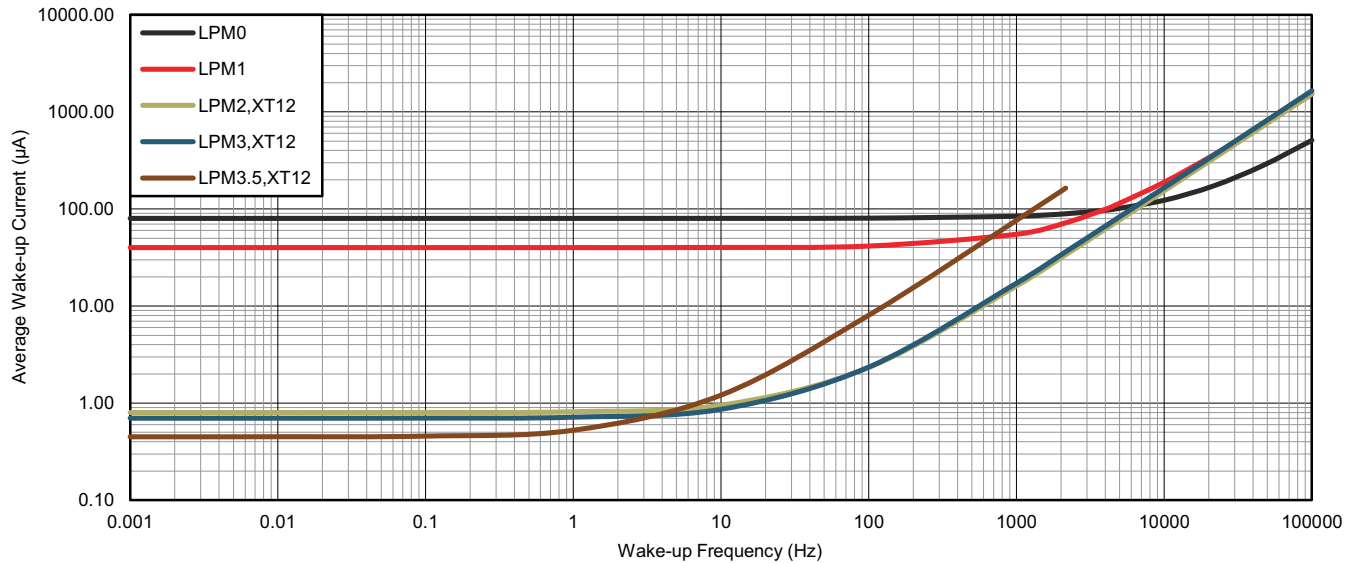
| PARAMETER                   |                                                                                                                     | TEST CONDITIONS | MIN | TYP  | MAX | UNIT |
|-----------------------------|---------------------------------------------------------------------------------------------------------------------|-----------------|-----|------|-----|------|
| Q <sub>WAKE-UP FRAM</sub>   | Charge used for activating the FRAM in AM or during wakeup from LPM0 if previously disabled by the FRAM controller. |                 |     | 16.5 |     | nAs  |
| Q <sub>WAKE-UP LPM0</sub>   | Charge used to wake up from LPM0 to active mode (with FRAM active)                                                  |                 |     | 3.8  |     | nAs  |
| Q <sub>WAKE-UP LPM1</sub>   | Charge used to wake up from LPM1 to active mode (with FRAM active)                                                  |                 |     | 21   |     | nAs  |
| Q <sub>WAKE-UP LPM2</sub>   | Charge used to wake up from LPM2 to active mode (with FRAM active)                                                  |                 |     | 22   |     | nAs  |
| Q <sub>WAKE-UP LPM3</sub>   | Charge used to wake up from LPM3 to active mode (with FRAM active)                                                  |                 |     | 28   |     | nAs  |
| Q <sub>WAKE-UP LPM4</sub>   | Charge used to wake up from LPM4 to active mode (with FRAM active)                                                  |                 |     | 28   |     | nAs  |
| Q <sub>WAKE-UP LPM3.5</sub> | Charge used to wake up from LPM3.5 to active mode <sup>(2)</sup>                                                    |                 |     | 170  |     | nAs  |
| Q <sub>WAKE-UP LPM4.5</sub> | Charge used to wake up from LPM4.5 to active mode <sup>(2)</sup>                                                    | SVSHE = 1       |     | 173  |     | nAs  |
|                             |                                                                                                                     | SVSHE = 0       |     | 171  |     |      |
| Q <sub>WAKE-UP-RESET</sub>  | Charge used for reset from RST or BOR event to active mode <sup>(2)</sup>                                           |                 |     | 148  |     | nAs  |

- (1) Charge used during the wake-up time from a given low-power mode to active mode. This does not include the energy required in active mode (for example, for an interrupt service routine).
- (2) Charge required until start of user code. This does not include the energy required to reconfigure the device.



### 8.13.4.3 Typical Characteristics, Average LPM Currents vs Wake-up Frequency

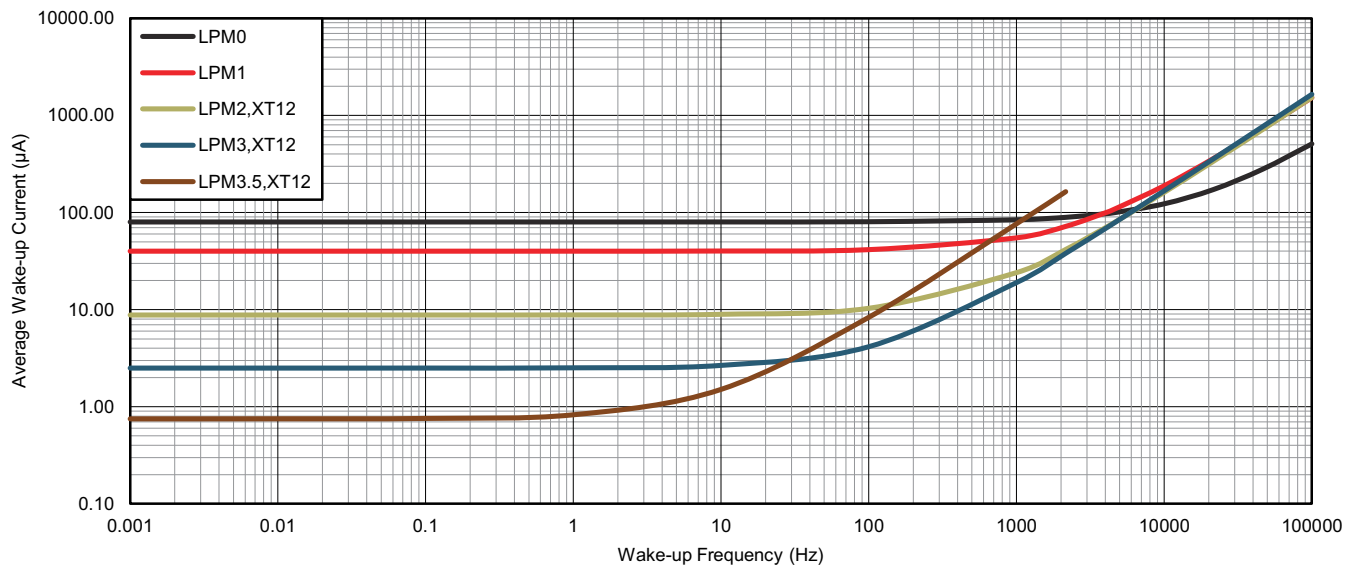
Figure 8-6 shows the average LPM currents vs wake-up frequency at 25°C.



The average wake-up current does not include the energy required in active mode; for example, for an interrupt service routine or to reconfigure the device.

**Figure 8-6. Average LPM Currents vs Wake-up Frequency at 25°C**

Figure 8-7 shows the average LPM currents vs wake-up frequency at 85°C.



The average wake-up current does not include the energy required in active mode; for example, for an interrupt service routine or to reconfigure the device.

**Figure 8-7. Average LPM Currents vs Wake-up Frequency at 85°C**

### 8.13.5 Digital I/Os

#### 8.13.5.1 Digital Inputs

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER              |                                                                                                  | TEST CONDITIONS                                                                                  | V <sub>CC</sub> | MIN  | TYP | MAX  | UNIT |
|------------------------|--------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------|-----------------|------|-----|------|------|
| V <sub>IT+</sub>       | Positive-going input threshold voltage                                                           |                                                                                                  | 2.2 V           | 1.2  |     | 1.65 | V    |
|                        |                                                                                                  |                                                                                                  | 3.0 V           | 1.65 |     | 2.25 |      |
| V <sub>IT-</sub>       | Negative-going input threshold voltage                                                           |                                                                                                  | 2.2 V           | 0.55 |     | 1.00 | V    |
|                        |                                                                                                  |                                                                                                  | 3.0 V           | 0.75 |     | 1.35 |      |
| V <sub>hys</sub>       | Input voltage hysteresis (V <sub>IT+</sub> – V <sub>IT-</sub> )                                  |                                                                                                  | 2.2 V           | 0.44 |     | 0.98 | V    |
|                        |                                                                                                  |                                                                                                  | 3.0 V           | 0.60 |     | 1.30 |      |
| R <sub>Pull</sub>      | Pullup or pulldown resistor                                                                      | For pullup: V <sub>IN</sub> = V <sub>SS</sub><br>For pulldown: V <sub>IN</sub> = V <sub>CC</sub> |                 | 20   | 35  | 50   | kΩ   |
| C <sub>I,dig</sub>     | Input capacitance, digital only port pins                                                        | V <sub>IN</sub> = V <sub>SS</sub> or V <sub>CC</sub>                                             |                 |      | 3   |      | pF   |
| C <sub>I,ana</sub>     | Input capacitance, port pins with shared analog functions <sup>(1)</sup>                         | V <sub>IN</sub> = V <sub>SS</sub> or V <sub>CC</sub>                                             |                 |      | 5   |      | pF   |
| I <sub>lkg(Px.y)</sub> | High-impedance input leakage current                                                             | See <sup>(2)</sup> <sup>(3)</sup>                                                                | 2.2 V, 3.0 V    | –20  |     | +20  | nA   |
| t <sub>(int)</sub>     | External interrupt timing (external trigger pulse duration to set interrupt flag) <sup>(4)</sup> | Ports with interrupt capability (see and <a href="#">§ 7.3</a> ).                                | 2.2 V, 3.0 V    | 20   |     |      | ns   |
| t <sub>(RST)</sub>     | External reset pulse duration on RST <sup>(5)</sup>                                              |                                                                                                  | 2.2 V, 3.0 V    | 2    |     |      | μs   |

- (1) If the port pins PJ.4/LFXIN and PJ.5/LFXOUT are used as digital I/Os, they are connected by a 4-pF capacitor and a 35-MΩ resistor in series. At frequencies of approximately 1 kHz and lower, the 4-pF capacitor can add to the pin capacitance of PJ.4/LFXIN and/or PJ.5/LFXOUT.
- (2) The input leakage current is measured with V<sub>SS</sub> or V<sub>CC</sub> applied to the corresponding pins, unless otherwise noted.
- (3) The input leakage of the digital port pins is measured individually. The port pin is selected for input and the pullup or pulldown resistor is disabled.
- (4) An external signal sets the interrupt flag every time the minimum interrupt pulse duration t<sub>(int)</sub> is met. It might be set by trigger signals shorter than t<sub>(int)</sub>.
- (5) Not applicable if RST/NMI pin configured as NMI

#### 8.13.5.2 Digital Outputs

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER             |                                                                                    | TEST CONDITIONS                                                                       | V <sub>CC</sub> | MIN                    | TYP | MAX                    | UNIT |
|-----------------------|------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|-----------------|------------------------|-----|------------------------|------|
| V <sub>OH</sub>       | High-level output voltage (see <a href="#">§ 8-10</a> and <a href="#">§ 8-11</a> ) | I <sub>(OHmax)</sub> = –1 mA <sup>(1)</sup>                                           | 2.2 V           | V <sub>CC</sub> – 0.25 |     | V <sub>CC</sub>        | V    |
|                       |                                                                                    | I <sub>(OHmax)</sub> = –3 mA <sup>(2)</sup>                                           |                 | V <sub>CC</sub> – 0.60 |     | V <sub>CC</sub>        |      |
|                       |                                                                                    | I <sub>(OHmax)</sub> = –2 mA <sup>(1)</sup>                                           | 3.0 V           | V <sub>CC</sub> – 0.25 |     | V <sub>CC</sub>        |      |
|                       |                                                                                    | I <sub>(OHmax)</sub> = –6 mA <sup>(2)</sup>                                           |                 | V <sub>CC</sub> – 0.60 |     | V <sub>CC</sub>        |      |
| V <sub>OL</sub>       | Low-level output voltage (see <a href="#">§ 8-8</a> and <a href="#">§ 8-9</a> )    | I <sub>(OLmax)</sub> = 1 mA <sup>(1)</sup>                                            | 2.2 V           | V <sub>SS</sub>        |     | V <sub>SS</sub> + 0.25 | V    |
|                       |                                                                                    | I <sub>(OLmax)</sub> = 3 mA <sup>(2)</sup>                                            |                 | V <sub>SS</sub>        |     | V <sub>SS</sub> + 0.60 |      |
|                       |                                                                                    | I <sub>(OLmax)</sub> = 2 mA <sup>(1)</sup>                                            | 3.0 V           | V <sub>SS</sub>        |     | V <sub>SS</sub> + 0.25 |      |
|                       |                                                                                    | I <sub>(OLmax)</sub> = 6 mA <sup>(2)</sup>                                            |                 | V <sub>SS</sub>        |     | V <sub>SS</sub> + 0.60 |      |
| f <sub>Px.y</sub>     | Port output frequency (with load) <sup>(5)</sup>                                   | C <sub>L</sub> = 20 pF, R <sub>L</sub> <sup>(3)</sup> <sup>(4)</sup>                  | 2.2 V           | 16                     |     |                        | MHz  |
|                       |                                                                                    |                                                                                       | 3.0 V           | 16                     |     |                        |      |
| f <sub>Port_CLK</sub> | Clock output frequency <sup>(5)</sup>                                              | ACLK, MCLK, or SMCLK at configured output port, C <sub>L</sub> = 20 pF <sup>(4)</sup> | 2.2 V           | 16                     |     |                        | MHz  |
|                       |                                                                                    |                                                                                       | 3.0 V           | 16                     |     |                        |      |
| t <sub>rise,dig</sub> | Port output rise time, digital only port pins                                      | C <sub>L</sub> = 20 pF                                                                | 2.2 V           |                        | 4   | 15                     | ns   |
|                       |                                                                                    |                                                                                       | 3.0 V           |                        | 3   | 15                     |      |
| t <sub>fall,dig</sub> | Port output fall time, digital only port pins                                      | C <sub>L</sub> = 20 pF                                                                | 2.2 V           |                        | 4   | 15                     | ns   |
|                       |                                                                                    |                                                                                       | 3.0 V           |                        | 3   | 15                     |      |

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER             |                                                               | TEST CONDITIONS        | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|-----------------------|---------------------------------------------------------------|------------------------|-----------------|-----|-----|-----|------|
| t <sub>rise,ana</sub> | Port output rise time, port pins with shared analog functions | C <sub>L</sub> = 20 pF | 2.2 V           |     | 6   | 15  | ns   |
|                       |                                                               |                        | 3.0 V           |     | 4   | 15  |      |
| t <sub>fall,ana</sub> | Port output fall time, port pins with shared analog functions | C <sub>L</sub> = 20 pF | 2.2 V           |     | 6   | 15  | ns   |
|                       |                                                               |                        | 3.0 V           |     | 4   | 15  |      |

- (1) The maximum total current, I<sub>(OHmax)</sub> and I<sub>(OLmax)</sub>, for all outputs combined should not exceed ±48 mA to hold the maximum voltage drop specified.
- (2) The maximum total current, I<sub>(OHmax)</sub> and I<sub>(OLmax)</sub>, for all outputs combined should not exceed ±100 mA to hold the maximum voltage drop specified.
- (3) A resistive divider with 2 × R1 and R1 = 1.6 kΩ between V<sub>CC</sub> and V<sub>SS</sub> is used as load. The output is connected to the center tap of the divider. C<sub>L</sub> = 20 pF is connected from the output to V<sub>SS</sub>.
- (4) The output voltage reaches at least 10% and 90% V<sub>CC</sub> at the specified toggle frequency.
- (5) The port can output frequencies at least up to the specified limit, and the port might support higher frequencies.

### 8.13.5.3 Typical Characteristics, Digital Outputs

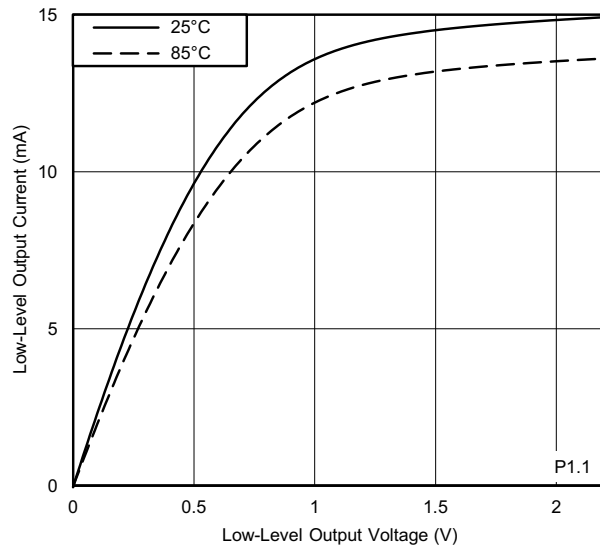


图 8-8. Typical Low-Level Output Current vs Low-Level Output Voltage

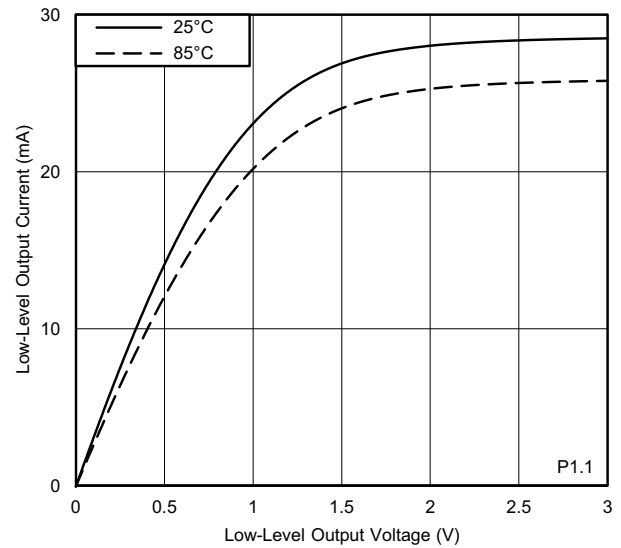


图 8-9. Typical Low-Level Output Current vs Low-Level Output Voltage

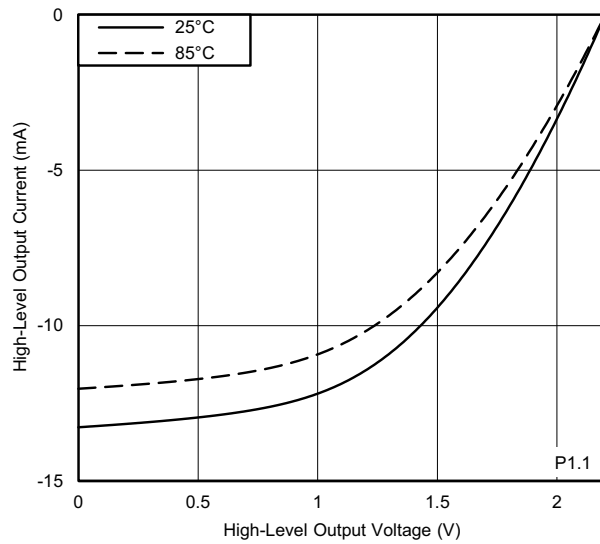


图 8-10. Typical High-Level Output Current vs High-Level Output Voltage

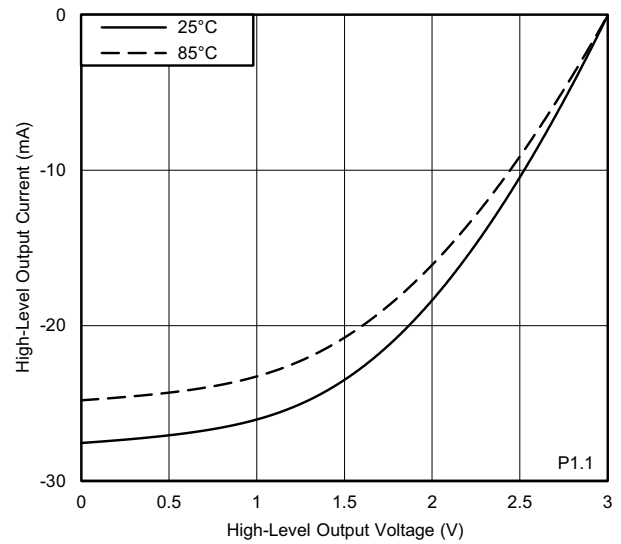


图 8-11. Typical High-Level Output Current vs High-Level Output Voltage

## 8.13.6 LEA

### 8.13.6.1 Low-Energy Accelerator (LEA) Performance

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER        |                                                 | TEST CONDITIONS                                                                    |                                        | MIN | TYP | MAX | UNIT |
|------------------|-------------------------------------------------|------------------------------------------------------------------------------------|----------------------------------------|-----|-----|-----|------|
| f <sub>LEA</sub> | Frequency for specified performance             | MCLK                                                                               |                                        |     | 16  |     | MHz  |
| W_LEA_FFT        | LEA subsystem energy on fast Fourier transform  | Complex FFT 128 pt. Q.15 with random data in LEA-RAM                               | V <sub>CORE</sub> = 3 V, MCLK = 16 MHz |     | 350 |     | nJ   |
| W_LEA_FIR        | LEA subsystem energy on finite impulse response | Real FIR on random Q.31 data with 128 taps on 24 points                            | V <sub>CORE</sub> = 3 V, MCLK = 16 MHz |     | 2.6 |     | μJ   |
| W_LEA_ADD        | LEA subsystem energy on additions               | On 32 Q.31 elements with random value out of LEA-RAM with linear address increment | V <sub>CORE</sub> = 3 V, MCLK = 16 MHz |     | 6.6 |     | nJ   |

## 8.13.7 Timer\_A and Timer\_B

### 8.13.7.1 Timer\_A

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER           |                               | TEST CONDITIONS                                                       | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|---------------------|-------------------------------|-----------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| f <sub>TA</sub>     | Timer_A input clock frequency | Internal: SMCLK or ACLK,<br>External: TACLK,<br>Duty cycle = 50% ±10% | 2.2 V, 3.0 V    |     |     | 16  | MHz  |
| t <sub>TA,cap</sub> | Timer_A capture timing        | All capture inputs, minimum pulse duration required for capture       | 2.2 V, 3.0 V    | 20  |     |     | ns   |

### 8.13.7.2 Timer\_B

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER           |                               | TEST CONDITIONS                                                       | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|---------------------|-------------------------------|-----------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| f <sub>TB</sub>     | Timer_B input clock frequency | Internal: SMCLK or ACLK,<br>External: TBCLK,<br>Duty cycle = 50% ±10% | 2.2 V, 3.0 V    |     |     | 16  | MHz  |
| t <sub>TB,cap</sub> | Timer_B capture timing        | All capture inputs, minimum pulse duration required for capture       | 2.2 V, 3.0 V    | 20  |     |     | ns   |

### 8.13.8 eUSCI

#### 8.13.8.1 eUSCI (UART Mode) Clock Frequency

| PARAMETER    |                                                       | CONDITIONS                                                                | MIN | MAX | UNIT |
|--------------|-------------------------------------------------------|---------------------------------------------------------------------------|-----|-----|------|
| $f_{eUSCI}$  | eUSCI input clock frequency                           | Internal: SMCLK or ACLK,<br>External: UCLK,<br>Duty cycle = 50% $\pm$ 10% |     | 16  | MHz  |
| $f_{BITCLK}$ | BITCLK clock frequency<br>(equals baud rate in MBaud) |                                                                           |     | 4   | MHz  |

#### 8.13.8.2 eUSCI (UART Mode) Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER |                                           | TEST CONDITIONS | $V_{CC}$     | MIN | TYP | MAX | UNIT |
|-----------|-------------------------------------------|-----------------|--------------|-----|-----|-----|------|
| $t_t$     | UART receive deglitch time <sup>(1)</sup> | UCGLITx = 0     | 2.2 V, 3.0 V | 5   |     | 30  | ns   |
|           |                                           | UCGLITx = 1     |              | 20  |     | 90  |      |
|           |                                           | UCGLITx = 2     |              | 35  |     | 160 |      |
|           |                                           | UCGLITx = 3     |              | 50  |     | 220 |      |

- (1) Pulses on the UART receive input (UCxRX) shorter than the UART receive deglitch time are suppressed. Thus the selected deglitch time can limit the maximum useable baud rate. To ensure that pulses are correctly recognized, their duration should exceed the maximum specification of the deglitch time.

#### 8.13.8.3 eUSCI (SPI Master Mode) Clock Frequency

| PARAMETER   |                             | TEST CONDITIONS                                        | MIN | MAX | UNIT |
|-------------|-----------------------------|--------------------------------------------------------|-----|-----|------|
| $f_{eUSCI}$ | eUSCI input clock frequency | Internal: SMCLK or ACLK,<br>Duty cycle = 50% $\pm$ 10% |     | 16  | MHz  |

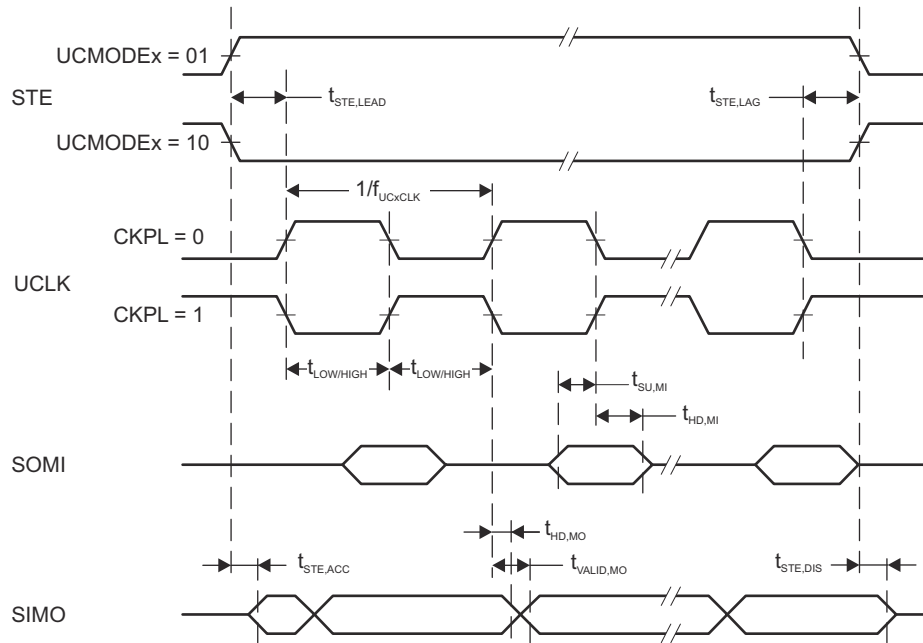
#### 8.13.8.4 eUSCI (SPI Master Mode) Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

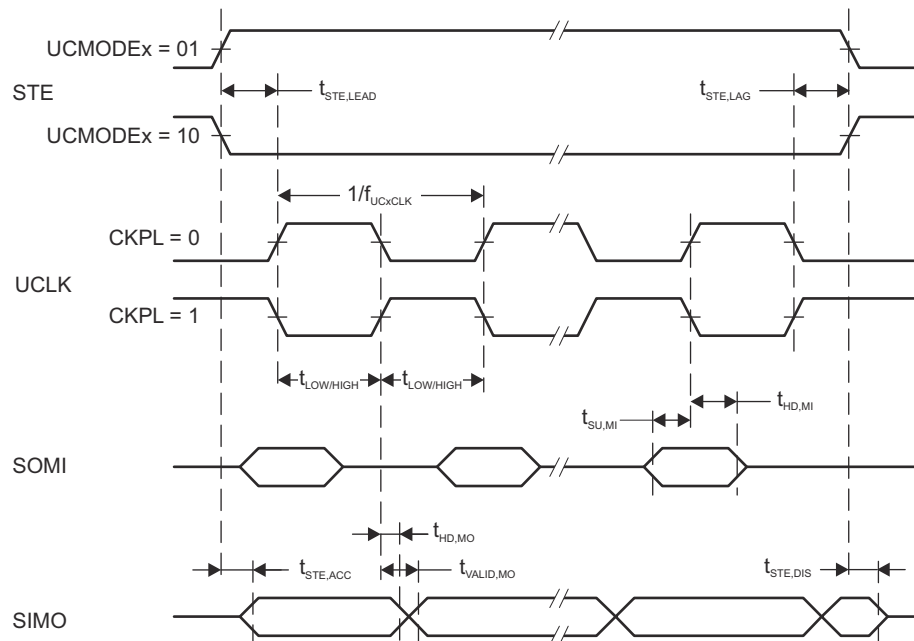
| PARAMETER      |                                                       | TEST CONDITIONS                           | $V_{CC}$     | MIN | TYP | MAX | UNIT          |
|----------------|-------------------------------------------------------|-------------------------------------------|--------------|-----|-----|-----|---------------|
| $t_{STE,LEAD}$ | STE lead time, STE active to clock                    | UCSTEM = 1, UCMODEx = 01 or 10            |              | 1   |     |     | UCxCLK cycles |
| $t_{STE,LAG}$  | STE lag time, Last clock to STE inactive              | UCSTEM = 1, UCMODEx = 01 or 10            |              | 1   |     |     |               |
| $t_{STE,ACC}$  | STE access time, STE active to SIMO data out          | UCSTEM = 0, UCMODEx = 01 or 10            | 2.2 V, 3.0 V |     |     | 60  | ns            |
| $t_{STE,DIS}$  | STE disable time, STE inactive to SOMI high impedance | UCSTEM = 0, UCMODEx = 01 or 10            | 2.2 V, 3.0 V |     |     | 80  | ns            |
| $t_{SU,MI}$    | SOMI input data setup time                            |                                           | 2.2 V        | 40  |     |     | ns            |
|                |                                                       |                                           | 3.0 V        | 40  |     |     |               |
| $t_{HD,MI}$    | SOMI input data hold time                             |                                           | 2.2 V        | 0   |     |     | ns            |
|                |                                                       |                                           | 3.0 V        | 0   |     |     |               |
| $t_{VALID,MO}$ | SIMO output data valid time <sup>(2)</sup>            | UCLK edge to SIMO valid,<br>$C_L = 20$ pF | 2.2 V        |     |     | 11  | ns            |
|                |                                                       |                                           | 3.0 V        |     |     | 10  |               |
| $t_{HD,MO}$    | SIMO output data hold time <sup>(3)</sup>             | $C_L = 20$ pF                             | 2.2 V        |     | 0   |     | ns            |
|                |                                                       |                                           | 3.0 V        |     | 0   |     |               |

- (1)  $f_{UCxCLK} = 1/2 t_{LO/HI}$  with  $t_{LO/HI} = \max(t_{VALID,MO}(eUSCI) + t_{SU,SI}(Slave), t_{SU,MI}(eUSCI) + t_{VALID,SO}(Slave))$ . For the slave parameters  $t_{SU,SI}(Slave)$  and  $t_{VALID,SO}(Slave)$ , see the SPI parameters of the attached slave.
- (2) Specifies the time to drive the next valid data to the SIMO output after the output changing UCLK clock edge. See the timing diagrams in [Figure 8-12](#) and [Figure 8-13](#).
- (3) Specifies how long data on the SIMO output is valid after the output changing UCLK clock edge. Negative values indicate that the data on the SIMO output can become invalid before the output changing clock edge observed on UCLK. See the timing diagrams in [Figure 8-12](#) and [Figure 8-13](#).

#### 8.13.8.5 eUSCI (SPI Master Mode) Timing Diagrams



**图 8-12. SPI Master Mode, CKPH = 0**



**图 8-13. SPI Master Mode, CKPH = 1**

#### 8.13.8.6 eUSCI (SPI Slave Mode) Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER      | TEST CONDITIONS                              | V <sub>CC</sub> | MIN | MAX | UNIT |
|----------------|----------------------------------------------|-----------------|-----|-----|------|
| $t_{STE,LEAD}$ | STE lead time, STE active to clock           | 2.2 V           | 45  | 40  | ns   |
|                |                                              | 3.0 V           |     |     |      |
| $t_{STE,LAG}$  | STE lag time, Last clock to STE inactive     | 2.2 V           | 2   | 3   | ns   |
|                |                                              | 3.0 V           |     |     |      |
| $t_{STE,ACC}$  | STE access time, STE active to SOMI data out | 2.2 V           |     | 45  | ns   |

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER             |                                                       | TEST CONDITIONS                                    | V <sub>CC</sub> | MIN | MAX | UNIT |
|-----------------------|-------------------------------------------------------|----------------------------------------------------|-----------------|-----|-----|------|
| t <sub>STE,DIS</sub>  | STE disable time, STE inactive to SOMI high impedance |                                                    | 3.0 V           |     | 40  | ns   |
|                       |                                                       |                                                    | 2.2 V           |     | 50  |      |
|                       |                                                       |                                                    | 3.0 V           |     | 45  |      |
| t <sub>SU,SI</sub>    | SIMO input data setup time                            |                                                    | 2.2 V           | 4   |     | ns   |
|                       |                                                       |                                                    | 3.0 V           | 4   |     |      |
| t <sub>HD,SI</sub>    | SIMO input data hold time                             |                                                    | 2.2 V           | 7   |     | ns   |
|                       |                                                       |                                                    | 3.0 V           | 7   |     |      |
| t <sub>VALID,SO</sub> | SOMI output data valid time <sup>(2)</sup>            | UCLK edge to SOMI valid,<br>C <sub>L</sub> = 20 pF | 2.2 V           |     | 35  | ns   |
|                       |                                                       |                                                    | 3.0 V           |     | 35  |      |
| t <sub>HD,SO</sub>    | SOMI output data hold time <sup>(3)</sup>             | C <sub>L</sub> = 20 pF                             | 2.2 V           | 0   |     | ns   |
|                       |                                                       |                                                    | 3.0 V           | 0   |     |      |

(1)  $f_{UCxCLK} = 1/2 t_{LO/Hi}$  with  $t_{LO/Hi} \geq \max(t_{VALID,MO(Master)} + t_{SU,SI(eUSCI)}, t_{SU,MI(Master)} + t_{VALID,SO(eUSCI)})$

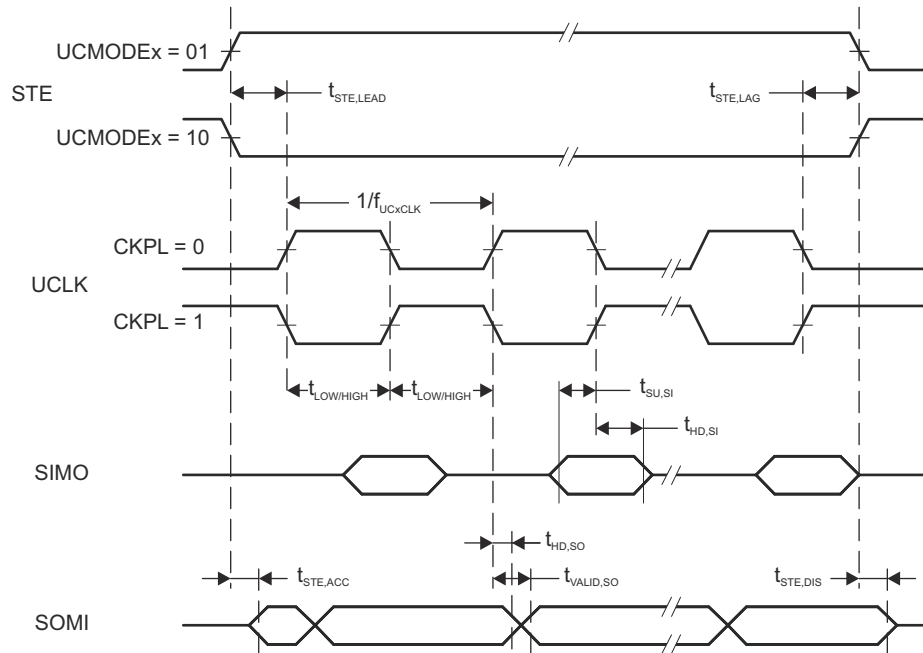
For the master parameters  $t_{SU,MI(Master)}$  and  $t_{VALID,MO(Master)}$ , see the SPI parameters of the attached master.

(2) Specifies the time to drive the next valid data to the SOMI output after the output changing UCLK clock edge. See the timing diagrams in [图 8-14](#) and [图 8-15](#).

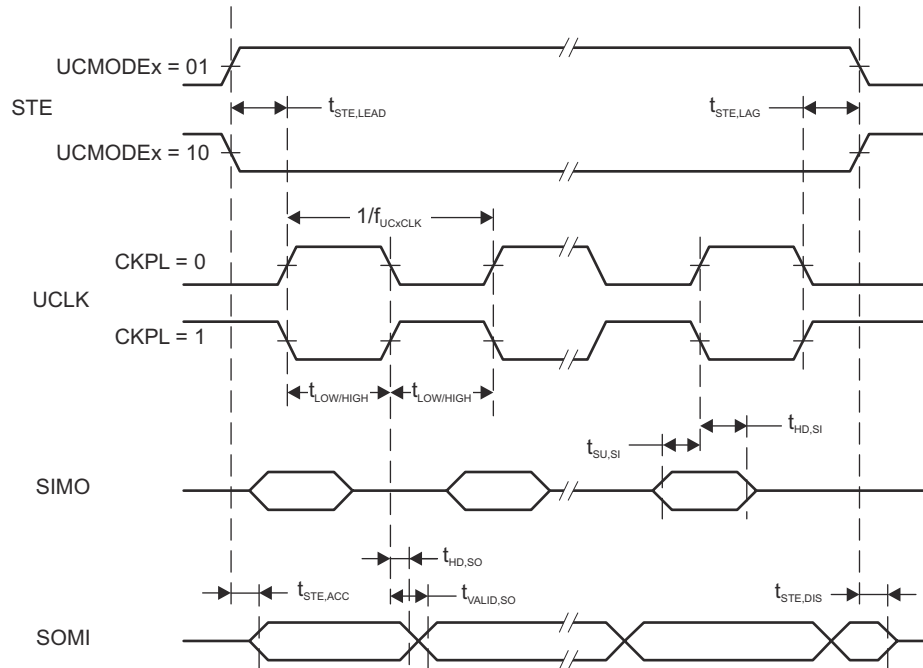
(3) Specifies how long data on the SOMI output is valid after the output changing UCLK clock edge. See the timing diagrams in [图 8-14](#) and [图 8-15](#).

#### 8.13.8.7 eUSCI (SPI Slave Mode) Timing Diagrams





**图 8-14. SPI Slave Mode, CKPH = 0**



**图 8-15. SPI Slave Mode, CKPH = 1**

#### 8.13.8.8 eUSCI (I<sup>2</sup>C Mode) Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [图 8-16](#))

| PARAMETER          | TEST CONDITIONS                                                                                     | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|--------------------|-----------------------------------------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| f <sub>eUSCI</sub> | eUSCI input clock frequency<br>Internal: SMCLK or ACLK,<br>External: UCLK,<br>Duty cycle = 50% ±10% |                 |     |     | 16  | MHz  |
| f <sub>SCL</sub>   | SCL clock frequency                                                                                 | 2.2 V, 3.0 V    | 0   |     | 400 | kHz  |

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see 图 8-16)

| PARAMETER            | TEST CONDITIONS                                     | V <sub>CC</sub>            | MIN  | TYP | MAX  | UNIT |
|----------------------|-----------------------------------------------------|----------------------------|------|-----|------|------|
| t <sub>HD,STA</sub>  | Hold time (repeated) START                          | f <sub>SCL</sub> = 100 kHz | 4.0  |     |      | μs   |
|                      | f <sub>SCL</sub> > 100 kHz                          | 2.2 V, 3.0 V               | 0.6  |     |      |      |
| t <sub>SU,STA</sub>  | Setup time for a repeated START                     | f <sub>SCL</sub> = 100 kHz | 4.7  |     |      | μs   |
|                      | f <sub>SCL</sub> > 100 kHz                          | 2.2 V, 3.0 V               | 0.6  |     |      |      |
| t <sub>HD,DAT</sub>  | Data hold time                                      |                            | 0    |     |      | ns   |
| t <sub>SU,DAT</sub>  | Data setup time                                     |                            | 100  |     |      | ns   |
| t <sub>SU,STO</sub>  | Setup time for STOP                                 | f <sub>SCL</sub> = 100 kHz | 4.0  |     |      | μs   |
|                      | f <sub>SCL</sub> > 100 kHz                          | 2.2 V, 3.0 V               | 0.6  |     |      |      |
| t <sub>BUF</sub>     | Bus free time between a STOP and START condition    | f <sub>SCL</sub> = 100 kHz | 4.7  |     |      | us   |
|                      | f <sub>SCL</sub> > 100 kHz                          |                            | 1.3  |     |      |      |
| t <sub>SP</sub>      | Pulse duration of spikes suppressed by input filter | UCGLITx = 0                | 50   |     | 250  | ns   |
|                      |                                                     | UCGLITx = 1                | 25   |     | 125  |      |
|                      |                                                     | UCGLITx = 2                | 12.5 |     | 62.5 |      |
|                      |                                                     | UCGLITx = 3                | 6.3  |     | 31.5 |      |
| t <sub>TIMEOUT</sub> | Clock low time-out                                  | UCCLTOx = 1                |      | 27  |      | ms   |
|                      |                                                     | UCCLTOx = 2                |      | 30  |      |      |
|                      |                                                     | UCCLTOx = 3                |      | 33  |      |      |

#### 8.13.8.9 eUSCI (I<sup>2</sup>C Mode) Timing Diagram

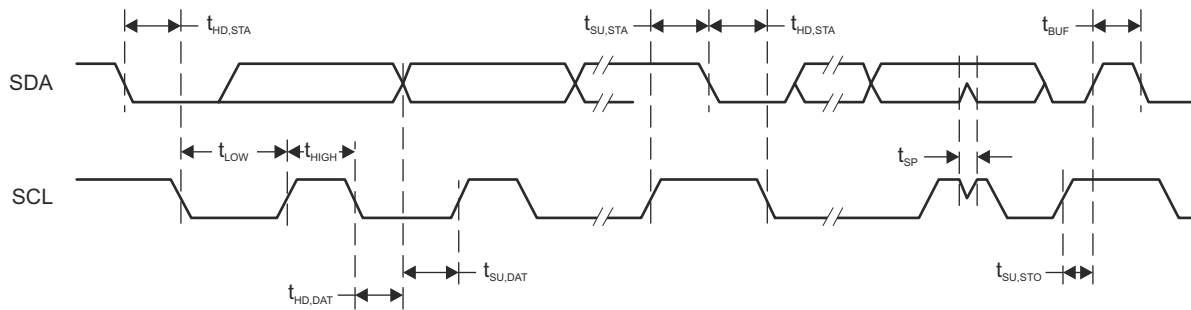


图 8-16. I<sup>2</sup>C Mode Timing

## 8.13.9 Segment LCD Controller

### 8.13.9.1 LCD\_C Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                  | CONDITIONS                                                                                     | MIN                                            | NOM    | MAX                | UNIT |
|----------------------------|------------------------------------------------------------------------------------------------|------------------------------------------------|--------|--------------------|------|
| $V_{CC,LCD\_C,CP\ en,3.6}$ | Supply voltage range, charge pump enabled, $V_{LCD} \leq 3.6$ V                                | 2.2                                            |        | 3.6                | V    |
| $V_{CC,LCD\_C,CP\ en,3.3}$ | Supply voltage range, charge pump enabled, $V_{LCD} \leq 3.3$ V                                | 2.0                                            |        | 3.6                | V    |
| $V_{CC,LCD\_C,int.\ bias}$ | Supply voltage range, internal biasing, charge pump disabled                                   | 2.4                                            |        | 3.6                | V    |
| $V_{CC,LCD\_C,ext.\ bias}$ | Supply voltage range, external biasing, charge pump disabled                                   | 2.4                                            |        | 3.6                | V    |
| $V_{CC,LCD\_C,VLCDEXT}$    | Supply voltage range, external LCD voltage, internal or external biasing, charge pump disabled | 2.0                                            |        | 3.6                | V    |
| $V_{LCDCAP}$               | External LCD voltage at LCDCAP, internal or external biasing, charge pump disabled             | 2.4                                            |        | 3.6                | V    |
| $C_{LCDCAP}$               | Capacitor value on LCDCAP when charge pump enabled                                             | 4.7 <sub>-20%</sub>                            | 4.7    | 10 <sub>+20%</sub> | μF   |
| $f_{ACLK,in}$              | ACLK input frequency range                                                                     | 30                                             | 32.768 | 40                 | kHz  |
| $f_{LCD}$                  | LCD frequency range                                                                            | 0                                              |        | 1024               | Hz   |
| $f_{FRAME,4mux}$           | LCD frame frequency range                                                                      |                                                |        | 128                | Hz   |
| $C_{Panel}$                | Panel capacitance                                                                              |                                                |        | 10000              | pF   |
| $V_{R33}$                  | Analog input voltage at R33                                                                    | 2.4                                            |        | $V_{CC} + 0.2$     | V    |
| $V_{R23,1/3bias}$          | Analog input voltage at R23                                                                    | $V_{R13} \times \frac{V_{R03} + 2/3}{V_{R03}}$ |        | $V_{R33}$          | V    |
| $V_{R13,1/3bias}$          | Analog input voltage at R13 with 1/3 biasing                                                   | $V_{R03} \times \frac{V_{R03} + 1/3}{V_{R03}}$ |        | $V_{R23}$          | V    |
| $V_{R13,1/2bias}$          | Analog input voltage at R13 with 1/2 biasing                                                   | $V_{R03} \times \frac{V_{R03} + 1/2}{V_{R03}}$ |        | $V_{R33}$          | V    |
| $V_{R03}$                  | Analog input voltage at R03                                                                    | $V_{SS}$                                       |        |                    | V    |
| $V_{LCD} - V_{R03}$        | Voltage difference between $V_{LCD}$ and R03                                                   | 2.4                                            |        | $V_{CC} + 0.2$     | V    |
| $V_{LCDREF}$               | External LCD reference voltage applied at LCDREF                                               | 0.8                                            | 1.0    | 1.2                | V    |

### 8.13.9.2 LCD\_C Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

| PARAMETER   | TEST CONDITIONS                      | $V_{CC}$       | MIN  | TYP      | MAX  | UNIT |
|-------------|--------------------------------------|----------------|------|----------|------|------|
| $V_{LCD,0}$ | $V_{LCDx} = 0000$ , $V_{LCDEXT} = 0$ | 2.4 V to 3.6 V |      | $V_{CC}$ |      | V    |
| $V_{LCD,1}$ | $LCDCPEN = 1$ , $V_{LCDx} = 0001b$   | 2 V to 3.6 V   | 2.49 | 2.60     | 2.72 |      |
| $V_{LCD,2}$ | $LCDCPEN = 1$ , $V_{LCDx} = 0010b$   | 2 V to 3.6 V   |      | 2.66     |      |      |
| $V_{LCD,3}$ | $LCDCPEN = 1$ , $V_{LCDx} = 0011b$   | 2 V to 3.6 V   |      | 2.72     |      |      |
| $V_{LCD,4}$ | $LCDCPEN = 1$ , $V_{LCDx} = 0100b$   | 2 V to 3.6 V   |      | 2.78     |      |      |
| $V_{LCD,5}$ | $LCDCPEN = 1$ , $V_{LCDx} = 0101b$   | 2 V to 3.6 V   |      | 2.84     |      |      |
| $V_{LCD,6}$ | $LCDCPEN = 1$ , $V_{LCDx} = 0110b$   | 2 V to 3.6 V   |      | 2.90     |      |      |
| $V_{LCD,7}$ | $LCDCPEN = 1$ , $V_{LCDx} = 0111b$   | 2 V to 3.6 V   |      | 2.96     |      |      |
| $V_{LCD,8}$ | $LCDCPEN = 1$ , $V_{LCDx} = 1000b$   | 2 V to 3.6 V   |      | 3.02     |      |      |
| $V_{LCD,9}$ | $LCDCPEN = 1$ , $V_{LCDx} = 1001b$   | 2 V to 3.6 V   |      | 3.08     |      |      |

over operating free-air temperature range (unless otherwise noted)

| PARAMETER               |                                                       | TEST CONDITIONS                                                                       | V <sub>CC</sub> | MIN          | TYP  | MAX | UNIT |
|-------------------------|-------------------------------------------------------|---------------------------------------------------------------------------------------|-----------------|--------------|------|-----|------|
| V <sub>LCD,10</sub>     |                                                       | LCDCPEN = 1, VLCDx = 1010b                                                            | 2 V to 3.6 V    | 3.14         |      |     |      |
| V <sub>LCD,11</sub>     |                                                       | LCDCPEN = 1, VLCDx = 1011b                                                            | 2 V to 3.6 V    | 3.20         |      |     |      |
| V <sub>LCD,12</sub>     |                                                       | LCDCPEN = 1, VLCDx = 1100b                                                            | 2 V to 3.6 V    | 3.26         |      |     |      |
| V <sub>LCD,13</sub>     |                                                       | LCDCPEN = 1, VLCDx = 1101b                                                            | 2.2 V to 3.6 V  | 3.32         |      |     |      |
| V <sub>LCD,14</sub>     |                                                       | LCDCPEN = 1, VLCDx = 1110b                                                            | 2.2 V to 3.6 V  | 3.38         |      |     |      |
| V <sub>LCD,15</sub>     |                                                       | LCDCPEN = 1, VLCDx = 1111b                                                            | 2.2 V to 3.6 V  | 3.32         | 3.44 | 3.6 |      |
| V <sub>LCD,7,0.8</sub>  | LCD voltage with external reference of 0.8 V          | LCDCPEN = 1, VLCDx = 0111b, VLCDREFx = 01b, V <sub>LCDREF</sub> = 0.8 V               | 2 V to 3.6 V    | 2.96 × 0.8 V |      |     | V    |
| V <sub>LCD,7,1.0</sub>  | LCD voltage with external reference of 1.0 V          | LCDCPEN = 1, VLCDx = 0111b, VLCDREFx = 01b, V <sub>LCDREF</sub> = 1.0 V               | 2 V to 3.6 V    | 2.96 × 1.0 V |      |     | V    |
| V <sub>LCD,7,1.2</sub>  | LCD voltage with external reference of 1.2 V          | LCDCPEN = 1, VLCDx = 0111b, VLCDREFx = 01b, V <sub>LCDREF</sub> = 1.2 V               | 2.2 V to 3.6 V  | 2.96 × 1.2 V |      |     | V    |
| ΔV <sub>LCD</sub>       | Voltage difference between consecutive VLCDx settings | ΔV <sub>LCD</sub> = V <sub>LCD,x</sub> – V <sub>LCD,x-1</sub> with x = 0010b to 1111b |                 | 40           | 60   | 80  | mV   |
| I <sub>CC,Peak,CP</sub> | Peak supply currents due to charge pump activities    | LCDCPEN = 1, VLCDx = 1111b external, with decoupling capacitor on DVCC supply ≥1 μF   | 2.2 V           | 600          |      |     | μA   |
| t <sub>LCD,CP,on</sub>  | Time to charge C <sub>LCD</sub> when discharged       | C <sub>LCD</sub> = 4.7 μF, LCDCPEN = 0→1, VLCDx = 1111b                               | 2.2 V           | 100 500      |      |     | ms   |
| I <sub>CP,Load</sub>    | Maximum charge pump load current                      | LCDCPEN = 1, VLCDx = 1111b                                                            | 2.2 V           | 50           |      |     | μA   |
| R <sub>LCD,Seg</sub>    | LCD driver output impedance, segment lines            | LCDCPEN = 0, I <sub>LOAD</sub> = ±10 μA                                               | 2.2 V           | 10           |      |     | kΩ   |
| R <sub>LCD,COM</sub>    | LCD driver output impedance, common lines             | LCDCPEN = 0, I <sub>LOAD</sub> = ±10 μA                                               | 2.2 V           | 10           |      |     | kΩ   |

### 8.13.10 ADC12\_B

#### 8.13.10.1 12-Bit ADC, Power Supply and Input Range Conditions

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                | TEST CONDITIONS                                                          | V <sub>CC</sub>                                                                                                     | MIN   | NOM | MAX  | UNIT |
|----------------------------------------------------------|--------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------|-------|-----|------|------|
| V <sub>(Ax)</sub>                                        | Analog input voltage range <sup>(1)</sup>                                | All ADC12 analog input pins Ax                                                                                      | 0     |     | AVCC | V    |
| I <sub>(ADC12_B)</sub><br>single-ended<br>mode           | Operating supply current into AVCC and DVCC terminals <sup>(2) (3)</sup> | f <sub>ADC12CLK</sub> = MODCLK, ADC12ON = 1, ADC12PWRMD = 0, ADC12DIF = 0, REFON = 0, ADC12SHTx = 0, ADC12DIV = 0   | 3.0 V | 145 | 199  | μA   |
|                                                          |                                                                          | f <sub>ADC12CLK</sub> = MODCLK, ADC12ON = 1, ADC12PWRMD = 0, ADC12DIF = 0, REFON = 0, ADC12SHTx = 0, ADC12DIV = 0   | 2.2 V | 140 | 190  |      |
| I <sub>(ADC12_B)</sub><br>differential mode              | Operating supply current into AVCC and DVCC terminals <sup>(2) (3)</sup> | f <sub>ADC12CLK</sub> = MODCLK, ADC12ON = 1, ADC12PWRMD = 0, ADC12DIF = 1, REFON = 0, ADC12SHTx = 0, ADC12DIV = 0   | 3.0 V | 175 | 245  | μA   |
|                                                          |                                                                          | f <sub>ADC12CLK</sub> = MODCLK, ADC12ON = 1, ADC12PWRMD = 0, ADC12DIF = 1, REFON = 0, ADC12SHTx = 0, ADC12DIV = 0   | 2.2 V | 170 | 230  |      |
| I <sub>(ADC12_B)</sub><br>single-ended<br>low-power mode | Operating supply current into AVCC and DVCC terminals <sup>(2) (3)</sup> | f <sub>ADC12CLK</sub> = MODCLK/4, ADC12ON = 1, ADC12PWRMD = 1, ADC12DIF = 0, REFON = 0, ADC12SHTx = 0, ADC12DIV = 0 | 3.0 V | 85  | 125  | μA   |
|                                                          |                                                                          | f <sub>ADC12CLK</sub> = MODCLK/4, ADC12ON = 1, ADC12PWRMD = 1, ADC12DIF = 0, REFON = 0, ADC12SHTx = 0, ADC12DIV = 0 | 2.2 V | 83  | 120  |      |
| I <sub>(ADC12_B)</sub><br>differential low-power mode    | Operating supply current into AVCC and DVCC terminals <sup>(2) (3)</sup> | f <sub>ADC12CLK</sub> = MODCLK/4, ADC12ON = 1, ADC12PWRMD = 1, ADC12DIF = 1, REFON = 0, ADC12SHTx = 0, ADC12DIV = 0 | 3.0 V | 110 | 165  | μA   |
|                                                          |                                                                          | f <sub>ADC12CLK</sub> = MODCLK/4, ADC12ON = 1, ADC12PWRMD = 1, ADC12DIF = 1, REFON = 0, ADC12SHTx = 0, ADC12DIV = 0 | 2.2 V | 109 | 160  |      |
| C <sub>I</sub>                                           | Input capacitance                                                        | Only one terminal Ax can be selected at one time                                                                    | 2.2 V | 10  | 15   | pF   |
| R <sub>I</sub>                                           | Input MUX ON resistance                                                  | 0 V ≤ V <sub>(Ax)</sub> ≤ AV <sub>CC</sub>                                                                          | >2 V  | 0.5 | 4    | kΩ   |
|                                                          |                                                                          |                                                                                                                     | <2 V  | 1   | 10   |      |

(1) The analog input voltage range must be within the selected reference voltage range V<sub>R+</sub> to V<sub>R-</sub> for valid conversion results.

(2) The internal reference supply current is not included in current consumption parameter I<sub>(ADC12\_B)</sub>.

(3) Approximately 60% (typical) of the total current into the AVCC and DVCC terminal is from AVCC.

#### 8.13.10.2 12-Bit ADC, Timing Parameters

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER             |                                                    | TEST CONDITIONS                                                                                                                            |                                                                                                                                                            | MIN                | TYP | MAX | UNIT |
|-----------------------|----------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------|-----|-----|------|
| f <sub>ADC12CLK</sub> | Frequency for specified performance                | For specified performance of ADC12 linearity parameters with ADC12PWRMD = 0, If ADC12PWRMD = 1, the maximum is 1/4 of the value shown here |                                                                                                                                                            | 0.45               |     | 5.4 | MHz  |
| f <sub>ADC12CLK</sub> | Frequency for reduced performance                  | Linearity parameters have reduced performance                                                                                              |                                                                                                                                                            | 32.768             |     |     | kHz  |
| f <sub>ADC12OSC</sub> | Internal oscillator <sup>(3)</sup>                 | ADC12DIV = 0, f <sub>ADC12CLK</sub> = f <sub>ADC12OSC</sub> from MODCLK                                                                    |                                                                                                                                                            | 4                  | 4.8 | 5.4 | MHz  |
| t <sub>CONVERT</sub>  | Conversion time                                    | REFON = 0, Internal oscillator, f <sub>ADC12CLK</sub> = f <sub>ADC12OSC</sub> from MODCLK, ADC12WINC = 0                                   |                                                                                                                                                            | 2.6                |     | 3.5 | μs   |
|                       |                                                    | External f <sub>ADC12CLK</sub> from ACLK, MCLK, or SMCLK, ADC12SSEL ≠ 0                                                                    |                                                                                                                                                            | See <sup>(2)</sup> |     |     |      |
| t <sub>ADC12ON</sub>  | Turnon settling time of the ADC                    | See <sup>(1)</sup>                                                                                                                         |                                                                                                                                                            |                    |     | 100 | ns   |
| t <sub>ADC12OFF</sub> | Time ADC must be off before can be turned on again | Note: t <sub>ADC12OFF</sub> must be met to make sure that t <sub>ADC12ON</sub> time holds.                                                 |                                                                                                                                                            | 100                |     |     | ns   |
| t <sub>Sample</sub>   | Sampling time                                      | R <sub>S</sub> = 400 Ω, R <sub>I</sub> = 4 kΩ, C <sub>I</sub> = 15 pF, C <sub>pext</sub> = 8 pF <sup>(4)</sup>                             | All pulse sample mode (ADC12SHP = 1) and extended sample mode (ADC12SHP = 0) with buffered reference (ADC12VRSEL = 0x1, 0x3, 0x5, 0x7, 0x9, 0xB, 0xD, 0xF) | 1                  |     |     | μs   |

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS                                                                                           | MIN     | TYP | MAX | UNIT |
|-----------|--|-----------------------------------------------------------------------------------------------------------|---------|-----|-----|------|
|           |  | Extended sample mode (ADC12SHP = 0) with unbuffered reference (ADC12VRSEL = 0x0, 0x2, 0x4, 0x6, 0xC, 0xE) | See (5) |     |     |      |

- (1) The condition is that the error in a conversion started after  $t_{\text{ADC12ON}}$  is less than  $\pm 0.5$  LSB. The reference and input signal are already settled.
- (2)  $14 \times 1 / f_{\text{ADC12CLK}}$ . If  $\text{ADC12WINC} = 1$  then  $15 \times 1 / f_{\text{ADC12CLK}}$ .
- (3) The  $\text{ADC12OSC}$  is sourced directly from  $\text{MODOSC}$  in the UCS.
- (4) Approximately 10 Tau ( $\tau$ ) are needed to get an error of less than  $\pm 0.5$  LSB:  $t_{\text{sample}} = \ln(2^{n+2}) \times (R_S + R_I) \times (C_I + C_{\text{pext}})$ , where  $n$  = ADC resolution = 12,  $R_S$  = external source resistance,  $C_{\text{pext}}$  = external parasitic capacitance.
- (5)  $6 \times 1 / f_{\text{ADC12CLK}}$

### 8.13.10.3 12-Bit ADC, Linearity Parameters

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER |                                                        | TEST CONDITIONS                                                                                                                                                              | MIN   | TYP         | MAX         | UNIT |
|-----------|--------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|-------------|-------------|------|
| $E_I$     | Integral linearity error (INL) for differential input  | With external voltage reference ( $\text{ADC12VRSEL} = 0x2, 0x3, 0x4, 0x14, 0x15$ ), $1.2 \text{ V} \leq (V_{R+} - V_{R-}) \leq AV_{CC}$                                     |       |             | $\pm 1.8$   | LSB  |
|           | Integral linearity error (INL) for single-ended inputs | With external voltage reference ( $\text{ADC12VRSEL} = 0x2, 0x3, 0x4, 0x14, 0x15$ ), $1.2 \text{ V} \leq (V_{R+} - V_{R-}) \leq AV_{CC}$                                     |       |             | $\pm 2.2$   |      |
| $E_D$     | Differential linearity error (DNL)                     | With external voltage reference ( $\text{ADC12VRSEL} = 0x2, 0x3, 0x4, 0x14, 0x15$ ),                                                                                         | -0.99 |             | +1.0        | LSB  |
| $E_O$     | Offset error <sup>(1) (2)</sup>                        | $\text{ADC12VRSEL} = 0x1$ without TLV calibration, TLV calibration data can be used to improve the parameter <sup>(3)</sup>                                                  |       | $\pm 0.5$   | $\pm 1.5$   | mV   |
| $E_G$     | Gain error                                             | With internal voltage reference $V_{\text{REF}} = 2.5 \text{ V}$ ( $\text{ADC12VRSEL} = 0x1, 0x7, 0x9, 0xB, \text{ or } 0xD$ )                                               |       | $\pm 0.2\%$ | $\pm 1.7\%$ |      |
|           |                                                        | With internal voltage reference $V_{\text{REF}} = 1.2 \text{ V}$ ( $\text{ADC12VRSEL} = 0x1, 0x7, 0x9, 0xB, \text{ or } 0xD$ )                                               |       | $\pm 0.2\%$ | $\pm 2.5\%$ |      |
|           |                                                        | With external voltage reference without internal buffer ( $\text{ADC12VRSEL} = 0x2 \text{ or } 0x4$ ) without TLV calibration, $V_{R+} = 2.5 \text{ V}$ , $V_{R-} = AV_{SS}$ |       | $\pm 1$     | $\pm 3$     | LSB  |
|           |                                                        | With external voltage reference with internal buffer ( $\text{ADC12VRSEL} = 0x3$ ), $V_{R+} = 2.5 \text{ V}$ , $V_{R-} = AV_{SS}$                                            |       | $\pm 2$     | $\pm 27$    |      |
| $E_T$     | Total unadjusted error                                 | With internal voltage reference $V_{\text{REF}} = 2.5 \text{ V}$ ( $\text{ADC12VRSEL} = 0x1, 0x7, 0x9, 0xB, \text{ or } 0xD$ )                                               |       | $\pm 0.2\%$ | $\pm 1.8\%$ |      |
|           |                                                        | With internal voltage reference $V_{\text{REF}} = 1.2 \text{ V}$ ( $\text{ADC12VRSEL} = 0x1, 0x7, 0x9, 0xB, \text{ or } 0xD$ )                                               |       | $\pm 0.2\%$ | $\pm 2.6\%$ |      |
|           |                                                        | With external voltage reference without internal buffer ( $\text{ADC12VRSEL} = 0x2 \text{ or } 0x4$ ) without TLV calibration, $V_{R+} = 2.5 \text{ V}$ , $V_{R-} = AV_{SS}$ |       | $\pm 1$     | $\pm 5$     | LSB  |
|           |                                                        | With external voltage reference with internal buffer ( $\text{ADC12VRSEL} = 0x3$ ), $V_{R+} = 2.5 \text{ V}$ , $V_{R-} = AV_{SS}$                                            |       | $\pm 1$     | $\pm 28$    |      |

- (1) Offset is measured as the input voltage (at which ADC output transitions from 0 to 1) minus 0.5 LSB.
- (2) Offset increases as  $I_R$  drop increases when  $V_{R-}$  is  $AV_{SS}$ .
- (3) For details, see the *Device Descriptor Table* section in the [MSP430FR58xx, MSP430FR59xx, and MSP430FR6xx Family User's Guide](#).

### 8.13.10.4 12-Bit ADC, Dynamic Performance With External Reference

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER  |                                                                  | TEST CONDITIONS                               | MIN | TYP  | MAX | UNIT |
|------------|------------------------------------------------------------------|-----------------------------------------------|-----|------|-----|------|
| Resolution | Number of no missing code output-code bits                       |                                               | 12  |      |     | bits |
| SNR        | Signal-to-noise with differential inputs                         | $V_{R+} = 2.5 \text{ V}$ , $V_{R-} = AV_{SS}$ |     | 71   |     | dB   |
|            | Signal-to-noise with single-ended inputs                         | $V_{R+} = 2.5 \text{ V}$ , $V_{R-} = AV_{SS}$ |     | 70   |     |      |
| ENOB       | Effective number of bits with differential inputs <sup>(1)</sup> | $V_{R+} = 2.5 \text{ V}$ , $V_{R-} = AV_{SS}$ |     | 11.4 |     | bits |
|            | Effective number of bits with single-ended inputs <sup>(1)</sup> | $V_{R+} = 2.5 \text{ V}$ , $V_{R-} = AV_{SS}$ |     | 11.1 |     |      |

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER |                                                                                     | TEST CONDITIONS                                                                                                                                     | MIN | TYP  | MAX | UNIT |
|-----------|-------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------|-----|------|-----|------|
|           | Effective number of bits with 32.768-kHz clock (reduced performance) <sup>(1)</sup> | Reduced performance with $f_{\text{ADC12CLK}}$ from ACLK LFXT 32.768 kHz, $V_{\text{R+}} = 2.5 \text{ V}$ , $V_{\text{R-}} = \text{AV}_{\text{SS}}$ |     | 10.9 |     |      |

(1)  $\text{ENOB} = (\text{SINAD} - 1.76) / 6.02$

### 8.13.10.5 12-Bit ADC, Dynamic Performance With Internal Reference

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER  |                                                                                     | TEST CONDITIONS                                                                                                                                     | MIN | TYP  | MAX | UNIT |
|------------|-------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------|-----|------|-----|------|
| Resolution | Number of no missing code output-code bits                                          |                                                                                                                                                     | 12  |      |     | bits |
| SNR        | Signal-to-noise with differential inputs                                            | $V_{\text{R+}} = 2.5 \text{ V}$ , $V_{\text{R-}} = \text{AV}_{\text{SS}}$                                                                           |     | 70   |     | dB   |
|            | Signal-to-noise with single-ended inputs                                            | $V_{\text{R+}} = 2.5 \text{ V}$ , $V_{\text{R-}} = \text{AV}_{\text{SS}}$                                                                           |     | 69   |     |      |
| ENOB       | Effective number of bits with differential inputs <sup>(1)</sup>                    | $V_{\text{R+}} = 2.5 \text{ V}$ , $V_{\text{R-}} = \text{AV}_{\text{SS}}$                                                                           |     | 11.4 |     | bits |
|            | Effective number of bits with single-ended inputs <sup>(1)</sup>                    | $V_{\text{R+}} = 2.5 \text{ V}$ , $V_{\text{R-}} = \text{AV}_{\text{SS}}$                                                                           |     | 11.0 |     |      |
|            | Effective number of bits with 32.768-kHz clock (reduced performance) <sup>(1)</sup> | Reduced performance with $f_{\text{ADC12CLK}}$ from ACLK LFXT 32.768 kHz, $V_{\text{R+}} = 2.5 \text{ V}$ , $V_{\text{R-}} = \text{AV}_{\text{SS}}$ |     | 10.9 |     |      |

(1)  $\text{ENOB} = (\text{SINAD} - 1.76) / 6.02$

### 8.13.10.6 12-Bit ADC, Temperature Sensor and Built-In $V_{1/2}$

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                   |                                                                                         | TEST CONDITIONS                                                              | MIN   | TYP | MAX   | UNIT                   |
|-----------------------------|-----------------------------------------------------------------------------------------|------------------------------------------------------------------------------|-------|-----|-------|------------------------|
| $V_{\text{SENSOR}}$         | Temperature sensor voltage <sup>(1) (2)</sup>                                           | ADC12ON = 1, ADC12TCMAP = 1, $T_{\text{A}} = 0^{\circ}\text{C}$              |       | 700 |       | mV                     |
| $\text{TC}_{\text{SENSOR}}$ | See <sup>(2)</sup>                                                                      | ADC12ON = 1, ADC12TCMAP = 1                                                  |       | 2.5 |       | mV/ $^{\circ}\text{C}$ |
| $t_{\text{SENSOR(sample)}}$ | Sample time required if ADC12TCMAP = 1 and channel (MAX – 1) is selected <sup>(3)</sup> | ADC12ON = 1, ADC12TCMAP = 1, Error of conversion result $\leq 1 \text{ LSB}$ | 30    |     |       | $\mu\text{s}$          |
| $V_{1/2}$                   | AVCC voltage divider for ADC12BATMAP = 1 on MAX input channel                           | ADC12ON = 1, ADC12BATMAP = 1                                                 | 47.5% | 50% | 52.5% |                        |
| $I_{V1/2}$                  | Current for battery monitor during sample time                                          | ADC12ON = 1, ADC12BATMAP = 1                                                 |       | 38  | 72    | $\mu\text{A}$          |
| $t_{V1/2(\text{sample})}$   | Sample time required if ADC12BATMAP = 1 and channel MAX is selected <sup>(4)</sup>      | ADC12ON = 1, ADC12BATMAP = 1                                                 | 1.7   |     |       | $\mu\text{s}$          |

- (1) The temperature sensor offset can be as much as  $\pm 30^{\circ}\text{C}$ . TI recommends a single-point calibration to minimize the offset error of the built-in temperature sensor.
- (2) The device descriptor structure contains calibration values for  $30^{\circ}\text{C} \pm 3^{\circ}\text{C}$  and  $85^{\circ}\text{C} \pm 3^{\circ}\text{C}$  for each of the available reference voltage levels. The sensor voltage can be computed as  $V_{\text{SENSE}} = \text{TC}_{\text{SENSOR}} \times (\text{Temperature}, ^{\circ}\text{C}) + V_{\text{SENSOR}}$ , where  $\text{TC}_{\text{SENSOR}}$  and  $V_{\text{SENSOR}}$  can be computed from the calibration values for higher accuracy.
- (3) The typical equivalent impedance of the sensor is 250 k $\Omega$ . The sample time required includes the sensor on-time,  $t_{\text{SENSOR(on)}}$ .
- (4) The on-time  $t_{V1/2(\text{on})}$  is included in the sampling time  $t_{V1/2(\text{sample})}$ ; no additional on time is needed.

### 8.13.10.7 12-Bit ADC, External Reference

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER                              |                                                                                                      | TEST CONDITIONS                                                                                                                                                                           | MIN | TYP | MAX                     | UNIT          |
|----------------------------------------|------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-------------------------|---------------|
| $V_{\text{R+}}$                        | Positive external reference voltage input $\text{VeREF+}$ or $\text{VeREF-}$ based on ADC12VRSEL bit | $V_{\text{R+}} > V_{\text{R-}}$                                                                                                                                                           | 1.2 |     | $\text{AV}_{\text{CC}}$ | V             |
| $V_{\text{R-}}$                        | Negative external reference voltage input $\text{VeREF+}$ or $\text{VeREF-}$ based on ADC12VRSEL bit | $V_{\text{R+}} > V_{\text{R-}}$                                                                                                                                                           | 0   |     | 1.2                     | V             |
| $V_{\text{R+}} - V_{\text{R-}}$        | Differential external reference voltage input                                                        | $V_{\text{R+}} > V_{\text{R-}}$                                                                                                                                                           | 1.2 |     | $\text{AV}_{\text{CC}}$ | V             |
| $I_{\text{VeREF+}}, I_{\text{VeREF-}}$ | Static input current singled-ended input mode                                                        | $1.2 \text{ V} \leq V_{\text{eREF+}} \leq V_{\text{AVCC}}$ , $V_{\text{eREF-}} = 0 \text{ V}$<br>$f_{\text{ADC12CLK}} = 5 \text{ MHz}$ , ADC12SHTx = 1h,<br>ADC12DIF = 0, ADC12PWRMD = 0  |     |     | $\pm 10$                | $\mu\text{A}$ |
|                                        |                                                                                                      | $1.2 \text{ V} \leq V_{\text{eREF+}} \leq V_{\text{AVCC}}$ , $V_{\text{eREF-}} = 0 \text{ V}$<br>$f_{\text{ADC12CLK}} = 5 \text{ MHz}$ , ADC12SHTx = 8h,<br>ADC12DIF = 0, ADC12PWRMD = 01 |     |     | $\pm 2.5$               |               |

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER                          | TEST CONDITIONS                                                                                                                                                                                                   | MIN | TYP | MAX      | UNIT          |
|------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|----------|---------------|
| $I_{V_{REF+}}$ ,<br>$I_{V_{REF-}}$ | Static input current differential input mode<br>$1.2\text{ V} \leq V_{eREF+} \leq V_{AVCC}$ , $V_{eREF-} = 0\text{ V}$<br>$f_{ADC12CLK} = 5\text{ MHz}$ , $ADC12SHTx = 1h$ ,<br>$ADC12DIF = 1$ , $ADC12PWRMD = 0$ |     |     | $\pm 20$ | $\mu\text{A}$ |
|                                    | $1.2\text{ V} \leq V_{eREF+} \leq V_{AVCC}$ , $V_{eREF-} = 0\text{ V}$<br>$f_{ADC12CLK} = 5\text{ MHz}$ , $ADC12SHTx = 8h$ ,<br>$ADC12DIF = 1$ , $ADC12PWRMD = 1$                                                 |     |     | $\pm 5$  |               |
| $I_{V_{REF+}}$                     | Peak input current with single-ended input<br>$0\text{ V} \leq V_{eREF+} \leq V_{AVCC}$ , $ADC12DIF = 0$                                                                                                          |     |     | 1.5      | $\text{mA}$   |
| $I_{V_{REF+}}$                     | Peak input current with differential input<br>$0\text{ V} \leq V_{eREF+} \leq V_{AVCC}$ , $ADC12DIF = 1$                                                                                                          |     |     | 3        | $\text{mA}$   |
| $C_{V_{REF+/-}}$                   | Capacitance at $V_{eREF+}$ or $V_{eREF-}$ terminal<br>See <sup>(2)</sup>                                                                                                                                          | 10  |     |          | $\mu\text{F}$ |

- (1) The external reference is used during ADC conversion to charge and discharge the capacitance array. The input capacitance ( $C_i$ ) is also the dynamic load for an external reference during conversion. The dynamic impedance of the reference supply should follow the recommendations on analog-source impedance to allow the charge to settle for 12-bit accuracy.
- (2) Connect two decoupling capacitors, 10  $\mu\text{F}$  and 470 nF, from  $V_{eREF+}$  or  $V_{eREF-}$  to  $AVSS$  to decouple the dynamic current required for an external reference source if it is used for the  $ADC12\_B$ . Also see the [MSP430FR58xx](#), [MSP430FR59xx](#), and [MSP430FR6xx Family User's Guide](#).

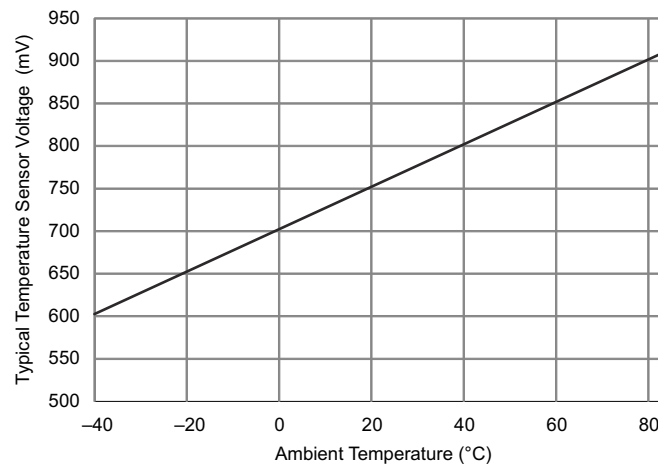


图 8-17. Typical Temperature Sensor Voltage



## 8.13.11 Reference

节 8.13.11.1 lists the characteristics of the internal reference.

### 8.13.11.1 REF, Built-In Reference

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                  | TEST CONDITIONS                                              | V <sub>CC</sub>                                                                                                                                        | MIN   | TYP   | MAX   | UNIT  |
|--------------------------------------------|--------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|-------|-------|-------|-------|
| V <sub>REF+</sub>                          | Positive built-in reference voltage output                   | REFVSEL = {2} for 2.5 V, REFON = 1                                                                                                                     | 2.7 V | 2.5   | ±1.5% | V     |
|                                            |                                                              | REFVSEL = {1} for 2.0 V, REFON = 1                                                                                                                     | 2.2 V | 2.0   | ±1.5% |       |
|                                            |                                                              | REFVSEL = {0} for 1.2 V, REFON = 1                                                                                                                     | 1.8 V | 1.2   | ±1.8% |       |
| Noise                                      | RMS noise at VREF <sup>(3)</sup>                             | From 0.1 Hz to 10 Hz, REFVSEL = {0}                                                                                                                    |       | 30    | 130   | μV    |
| V <sub>OS_BUF_INT</sub>                    | VREF ADC BUF_INT buffer offset <sup>(5)</sup>                | T <sub>A</sub> = 25°C, ADC on, REFVSEL = {0}, REFON = 1, REFOUT = 0                                                                                    |       | –16   | +16   | mV    |
| V <sub>OS_BUF_EXT</sub>                    | VREF ADC BUF_EXT buffer offset <sup>(4)</sup>                | T <sub>A</sub> = 25°C, REFVSEL = {0}, REFOUT = 1, REFON = 1 or ADC on                                                                                  |       | –16   | +16   | mV    |
| AV <sub>CC(min)</sub>                      | AVCC minimum voltage, Positive built-in reference active     | REFVSEL = {0} for 1.2 V                                                                                                                                |       | 1.8   |       | V     |
|                                            |                                                              | REFVSEL = {1} for 2.0 V                                                                                                                                |       | 2.2   |       |       |
|                                            |                                                              | REFVSEL = {2} for 2.5 V                                                                                                                                |       | 2.7   |       |       |
| I <sub>REF+</sub>                          | Operating supply current into AVCC terminal <sup>(1)</sup>   | REFON = 1                                                                                                                                              | 3 V   | 19    | 26    | μA    |
| I <sub>REF+_ADC_BUF</sub>                  | Operating supply current into AVCC terminal <sup>(1)</sup>   | ADC ON, REFOUT = 0, REFVSEL = {0, 1, or 2}, ADC12PWRMD = 0                                                                                             | 3 V   | 247   | 400   | μA    |
|                                            |                                                              | ADC ON, REFOUT = 1, REFVSEL = {0, 1, 2}, ADC12PWRMD = 0                                                                                                |       | 1053  | 1820  |       |
|                                            |                                                              | ADC ON, REFOUT = 0, REFVSEL = {0, 1, 2}, ADC12PWRMD = 1                                                                                                |       | 153   | 240   |       |
|                                            |                                                              | ADC ON, REFOUT = 1, REFVSEL = {0, 1, 2}, ADC12PWRMD = 1                                                                                                |       | 581   | 1030  |       |
|                                            |                                                              | ADC OFF, REFON = 1, REFOUT = 1, REFVSEL = {0, 1, 2}                                                                                                    |       | 1105  | 1890  |       |
| I <sub>O(VREF+)</sub>                      | VREF maximum load current, VREF+ terminal                    | REFVSEL = {0, 1, 2}, AV <sub>CC</sub> = AV <sub>CC(min)</sub> for each reference level, REFON = REFOUT = 1                                             |       | –1000 | +10   | μA    |
| ΔV <sub>out</sub> /ΔI <sub>O</sub> (VREF+) | Load-current regulation, VREF+ terminal                      | REFVSEL = {0, 1, 2}, I <sub>O(VREF+)</sub> = +10 μA or –1000 μA, AV <sub>CC</sub> = AV <sub>CC(min)</sub> for each reference level, REFON = REFOUT = 1 |       |       | 1500  | μV/mA |
| C <sub>VREF+/-</sub>                       | Capacitance at VREF+ and VREF- terminals                     | REFON = REFOUT = 1                                                                                                                                     |       | 0     | 100   | pF    |
| TC <sub>REF+</sub>                         | Temperature coefficient of built-in reference                | REFVSEL = {0, 1, 2}, REFON = REFOUT = 1, T <sub>A</sub> = –40°C to 85°C <sup>(6)</sup>                                                                 |       | 24    | 50    | ppm/K |
| PSRR_DC                                    | Power supply rejection ratio (DC)                            | AV <sub>CC</sub> = AV <sub>CC(min)</sub> to AV <sub>CC(max)</sub> , T <sub>A</sub> = 25°C, REFVSEL = {0, 1, 2}, REFON = REFOUT = 1                     |       | 100   | 400   | μV/V  |
| PSRR_AC                                    | Power supply rejection ratio (AC)                            | dAV <sub>CC</sub> = 0.1 V at 1 kHz                                                                                                                     |       | 3.0   |       | mV/V  |
| t <sub>SETTLE</sub>                        | Settling time of reference voltage <sup>(2)</sup>            | AV <sub>CC</sub> = AV <sub>CC(min)</sub> to AV <sub>CC(max)</sub> , REFVSEL = {0, 1, 2}, REFON = 0 → 1                                                 |       | 40    | 80    | μs    |
| T <sub>buf_settle</sub>                    | Settling time of ADC reference voltage buffer <sup>(2)</sup> | AV <sub>CC</sub> = AV <sub>CC(min)</sub> to AV <sub>CC(max)</sub> , REFVSEL = {0, 1, 2}, REFON = 1                                                     |       | 0.4   | 2     | us    |

- (1) The internal reference current is supplied through the AVCC terminal.
- (2) The condition is that the error in a conversion started after t<sub>REFON</sub> is less than ±0.5 LSB.
- (3) Internal reference noise affects ADC performance when ADC uses the internal reference. See [Designing With the MSP430FR59xx and MSP430FR58xx ADC](#) for details on optimizing ADC performance for your application with the choice of internal or external reference.
- (4) Buffer offset affects ADC gain error and thus total unadjusted error.
- (5) Buffer offset affects ADC gain error and thus total unadjusted error.
- (6) Calculated using the box method: (MAX(–40°C to 85°C) – MIN(–40°C to 85°C)) / MIN(–40°C to 85°C)/(85°C – (–40°C)).

### 8.13.12 Comparator

节 8.13.12.1 lists the characteristics of the comparator.

#### 8.13.12.1 Comparator\_E

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                  | TEST CONDITIONS                                                                   | V <sub>CC</sub>                                                     | MIN                                                              | TYP   | MAX                 | UNIT |
|----------------------------|-----------------------------------------------------------------------------------|---------------------------------------------------------------------|------------------------------------------------------------------|-------|---------------------|------|
| I <sub>AVCC_COMP</sub>     | Comparator operating supply current into AVCC, excludes reference resistor ladder | 2.2 V, 3.0 V                                                        | CEPWRMD = 00, CEON = 1, CERSx = 00 (fast)                        | 12    | 16                  | μA   |
|                            |                                                                                   |                                                                     | CEPWRMD = 01, CEON = 1, CERSx = 00 (medium)                      | 10    | 14                  |      |
|                            |                                                                                   |                                                                     | CEPWRMD = 10, CEON = 1, CERSx = 00 (slow), T <sub>A</sub> = 30°C | 0.1   | 0.3                 |      |
|                            |                                                                                   |                                                                     | CEPWRMD = 10, CEON = 1, CERSx = 00 (slow), T <sub>A</sub> = 85°C | 0.3   | 1.3                 |      |
| I <sub>AVCC_COMP_REF</sub> | Quiescent current of resistor ladder into AVCC, including REF module current      | 2.2 V, 3.0 V                                                        | CEREFLx = 01, CERSx = 10, REFON = 0, CEON = 1, CEREFACC = 0      | 31    | 38                  | μA   |
|                            |                                                                                   |                                                                     | CEREFLx = 01, CERSx = 10, REFON = 0, CEON = 1, CEREFACC = 1      | 16    | 19                  |      |
| V <sub>REF</sub>           | Reference voltage level                                                           | 1.8 V                                                               | CERSx = 11, CEREFLx = 01, CEREFACC = 0                           | 1.152 | 1.2                 | V    |
|                            |                                                                                   | 2.2 V                                                               | CERSx = 11, CEREFLx = 10, CEREFACC = 0                           | 1.92  | 2.0                 |      |
|                            |                                                                                   | 2.7 V                                                               | CERSx = 11, CEREFLx = 11, CEREFACC = 0                           | 2.40  | 2.5                 |      |
|                            |                                                                                   | 1.8 V                                                               | CERSx = 11, CEREFLx = 01, CEREFACC = 1                           | 1.10  | 1.2                 |      |
|                            |                                                                                   | 2.2 V                                                               | CERSx = 11, CEREFLx = 10, CEREFACC = 1                           | 1.90  | 2.0                 |      |
|                            |                                                                                   | 2.7 V                                                               | CERSx = 11, CEREFLx = 11, CEREFACC = 1                           | 2.35  | 2.5                 |      |
| V <sub>IC</sub>            | Common-mode input range                                                           |                                                                     |                                                                  | 0     | V <sub>CC</sub> – 1 | V    |
| V <sub>OFFSET</sub>        | Input offset voltage                                                              | CEPWRMD = 00                                                        |                                                                  | –16   | 16                  | mV   |
|                            |                                                                                   | CEPWRMD = 01                                                        |                                                                  | –12   | 12                  |      |
|                            |                                                                                   | CEPWRMD = 10                                                        |                                                                  | –37   | 37                  |      |
| C <sub>IN</sub>            | Input capacitance                                                                 | CEPWRMD = 00 or CEPWRMD = 01                                        |                                                                  | 10    |                     | pF   |
|                            |                                                                                   | CEPWRMD = 10                                                        |                                                                  | 10    |                     |      |
| R <sub>SIN</sub>           | Series input resistance                                                           | ON (switch closed)                                                  |                                                                  | 1     | 3                   | kΩ   |
|                            |                                                                                   | OFF (switch open)                                                   |                                                                  | 50    |                     | MΩ   |
| t <sub>PD</sub>            | Propagation delay, response time                                                  | CEPWRMD = 00, CEF = 0, Overdrive ≥ 20 mV                            |                                                                  | 193   | 330                 | ns   |
|                            |                                                                                   | CEPWRMD = 01, CEF = 0, Overdrive ≥ 20 mV                            |                                                                  | 230   | 400                 |      |
|                            |                                                                                   | CEPWRMD = 10, CEF = 0, Overdrive ≥ 20 mV                            |                                                                  | 5     | 15                  | μs   |
| t <sub>PD,filter</sub>     | Propagation delay with filter active                                              | CEPWRMD = 00 or 01, CEF = 1, Overdrive ≥ 20 mV, CEFDLy = 00         |                                                                  | 700   | 1000                | ns   |
|                            |                                                                                   | CEPWRMD = 00 or 01, CEF = 1, Overdrive ≥ 20 mV, CEFDLy = 01         |                                                                  | 1.0   | 1.9                 | μs   |
|                            |                                                                                   | CEPWRMD = 00 or 01, CEF = 1, Overdrive ≥ 20 mV, CEFDLy = 10         |                                                                  | 2.0   | 3.7                 |      |
|                            |                                                                                   | CEPWRMD = 00 or 01, CEF = 1, Overdrive ≥ 20 mV, CEFDLy = 11         |                                                                  | 4.0   | 7.7                 |      |
| t <sub>EN_CMP</sub>        | Comparator enable time                                                            | CEON = 0 → 1, VIN+, VIN- from pins, Overdrive ≥ 20 mV, CEPWRMD = 00 |                                                                  | 0.9   | 1.5                 | μs   |
|                            |                                                                                   | CEON = 0 → 1, VIN+, VIN- from pins, Overdrive ≥ 20 mV, CEPWRMD = 01 |                                                                  | 0.9   | 1.5                 |      |

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                |                                                                   | TEST CONDITIONS                                                                | V <sub>CC</sub> | MIN                  | TYP                | MAX                  | UNIT |
|--------------------------|-------------------------------------------------------------------|--------------------------------------------------------------------------------|-----------------|----------------------|--------------------|----------------------|------|
|                          |                                                                   | CEON = 0 → 1,<br>VIN+, VIN- from pins,<br>Overdrive ≥ 20 mV, CEPWRMD = 10      |                 |                      | 15                 | 65                   |      |
| t <sub>EN_CMP_VREF</sub> | Comparator and reference ladder and reference voltage enable time | CEON = 0 → 1, CEREF0 = 10, CERSx = 10 or 11, CEREF0 = CEREF1 = 0x0F, REFON = 0 |                 |                      | 120                | 220                  | μs   |
| t <sub>EN_CMP_RL</sub>   | Comparator and reference ladder enable time                       | CEON = 0 → 1, CEREF0 = 10, CERSx = 10, REFON = 1, CEREF0 = CEREF1 = 0x0F       |                 |                      | 10                 | 30                   |      |
| V <sub>CE_REF</sub>      | Reference voltage for a given tap                                 | VIN = reference into resistor ladder, n = 0 to 31                              |                 | VIN × (n + 0.5) / 32 | VIN × (n + 1) / 32 | VIN × (n + 1.5) / 32 | V    |

### 8.13.13 FRAM

节 8.13.13.1 lists the characteristics of the FRAM.

#### 8.13.13.1 FRAM

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER              |                                           | T <sub>J</sub> | MIN              | TYP                     | MAX | UNIT   |
|------------------------|-------------------------------------------|----------------|------------------|-------------------------|-----|--------|
|                        | Read and write endurance                  |                | 10 <sup>15</sup> |                         |     | cycles |
| t <sub>Retention</sub> | Data retention duration                   | 25°C           | 100              |                         |     | years  |
|                        |                                           | 70°C           | 40               |                         |     |        |
|                        |                                           | 85°C           | 10               |                         |     |        |
| I <sub>WRITE</sub>     | Current to write into FRAM <sup>(1)</sup> |                |                  | I <sub>READ</sub>       |     | nA     |
| I <sub>ERASE</sub>     | Erase current <sup>(2)</sup>              |                |                  | N/A <sup>(3)</sup>      |     | nA     |
| t <sub>WRITE</sub>     | Write time <sup>(4)</sup>                 |                |                  | t <sub>READ</sub>       |     | ns     |
| t <sub>READ</sub>      | Read time <sup>(5)</sup>                  | NWAITSx = 0    |                  | 1 / f <sub>SYSTEM</sub> |     | ns     |
|                        |                                           | NWAITSx = 1    |                  | 2 / f <sub>SYSTEM</sub> |     |        |

- (1) Writing to FRAM does not require a setup sequence or additional power when compared to reading from FRAM. The FRAM read current I<sub>READ</sub> is included in the active mode current consumption, I<sub>AM,FRAM</sub>.
- (2) FRAM does not require a special erase sequence.
- (3) N/A = Not applicable
- (4) Writing into FRAM is as fast as reading.
- (5) The maximum read (and write) speed is specified by f<sub>SYSTEM</sub> using the appropriate wait state settings (NWAITSx).

### 8.13.14 USS

#### 8.13.14.1

节 8.13.14.2 lists the USS recommended operating conditions.

#### 8.13.14.2 USS Recommended Operating Conditions

| PARAMETER        |                                                      | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------|------------------------------------------------------|-----------------|-----|-----|-----|------|
| PV <sub>CC</sub> | Analog supply voltage at PVCC pins for LDO operation |                 | 2.2 |     | 3.6 | V    |
| PV <sub>CC</sub> | Analog supply voltage at PVCC pins for USS operation |                 | 2.2 |     | 3.6 | V    |

#### 8.13.14.3

节 8.13.14.4 lists the characteristics of the USS LDO.

#### 8.13.14.4 USS LDO

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER             |                                          | TEST CONDITIONS                     | MIN  | TYP                        | MAX  | UNIT |
|-----------------------|------------------------------------------|-------------------------------------|------|----------------------------|------|------|
| V <sub>CC-LDO</sub>   | Analog supply voltage at PVCC pins       |                                     | 2.2  |                            | 3.6  | V    |
| V <sub>USS</sub>      | USS voltage                              | $0 \leq I_{LOAD} \leq I_{LOAD,MAX}$ | 1.52 | 1.6                        | 1.65 | V    |
| t <sub>holdoff</sub>  | Hold off delay on power up               | LBHDEL = 0                          |      | 0                          |      | μs   |
|                       |                                          | LBHDEL = 1                          |      | 100                        |      |      |
|                       |                                          | LBHDEL = 2                          |      | 200                        |      |      |
|                       |                                          | LBHDEL = 3                          |      | 300                        |      |      |
| t <sub>time-out</sub> | Time-out on transition from OFF to READY |                                     |      | 160 + t <sub>holdoff</sub> |      | μs   |

#### 8.13.14.5

节 8.13.14.6 lists the characteristics of the USS crystal.

#### 8.13.14.6 USSXTAL

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER              |                        | TEST CONDITIONS                                                                                                                             | MIN | TYP  | MAX  | UNIT |
|------------------------|------------------------|---------------------------------------------------------------------------------------------------------------------------------------------|-----|------|------|------|
| N <sub>phase_osc</sub> | Integrated phase noise | f <sub>osc</sub> = 4 MHz or 8 MHz, range = 10 kHz to 4 MHz                                                                                  |     | -74  |      | dBc  |
| FRQ <sub>XTAL</sub>    | Resonator frequency    |                                                                                                                                             | 4   |      | 8    | MHz  |
| DC <sub>osc</sub>      | Duty cycle             |                                                                                                                                             | 35% |      | 65%  |      |
| I <sub>osc</sub>       | OSC supply current     | f <sub>osc</sub> = 4 MHz or 8 MHz, C <sub>L</sub> = 18 pF, C <sub>S</sub> = 4 pF, fully settled, ceramic resonator                          |     | 180  |      | μA   |
|                        |                        | f <sub>osc</sub> = 4 MHz or 8 MHz, C <sub>L</sub> = 12 pF (4 MHz) or 16 pF (8 MHz), C <sub>S</sub> = 7 pF, fully settled, crystal resonator |     | 240  |      |      |
| A <sub>osc</sub>       | Oscillation allowance  | f <sub>osc</sub> = 4 MHz, C <sub>L</sub> = 18 pF, C <sub>S</sub> = 4 pF, ceramic resonator                                                  |     | 1500 |      | Ω    |
|                        |                        | f <sub>osc</sub> = 4 MHz, C <sub>L</sub> = 12 pF, C <sub>S</sub> = 7 pF, crystal resonator                                                  |     | 1000 |      |      |
|                        |                        | f <sub>osc</sub> = 8 MHz, C <sub>L</sub> = 18 pF, C <sub>S</sub> = 4 pF, ceramic resonator                                                  |     | 500  |      |      |
|                        |                        | f <sub>osc</sub> = 8 MHz, C <sub>L</sub> = 16 pF, C <sub>S</sub> = 7 pF, crystal resonator                                                  |     | 350  |      |      |
| T <sub>start_osc</sub> | Start-up time (gate)   | f <sub>osc</sub> = 4 MHz, crystal resonator                                                                                                 |     | 2.8  | 4.6  | ms   |
|                        |                        | f <sub>osc</sub> = 8 MHz, crystal resonator                                                                                                 |     | 1    | 1.9  |      |
|                        |                        | f <sub>osc</sub> = 4 MHz, ceramic resonator                                                                                                 |     | 0.14 | 0.17 |      |
|                        |                        | f <sub>osc</sub> = 8 MHz, ceramic resonator                                                                                                 |     | 0.08 | 0.12 |      |

#### 8.13.14.7

节 8.13.14.8 lists the characteristics of the USS HSPLL.

### 8.13.14.8 USS HSPLL

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER              |                             | TEST CONDITIONS                                                                                                                                                                                             | MIN | TYP | MAX | UNIT   |
|------------------------|-----------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|--------|
| PLL_CLK <sub>in</sub>  | Input clock to HSPLL        |                                                                                                                                                                                                             | 4   |     | 8   | MHz    |
| PLL_CLK <sub>out</sub> | Output clock from HSPLL     |                                                                                                                                                                                                             | 68  |     | 80  | MHz    |
| LOCK <sub>pwr</sub>    | Lock time from PLL power up | Reference clock = PLL_CLK <sub>in</sub> ,<br>Sequence: Set USS.CTL.USSPWRUP bit = 1, then<br>measure the time between PSQ_PLLUP (internal control<br>signal) is set to 1 and HSPLL.CTL.PLL_LOCK is set to 1 |     |     | 64  | cycles |

### 8.13.14.9

节 8.13.14.10 lists the characteristics of the USS SDHS.

### 8.13.14.10 USS SDHS

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                 |                                             | TEST CONDITIONS                                                                                                                                                                                | MIN  | TYP | MAX  | UNIT |
|---------------------------|---------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|-----|------|------|
| V <sub>sdhs</sub>         | SDHS power domain supply voltage            | V <sub>sdhs</sub> = V <sub>uss</sub>                                                                                                                                                           | 1.52 | 1.6 | 1.65 | V    |
| I <sub>sdhs_product</sub> | Operating supply current into AVCC and DVCC | Includes PLL, PGA, SDHS, and DTC, modulator clock = 80 MHz, output data rate = 8 Msps                                                                                                          |      | 5.2 |      | mA   |
| f <sub>mod</sub>          | Modulator clock                             |                                                                                                                                                                                                | 68   |     | 80   | MHz  |
| BW <sub>mod</sub>         | Frequency at –3-dB SNR                      | Modulator clock = 80 MHz, modulator only (no filter is enabled)                                                                                                                                |      | 1.5 |      | MHz  |
| SNR                       | Signal-to-noise ratio                       | Bandwidth from 200 kHz to 1.5 MHz, PGA gain: a gain from the PGA gain table for the maximum SNR<br>100mVpp ≤ Input signal level ≤ 1000 mVpp, PVCC = 3.0 V, f <sub>mod</sub> = 80 MHz, OSR = 20 |      | 45  |      | dB   |
| t <sub>MOD_Settle</sub>   | SDHS settling time (PGA + modulator)        | TM2 – TM1, AUTOSSDIS = 0, 1% of settled DC level                                                                                                                                               |      |     | 40   | μs   |
|                           |                                             | TM2 – TM1, AUTOSSDIS = 1, 1% of settled DC level                                                                                                                                               |      |     | 40   |      |
| DROUT <sub>sdhs</sub>     | Output data rate                            |                                                                                                                                                                                                |      |     | 8    | Msps |

### 8.13.14.11

节 8.13.14.12 lists the characteristics of the USS PHY outputs.

### 8.13.14.12 USS PHY Output Stage

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER          |                                                              | TEST CONDITIONS                                 | MIN | TYP | MAX | UNIT |
|--------------------|--------------------------------------------------------------|-------------------------------------------------|-----|-----|-----|------|
| PVCC               | PHY supply voltage                                           | PVCC = V <sub>CC</sub> , PVSS = V <sub>SS</sub> | 2.2 |     | 3.6 | V    |
| R <sub>DSonT</sub> | Output impedance of CH0OUT and CH1OUT for high and low sides | PVCC ≥ 2.5 V                                    |     | 3.4 |     | Ω    |
| R <sub>Term</sub>  | Termination impedance of CH0OUT and CH1OUT toward PVSS       | PVCC ≥ 2.5 V                                    |     | 3.4 |     | Ω    |
| f <sub>MAX</sub>   | Maximum output frequency                                     | PVCC = V <sub>CC</sub> (2.5 V to 3.6 V)         | 4.5 |     |     | MHz  |
| C <sub>SUPP</sub>  | Supply buffering capacitance (low ESR type)                  | PVCC = V <sub>CC</sub>                          | 22  | 100 |     | μF   |
| R <sub>SUPP</sub>  | Series resistance to C <sub>SUPP</sub>                       | PVCC = V <sub>CC</sub>                          |     | 22  |     | Ω    |

### 8.13.14.13

节 8.13.14.14 lists the characteristics of the USS PHY inputs.

### 8.13.14.14 USS PHY Input Stage, Multiplexer

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER       |                                 | TEST CONDITIONS                                 | MIN        | TYP | MAX | UNIT |
|-----------------|---------------------------------|-------------------------------------------------|------------|-----|-----|------|
| V <sub>IN</sub> | Input voltage on CH0IN or CH1IN | PVCC = V <sub>CC</sub> , PVSS = V <sub>SS</sub> | PVSS – 0.3 |     | 1.8 | V    |

### 8.13.14.15

节 8.13.14.16 lists the characteristics of the USS PGA.

### 8.13.14.16 USS PGA

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER            |                                                 | TEST CONDITIONS                                                                                                                                                          | MIN              | TYP    | MAX  | UNIT  |
|----------------------|-------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|--------|------|-------|
| PV <sub>CC</sub>     | Supply voltage                                  |                                                                                                                                                                          | 2.2              |        | 3.6  | V     |
| G <sub>N</sub>       | Gain <sup>(1)</sup>                             |                                                                                                                                                                          | –6.5             |        | 30.8 | dB    |
| V <sub>inr1</sub>    | Input range                                     | 2.2 V ≤ PVCC                                                                                                                                                             | 30               |        | 800  | mVpp  |
| V <sub>inr2</sub>    | Input range                                     | 2.5 V ≤ PVCC                                                                                                                                                             | 30               |        | 1000 | mVpp  |
| V <sub>inrperf</sub> | Recommended input range for maximum performance | 2.5 V ≤ PVCC                                                                                                                                                             | 30               |        | 800  | mVpp  |
| G <sub>tol</sub>     | Gain tolerance                                  | Full PGA gain range, V <sub>OUT</sub> = 600 mV                                                                                                                           | –1.5             |        | 1.5  | dB    |
| G <sub>Tdrift</sub>  | Gain drift with temperature                     | Full PGA gain range, V <sub>OUT</sub> = 600 mV                                                                                                                           |                  | 0.0019 |      | dB/°C |
| G <sub>Vdrift</sub>  | Gain drift with voltage                         | Full PGA gain range, V <sub>OUT</sub> = 600 mV                                                                                                                           |                  | 0.15   |      | dB/V  |
| t <sub>SET</sub>     | Gain settling time                              | Gain setting: from 0 dB to 6 dB, to ±5%                                                                                                                                  |                  | 0.65   | 1.4  | μs    |
| DC <sub>offset</sub> | DC offset (PGA and SDHS)                        | Full PGA gain range, measured at SDHS output                                                                                                                             |                  | 5.5    |      | mV    |
| DC <sub>drift</sub>  | DC offset drift (PGA and SDHS)                  | Full PGA gain range, measured at SDHS output                                                                                                                             |                  | 4.7    |      | μV/°C |
| PSRR <sub>AC</sub>   | AC power supply rejection ratio                 | V <sub>CC</sub> = 3 V + 50 mVpp × sin(2π × f <sub>C</sub> ) where f <sub>C</sub> = 1 MHz, V <sub>IN</sub> = ground, PSRR <sub>AC</sub> = 20log(V <sub>OUT</sub> / 50 mV) | PGA gain = 0 dB  |        | –41  | dB    |
|                      |                                                 |                                                                                                                                                                          | PGA gain = 10 dB |        | –37  |       |
|                      |                                                 |                                                                                                                                                                          | PGA gain = 30 dB |        | –19  |       |

(1) See the PGA Gain table in the [MSP430FR58xx, MSP430FR59xx, and MSP430FR6xx Family User's Guide](#).

### 8.13.14.17

节 8.13.14.18 lists the characteristics of the USS bias voltage generator.

### 8.13.14.18 USS Bias Voltage Generator

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER       |                                               | TEST CONDITIONS                                                                                                       |             | MIN | TYP  | MAX | UNIT          |
|-----------------|-----------------------------------------------|-----------------------------------------------------------------------------------------------------------------------|-------------|-----|------|-----|---------------|
| $V_{exc\_bias}$ | Excitation bias voltage (coupling capacitors) | PVCC = $V_{CC}$ (2.2 V to 3.6 V)                                                                                      | EXCBias = 0 |     | 200  |     | mV            |
|                 |                                               |                                                                                                                       | EXCBias = 1 |     | 300  |     |               |
|                 |                                               |                                                                                                                       | EXCBias = 2 |     | 400  |     |               |
|                 |                                               |                                                                                                                       | EXCBias = 3 |     | 600  |     |               |
| $R_{VBE}$       | Impedance of excitation bias generator        | PVCC = $V_{CC}$ (2.2 V to 3.6 V)                                                                                      | BIMP = 0    |     | 450  |     | $\Omega$      |
|                 |                                               |                                                                                                                       | BIMP = 1    |     | 850  |     |               |
|                 |                                               |                                                                                                                       | BIMP = 2    |     | 1450 |     |               |
|                 |                                               |                                                                                                                       | BIMP = 3    |     | 2900 |     |               |
| $t_{SBE}$       | Excitation bias settling time                 | PVCC = $V_{CC}$ (2.2 V to 3.6 V), to 0.1% end value, $R_{ET} = 200 \Omega$ , $C_K + C_{OP} = 1 \text{ nF}$ , BIMP = 2 |             |     | 20   |     | $\mu\text{s}$ |
| $V_{pga\_bias}$ | PGA bias voltage (coupling capacitors)        | PVCC = $V_{CC}$ (2.2 V to 3.6 V)                                                                                      | PGABias = 0 |     | 750  |     | mV            |
|                 |                                               |                                                                                                                       | PGABias = 1 |     | 800  |     |               |
|                 |                                               |                                                                                                                       | PGABias = 2 |     | 900  |     |               |
|                 |                                               |                                                                                                                       | PGABias = 3 |     | 950  |     |               |
| $R_{VBA}$       | Impedance of acquisition bias generator       | PVCC = $V_{CC}$ (2.2 V to 3.6 V)                                                                                      | BIMP = 0    |     | 500  |     | $\Omega$      |
|                 |                                               |                                                                                                                       | BIMP = 1    |     | 900  |     |               |
|                 |                                               |                                                                                                                       | BIMP = 2    |     | 1500 |     |               |
|                 |                                               |                                                                                                                       | BIMP = 3    |     | 2950 |     |               |
| $t_{SBA}$       | Acquisition bias settling time                | PVCC = $V_{CC}$ (2.2 V to 3.6 V), to 0.1% end value, $R_{ET} = 200 \Omega$ , $C_K + C_{OP} = 1 \text{ nF}$ , BIMP = 2 |             |     | 22   |     | $\mu\text{s}$ |

### 8.13.15 Emulation and Debug

节 8.13.15.1 lists the characteristics of the JTAG and SBW interface.

#### 8.13.15.1 JTAG and Spy-Bi-Wire Interface

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                |                                                                                                                  | $V_{CC}$     | MIN  | TYP | MAX | UNIT          |
|--------------------------|------------------------------------------------------------------------------------------------------------------|--------------|------|-----|-----|---------------|
| $I_{JTAG}$               | Supply current adder when JTAG active (but not clocked)                                                          | 2.2 V, 3.0 V |      | 40  | 100 | $\mu\text{A}$ |
| $f_{SBW}$                | Spy-Bi-Wire input frequency                                                                                      | 2.2 V, 3.0 V | 0    |     | 10  | MHz           |
| $t_{SBW,Low}$            | Spy-Bi-Wire low clock pulse duration                                                                             | 2.2 V, 3.0 V | 0.04 |     | 15  | $\mu\text{s}$ |
| $t_{SBW,En}$             | Spy-Bi-Wire enable time (TEST high to acceptance of first clock edge) <sup>(1)</sup>                             | 2.2 V, 3.0 V |      |     | 110 | $\mu\text{s}$ |
| $t_{SBW,Rst}$            | Spy-Bi-Wire return to normal operation time                                                                      |              | 15   |     | 100 | $\mu\text{s}$ |
| $f_{TCK}$                | TCK input frequency, 4-wire JTAG <sup>(2)</sup>                                                                  | 2.2 V        | 0    |     | 16  | MHz           |
|                          |                                                                                                                  | 3.0 V        | 0    |     | 16  |               |
| $R_{Internal}$           | Internal pulldown resistance on TEST                                                                             | 2.2 V, 3.0 V | 20   | 35  | 50  | k $\Omega$    |
| $f_{TCLK}$               | TCLK/MCLK frequency during JTAG access, no FRAM access (limited by $f_{SYSTEM}$ )                                |              |      |     | 16  | MHz           |
| $t_{TCLK,Low/High}$      | TCLK low or high clock pulse duration, no FRAM access                                                            |              |      |     | 25  | ns            |
| $f_{TCLK,FRAM}$          | TCLK/MCLK frequency during JTAG access, including FRAM access (limited by $f_{SYSTEM}$ with no FRAM wait states) |              |      |     | 4   | MHz           |
| $t_{TCLK,FRAM,Low/High}$ | TCLK low or high clock pulse duration, including FRAM accesses                                                   |              |      |     | 100 | ns            |

- (1) Tools that access the Spy-Bi-Wire and the BSL interfaces must wait for the  $t_{SBW,En}$  time after the first transition of the TEST/SBWTCK pin (low to high), before the second transition of the pin (high to low) during the entry sequence.
- (2)  $f_{TCK}$  may be restricted to meet the timing requirements of the module selected.

## 9 Detailed Description

### 9.1 Overview

The TI MSP430FR60xx family of ultra-low-power microcontrollers consists of several devices featuring different sets of peripherals. The architecture, combined with seven low-power modes, is optimized to achieve extended battery life for example in portable measurement applications. The devices features a powerful 16-bit RISC CPU, 16-bit registers, and constant generators that contribute to maximum code efficiency.

The device is an MSP430FR6xx family device with ultrasonic sensing solution (USS), low-energy accelerator (LEA), up to six 16-bit timers, up to six eUSCIs that support UART, SPI, and I<sup>2</sup>C, a comparator, a hardware multiplier, an AES accelerator, a 6-channel DMA, an RTC module with alarm capabilities, up to 76 I/O pins, and a high-performance 12-bit ADC. The MSP430FR60xx devices also include an LCD module with contrast control for displays with up to 264 segments.

### 9.2 CPU

The MSP430 CPU has a 16-bit RISC architecture that is highly transparent to the application. All operations, other than program-flow instructions, are performed as register operations in conjunction with seven addressing modes for source operand and four addressing modes for destination operand.

The CPU is integrated with 16 registers that provide reduced instruction execution time. The register-to-register operation execution time is one cycle of the CPU clock.

Four of the registers, R0 to R3, are dedicated as program counter, stack pointer, status register, and constant generator, respectively. The remaining registers are general-purpose registers.

Peripherals are connected to the CPU using data, address, and control buses. The peripherals can be managed with all instructions.

The instruction set consists of the original 51 instructions with three formats and seven address modes and additional instructions for the expanded address range. Each instruction can operate on word and byte data.

### 9.3 Ultrasonic Sensing Solution (USS) Module

The USS module provides a high-precision ultrasonic sensing solution. The USS module is a sophisticated system that consists of six submodules:

- UUPS (universal USS power supply)
- HSPLL (high-speed PLL) with oscillator
- ASQ (acquisition sequencer)
- PHY (physical interface)
- PPG (programmable pulse generator) with low-output-impedance driver
- PGA (programmable gain amplifier)
- SDHS (sigma-delta high-speed ADC) with DTC (data transfer controller)

The submodules have different roles, and together they enable high-precision data acquisition in ultrasonic applications. See the dedicated chapter for each submodule in the [MSP430FR58xx, MSP430FR59xx, and MSP430FR6xx Family User's Guide](#).

The USS module performs complete measurement sequence without CPU involvement to achieve ultra-low power consumption for ultrasonic metrology. [图 9-1](#) shows the USS subsystem block diagram. The USS module has dedicated I/O pins without secondary functions. See the *Ultrasonic Sensing Solution (USS)* chapter in the [MSP430FR58xx, MSP430FR59xx, and MSP430FR6xx Family User's Guide](#) for details.



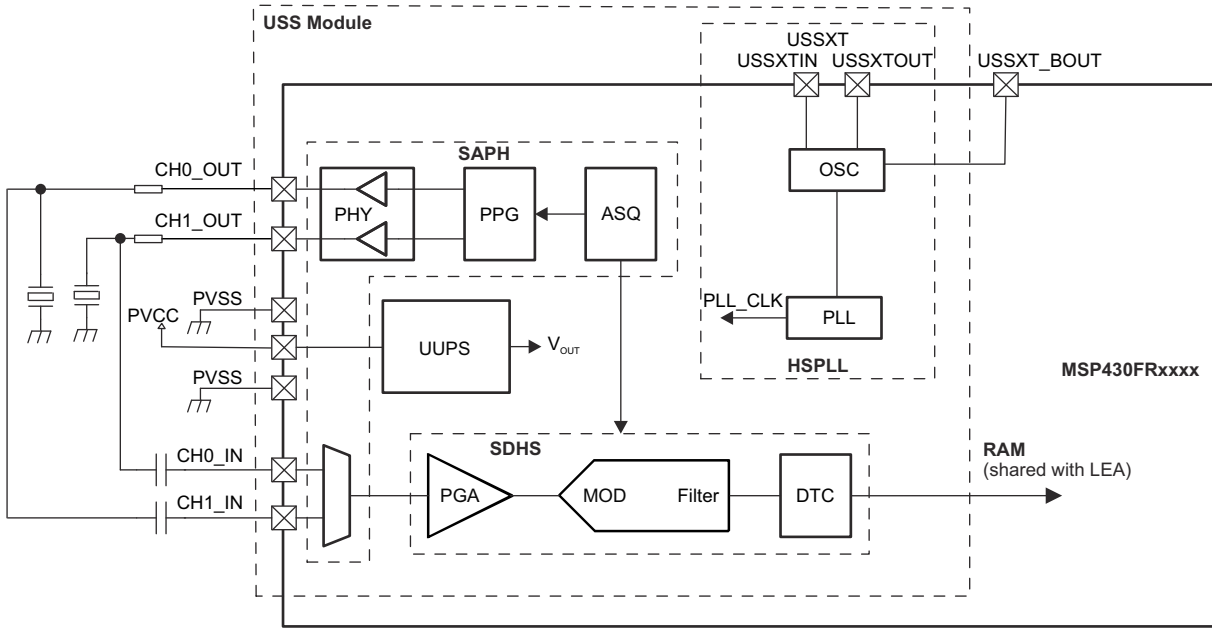


图 9-1. USS Subsystem Block Diagram

## 9.4 Low-Energy Accelerator (LEA) for Signal Processing

The LEA is a hardware engine designed for operations that involve vector-based signal processing, such as FIR, IIR, and FFT. The LEA offers fast performance and low energy consumption when performing vector-based digital signal processing computations. For performance benchmarks comparing LEA to using the CPU or other processors, see [Benchmarking the Signal Processing Capabilities of the Low-Energy Accelerator](#).

The LEA requires MCLK to be operational; therefore, LEA operates only in active mode or LPM0. While the LEA is running, the LEA data operations are performed on a shared 4KB of RAM out of the 8KB of total RAM (see [表 9-45](#)). This shared RAM can also be used by the regular application. The MSP CPU and the LEA can run simultaneously and independently unless they access the same system RAM.

Direct access to LEA registers is not supported, and TI offers the optimized [Digital Signal Processing \(DSP\) Library for MSP Microcontrollers](#) for the operations that the LEA module supports.

## 9.5 Operating Modes

The MCU has one active mode and seven software-selectable low-power modes of operation. An interrupt event can wake up the device from low-power modes LPM0 to LPM4, service the request, and return to the low-power mode on return from the interrupt program. Low-power modes LPM3.5 and LPM4.5 disable the core supply to minimize power consumption. 表 9-1 lists the operating modes and the clocks and peripherals that are available in each.

**Table 9-1. Operating Modes**

| MODE                                               | AM                      |                                 | LPM0                                | LPM1                    | LPM2                     | LPM3                     | LPM4                     | LPM3.5                  | LPM4.5            |                      |
|----------------------------------------------------|-------------------------|---------------------------------|-------------------------------------|-------------------------|--------------------------|--------------------------|--------------------------|-------------------------|-------------------|----------------------|
|                                                    | ACTIVE                  | ACTIVE, FRAM OFF <sup>(1)</sup> | CPU OFF <sup>(2)</sup>              | CPU OFF                 | STANDBY                  | STANDBY                  | OFF                      | RTC ONLY                | SHUTDOWN WITH SVS | SHUTDOWN WITHOUT SVS |
| Maximum system clock                               | 16 MHz                  |                                 | 16 MHz                              | 16 MHz                  | 50 kHz                   | 50 kHz                   | 0 <sup>(3)</sup>         | 50 kHz                  | 0 <sup>(3)</sup>  |                      |
| Typical current consumption, T <sub>A</sub> = 25°C | 103 µA/MHz              | 65 µA/MHz                       | 70 µA at 1 MHz                      | 35 µA at 1 MHz          | 0.7 µA                   | 0.4 µA                   | 0.3 µA                   | 0.25 µA                 | 0.2 µA            | 0.02 µA              |
| Typical wake-up time                               | N/A                     |                                 | instant                             | 6 µs                    | 6 µs                     | 7 µs                     | 7 µs                     | 250 µs                  | 250 µs            | 1000 µs              |
| Wake-up events                                     | N/A                     |                                 | all                                 | all                     | LF<br>RTC<br>I/O<br>Comp | LF<br>RTC<br>I/O<br>Comp | I/O<br>Comp              | RTC<br>I/O              | I/O               |                      |
| CPU                                                | on                      |                                 | off                                 | off                     | off                      | off                      | off                      | reset                   | reset             |                      |
| USS                                                | on                      |                                 | on                                  | off                     | off                      | off                      | off                      | reset                   | reset             |                      |
| LEA                                                | on                      |                                 | on <sup>(10)</sup>   off            | off                     | off                      | off                      | off                      | reset                   | reset             |                      |
| FRAM                                               | on                      | off <sup>(1)</sup>              | standby<br>(or off <sup>(1)</sup> ) | off                     | off                      | off                      | off                      | off                     | off               |                      |
| High-frequency peripherals                         | available               |                                 | available                           | available               | off                      | off                      | off                      | reset                   | reset             |                      |
| Low-frequency peripherals                          | available               |                                 | available                           | available               | available                | available <sup>(4)</sup> | off                      | RTC                     | reset             |                      |
| Unclocked peripherals <sup>(5)</sup>               | available               |                                 | available                           | available               | available                | available <sup>(4)</sup> | available <sup>(4)</sup> | reset                   | reset             |                      |
| MCLK                                               | on                      |                                 | on <sup>(10)</sup>   off            | off                     | off                      | off                      | off                      | off                     | off               |                      |
| SMCLK                                              | optional <sup>(6)</sup> |                                 | optional <sup>(6)</sup>             | optional <sup>(6)</sup> | off                      | off                      | off                      | off                     | off               |                      |
| ACLK                                               | on                      |                                 | on                                  | on                      | on                       | on                       | off                      | off                     | off               |                      |
| Full retention                                     | yes                     |                                 | yes                                 | yes                     | yes                      | yes                      | yes                      | no                      | no                |                      |
| SVS                                                | always                  |                                 | always                              | always                  | optional <sup>(7)</sup>  | optional <sup>(7)</sup>  | optional <sup>(7)</sup>  | optional <sup>(7)</sup> | on <sup>(8)</sup> | off <sup>(9)</sup>   |
| Brownout                                           | always                  |                                 | always                              | always                  | always                   | always                   | always                   | always                  | always            |                      |

(1) FRAM is disabled in the FRAM controller (FRCTL\_A).

(2) Disabling the FRAM through the FRAM controller (FRCTL\_A) allows the application to lower the LPM current consumption but the wake-up time increases when FRAM is accessed (for example, to fetch an interrupt vector). For a wakeup that does not involve FRAM (for example, a DMA transfer to RAM) the wake-up time is not increased.

(3) All clocks disabled

(4) See 节 9.5.2, which describes the use of peripherals in LPM3 and LPM4.

(5) *Unclocked peripherals* are peripherals that do not require a clock source to operate; for example, the comparator and REF, or the eUSCI when operated as an SPI slave.

(6) Controlled by SMCLKOFF.

(7) Activated SVS (SVSHE = 1) results in higher current consumption. SVS is not included in typical current consumption.

(8) SVSHE = 1

- (9) SVSHE = 0
- (10) Only while the LEA is performing a task enabled by the CPU during AM. The LEA cannot be enabled in LPM0.

### 9.5.1 Peripherals in Low-Power Modes

Peripherals can be in different states that affect the achievable power modes of the device. The states depend on the operational modes of the peripherals (see 表 9-2). The states are:

- A peripheral is in a "high-frequency state" if it requires or uses a clock with a "high" frequency of more than 50 kHz.
- A peripheral is in a "low-frequency state" if it requires or uses a clock with a "low" frequency of 50 kHz or less.
- A peripheral is in an "unclocked state" if it does not require or use an internal clock.

If the CPU requests a power mode that does not support the current state of all active peripherals, the device does not enter the requested power mode, but it does enter a power mode that still supports the current state of the peripherals, except if an external clock is used. If an external clock is used, the application must use the correct frequency range for the requested power mode.

**Table 9-2. Peripheral States**

| PERIPHERAL                               | IN HIGH-FREQUENCY STATE <sup>(1)</sup>                | IN LOW-FREQUENCY STATE <sup>(2)</sup>                | IN UNLOCKED STATE <sup>(3)</sup>                                 |
|------------------------------------------|-------------------------------------------------------|------------------------------------------------------|------------------------------------------------------------------|
| WDT                                      | Clocked by SMCLK                                      | Clocked by ACLK                                      | Not applicable                                                   |
| DMA <sup>(4)</sup>                       | Not applicable                                        | Not applicable                                       | Waiting for a trigger                                            |
| RTC_C                                    | Not applicable                                        | Clocked by LFXT                                      | Not applicable                                                   |
| LCD_C                                    | Not applicable                                        | Clocked by ACLK or VLOCLK                            | Not applicable                                                   |
| Timer_A, TAx                             | Clocked by SMCLK or clocked by external clock >50 kHz | Clocked by ACLK or clocked by external clock ≤50 kHz | Clocked by external clock ≤50 kHz                                |
| Timer_B, TBx                             | Clocked by SMCLK or clocked by external clock >50 kHz | Clocked by ACLK or clocked by external clock ≤50 kHz | Clocked by external clock ≤50 kHz                                |
| eUSCI_Ax in UART mode                    | Clocked by SMCLK                                      | Clocked by ACLK                                      | Waiting for first edge of START bit                              |
| eUSCI_Ax in SPI master mode              | Clocked by SMCLK                                      | Clocked by ACLK                                      | Not applicable                                                   |
| eUSCI_Ax in SPI slave mode               | Clocked by external clock >50 kHz                     | Clocked by external clock ≤50 kHz                    | Clocked by external clock ≤50 kHz                                |
| eUSCI_Bx in I <sup>2</sup> C master mode | Clocked by SMCLK or clocked by external clock >50 kHz | Clocked by ACLK or clocked by external clock ≤50 kHz | Not applicable                                                   |
| eUSCI_Bx in I <sup>2</sup> C slave mode  | Clocked by external clock >50 kHz                     | Clocked by external clock ≤50 kHz                    | Waiting for START condition or clocked by external clock ≤50 kHz |
| eUSCI_Bx in SPI master mode              | Clocked by SMCLK                                      | Clocked by ACLK                                      | Not applicable                                                   |
| eUSCI_Bx in SPI slave mode               | Clocked by external clock >50 kHz                     | Clocked by external clock ≤50 kHz                    | Clocked by external clock ≤50 kHz                                |
| ADC12_B                                  | Clocked by SMCLK or by MODOSC                         | Clocked by ACLK                                      | Waiting for a trigger                                            |
| REF_A                                    | Not applicable                                        | Not applicable                                       | Always                                                           |
| COMP_E                                   | Not applicable                                        | Not applicable                                       | Always                                                           |
| CRC <sup>(5)</sup>                       | Not applicable                                        | Not applicable                                       | Not applicable                                                   |
| MPY <sup>(5)</sup>                       | Not applicable                                        | Not applicable                                       | Not applicable                                                   |
| AES <sup>(5)</sup>                       | Not applicable                                        | Not applicable                                       | Not applicable                                                   |

- (1) Peripherals are in a state that requires or uses a clock with a "high" frequency of more than 50 kHz
- (2) Peripherals are in a state that requires or uses a clock with a "low" frequency of 50 kHz or less.
- (3) Peripherals are in a state that does not require or does not use an internal clock.
- (4) The DMA always transfers data in active mode but can wait for a trigger in any low-power mode. A DMA trigger during a low-power mode causes a temporary transition into active mode for the time of the transfer.
- (5) This peripheral operates during active mode only and will delay the transition into a low-power mode until its operation is completed.

### 9.5.2 Idle Currents of Peripherals in LPM3 and LPM4

Most peripherals can be operational in LPM3 if clocked by ACLK. Some modules are operational in LPM4, because they do not require a clock to operate (for example, the comparator). Activating a peripheral in LPM3 or LPM4 increases the current consumption due to its active supply current contribution but also due to an additional idle current. To reduce the idle current adder, certain peripherals are grouped together. To achieve optimal current consumption, use modules within one group and limit the number of groups with active modules. 表 9-3 lists the peripheral groups. Modules not listed in this table are either already included in the standard LPM3 current consumption or cannot be used in LPM3 or LPM4.

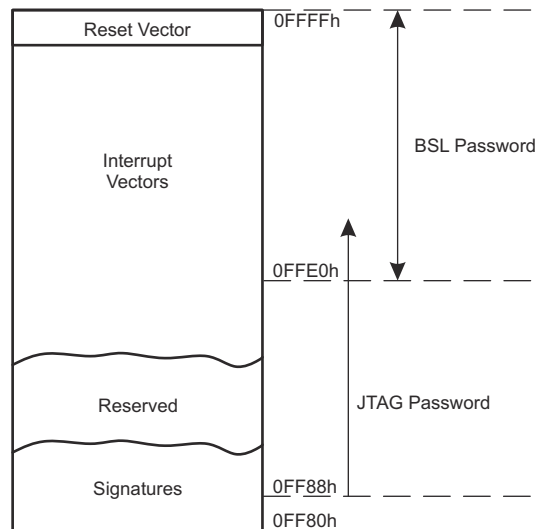
The idle current adder is very small at room temperature (25°C) but increases at high temperatures (85°C); see the  $I_{IDLE}$  current parameters in 节 8 for details.

**Table 9-3. Peripheral Groups**

| GROUP A   | GROUP B    | GROUP C   |
|-----------|------------|-----------|
| Timer TA1 | Timer TA0  | Timer TA4 |
| Timer TA2 | Timer TA3  | eUSCI_A2  |
| Timer TB0 | Comparator | eUSCI_A3  |
| eUSCI_A0  | ADC12_B    | eUSCI_B1  |
| eUSCI_A1  | REF_A      | LCD_C     |
| eUSCI_B0  |            |           |

### 9.6 Interrupt Vector Table and Signatures

The interrupt vectors, the power-up start address, and signatures are in the address range 0FFFFh to 0FF80h. 图 9-2 summarizes the content of this address range.



**图 9-2. Interrupt Vectors, Signatures and Passwords**

The power-up start address or reset vector is at 0FFFFh to 0FFFEh. It contains the 16-bit address pointing to the start address of the application program.

The interrupt vectors start at 0FFFDh and extend to lower addresses. Each vector contains the 16-bit address of the appropriate interrupt-handler instruction sequence. 表 9-4 shows the device-specific interrupt vector locations.

The vectors programmed into the address range from 0FFFFh to 0FFE0h are used as BSL password (if enabled by the corresponding signature).

The signatures start at 0FF80h and extend to higher addresses. Signatures are evaluated during device start-up. 表 9-5 shows the device-specific signature locations.

A JTAG password can be programmed starting from address 0FF88h and extending to higher addresses. The password can extend into the interrupt vector locations using the interrupt vector addresses as additional bits for the password. The length of the JTAG password depends on the JTAG signature.

See the chapter *System Resets, Interrupts, and Operating Modes, System Control Module (SYS)* in the *MSP430FR58xx, MSP430FR59xx, and MSP430FR6xx Family User's Guide* for details.

**Table 9-4. Interrupt Sources, Flags, and Vectors**

| INTERRUPT SOURCE                                                                                                                                                                                                                                                                  | INTERRUPT FLAG                                                                                                                                                                                                                                           | SYSTEM INTERRUPT | WORD ADDRESS | PRIORITY |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|--------------|----------|
| <b>System Reset</b><br>Power up, brownout, supply supervisor<br>External reset $\overline{\text{RST}}$<br>Watchdog time-out (watchdog mode)<br>WDT, FRCTL MPU, CS, PMM password violation<br>FRAM uncorrectable bit error detection<br>MPU segment violation<br>Software POR, BOR | SVSHIFG<br>PMMRSTIFG<br>WDTIFG<br>WDTPW, FRCTLPW, MPUPW, CSPW, PMMPW<br>UBDIFG<br>MPUSEG1IFG, MPUSEG2IFG, MPUSEG3IFG<br>PMMPORIFG, PMMBORIFG<br>(SYSRSTIV) <sup>(1) (2)</sup>                                                                            | Reset            | 0FFFEh       | Highest  |
| <b>System NMI</b><br>Vacant memory access<br>JTAG mailbox<br>FRAM access time error<br>FRAM write protection error<br>FRAM bit error detection<br>MPU segment violation                                                                                                           | VMAIFG<br>JMBINIFG, JMBOUTIFG<br>ACCTEIFG, WPIFG<br>CBDIFG, UBDIFG<br>MPUSEG1IFG, MPUSEG2IFG, MPUSEG3IFG<br>(SYSSNIV) <sup>(1) (3)</sup>                                                                                                                 | (Non)maskable    | 0FFFCh       |          |
| <b>User NMI</b><br>External NMI<br>Oscillator fault<br>LEA RAM access conflict                                                                                                                                                                                                    | NMIFG, OFIFG<br>DACCESSIFG<br>(SYSUNIV) <sup>(1) (3)</sup>                                                                                                                                                                                               | (Non)maskable    | 0FFFAh       |          |
| Comparator_E                                                                                                                                                                                                                                                                      | CEIFG, CEIIFG<br>(CEIV) <sup>(1)</sup>                                                                                                                                                                                                                   | Maskable         | 0FFF8h       |          |
| TB0                                                                                                                                                                                                                                                                               | TB0CCR0.CCIFG                                                                                                                                                                                                                                            | Maskable         | 0FFF6h       |          |
| TB0                                                                                                                                                                                                                                                                               | TB0CCR1.CCIFG to TB0CCR6.CCIFG,<br>TB0CTL.TBIFG<br>(TB0IV) <sup>(1)</sup>                                                                                                                                                                                | Maskable         | 0FFF4h       |          |
| Watchdog timer (interval timer mode)                                                                                                                                                                                                                                              | WDTIFG                                                                                                                                                                                                                                                   | Maskable         | 0FFF2h       |          |
| eUSCI_A0 receive or transmit                                                                                                                                                                                                                                                      | UCA0IFG: UCRXIFG, UCTXIFG (SPI mode)<br>UCA0IFG: UCSTTIFG, UCTXCPITFG, UCRXIFG,<br>UCTXIFG (UART mode)<br>(UCA0IV) <sup>(1)</sup>                                                                                                                        | Maskable         | 0FFF0h       |          |
| eUSCI_B0 receive or transmit                                                                                                                                                                                                                                                      | UCB0IFG: UCRXIFG, UCTXIFG (SPI mode)<br>UCB0IFG: UCALIFG, UCNACKIFG, UCSTTIFG,<br>UCSTPIFG, UCRXIFG0, UCTXIFG0, UCRXIFG1,<br>UCTXIFG1, UCRXIFG2, UCTXIFG2, UCRXIFG3,<br>UCTXIFG3, UCCNTIFG, UCBIT9IFG (I <sup>2</sup> C mode)<br>(UCB0IV) <sup>(1)</sup> | Maskable         | 0FFEEh       |          |
| ADC12_B                                                                                                                                                                                                                                                                           | ADC12IFG0 to ADC12IFG31<br>ADC12LOIFG, ADC12INIFG, ADC12HIIFG,<br>ADC12RDYIFG, ADC21OVIFG, ADC12TOVIFG<br>(ADC12IV) <sup>(1) (4)</sup>                                                                                                                   | Maskable         | 0FFECh       |          |
| TA0                                                                                                                                                                                                                                                                               | TA0CCR0.CCIFG                                                                                                                                                                                                                                            | Maskable         | 0FFEAh       |          |
| TA0                                                                                                                                                                                                                                                                               | TA0CCR1.CCIFG, TA0CCR2.CCIFG,<br>TA0CTL.TAIFG<br>(TA0IV) <sup>(1)</sup>                                                                                                                                                                                  | Maskable         | 0FFE8h       |          |

**Table 9-4. Interrupt Sources, Flags, and Vectors (continued)**

| INTERRUPT SOURCE             | INTERRUPT FLAG                                                                                                                                                                                                                                           | SYSTEM INTERRUPT | WORD ADDRESS | PRIORITY |
|------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|--------------|----------|
| eUSCI_A1 receive or transmit | UCA1IFG: UCRXIFG, UCTXIFG (SPI mode)<br>UCA1IFG: UCSTTIFG, UCTXCPITIFG, UCRXIFG,<br>UCTXIFG (UART mode)<br>(UCA1IV) <sup>(1)</sup>                                                                                                                       | Maskable         | 0FFE6h       |          |
| DMA                          | DMA0CTL.DMAIFG, DMA1CTL.DMAIFG,<br>DMA2CTL.DMAIFG<br>(DMAIV) <sup>(1)</sup>                                                                                                                                                                              | Maskable         | 0FFE4h       |          |
| TA1                          | TA1CCR0.CCIFG                                                                                                                                                                                                                                            | Maskable         | 0FFE2h       |          |
| TA1                          | TA1CCR1.CCIFG, TA1CCR2.CCIFG,<br>TA1CTL.TAIFG<br>(TA1IV) <sup>(1)</sup>                                                                                                                                                                                  | Maskable         | 0FFE0h       |          |
| I/O port P1                  | P1IFG.0 to P1IFG.7<br>(P1IV) <sup>(1)</sup>                                                                                                                                                                                                              | Maskable         | 0FFDEh       |          |
| TA2                          | TA2CCR0.CCIFG                                                                                                                                                                                                                                            | Maskable         | 0FFDCh       |          |
| TA2                          | TA2CCR1.CCIFG<br>TA2CTL.TAIFG<br>(TA2IV) <sup>(1)</sup>                                                                                                                                                                                                  | Maskable         | 0FFDAh       |          |
| I/O port P2                  | P2IFG.0 to P2IFG.7<br>(P2IV) <sup>(1)</sup>                                                                                                                                                                                                              | Maskable         | 0FFD8h       |          |
| TA3                          | TA3CCR0.CCIFG                                                                                                                                                                                                                                            | Maskable         | 0FFD6h       |          |
| TA3                          | TA3CCR1.CCIFG<br>TA3CTL.TAIFG<br>(TA3IV) <sup>(1)</sup>                                                                                                                                                                                                  | Maskable         | 0FFD4h       |          |
| I/O port P3                  | P3IFG.0 to P3IFG.7<br>(P3IV) <sup>(1)</sup>                                                                                                                                                                                                              | Maskable         | 0FFD2h       |          |
| I/O port P4                  | P4IFG.0 to P4IFG.7<br>(P4IV) <sup>(1)</sup>                                                                                                                                                                                                              | Maskable         | 0FFD0h       |          |
| LCD_C                        | LCD_C interrupt flags (LCDIV) <sup>(1)</sup>                                                                                                                                                                                                             | Maskable         | 0FFCEh       |          |
| RTC_C                        | RTCRDYIFG, RTCTEVIFG, RTCAIFG, RT0PSIFG,<br>RT1PSIFG, RTCOFIFG<br>(RTCIV) <sup>(1)</sup>                                                                                                                                                                 | Maskable         | 0FFCCh       |          |
| AES                          | AESRDYIFG                                                                                                                                                                                                                                                | Maskable         | 0FFCAh       |          |
| TA4                          | TA4CCR0.CCIFG                                                                                                                                                                                                                                            | Maskable         | 0FFC8h       |          |
| TA4                          | TA4CCR1.CCIFG<br>TA4CTL.TAIFG<br>(TA4IV) <sup>(1)</sup>                                                                                                                                                                                                  | Maskable         | 0FFC6h       |          |
| I/O port P5                  | P5IFG.0 to P5IFG.7<br>(P5IV) <sup>(1)</sup>                                                                                                                                                                                                              | Maskable         | 0FFC4h       |          |
| I/O port P6                  | P6IFG.0 to P6IFG.7<br>(P6IV) <sup>(1)</sup>                                                                                                                                                                                                              | Maskable         | 0FFC2h       |          |
| eUSCI_A2 receive or transmit | UCA2IFG: UCRXIFG, UCTXIFG (SPI mode)<br>UCA2IFG: UCSTTIFG, UCTXCPITIFG, UCRXIFG,<br>UCTXIFG (UART mode)<br>(UCA2IV) <sup>(1)</sup>                                                                                                                       | Maskable         | 0FFC0h       |          |
| eUSCI_A3 receive or transmit | UCA3IFG: UCRXIFG, UCTXIFG (SPI mode)<br>UCA3IFG: UCSTTIFG, UCTXCPITIFG, UCRXIFG,<br>UCTXIFG (UART mode)<br>(UCA3IV) <sup>(1)</sup>                                                                                                                       | Maskable         | 0FFBEh       |          |
| eUSCI_B1 receive or transmit | UCB1IFG: UCRXIFG, UCTXIFG (SPI mode)<br>UCB1IFG: UCALIFG, UCNACKIFG, UCSTTIFG,<br>UCSTPIFG, UCRXIFG0, UCTXIFG0, UCRXIFG1,<br>UCTXIFG1, UCRXIFG2, UCTXIFG2, UCRXIFG3,<br>UCTXIFG3, UCCNTIFG, UCBIT9IFG (I <sup>2</sup> C mode)<br>(UCB1IV) <sup>(1)</sup> | Maskable         | 0FFBCh       |          |

**Table 9-4. Interrupt Sources, Flags, and Vectors (continued)**

| INTERRUPT SOURCE | INTERRUPT FLAG                                                    | SYSTEM INTERRUPT | WORD ADDRESS | PRIORITY |
|------------------|-------------------------------------------------------------------|------------------|--------------|----------|
| I/O port P7      | P7IFG.0 to P7IFG.7<br>(P7IV) <sup>(1)</sup>                       | Maskable         | 0FFBAh       |          |
| I/O port P8      | P8IFG.0 to P8IFG.7<br>(P8IV) <sup>(1)</sup>                       | Maskable         | 0FFB8h       |          |
| I/O port P9      | P9IFG.0 to P9IFG.7<br>(P9IV) <sup>(1)</sup>                       | Maskable         | 0FFB6h       |          |
| LEA              | CMDIFG, SDIIFG, OORIFG, TIFG, COVLIFG<br>(LEAIV) <sup>(1)</sup>   | Maskable         | 0FFB4h       |          |
| UUPS             | PTMOUT, PREQIG<br>(IIDX) <sup>(1)</sup>                           | Maskable         | 0FFB2h       |          |
| HSPLL            | PLLUNLOCK<br>(IIDX) <sup>(1)</sup>                                | Maskable         | 0FFB0h       |          |
| SAPH             | DATAERR, TAMTO, SEQDN, PNGDN<br>(IIDX) <sup>(1)</sup>             | Maskable         | 0FFAEh       |          |
| SDHS             | OVF, ACQDONE, SSTRG, DTRDY, WINHI, WINLO<br>(IIDX) <sup>(1)</sup> | Maskable         | 0FFACh       | Lowest   |

(1) Multiple source flags

(2) A reset is generated if the CPU tries to fetch instructions from within peripheral space.

(3) (Non)maskable: the individual interrupt enable bit can disable an interrupt event, but the general interrupt enable cannot disable it.

(4) Only on devices with ADC, otherwise reserved.

**Table 9-5. Signatures**

| SIGNATURE                                  | WORD ADDRESS |
|--------------------------------------------|--------------|
| IP Encapsulation Signature2                | 0FF8Ah       |
| IP Encapsulation Signature1 <sup>(1)</sup> | 0FF88h       |
| BSL Signature2                             | 0FF86h       |
| BSL Signature1                             | 0FF84h       |
| JTAG Signature2                            | 0FF82h       |
| JTAG Signature1                            | 0FF80h       |

(1) Must not contain 0AAAAh if used as the JTAG password.

## 9.7 Bootloader (BSL)

The BSL can program the FRAM or RAM using a UART serial interface (FRxxxx devices). Access to the device memory through the BSL is protected by a user-defined password. 表 9-6 lists the pins that are required for use of the BSL. BSL entry requires a specific entry sequence on the  $\overline{\text{RST}}$ /NMI/SBWTIO and TEST/SBWTCK pins. For a complete description of the features of the BSL and its implementation, see the [MSP430 FRAM Devices Bootloader \(BSL\) User's Guide](#). More information on the BSL can be found at [www.ti.com/tool/mspbsl](http://www.ti.com/tool/mspbsl).

**Table 9-6. BSL Pin Requirements and Functions**

| DEVICE SIGNAL  | BSL FUNCTION                                  |
|----------------|-----------------------------------------------|
| RST/NMI/SBWTIO | Entry sequence signal                         |
| TEST/SBWTCK    | Entry sequence signal                         |
| P2.0           | Devices with UART BSL (FRxxxx): Data transmit |
| P2.1           | Devices with UART BSL (FRxxxx): Data receive  |
| VCC            | Power supply                                  |
| VSS            | Ground supply                                 |



## 9.8 JTAG Operation

### 9.8.1 JTAG Standard Interface

The MSP family supports the standard JTAG interface, which requires four signals for sending and receiving data. The JTAG signals are shared with general-purpose I/O. The TEST/SBWTCK pin is used to enable the JTAG signals. In addition to these signals, the RST/NMI/SBWTIO is required to interface with MSP development tools and device programmers. 表 9-7 lists the JTAG pin requirements. For further details on interfacing to development tools and device programmers, see the [MSP430 Hardware Tools User's Guide](#). For a complete description of the features of the JTAG interface and its implementation, see [MSP430 Programming With the JTAG Interface](#).

**Table 9-7. JTAG Pin Requirements and Functions**

| DEVICE SIGNAL  | DIRECTION <sup>(1)</sup> | FUNCTION                    |
|----------------|--------------------------|-----------------------------|
| PJ.3/TCK       | IN                       | JTAG clock input            |
| PJ.2/TMS       | IN                       | JTAG state control          |
| PJ.1/TDI/TCLK  | IN                       | JTAG data input, TCLK input |
| PJ.0/TDO       | OUT                      | JTAG data output            |
| TEST/SBWTCK    | IN                       | Enable JTAG pins            |
| RST/NMI/SBWTIO | IN                       | External reset              |
| DVCC           | N/A                      | Power supply                |
| DVSS           | N/A                      | Ground supply               |

(1) N/A = not applicable

### 9.8.2 Spy-Bi-Wire (SBW) Interface

In addition to the standard JTAG interface, the MSP family supports the 2-wire SBW interface. SBW can be used to interface with MSP development tools and device programmers. 表 9-8 lists the SBW interface pin requirements. For further details on interfacing to development tools and device programmers, see the [MSP430 Hardware Tools User's Guide](#). For a complete description of the features of the JTAG interface and its implementation, see [MSP430 Programming With the JTAG Interface](#).

**Table 9-8. SBW Pin Requirements and Functions**

| DEVICE SIGNAL  | DIRECTION <sup>(1)</sup> | FUNCTION                          |
|----------------|--------------------------|-----------------------------------|
| TEST/SBWTCK    | IN                       | Spy-Bi-Wire clock input           |
| RST/NMI/SBWTIO | IN, OUT                  | Spy-Bi-Wire data input and output |
| DVCC           | N/A                      | Power supply                      |
| DVSS           | N/A                      | Ground supply                     |

(1) N/A = not applicable

## 9.9 FRAM Controller A (FRCTL\_A)

The FRAM can be programmed through the JTAG port, SBW, the BSL, or in-system by the CPU. Features of the FRAM include:

- Ultra-low-power ultra-fast-write nonvolatile memory
- Byte and word access capability
- Programmable wait state generation
- Error correction coding (ECC)

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### Note

#### Wait States

For MCLK frequencies > 8 MHz, wait states must be configured following the flow described in the "Wait State Control" section of the *FRAM Controller A (FRCTL\_A)* chapter in the [MSP430FR58xx](#), [MSP430FR59xx](#), and [MSP430FR6xx Family User's Guide](#).

For important software design information regarding FRAM including but not limited to partitioning the memory layout according to application-specific code, constant, and data space requirements, the use of FRAM to optimize application energy consumption, and the use of the Memory Protection Unit (MPU) to maximize application robustness by protecting the program code against unintended write accesses, see [MSP430™ FRAM Technology – How To and Best Practices](#).

## 9.10 RAM

The RAM is made up of three sectors: Sector 0 = 2KB, Sector 1 = 2KB, Sector 2 = 4KB (shared with LEA). Each sector can be individually powered down in LPM3 and LPM4 to save leakage. All data in the sector is lost when a sector is powered down.

## 9.11 Tiny RAM

Tiny RAM is 22 bytes of RAM in addition to the complete RAM (see [表 9-45](#)). This memory is always available, even in LPM3 and LPM4, while the complete RAM can be powered down in LPM3 and LPM4. Tiny RAM can be used to hold data or a very small stack when the complete RAM is powered down in LPM3 and LPM4. No memory is available in LPMx.5.

## 9.12 Memory Protection Unit (MPU) Including IP Encapsulation

The FRAM can be protected by the MPU from inadvertent CPU execution, read access, or write access. Features of the MPU include:

- IP encapsulation with programmable boundaries in steps of 1KB (prevents reads from outside the application; for example, through JTAG or by non-IP software).
- Main memory partitioning is programmable up to three segments in steps of 1KB.
- Access rights of each segment can be individually selected (main and information memory).
- Access violation flags with interrupt capability for easy servicing of access violations.

## 9.13 Peripherals

Peripherals are connected to the CPU through data, address, and control buses. Peripherals can be controlled using all instructions. For complete module descriptions, see the [MSP430FR58xx](#), [MSP430FR59xx](#), and [MSP430FR6xx Family User's Guide](#).

### 9.13.1 Digital I/O

Up to ten 8-bit I/O ports are implemented:

- All individual I/O bits are independently programmable.
- Any combination of input, output, and interrupt conditions is possible.
- Programmable pullup or pulldown on all ports.
- Edge-selectable interrupt and LPM3.5 and LPM4.5 wake-up input is available for all pins of ports P1 to P9.
- Read and write access to port control registers is supported by all instructions.
- Ports P1 and P2 (PA), P3 and P4 (PB), P5 and P6 (PC), P7 and P8 (PD), or P9 (PE) can be accessed byte-wise or word-wise in pairs.
- No cross currents during start-up.

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#### Note

##### Configuration of Digital I/Os After BOR Reset

To prevent any cross currents during start-up of the device, all port pins are high-impedance with Schmitt triggers and their module functions disabled. To enable the I/O functionality after a BOR reset, the ports must be configured first and then the LOCKLPM5 bit must be cleared. For details, see the *Configuration After Reset* section of the *Digital I/O* chapter in the [MSP430FR58xx](#), [MSP430FR59xx](#), and [MSP430FR6xx Family User's Guide](#).

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### 9.13.2 Oscillator and Clock System (CS)

The clock system includes support for a 32-kHz watch-crystal oscillator XT1 (LF), an internal very-low-power low-frequency oscillator (VLO), an integrated internal digitally controlled oscillator (DCO), and a high-frequency crystal oscillator XT2 (HF). The clock system module is designed to meet the requirements of both low system cost and low power consumption. A fail-safe mechanism exists for all crystal sources. The clock system module provides the following clock signals:

- Auxiliary clock (ACLK). ACLK can be sourced from a 32-kHz watch crystal (LFXT1), the internal VLO, or a digital external low-frequency (<50-kHz) clock source.
- Main clock (MCLK), the system clock used by the CPU. MCLK can be sourced from a high-frequency crystal (HFXT2), the internal DCO, a 32-kHz watch crystal (LFXT1), the internal VLO, or a digital external clock source.
- Sub-Main clock (SMCLK), the subsystem clock used by the peripheral modules. SMCLK can be sourced by same sources made available to MCLK.

### 9.13.3 Power-Management Module (PMM)

The PMM includes an integrated voltage regulator that supplies the core voltage to the device. The PMM also includes supply voltage supervisor (SVS) and brownout protection. The brownout circuit provides the proper internal reset signal to the device during power on and power off. The SVS circuitry detects if the supply voltage drops below a safe level and below a user-selectable level. SVS circuitry is available on the primary and core supplies.

### 9.13.4 Hardware Multiplier (MPY)

The multiplication operation is supported by a dedicated peripheral module. The module performs operations with 32-, 24-, 16-, and 8-bit operands. The module supports signed multiplication, unsigned multiplication, signed multiply-and-accumulate, and unsigned multiply-and-accumulate operations.

### 9.13.5 Real-Time Clock (RTC\_C)

The RTC\_C module contains an integrated real-time clock (RTC) with the following features:

- Calendar mode with leap year correction
- General-purpose counter mode

The internal calendar compensates for months with fewer than 31 days and includes leap year correction. The RTC\_C also supports flexible alarm functions and offset-calibration hardware. RTC operation is available in LPM3.5 modes to minimize power consumption.

### 9.13.6 Watchdog Timer (WDT\_A)

The primary function of the WDT\_A module is to perform a controlled system restart if a software problem occurs. If the selected time interval expires, a system reset is generated. If the watchdog function is not needed in an application, the module can be configured as an interval timer and can generate interrupts at selected time intervals. 表 9-9 lists the clocks that can source the WDT\_A module.

**Table 9-9. WDT\_A Clocks**

| WDTSEL | NORMAL OPERATION<br>(WATCHDOG AND INTERVAL TIMER<br>MODE) |
|--------|-----------------------------------------------------------|
| 00     | SMCLK                                                     |
| 01     | ACLK                                                      |
| 10     | VLOCLK                                                    |
| 11     | LFMODCLK                                                  |

### 9.13.7 System Module (SYS)

The SYS module manages many system functions within the device. These functions include power-on reset (POR) and power-up clear (PUC) handling, NMI source selection and management, reset interrupt vector generators, bootloader (BSL) entry mechanisms, and configuration management (device descriptors). The SYS module also includes a data exchange mechanism through JTAG called a JTAG mailbox that can be used in the application. 表 9-10 lists the SYS module interrupt vector registers.

**Table 9-10. System Module Interrupt Vector Registers**

| INTERRUPT VECTOR REGISTER | ADDRESS | INTERRUPT EVENT                              | VALUE | PRIORITY |
|---------------------------|---------|----------------------------------------------|-------|----------|
| SYSRSTIV, System Reset    | 019Eh   | No interrupt pending                         | 00h   |          |
|                           |         | Brownout (BOR)                               | 02h   | Highest  |
|                           |         | RSTIFG RST/NMI (BOR)                         | 04h   |          |
|                           |         | PMMSWBOR software BOR (BOR)                  | 06h   |          |
|                           |         | LPMx.5 wakeup (BOR)                          | 08h   |          |
|                           |         | Security violation (BOR)                     | 0Ah   |          |
|                           |         | Reserved                                     | 0Ch   |          |
|                           |         | SVSHIFG SVSH event (BOR)                     | 0Eh   |          |
|                           |         | Reserved                                     | 10h   |          |
|                           |         | Reserved                                     | 12h   |          |
|                           |         | PMMSWPOR software POR (POR)                  | 14h   |          |
|                           |         | WDTIFG watchdog time-out (PUC)               | 16h   |          |
|                           |         | WDTPW password violation (PUC)               | 18h   |          |
|                           |         | FRCTLPW password violation (PUC)             | 1Ah   |          |
|                           |         | Uncorrectable FRAM bit error detection (PUC) | 1Ch   |          |
|                           |         | Peripheral area fetch (PUC)                  | 1Eh   |          |
|                           |         | PMMPW PMM password violation (PUC)           | 20h   |          |

**Table 9-10. System Module Interrupt Vector Registers (continued)**

| INTERRUPT VECTOR REGISTER | ADDRESS | INTERRUPT EVENT                                           | VALUE      | PRIORITY |
|---------------------------|---------|-----------------------------------------------------------|------------|----------|
|                           |         | MPUPW MPU password violation (PUC)                        | 22h        |          |
|                           |         | CSPW CS password violation (PUC)                          | 24h        |          |
|                           |         | MPUSEGPIFG encapsulated IP memory segment violation (PUC) | 26h        |          |
|                           |         | Reserved                                                  | 28h        |          |
|                           |         | MPUSEG1IFG segment 1 memory violation (PUC)               | 2Ah        |          |
|                           |         | MPUSEG2IFG segment 2 memory violation (PUC)               | 2Ch        |          |
|                           |         | MPUSEG3IFG segment 3 memory violation (PUC)               | 2Eh        |          |
|                           |         | Reserved                                                  | 30h to 3Eh | Lowest   |
| SYSSNIV, System NMI       | 019Ch   | No interrupt pending                                      | 00h        |          |
|                           |         | Reserved                                                  | 02h        | Highest  |
|                           |         | Uncorrectable FRAM bit error detection                    | 04h        |          |
|                           |         | FRAM access time error                                    | 06h        |          |
|                           |         | MPUSEGPIFG encapsulated IP memory segment violation       | 08h        |          |
|                           |         | Reserved                                                  | 0Ah        |          |
|                           |         | MPUSEG1IFG segment 1 memory violation                     | 0Ch        |          |
|                           |         | MPUSEG2IFG segment 2 memory violation                     | 0Eh        |          |
|                           |         | MPUSEG3IFG segment 3 memory violation                     | 10h        |          |
|                           |         | VMAIFG vacant memory access                               | 12h        |          |
|                           |         | JMBINIFG JTAG mailbox input                               | 14h        |          |
|                           |         | JMBOUTIFG JTAG mailbox output                             | 16h        |          |
|                           |         | Correctable FRAM bit error detection                      | 18h        |          |
|                           |         | FRAM Write Protection Detection                           | 1Ah        |          |
|                           |         | LEA time-out fault                                        | 1Ch        |          |
|                           |         | LEA command fault                                         | 1Eh        | Lowest   |
| SYSUNIV, User NMI         | 019Ah   | No interrupt pending                                      | 00h        |          |
|                           |         | NMIIFG NMI pin                                            | 02h        | Highest  |
|                           |         | OFIFG oscillator fault                                    | 04h        |          |
|                           |         | DACCESSIFG                                                | 06h        |          |
|                           |         | Reserved                                                  | 08h        |          |
|                           |         | Reserved                                                  | 0Ah to 1Eh | Lowest   |

### 9.13.8 DMA Controller

The DMA controller allows movement of data from one memory address to another without CPU intervention. For example, the DMA controller can be used to move data from the ADC12\_B conversion memory to RAM. Using the DMA controller can increase the throughput of peripheral modules. The DMA controller reduces system power consumption by allowing the CPU to remain in sleep mode, without having to awaken to move data to or from a peripheral. 表 9-11 lists the available triggers for the DMA.

**Table 9-11. DMA Trigger Assignments**

| TRIGGER<br>(1) | CHANNEL 0     | CHANNEL 1     | CHANNEL 2     | CHANNEL 3     | CHANNEL 4     | CHANNEL 5     |
|----------------|---------------|---------------|---------------|---------------|---------------|---------------|
| 0              | DMAREQ        | DMAREQ        | DMAREQ        | DMAREQ        | DMAREQ        | DMAREQ        |
| 1              | TA0CCR0 CCIFG | TA0CCR0 CCIFG | TA0CCR0 CCIFG | TA0CCR0 CCIFG | TA0CCR0 CCIFG | TA0CCR0 CCIFG |
| 2              | TA0CCR2 CCIFG | TA0CCR2 CCIFG | TA0CCR2 CCIFG | TA0CCR2 CCIFG | TA0CCR2 CCIFG | TA0CCR2 CCIFG |
| 3              | TA1CCR0 CCIFG | TA1CCR0 CCIFG | TA1CCR0 CCIFG | TA1CCR0 CCIFG | TA1CCR0 CCIFG | TA1CCR0 CCIFG |
| 4              | TA1CCR2 CCIFG | TA1CCR2 CCIFG | TA1CCR2 CCIFG | TA1CCR2 CCIFG | TA1CCR2 CCIFG | TA1CCR2 CCIFG |

**Table 9-11. DMA Trigger Assignments (continued)**

| TRIGGER<br>(1) | CHANNEL 0                                        | CHANNEL 1                                        | CHANNEL 2                                        | CHANNEL 3                                        | CHANNEL 4                                        | CHANNEL 5                                        |
|----------------|--------------------------------------------------|--------------------------------------------------|--------------------------------------------------|--------------------------------------------------|--------------------------------------------------|--------------------------------------------------|
| 5              | TA2CCR0 CCIFG                                    | TA2CCR0 CCIFG                                    | TA2CCR0 CCIFG                                    | TA2CCR0 CCIFG                                    | TA2CCR0 CCIFG                                    | TA2CCR0 CCIFG                                    |
| 6              | TA3CCR0 CCIFG                                    | TA3CCR0 CCIFG                                    | TA3CCR0 CCIFG                                    | TA3CCR0 CCIFG                                    | TA3CCR0 CCIFG                                    | TA3CCR0 CCIFG                                    |
| 7              | TB0CCR0 CCIFG                                    | TB0CCR0 CCIFG                                    | TB0CCR0 CCIFG                                    | TB0CCR0 CCIFG                                    | TB0CCR0 CCIFG                                    | TB0CCR0 CCIFG                                    |
| 8              | TB0CCR2 CCIFG                                    | TB0CCR2 CCIFG                                    | TB0CCR2 CCIFG                                    | TB0CCR2 CCIFG                                    | TB0CCR2 CCIFG                                    | TB0CCR2 CCIFG                                    |
| 9              | TA4CCR0 CCIFG                                    | TA4CCR0 CCIFG                                    | TA4CCR0 CCIFG                                    | TA4CCR0 CCIFG                                    | TA4CCR0 CCIFG                                    | TA4CCR0 CCIFG                                    |
| 10             | Reserved                                         | Reserved                                         | Reserved                                         | Reserved                                         | Reserved                                         | Reserved                                         |
| 11             | AES Trigger 0                                    | AES Trigger 0                                    | AES Trigger 0                                    | AES Trigger 0                                    | AES Trigger 0                                    | AES Trigger 0                                    |
| 12             | AES Trigger 1                                    | AES Trigger 1                                    | AES Trigger 1                                    | AES Trigger 1                                    | AES Trigger 1                                    | AES Trigger 1                                    |
| 13             | AES Trigger 2                                    | AES Trigger 2                                    | AES Trigger 2                                    | AES Trigger 2                                    | AES Trigger 2                                    | AES Trigger 2                                    |
| 14             | UCA0RXIFG                                        | UCA0RXIFG                                        | UCA0RXIFG                                        | UCA2RXIFG                                        | UCA2RXIFG                                        | UCA2RXIFG                                        |
| 15             | UCA0TXIFG                                        | UCA0TXIFG                                        | UCA0TXIFG                                        | UCA2TXIFG                                        | UCA2TXIFG                                        | UCA2TXIFG                                        |
| 16             | UCA1RXIFG                                        | UCA1RXIFG                                        | UCA1RXIFG                                        | UCA3RXIFG                                        | UCA3RXIFG                                        | UCA3RXIFG                                        |
| 17             | UCA1TXIFG                                        | UCA1TXIFG                                        | UCA1TXIFG                                        | UCA3TXIFG                                        | UCA3TXIFG                                        | UCA3TXIFG                                        |
| 18             | UCB0RXIFG (SPI)<br>UCB0RXIFG0 (I <sup>2</sup> C) | UCB0RXIFG (SPI)<br>UCB0RXIFG0 (I <sup>2</sup> C) | UCB0RXIFG (SPI)<br>UCB0RXIFG0 (I <sup>2</sup> C) | UCB1RXIFG (SPI)<br>UCB1RXIFG0 (I <sup>2</sup> C) | UCB1RXIFG (SPI)<br>UCB1RXIFG0 (I <sup>2</sup> C) | UCB1RXIFG (SPI)<br>UCB1RXIFG0 (I <sup>2</sup> C) |
| 19             | UCB0TXIFG (SPI)<br>UCB0TXIFG0 (I <sup>2</sup> C) | UCB0TXIFG (SPI)<br>UCB0TXIFG0 (I <sup>2</sup> C) | UCB0TXIFG (SPI)<br>UCB0TXIFG0 (I <sup>2</sup> C) | UCB1TXIFG (SPI)<br>UCB1TXIFG0 (I <sup>2</sup> C) | UCB1TXIFG (SPI)<br>UCB1TXIFG0 (I <sup>2</sup> C) | UCB1TXIFG (SPI)<br>UCB1TXIFG0 (I <sup>2</sup> C) |
| 20             | UCB0RXIFG1 (I <sup>2</sup> C)                    | UCB0RXIFG1 (I <sup>2</sup> C)                    | UCB0RXIFG1 (I <sup>2</sup> C)                    | UCB1RXIFG1 (I <sup>2</sup> C)                    | UCB1RXIFG1 (I <sup>2</sup> C)                    | UCB1RXIFG1 (I <sup>2</sup> C)                    |
| 21             | UCB0TXIFG1 (I <sup>2</sup> C)                    | UCB0TXIFG1 (I <sup>2</sup> C)                    | UCB0TXIFG1 (I <sup>2</sup> C)                    | UCB1TXIFG1 (I <sup>2</sup> C)                    | UCB1TXIFG1 (I <sup>2</sup> C)                    | UCB1TXIFG1 (I <sup>2</sup> C)                    |
| 22             | UCB0RXIFG2 (I <sup>2</sup> C)                    | UCB0RXIFG2 (I <sup>2</sup> C)                    | UCB0RXIFG2 (I <sup>2</sup> C)                    | UCB1RXIFG2 (I <sup>2</sup> C)                    | UCB1RXIFG2 (I <sup>2</sup> C)                    | UCB1RXIFG2 (I <sup>2</sup> C)                    |
| 23             | UCB0TXIFG2 (I <sup>2</sup> C)                    | UCB0TXIFG2 (I <sup>2</sup> C)                    | UCB0TXIFG2 (I <sup>2</sup> C)                    | UCB1TXIFG2 (I <sup>2</sup> C)                    | UCB1TXIFG2 (I <sup>2</sup> C)                    | UCB1TXIFG2 (I <sup>2</sup> C)                    |
| 24             | UCB0RXIFG3 (I <sup>2</sup> C)                    | UCB0RXIFG3 (I <sup>2</sup> C)                    | UCB0RXIFG3 (I <sup>2</sup> C)                    | UCB1RXIFG3 (I <sup>2</sup> C)                    | UCB1RXIFG3 (I <sup>2</sup> C)                    | UCB1RXIFG3 (I <sup>2</sup> C)                    |
| 25             | UCB0TXIFG3 (I <sup>2</sup> C)                    | UCB0TXIFG3 (I <sup>2</sup> C)                    | UCB0TXIFG3 (I <sup>2</sup> C)                    | UCB1TXIFG3 (I <sup>2</sup> C)                    | UCB1TXIFG3 (I <sup>2</sup> C)                    | UCB1TXIFG3 (I <sup>2</sup> C)                    |
| 26             | ADC12 end of conversion                          | ADC12 end of conversion                          | ADC12 end of conversion                          | ADC12 end of conversion                          | ADC12 end of conversion                          | ADC12 end of conversion                          |
| 27             | LEA ready                                        | LEA ready                                        | LEA ready                                        | LEA ready                                        | LEA ready                                        | LEA ready                                        |
| 28             | Reserved                                         | Reserved                                         | Reserved                                         | Reserved                                         | Reserved                                         | Reserved                                         |
| 29             | MPY ready                                        | MPY ready                                        | MPY ready                                        | MPY ready                                        | MPY ready                                        | MPY ready                                        |
| 30             | DMA2IFG                                          | DMA0IFG                                          | DMA1IFG                                          | DMA5IFG                                          | DMA3IFG                                          | DMA4IFG                                          |
| 31             | DMAE0                                            | DMAE0                                            | DMAE0                                            | DMAE0                                            | DMAE0                                            | DMAE0                                            |

(1) If a reserved trigger source is selected, no trigger is generated.

### 9.13.9 Enhanced Universal Serial Communication Interface (eUSCI)

The eUSCI modules are used for serial data communication. The eUSCI module supports synchronous communication protocols such as SPI (3- or 4-pin) and I<sup>2</sup>C, and asynchronous communication protocols such as UART, enhanced UART with automatic baud-rate detection, and IrDA.

The eUSCI\_A0, eUSCI\_A1, eUSCI\_A2, and eUSCI\_A3 modules support SPI (3- or 4-pin), UART, enhanced UART, and IrDA.

The eUSCI\_B0 and eUSCI\_B1 modules support SPI (3- or 4-pin) and I<sup>2</sup>C.

Four eUSCI\_A modules and two eUSCI\_B modules are implemented.

#### 9.13.10 TA0, TA1, and TA4

TA0, TA1, and TA4 are 16-bit timers and counters (Timer\_A type) with three (TA0 and TA1) or two (TA4) capture/compare registers each. Each timer can support multiple captures or compares, PWM outputs, and interval timing (see 表 9-12, 表 9-13, and 表 9-14). Each timer has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each capture/compare register.

**Table 9-12. TA0 Signal Connections**

| INPUT PORT PIN   | DEVICE INPUT SIGNAL | MODULE INPUT SIGNAL | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL | OUTPUT PORT PIN                                              |
|------------------|---------------------|---------------------|--------------|----------------------|----------------------|--------------------------------------------------------------|
| P2.4, P4.5, P5.5 | TA0CLK              | TACLK               | Timer        | N/A                  | N/A                  |                                                              |
|                  | ACLK (internal)     | ACLK                |              |                      |                      |                                                              |
|                  | SMCLK (internal)    | SMCLK               |              |                      |                      |                                                              |
| P2.4, P4.5, P5.5 | TA0CLK              | INCLK               |              |                      |                      |                                                              |
| P2.3             | TA0.0               | CCI0A               | CCR0         | TA0                  | TA0.0                | P2.3                                                         |
| P2.7             | TA0.0               | CCI0B               |              |                      |                      | P2.7                                                         |
|                  | DVSS                | GND                 |              |                      |                      |                                                              |
|                  | DVCC                | V <sub>CC</sub>     |              |                      |                      |                                                              |
| P7.4             | TA0.1               | CCI1A               | CCR1         | TA1                  | TA0.1                | P7.4                                                         |
|                  | COUT (internal)     | CCI1B               |              |                      |                      | ADC12(internal) <sup>(1)</sup><br>ADC12SHSx = {1}            |
|                  | DVSS                | GND                 |              |                      |                      |                                                              |
|                  | DVCC                | V <sub>CC</sub>     |              |                      |                      |                                                              |
| P7.7             | TA0.2               | CCI2A               | CCR2         | TA2                  | TA0.2                | P7.7                                                         |
|                  | ACLK (internal)     | CCI2B               |              |                      |                      | UUPS Trigger<br>(USSPWRUP)<br>UUPS.CTL.USSPWRU<br>PSEL = {2} |
|                  | DVSS                | GND                 |              |                      |                      |                                                              |
|                  | DVCC                | V <sub>CC</sub>     |              |                      |                      |                                                              |

(1) Only on devices with ADC.

**Table 9-13. TA1 Signal Connections**

| INPUT PORT PIN | DEVICE INPUT SIGNAL | MODULE INPUT SIGNAL | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL | OUTPUT PORT PIN                                        |
|----------------|---------------------|---------------------|--------------|----------------------|----------------------|--------------------------------------------------------|
| P2.4, P4.5     | TA1CLK              | TACLK               | Timer        | N/A                  | N/A                  |                                                        |
|                | ACLK (internal)     | ACLK                |              |                      |                      |                                                        |
|                | SMCLK (internal)    | SMCLK               |              |                      |                      |                                                        |
| P2.4, P4.5     | TA1CLK              | INCLK               |              |                      |                      |                                                        |
| P1.0           | TA1.0               | CCI0A               | CCR0         | TA0                  | TA1.0                | P1.0                                                   |
| P9.0           | TA1.0               | CCI0B               |              |                      |                      | P9.0                                                   |
|                | DVSS                | GND                 |              |                      |                      |                                                        |
|                | DVCC                | V <sub>CC</sub>     |              |                      |                      |                                                        |
| P7.5           | TA1.1               | CCI1A               | CCR1         | TA1                  | TA1.1                | P7.5                                                   |
|                | COUT (internal)     | CCI1B               |              |                      |                      | ADC12(internal) <sup>(1)</sup><br>ADC12SHSx = {4}      |
|                | DVSS                | GND                 |              |                      |                      |                                                        |
|                | DVCC                | V <sub>CC</sub>     |              |                      |                      |                                                        |
| P8.4           | TA1.2               | CCI2A               | CCR2         | TA2                  | TA1.2                | P8.4                                                   |
|                | ACLK (internal)     | CCI2B               |              |                      |                      | ASQ Trigger (ASQTRIG)<br>SAPH.ASCTL0.TRIGS<br>EL = {2} |
|                | DVSS                | GND                 |              |                      |                      |                                                        |
|                | DVCC                | V <sub>CC</sub>     |              |                      |                      |                                                        |

(1) Only on devices with ADC.

**Table 9-14. TA4 Signal Connections**

| INPUT PORT PIN | DEVICE INPUT SIGNAL | MODULE INPUT SIGNAL | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL | OUTPUT PORT PIN                                   |
|----------------|---------------------|---------------------|--------------|----------------------|----------------------|---------------------------------------------------|
| PJ.1, P4.6     | TA4CLK              | TACLK               | Timer        | N/A                  | N/A                  |                                                   |
|                | ACLK (internal)     | ACLK                |              |                      |                      |                                                   |
|                | SMCLK (internal)    | SMCLK               |              |                      |                      |                                                   |
| PJ.1, P4.6     | TA4CLK              | INCLK               |              |                      |                      |                                                   |
| P1.1           | TA4.0               | CCI0A               | CCR0         | TA0                  | TA4.0                | P1.1                                              |
| P2.5           | TA4.0               | CCI0B               |              |                      |                      | P2.5                                              |
|                | DVSS                | GND                 |              |                      |                      |                                                   |
|                | DVCC                | V <sub>CC</sub>     |              |                      |                      |                                                   |
| P7.6           | TA4.1               | CCI1A               | CCR1         | TA1                  | TA4.1                | P7.6                                              |
| P2.6           | TA4.1               | CCI1B               |              |                      |                      | P2.6                                              |
|                | DVSS                | GND                 |              |                      |                      | ADC12(internal) <sup>(1)</sup><br>ADC12SHSx = {7} |
|                | DVCC                | V <sub>CC</sub>     |              |                      |                      |                                                   |



### 9.13.11 TA2 and TA3

TA2 and TA3 are 16-bit timers and counters (Timer\_A type) with two capture/compare registers each and with internal connections only. Each timer can support multiple captures or compares, PWM outputs, and interval timing (see 表 9-15 and 表 9-16). Each timer has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each capture/compare register.

**Table 9-15. TA2 Signal Connections**

| DEVICE INPUT SIGNAL        | MODULE INPUT NAME | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL                            |
|----------------------------|-------------------|--------------|----------------------|-------------------------------------------------|
| COUT (internal)            | TACLK             | Timer        | N/A                  |                                                 |
| ACLK (internal)            | ACLK              |              |                      |                                                 |
| SMCLK (internal)           | SMCLK             |              |                      |                                                 |
| Reserved                   | INCLK             |              |                      |                                                 |
| TA3 CCR0 output (internal) | CCIOA             | CCR0         | TA0                  | TA3 CCI0A input                                 |
| ACLK (internal)            | CCIOB             |              |                      |                                                 |
| DVSS                       | GND               |              |                      |                                                 |
| DVCC                       | V <sub>CC</sub>   |              |                      |                                                 |
| Reserved                   | CCI1A             | CCR1         | TA1                  | ADC12 (internal)<br>ADC12SHSx = {5}             |
| COUT (internal)            | CCI1B             |              |                      | PPG Trigger (PPGTRIG)<br>SAPH.PGCTL.TRSEL = {2} |
| DVSS                       | GND               |              |                      |                                                 |
| DVCC                       | V <sub>CC</sub>   |              |                      |                                                 |

**Table 9-16. TA3 Signal Connections**

| DEVICE INPUT SIGNAL        | MODULE INPUT NAME | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL                |
|----------------------------|-------------------|--------------|----------------------|-------------------------------------|
| COUT (internal)            | TACLK             | Timer        | N/A                  |                                     |
| ACLK (internal)            | ACLK              |              |                      |                                     |
| SMCLK (internal)           | SMCLK             |              |                      |                                     |
| Reserved                   | INCLK             |              |                      |                                     |
| TA2 CCR0 output (internal) | CCIOA             | CCR0         | TA0                  | TA2 CCI0A input                     |
| ACLK (internal)            | CCIOB             |              |                      |                                     |
| DVSS                       | GND               |              |                      |                                     |
| DVCC                       | V <sub>CC</sub>   |              |                      |                                     |
| Reserved                   | CCI1A             | CCR1         | TA1                  | ADC12 (internal)<br>ADC12SHSx = {6} |
| COUT (internal)            | CCI1B             |              |                      |                                     |
| DVSS                       | GND               |              |                      |                                     |
| DVCC                       | V <sub>CC</sub>   |              |                      |                                     |

### 9.13.12 TB0

TB0 is a 16-bit timer and counter (Timer\_B type) with seven capture/compare registers. TB0 can support multiple captures or compares, PWM outputs, and interval timing (see 表 9-17). TB0 has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each capture/compare register.

**Table 9-17. TB0 Signal Connections**

| INPUT PORT PIN | DEVICE INPUT SIGNAL         | MODULE INPUT SIGNAL | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL | OUTPUT PORT PIN                     |
|----------------|-----------------------------|---------------------|--------------|----------------------|----------------------|-------------------------------------|
| P2.4, P4.6     | TB0CLK                      | TBCLK               | Timer        | N/A                  | N/A                  |                                     |
|                | ACLK (internal)             | ACLK                |              |                      |                      |                                     |
|                | SMCLK (internal)            | SMCLK               |              |                      |                      |                                     |
| P2.4, P4.6     | $\overline{\text{TB0CLK}}$  | INCLK               |              |                      |                      |                                     |
| P7.2           | TB0.0                       | CCI0A               | CCR0         | TB0                  | TB0.0                | P7.2                                |
| P3.0           | TB0.0                       | CCI0B               |              |                      |                      | P3.0                                |
|                | DVSS                        | GND                 |              |                      |                      | ADC12 (internal)<br>ADC12SHSx = {2} |
|                | DVCC                        | V <sub>CC</sub>     |              |                      |                      |                                     |
| P7.3           | TB0.1                       | CCI1A               | CCR1         | TB1                  | TB0.1                | P7.3                                |
|                | COU <sub>T</sub> (internal) | CCI1B               |              |                      |                      | P3.1                                |
|                | DVSS                        | GND                 |              |                      |                      | ADC12 (internal)<br>ADC12SHSx = {3} |
|                | DVCC                        | V <sub>CC</sub>     |              |                      |                      |                                     |
| P8.0           | TB0.2                       | CCI2A               | CCR2         | TB2                  | TB0.2                | P8.0                                |
|                | ACLK (internal)             | CCI2B               |              |                      |                      | P3.2                                |
|                | DVSS                        | GND                 |              |                      |                      |                                     |
|                | DVCC                        | V <sub>CC</sub>     |              |                      |                      |                                     |
| P8.1           | TB0.3                       | CCI3A               | CCR3         | TB3                  | TB0.3                | P8.1                                |
| P3.3           | TB0.3                       | CCI3B               |              |                      |                      | P3.3                                |
|                | DVSS                        | GND                 |              |                      |                      |                                     |
|                | DVCC                        | V <sub>CC</sub>     |              |                      |                      |                                     |
| P1.4           | TB0.4                       | CCI4A               | CCR4         | TB4                  | TB0.4                | P1.4                                |
| P3.5           | TB0.4                       | CCI4B               |              |                      |                      | P3.5                                |
|                | DVSS                        | GND                 |              |                      |                      |                                     |
|                | DVCC                        | V <sub>CC</sub>     |              |                      |                      |                                     |
| P1.5           | TB0.5                       | CCI5A               | CCR5         | TB5                  | TB0.5                | P1.5                                |
| P3.6           | TB0.5                       | CCI5B               |              |                      |                      | P3.6                                |
|                | DVSS                        | GND                 |              |                      |                      |                                     |
|                | DVCC                        | V <sub>CC</sub>     |              |                      |                      |                                     |
| PJ.3           | TB0.6                       | CCI6A               | CCR6         | TB6                  | TB0.6                | PJ.3                                |
| P3.7           | TB0.6                       | CCI6B               |              |                      |                      | P3.7                                |
|                | DVSS                        | GND                 |              |                      |                      |                                     |
|                | DVCC                        | V <sub>CC</sub>     |              |                      |                      |                                     |

### 9.13.13 ADC12\_B

The ADC12\_B module supports fast 12-bit analog-to-digital conversions with differential and single-ended inputs. The module implements a 12-bit SAR core, sample select control, a reference generator, and a conversion result buffer. A window comparator with lower and upper limits allows CPU-independent result monitoring with three window comparator interrupt flags.

表 9-18 lists the external trigger sources.

表 9-19 lists the available multiplexing between internal and external analog inputs.

**Table 9-18. ADC12\_B Trigger Signal Connections**

| ADC12SHSx |         | CONNECTED TRIGGER SOURCE |
|-----------|---------|--------------------------|
| BINARY    | DECIMAL |                          |
| 000       | 0       | Software (ADC12SC)       |
| 001       | 1       | TA0 CCR1 output          |
| 010       | 2       | TB0 CCR0 output          |
| 011       | 3       | TB0 CCR1 output          |
| 100       | 4       | TA1 CCR1 output          |
| 101       | 5       | TA2 CCR1 output          |
| 110       | 6       | TA3 CCR1 output          |
| 111       | 7       | TA4 CCR1 output          |

**Table 9-19. ADC12\_B External and Internal Signal Mapping**

| CONTROL BIT IN ADC12CTL3 REGISTER | EXTERNAL ADC INPUT (CONTROL BIT = 0) | INTERNAL ADC INPUT (CONTROL BIT = 1) |
|-----------------------------------|--------------------------------------|--------------------------------------|
| ADC12BATMAP                       | A31                                  | Battery monitor                      |
| ADC12TCMAP                        | A30                                  | Temperature sensor                   |
| ADC12CH0MAP                       | A29                                  | N/A <sup>(1)</sup>                   |
| ADC12CH1MAP                       | A28                                  | N/A <sup>(1)</sup>                   |
| ADC12CH2MAP                       | A27                                  | N/A <sup>(1)</sup>                   |
| ADC12CH3MAP                       | A26                                  | N/A <sup>(1)</sup>                   |

(1) N/A = No internal signal is available on this device.

### 9.13.14 USS

表 9-20 lists the available UUPS triggers.

**Table 9-20. UUPS Trigger Signal Connections**

| UUPS.CTL.USSPWRUPSEL | CONNECTED TRIGGER SOURCE           |
|----------------------|------------------------------------|
| BINARY               |                                    |
| 00                   | Software (UUPS.CTL.USSPWRUP)       |
| 01                   | RTC (any enabled interrupt events) |
| 10                   | TA0 CCR2 output                    |
| 11                   | P1.7                               |

表 9-21 lists the available PPG triggers.

**Table 9-21. PPG Trigger Signal Connections**

| SAPH.PGCTL.TRSEL | CONNECTED TRIGGER SOURCE        |
|------------------|---------------------------------|
| BINARY           |                                 |
| 00               | Software (SAPH.PPGTRIG.PPGTRIG) |
| 01               | ASQ (Acquisition Sequencer)     |
| 10               | TA2 CCR1 output                 |
| 11               | Reserved                        |

表 9-22 lists the available ASQ triggers.

**Table 9-22. ASQ Trigger Signal Connections**

| SAPH.ASCTL0.TRIGSEL | CONNECTED TRIGGER SOURCE        |
|---------------------|---------------------------------|
| BINARY              |                                 |
| 00                  | Software (SAPH.ASQTRIG.ASQTRIG) |
| 01                  | PSQ (Power Sequencer)           |
| 10                  | TA1 CCR2 output                 |
| 11                  | Reserved                        |

### 9.13.15 Comparator\_E

The primary function of the Comparator\_E module is to support precision slope analog-to-digital conversions, battery voltage supervision, and monitoring of external analog signals.

### 9.13.16 CRC16

The CRC16 module produces a signature based on a sequence of entered data values and can be used for data checking purposes. The CRC16 module signature is based on the CRC-CCITT standard.

### 9.13.17 CRC32

The CRC32 module produces a signature based on a sequence of entered data values and can be used for data checking purposes. The CRC32 module signature is based on the ISO 3309 standard.

### 9.13.18 AES256 Accelerator

The AES accelerator module performs encryption and decryption of 128-bit data with 128-, 192-, or 256-bit keys according to the Advanced Encryption Standard (AES) (FIPS PUB 197) in hardware.

### 9.13.19 True Random Seed

The device descriptor information (TLV) section contains a 128-bit true random seed that can be used to implement a deterministic random number generator.

### 9.13.20 Shared Reference (REF)

The REF module generates critical reference voltages that can be used by the various analog peripherals in the device.

### 9.13.21 LCD\_C

The LCD\_C driver generates the segment and common signals required to drive a liquid crystal display (LCD). The LCD\_C controller has dedicated data memories to hold segment drive information. Common and segment signals are generated as defined by the mode. Static and 2-mux to 8-mux LCDs are supported. The module can provide an LCD voltage independent of the supply voltage with its integrated charge pump. It is possible to control the level of the LCD voltage and thus contrast by software. The module also provides an automatic blinking capability for individual segments in static, 2-, 3-, and 4-mux modes.

To reduce system noise, the charge pump can be temporarily disabled. 表 9-23 lists the available automatic charge pump disable options.

**Table 9-23. LCD Automatic Charge Pump Disable Bits (LCDCPDISx)**

| CONTROL BIT          | DESCRIPTION                                                                                                                                                                             |
|----------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| LDCPDISO             | LCD charge pump disable during ADC12 conversion<br>0b = LCD charge pump not automatically disabled during conversion.<br>1b = LCD charge pump automatically disabled during conversion. |
| LDCPDIS1 to LDCPDIS7 | No functionality.                                                                                                                                                                       |

### 9.13.22 Embedded Emulation

#### 9.13.22.1 Embedded Emulation Module (EEM) (S Version)

The EEM supports real-time in-system debugging. The S version of the EEM has the following features:

- Three hardware triggers or breakpoints on memory access
- One hardware trigger or breakpoint on CPU register write access
- Up to four hardware triggers that can be combined to form complex triggers or breakpoints
- One cycle counter
- Clock control on module level

#### 9.13.22.2 EnergyTrace++ Technology

The devices implement circuitry to support EnergyTrace++ technology. The EnergyTrace++ technology lets the user observe information about the internal states of the microcontroller. These states include the CPU Program Counter (PC), the on or off status of the peripherals and system clocks (regardless of the clock source), and the low-power mode currently in use. These states can always be read by a debug tool, even when the microcontroller sleeps in LPMx.5 modes.

The activity of the following modules can be observed:

- LEA is running
- MPY is calculating.
- WDT is counting.
- RTC is counting.
- ADC: a sequence, sample, or conversion is active.
- REF: REFBG or REFGEN active and BG in static mode.
- COMP is on.
- AES is encrypting or decrypting.
- eUSCI\_A0 is transferring (receiving or transmitting) data.
- eUSCI\_A1 is transferring (receiving or transmitting) data.
- eUSCI\_A2 is transferring (receiving or transmitting) data.
- eUSCI\_A3 is transferring (receiving or transmitting) data.
- eUSCI\_B0 is transferring (receiving or transmitting) data.

- eUSCI\_B1 is transferring (receiving or transmitting) data.
- TB0 is counting.
- TA0 is counting.
- TA1 is counting.
- TA2 is counting.
- TA3 is counting.
- TA4 is counting.
- LCD\_C is running.
- USS status

## 9.14 Input/Output Diagrams

### 9.14.1 Port Function Select Registers (PySEL1 , PySEL0)

Port pins are multiplexed with peripheral module functions as described in the [MSP430FR58xx, MSP430FR59xx, and MSP430FR6xx Family User's Guide](#). The functions of each port pin are controlled by its port function select registers, PySEL1 and PySEL0, where y = port number. The bits in the registers are mapped to the pins in the port. The primary module function, secondary module function, and tertiary module function of the pins are determined by the configuration of the PySEL1.x and PySEL0.x bits (see [表 9-24](#)). For example, P1SEL1.0 and P1SEL0.0 determine the primary module function, secondary module function, and tertiary module function of the P1.0 pin, which is in port 1. The module functions may also require the PxDIR bits to be configured according to the direction needed for the module function.

**Table 9-24. I/O Function Selection**

| I/O FUNCTIONS                         | PySEL1.x | PySEL0.x |
|---------------------------------------|----------|----------|
| General-purpose I/O is selected       | 0        | 0        |
| Primary module function is selected   | 0        | 1        |
| Secondary module function is selected | 1        | 0        |
| Tertiary module function is selected  | 1        | 1        |

See the port pin function tables in the following sections for the configurations of the function and direction for each pin.

### 9.14.2 Port P1 (P1.0 and P1.1) Input/Output With Schmitt Trigger

图 9-3 shows the port diagram. 表 9-25 summarizes the selection of the pin function.

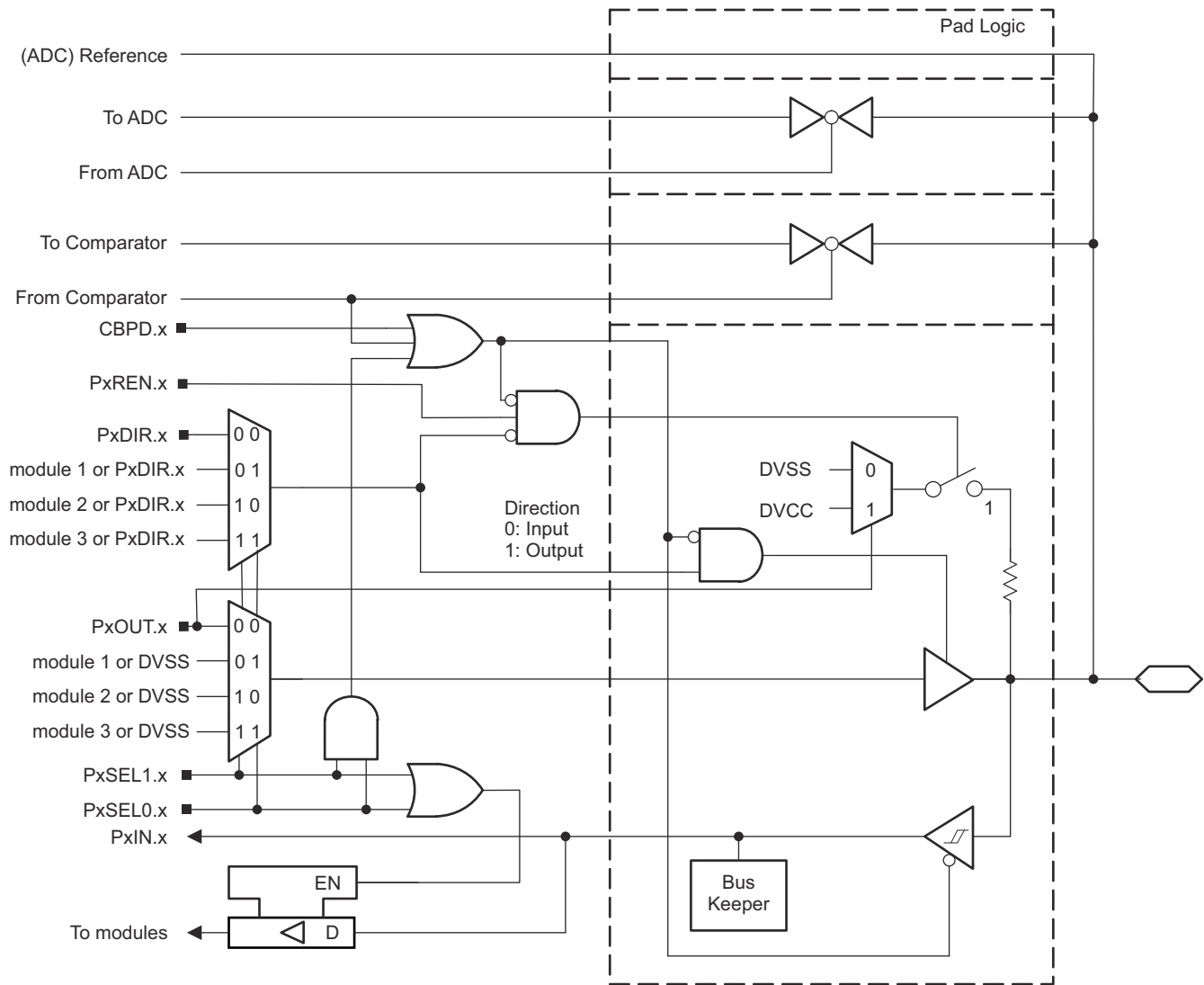


图 9-3. Port P1 (P1.0 to P1.1) Diagram



**Table 9-25. Port P1 (P1.0 to P1.1) Pin Functions**

| PIN NAME (P1.x)                            | x | FUNCTION                                 | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |
|--------------------------------------------|---|------------------------------------------|-----------------------------------------|----------|----------|
|                                            |   |                                          | P1DIR.x                                 | P1SEL1.x | P1SEL0.x |
| P1.0/UCA1CLK/TA1.0/A0/C0/ VREF-/<br>VeREF- | 0 | P1.0 (I/O)                               | 0 = Input,<br>1 = Output                | 0        | 0        |
|                                            |   | UCA1CLK                                  | X <sup>(4)</sup>                        | 0        | 1        |
|                                            |   | TA1.CCI0A                                | 0                                       | 1        | 0        |
|                                            |   | TA1.0                                    | 1                                       |          |          |
|                                            |   | A0, C0, VREF-, VeREF- <sup>(2) (3)</sup> | X                                       | 1        | 1        |
| P1.1/UCA1STE/TA4.0/A1/C1/ VREF+/<br>VeREF+ | 1 | P1.1 (I/O)                               | 0 = Input,<br>1 = Output                | 0        | 0        |
|                                            |   | UCA1STE                                  | X <sup>(4)</sup>                        | 0        | 1        |
|                                            |   | TA4.CCI0A                                | 0                                       | 1        | 0        |
|                                            |   | TA4.0                                    | 1                                       |          |          |
|                                            |   | A1, C1, VREF+, VeREF+ <sup>(2) (3)</sup> | X                                       | 1        | 1        |

(1) X = Don't care

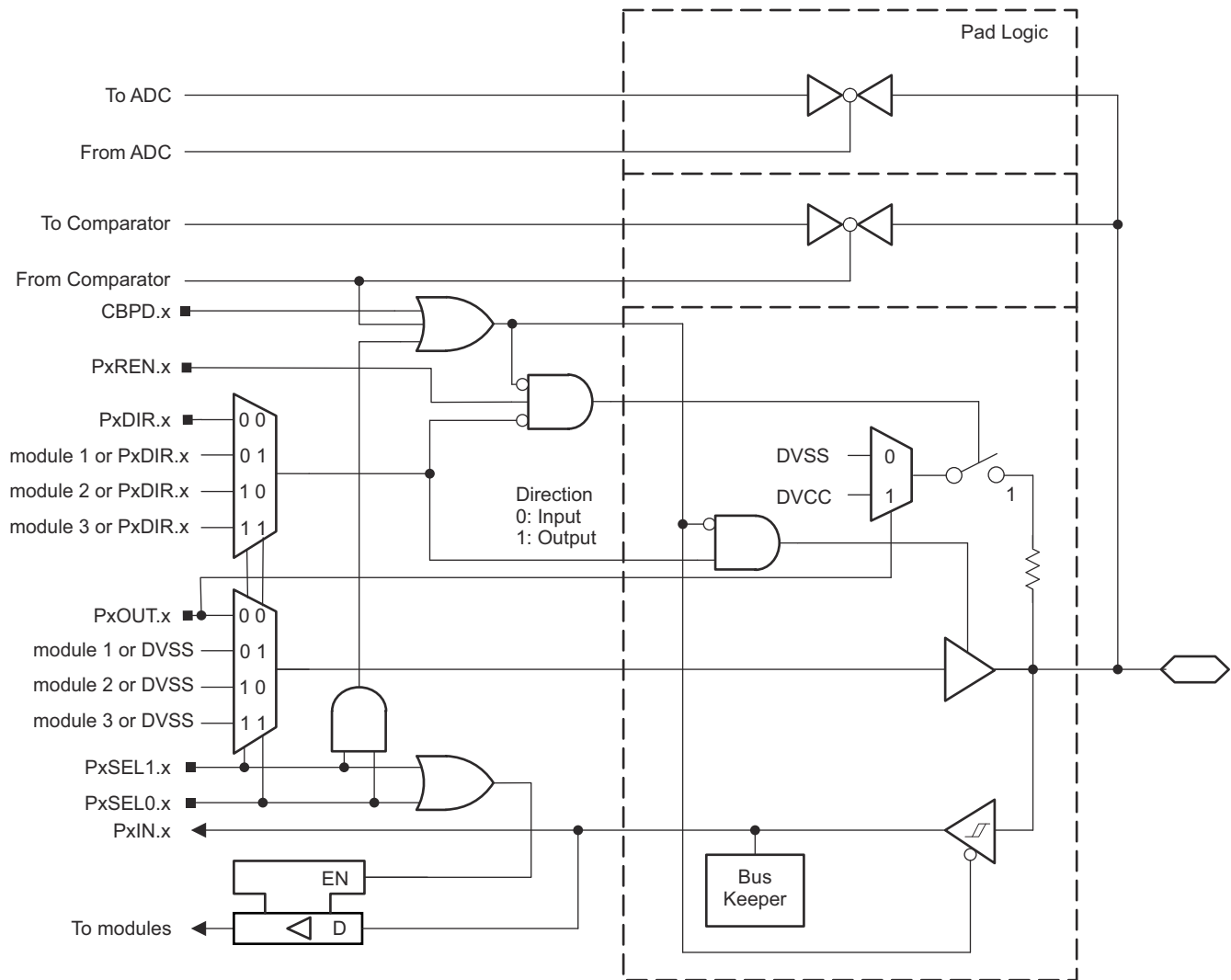
(2) Setting P1SEL1.x and P1SEL0.x disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals.

(3) Setting the CEPDx bit of the comparator disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals. Selecting the Cx input pin to the comparator multiplexer with the input select bits in the comparator module automatically disables output driver and input buffer for that pin, regardless of the state of the associated CEPDx bit.

(4) Direction controlled by eUSCI\_A1 module.

### 9.14.3 Port P1 (P1.2 to P1.7) Input/Output With Schmitt Trigger

图 9-4 shows the port diagram. 表 9-26 summarizes the selection of the pin function.



Functional representation only.

图 9-4. Port P1 (P1.2 to P1.7) Diagram

**Table 9-26. Port P1 (P1.2 to P1.7) Pin Functions**

| PIN NAME (P1.x)                    | x | FUNCTION                      | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |
|------------------------------------|---|-------------------------------|-----------------------------------------|----------|----------|
|                                    |   |                               | P1DIR.x                                 | P1SEL1.x | P1SEL0.x |
| P1.2/UCA1SIMO/UCA1TXD/A8/C8        | 2 | P1.2 (I/O)                    | 0 = Input,<br>1 = Output                | 0        | 0        |
|                                    |   | UCA1SIMO/UCA1TXD              | X <sup>(2)</sup>                        | 0        | 1        |
|                                    |   | N/A                           | 0                                       | 1        | 0        |
|                                    |   | Internally tied to DVSS       | 1                                       |          |          |
|                                    |   | A8, C8 <sup>(3) (4)</sup>     | X                                       | 1        | 1        |
| P1.3/UCA1SOMI/UCA1RXD/A9/C9        | 3 | P1.3 (I/O)                    | 0 = Input,<br>1 = Output                | 0        | 0        |
|                                    |   | UCA1SOMI/UCA1RXD              | X <sup>(2)</sup>                        | 0        | 1        |
|                                    |   | N/A                           | 0                                       | 1        | 0        |
|                                    |   | Internally tied to DVSS       | 1                                       |          |          |
|                                    |   | A9, C9 <sup>(3) (4)</sup>     | X                                       | 1        | 1        |
| P1.4/TB0.4/UCB0STE/A2/C2           | 4 | P1.4 (I/O)                    | 0 = Input,<br>1 = Output                | 0        | 0        |
|                                    |   | TB0.CCI4A                     | 0                                       | 0        | 1        |
|                                    |   | TB0.4                         | 1                                       |          |          |
|                                    |   | UCB0STE                       | X <sup>(1)</sup>                        | 1        | 0        |
|                                    |   | A2, C2 <sup>(3) (4)</sup>     | X                                       | 1        | 1        |
| P1.5/TB0.5/UCB0CLK/A3/C3           | 5 | P1.5 (I/O)                    | 0 = Input,<br>1 = Output                | 0        | 0        |
|                                    |   | TB0.CCI5A                     | 0                                       | 0        | 1        |
|                                    |   | TB0.5                         | 1                                       |          |          |
|                                    |   | UCB0CLK                       | X <sup>(1)</sup>                        | 1        | 0        |
|                                    |   | A3, C3 <sup>(3) (4)</sup>     | X                                       | 1        | 1        |
| P1.6/UCB0SIMO/UCB0SDA/A4/C4        | 6 | P1.6 (I/O)                    | 0 = Input,<br>1 = Output                | 0        | 0        |
|                                    |   | N/A                           | 0                                       | 0        | 1        |
|                                    |   | Internally tied to DVSS       | 1                                       |          |          |
|                                    |   | UCB0SIMO/UCB0SDA              | X <sup>(1)</sup>                        | 1        | 0        |
|                                    |   | A4, C4 <sup>(3) (4)</sup>     | X                                       | 1        | 1        |
| P1.7/USSTRG/UCB0SOMI/UCB0SCL/A5/C5 | 7 | P1.7 (I/O)                    | 0 = Input,<br>1 = Output                | 0        | 0        |
|                                    |   | USSTRG (independent function) | 0                                       | X        | 1        |
|                                    |   | Internally tied to DVSS       | 1                                       | 1        | X        |
|                                    |   | UCB0SOMI/UCB0SCL              | X <sup>(1)</sup>                        | 0        | 1        |
|                                    |   | A5, C5 <sup>(3) (4)</sup>     | X                                       | 1        | 0        |
|                                    |   |                               | X                                       | 1        | 1        |

(1) Direction controlled by eUSCI\_B0 module.

(2) Direction controlled by eUSCI\_A1 module.

(3) Setting P1SEL1.x and P1SEL0.x disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals.

(4) Setting the CEPDx bit of the comparator disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals. Selecting the Cx input pin to the comparator multiplexer with the input select bits in the comparator module automatically disables output driver and input buffer for that pin, regardless of the state of the associated CEPDx bit.

#### 9.14.4 Port P2 (P2.0 to P2.3) Input/Output With Schmitt Trigger

图 9-5 shows the port diagram. 表 9-27 summarizes the selection of the pin function.

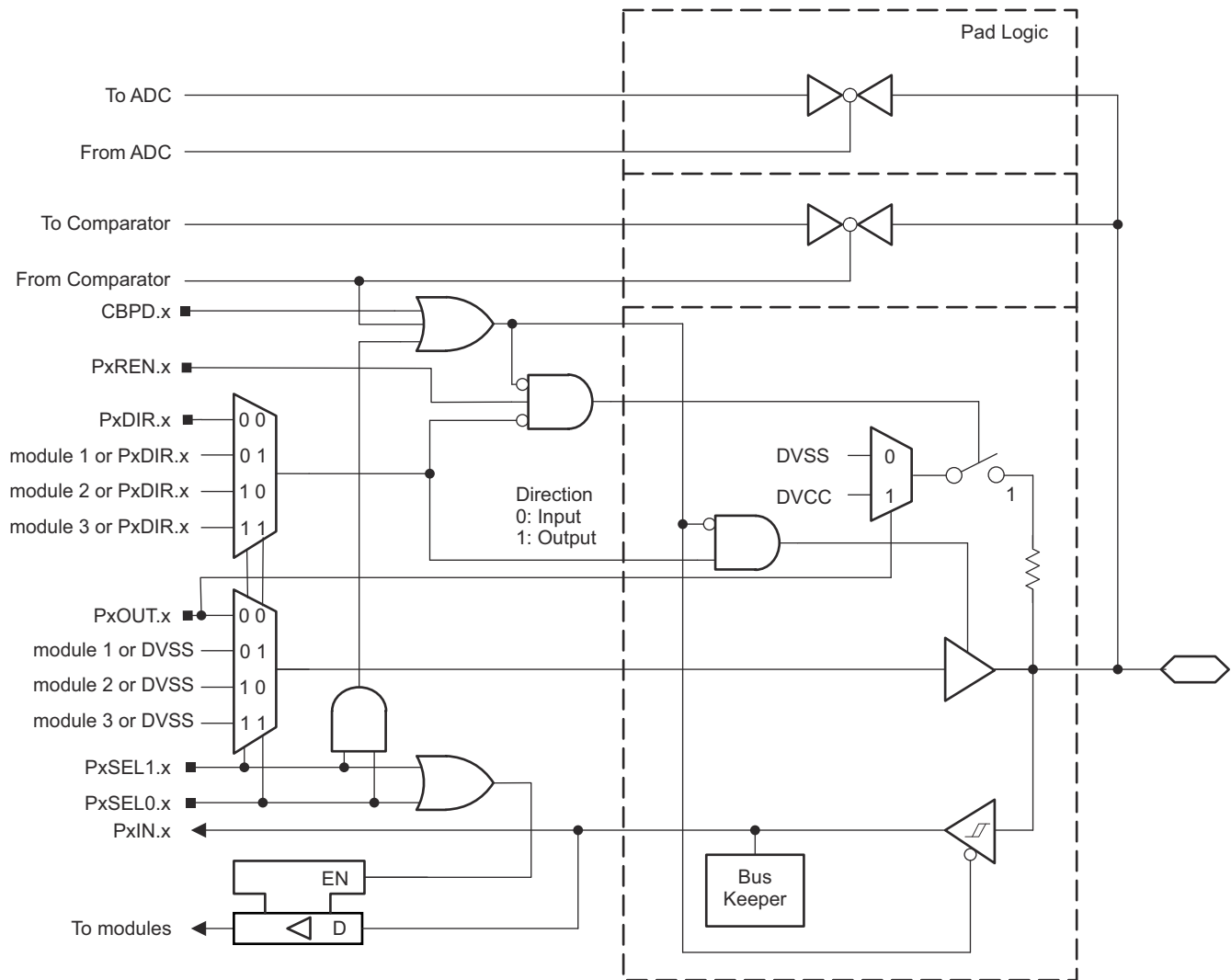


图 9-5. Port P2 (P2.0 to P2.3) Diagram

**Table 9-27. Port P2 (P2.0 to P2.3) Pin Functions**

| PIN NAME (P2.x)             | x | FUNCTION                    | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |
|-----------------------------|---|-----------------------------|-----------------------------------------|----------|----------|
|                             |   |                             | P2DIR.x                                 | P2SEL1.x | P2SEL0.x |
| P2.0/UCA0SIMO/UCA0TXD/A6/C6 | 0 | P2.0 (I/O)                  | 0 = Input,<br>1 = Output                | 0        | 0        |
|                             |   | N/A                         | 0                                       | 0        | 1        |
|                             |   | Internally tied to DVSS     | 1                                       |          |          |
|                             |   | UCA0SIMO/UCA0TXD            | X <sup>(1)</sup>                        | 1        | 0        |
|                             |   | A6, C6 <sup>(2) (3)</sup>   | X                                       | 1        | 1        |
| P2.1/UCA0SOMI/UCA0RXD/A7/C7 | 1 | P2.1 (I/O)                  | 0 = Input,<br>1 = Output                | 0        | 0        |
|                             |   | N/A                         | 0                                       | 0        | 1        |
|                             |   | Internally tied to DVSS     | 1                                       |          |          |
|                             |   | UCA0SOMI/UCA0RXD            | X <sup>(1)</sup>                        | 1        | 0        |
|                             |   | A7, C7 <sup>(2) (3)</sup>   | X                                       | 1        | 1        |
| P2.2/COU0/UCA0CLK/A14/C14   | 2 | P2.2 (I/O)                  | 0 = Input,<br>1 = Output                | 0        | 0        |
|                             |   | N/A                         | 0                                       | 0        | 1        |
|                             |   | COU0                        | 1                                       |          |          |
|                             |   | UCA0CLK                     | X <sup>(1)</sup>                        | 1        | 0        |
|                             |   | A14, C14 <sup>(2) (3)</sup> | X                                       | 1        | 1        |
| P2.3/TA0.0/UCA0STE/A15/C15  | 3 | P2.3(I/O)                   | 0 = Input,<br>1 = Output                | 0        | 0        |
|                             |   | TA0.CCI0A                   | 0                                       | 0        | 1        |
|                             |   | TA0.0                       | 1                                       |          |          |
|                             |   | UCA0STE                     | X <sup>(1)</sup>                        | 1        | 0        |
|                             |   | A15, C15 <sup>(2) (3)</sup> | X                                       | 1        | 1        |

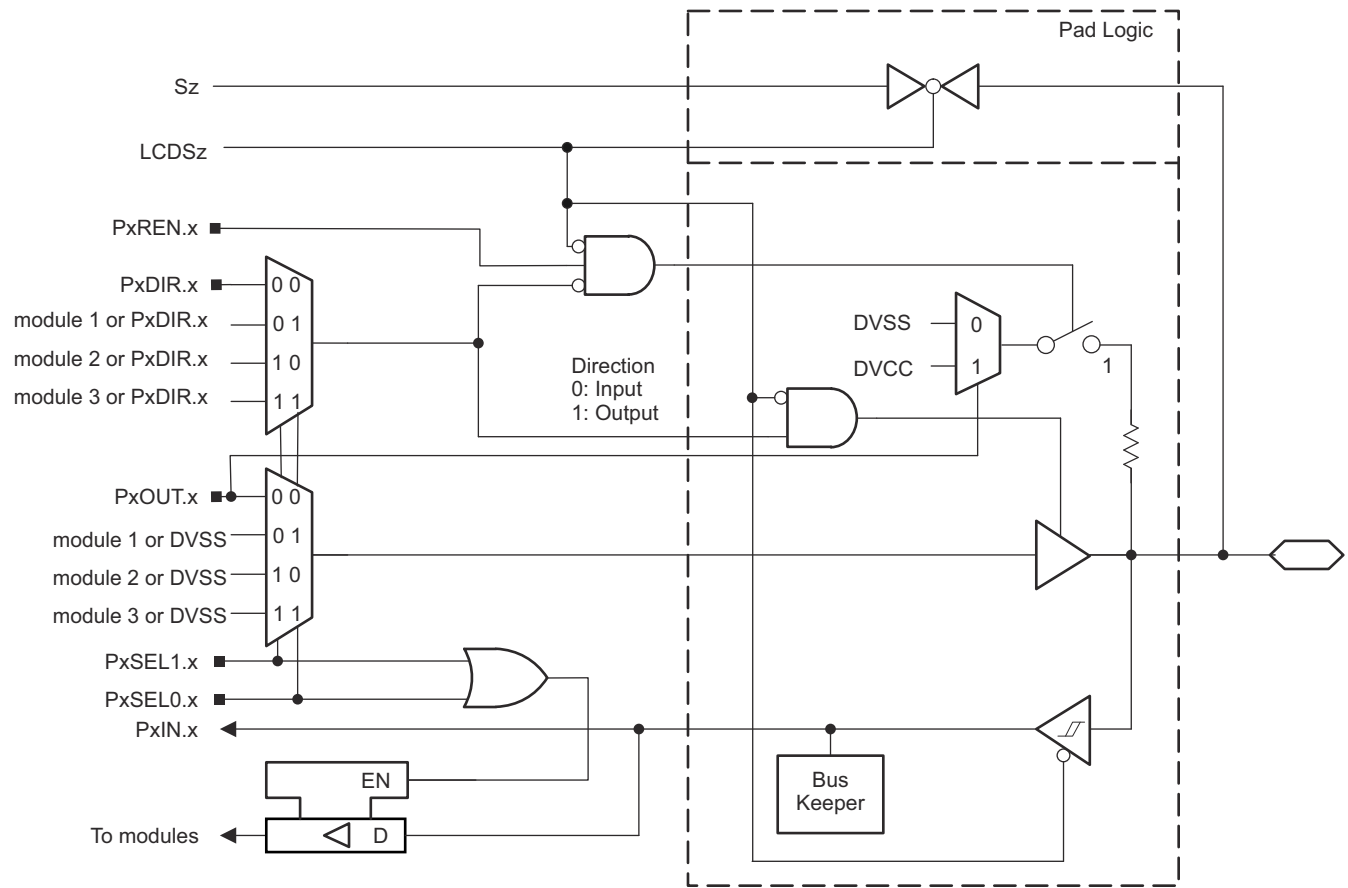
(1) Direction controlled by eUSCI\_A0 module.

(2) Setting P2SEL1.x and P2SEL0.x disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals.

(3) Setting the CEPDx bit of the comparator disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals. Selecting the Cx input pin to the comparator multiplexer with the input select bits in the comparator module automatically disables output driver and input buffer for that pin, regardless of the state of the associated CEPDx bit.

### 9.14.5 Port P2 (P2.4 to P2.7) Input/Output With Schmitt Trigger

图 9-6 shows the port diagram. 表 9-28 summarizes the selection of the pin function.



Functional representation only.

图 9-6. Port P2 (P2.4 to P2.7) Diagram

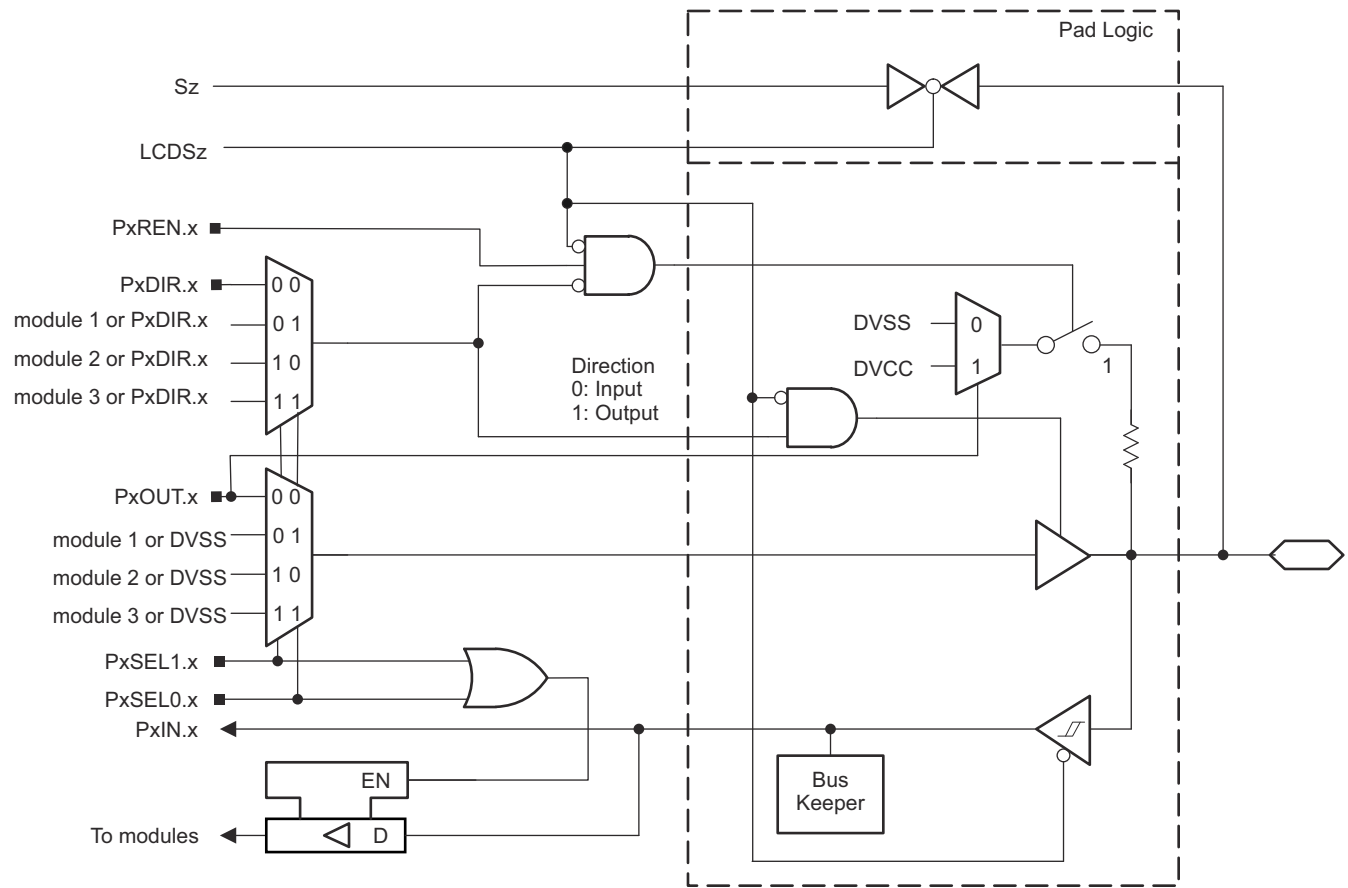
**Table 9-28. Port P2 (P2.4 to P2.7) Pin Functions**

| PIN NAME (P2.x)                  | x | FUNCTION                | CONTROL BITS OR SIGNALS <sup>(1)</sup> |          |          |       |
|----------------------------------|---|-------------------------|----------------------------------------|----------|----------|-------|
|                                  |   |                         | P2DIR.x                                | P2SEL1.x | P2SEL0.x | LCDSz |
| P2.4/TA0LCK/TB0CLK/TA1CLK/LCDS32 | 4 | P2.4 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                                  |   | TA0LCK                  | 0                                      | 0        | 1        | 0     |
|                                  |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                  |   | TB0LCK                  | 0                                      | 1        | 0        | 0     |
|                                  |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                  |   | TA1LCK                  | 0                                      | 1        | 1        | 0     |
|                                  |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                  |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P2.5/TA4.0/LCDS31                | 5 | P2.5 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                                  |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                                  |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                  |   | TA4.CCI0B               | 0                                      | 1        | 0        | 0     |
|                                  |   | TA4.0                   | 1                                      |          |          |       |
|                                  |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                                  |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                  |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P2.6/TA4.1/LCDS30                | 6 | P2.6 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                                  |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                                  |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                  |   | TA4.CCI1B               | 0                                      | 1        | 0        | 0     |
|                                  |   | TA4.1                   | 1                                      |          |          |       |
|                                  |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                                  |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                  |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P2.7/TA0.0/LCDS21                | 7 | P2.7 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                                  |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                                  |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                  |   | TA0.CCI0B               | 0                                      | 1        | 0        | 0     |
|                                  |   | TA0.0                   | 1                                      |          |          |       |
|                                  |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                                  |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                  |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |

(1) Associated LCD segment is package dependent. Refer to the pin diagrams and signal descriptions in [节 7](#).

### 9.14.6 Port P3 (P3.0 to P3.7) Input/Output With Schmitt Trigger

图 9-7 shows the port diagram. 表 9-29 summarizes the selection of the pin function.



Functional representation only.

图 9-7. Port P3 (P3.0 to P3.7) Diagram



**Table 9-29. Port P3 (P3.0 to P3.7) Pin Functions**

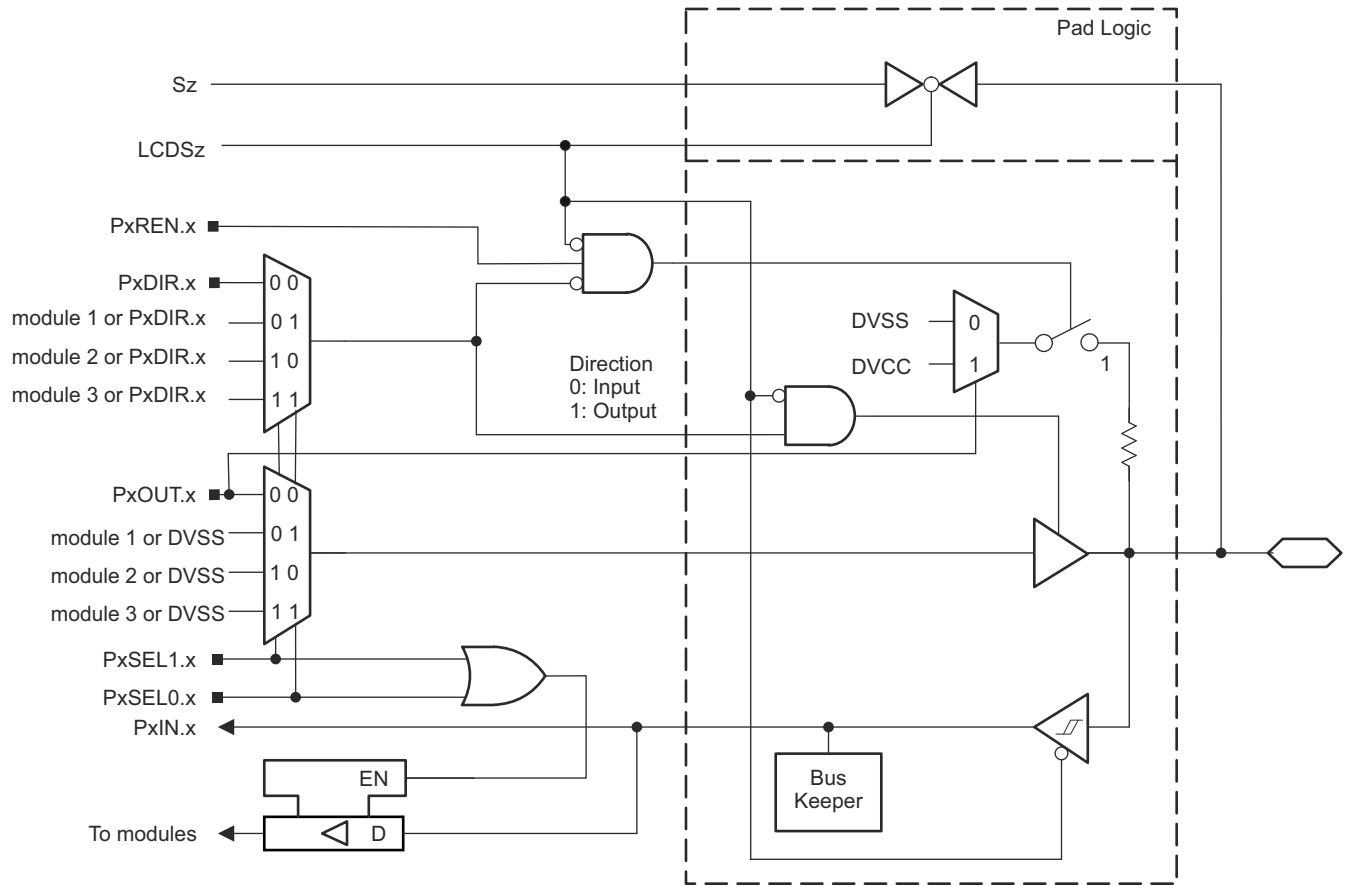
| PIN NAME (P3.x)     | x | FUNCTION                | CONTROL BITS OR SIGNALS <sup>(1)</sup> |          |          |       |
|---------------------|---|-------------------------|----------------------------------------|----------|----------|-------|
|                     |   |                         | P3DIR.x                                | P3SEL1.x | P3SEL0.x | LCDSz |
| P3.0/TB0.0/LCDS29   | 0 | P3.0 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                     |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                     |   | Internally tied to DVSS | 1                                      |          |          |       |
|                     |   | TB0.CCI0B               | 0                                      | 1        | 0        | 0     |
|                     |   | TB0.0                   | 1                                      |          |          |       |
|                     |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                     |   | Internally tied to DVSS | 1                                      |          |          |       |
|                     |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P3.1/TB0.1/LCDS28   | 1 | P3.1 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                     |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                     |   | Internally tied to DVSS | 1                                      |          |          |       |
|                     |   | N/A                     | 0                                      | 1        | 0        | 0     |
|                     |   | TB0.1                   | 1                                      |          |          |       |
|                     |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                     |   | Internally tied to DVSS | 1                                      |          |          |       |
|                     |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P3.2/TB0.2/LCDS27   | 2 | P3.2 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                     |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                     |   | Internally tied to DVSS | 1                                      |          |          |       |
|                     |   | N/A                     | 0                                      | 1        | 0        | 0     |
|                     |   | TB0.2                   | 1                                      |          |          |       |
|                     |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                     |   | Internally tied to DVSS | 1                                      |          |          |       |
|                     |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P3.3/TB0.3/LCDS26   | 3 | P3.3 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                     |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                     |   | Internally tied to DVSS | 1                                      |          |          |       |
|                     |   | TB0.CCI3B               | 0                                      | 1        | 0        | 0     |
|                     |   | TB0.3                   | 1                                      |          |          |       |
|                     |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                     |   | Internally tied to DVSS | 1                                      |          |          |       |
|                     |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P3.4/TB0OUTH/LCDS25 | 4 | P3.4 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                     |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                     |   | Internally tied to DVSS | 1                                      |          |          |       |
|                     |   | TB0OUTH                 | 0                                      | 1        | 0        | 0     |
|                     |   | Internally tied to DVSS | 1                                      |          |          |       |
|                     |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                     |   | Internally tied to DVSS | 1                                      |          |          |       |
|                     |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |

**Table 9-29. Port P3 (P3.0 to P3.7) Pin Functions (continued)**

| PIN NAME (P3.x)   | x | FUNCTION                | CONTROL BITS OR SIGNALS <sup>(1)</sup> |          |          |       |
|-------------------|---|-------------------------|----------------------------------------|----------|----------|-------|
|                   |   |                         | P3DIR.x                                | P3SEL1.x | P3SEL0.x | LCDSz |
| P3.5/TB0.4/LCDS24 | 5 | P3.5 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                   |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                   |   | Internally tied to DVSS | 1                                      |          |          |       |
|                   |   | TB0.CCI4B               | 0                                      | 1        | 0        | 0     |
|                   |   | TB0.4                   | 1                                      |          |          |       |
|                   |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                   |   | Internally tied to DVSS | 1                                      |          |          |       |
|                   |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P3.6/TB0.5/LCDS23 | 6 | P3.6 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                   |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                   |   | Internally tied to DVSS | 1                                      |          |          |       |
|                   |   | TB0.CCI5B               | 0                                      | 1        | 0        | 0     |
|                   |   | TB0.5                   | 1                                      |          |          |       |
|                   |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                   |   | Internally tied to DVSS | 1                                      |          |          |       |
|                   |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P3.7/TB0.6/LCDS22 | 7 | P3.7 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                   |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                   |   | Internally tied to DVSS | 1                                      |          |          |       |
|                   |   | TB0.CCI6B               | 0                                      | 1        | 0        | 0     |
|                   |   | TB0.6                   | 1                                      |          |          |       |
|                   |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                   |   | Internally tied to DVSS | 1                                      |          |          |       |
|                   |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |

### 9.14.7 Port P4 (P4.0 to P4.7) Input/Output With Schmitt Trigger

图 9-8 shows the port diagram. 表 9-30 summarizes the selection of the pin function.



Functional representation only.

**图 9-8. Port P4 (P4.0 to P4.7) Diagram**

**Table 9-30. Port P4 (P4.0 to P4.7) Pin Functions**

| PIN NAME (P4.x)    | x | FUNCTION                | CONTROL BITS OR SIGNALS <sup>(1)</sup> |          |          |       |
|--------------------|---|-------------------------|----------------------------------------|----------|----------|-------|
|                    |   |                         | P4DIR.x                                | P4SEL1.x | P4SEL0.x | LCDSz |
| P4.0/RTCCLK/LCDS16 | 0 | P4.0 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                    |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                    |   | Internally tied to DVSS | 1                                      |          |          |       |
|                    |   | N/A                     | 0                                      | 1        | 0        | 0     |
|                    |   | RTCCLK                  | 1                                      |          |          |       |
|                    |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                    |   | Internally tied to DVSS | 1                                      |          |          |       |
|                    |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P4.1/UCACLK/LCDS15 | 1 | P4.1 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                    |   | UCA0CLK                 | X <sup>(1)</sup>                       | 0        | 1        | 0     |
|                    |   | N/A                     | 0                                      | 1        | 0        | 0     |
|                    |   | Internally tied to DVSS | 1                                      |          |          |       |
|                    |   | N/A                     | 0                                      | 1        | 1        | 0     |

**Table 9-30. Port P4 (P4.0 to P4.7) Pin Functions (continued)**

| PIN NAME (P4.x)              | x | FUNCTION                | CONTROL BITS OR SIGNALS <sup>(1)</sup> |          |          |       |
|------------------------------|---|-------------------------|----------------------------------------|----------|----------|-------|
|                              |   |                         | P4DIR.x                                | P4SEL1.x | P4SEL0.x | LCDSz |
|                              |   | Internally tied to DVSS | 1                                      |          |          |       |
|                              |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P4.2/UCA0STE/LCDS14          | 2 | P4.2 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                              |   | UCA0STE                 | X <sup>(1)</sup>                       | 0        | 1        | 0     |
|                              |   | N/A                     | 0                                      | 1        | 0        | 0     |
|                              |   | Internally tied to DVSS | 1                                      |          |          |       |
|                              |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                              |   | Internally tied to DVSS | 1                                      |          |          |       |
|                              |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
|                              |   |                         |                                        |          |          |       |
| P4.3/UCA0SIMO/UCA0TXD/LCDS13 | 3 | P4.3 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                              |   | UCA0SIMO/UCA0TXD        | X <sup>(1)</sup>                       | 0        | 1        | 0     |
|                              |   | N/A                     | 0                                      | 1        | 0        | 0     |
|                              |   | Internally tied to DVSS | 1                                      |          |          |       |
|                              |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                              |   | Internally tied to DVSS | 1                                      |          |          |       |
|                              |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
|                              |   |                         |                                        |          |          |       |
| P4.4/UCA0SOMI/UCA0RXD/LCDS12 | 4 | P4.4 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                              |   | UCA0SOMI/UCA0RXD        | X <sup>(1)</sup>                       | 0        | 1        | 0     |
|                              |   | N/A                     | 0                                      | 1        | 0        | 0     |
|                              |   | Internally tied to DVSS | 1                                      |          |          |       |
|                              |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                              |   | Internally tied to DVSS | 1                                      |          |          |       |
|                              |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
|                              |   |                         |                                        |          |          |       |
| P4.5/TA0CLK/TA1CLK/LCDS11    | 5 | P4.5 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                              |   | TA0CLK                  | 0                                      | 0        | 1        | 0     |
|                              |   | Internally tied to DVSS | 1                                      |          |          |       |
|                              |   | TA1CLK                  | 0                                      | 1        | 0        | 0     |
|                              |   | Internally tied to DVSS | 1                                      |          |          |       |
|                              |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                              |   | Internally tied to DVSS | 1                                      |          |          |       |
|                              |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P4.6/TB0CLK/TA4CLK/LCDS10    | 6 | P4.6 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                              |   | TB0CLK                  | 0                                      | 0        | 1        | 0     |
|                              |   | Internally tied to DVSS | 1                                      |          |          |       |
|                              |   | TA4CLK                  | 0                                      | 1        | 0        | 0     |
|                              |   | Internally tied to DVSS | 1                                      |          |          |       |
|                              |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                              |   | Internally tied to DVSS | 1                                      |          |          |       |
|                              |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P4.7/DMAE0/LCDS9             | 7 | P4.7 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |

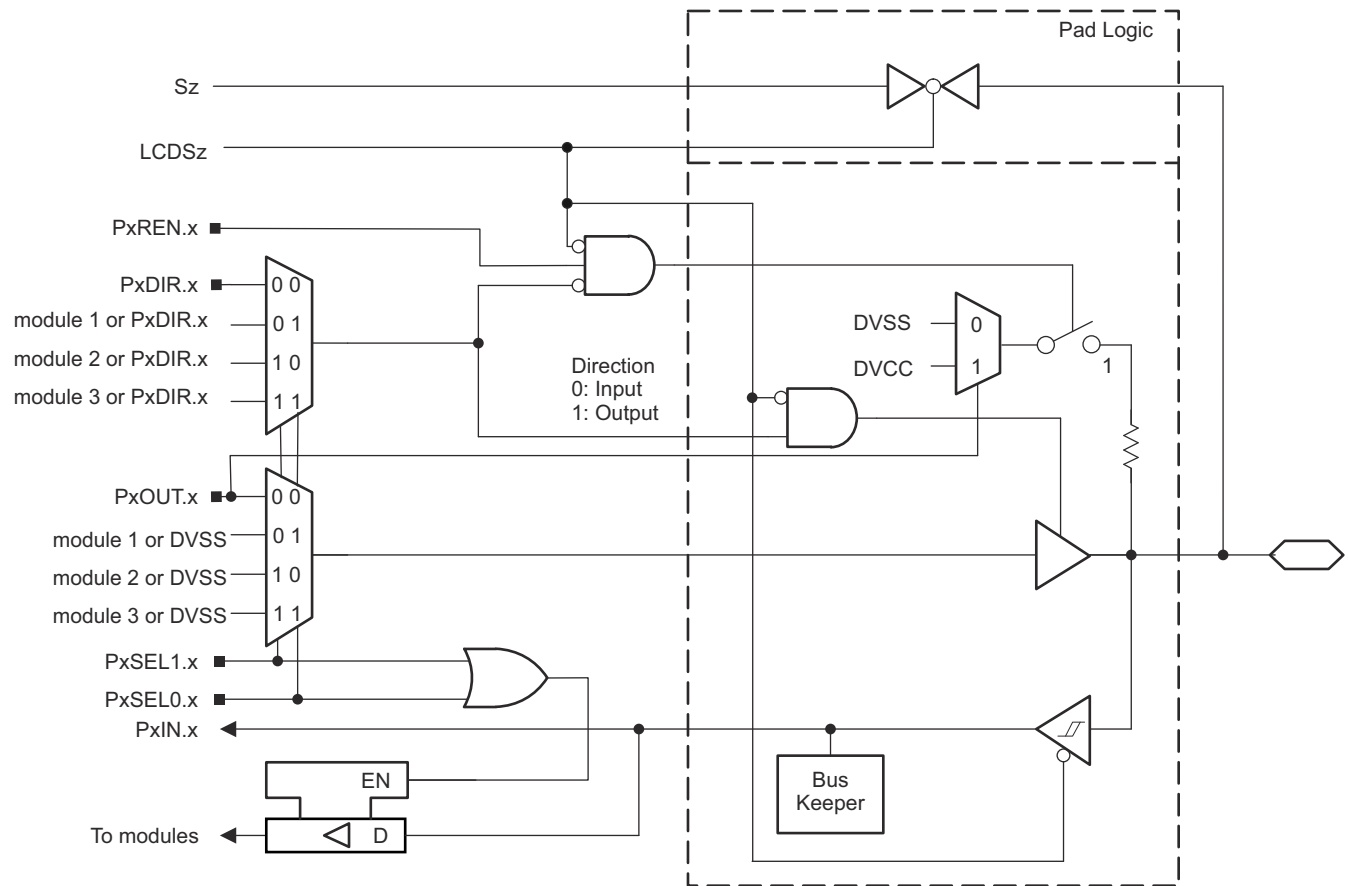
**Table 9-30. Port P4 (P4.0 to P4.7) Pin Functions (continued)**

| PIN NAME (P4.x) | x | FUNCTION                | CONTROL BITS OR SIGNALS <sup>(1)</sup> |          |          |       |
|-----------------|---|-------------------------|----------------------------------------|----------|----------|-------|
|                 |   |                         | P4DIR.x                                | P4SEL1.x | P4SEL0.x | LCDSz |
|                 |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                 |   | Internally tied to DVSS | 1                                      |          |          |       |
|                 |   | DMAE0                   | 0                                      | 1        | 0        | 0     |
|                 |   | Internally tied to DVSS | 1                                      |          |          |       |
|                 |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                 |   | Internally tied to DVSS | 1                                      |          |          |       |
|                 |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |

(1) Direction controlled by eUSCI\_A0 module.

### 9.14.8 Port P5 (P5.0 to P5.7) Input/Output With Schmitt Trigger

图 9-9 shows the port diagram. 表 9-31 summarizes the selection of the pin function.



Functional representation only.

图 9-9. Port P5 (P5.0 to P5.7) Diagram

Table 9-31. Port P5 (P5.0 to P5.7) Pin Functions

| PIN NAME (P5.x)             | x | FUNCTION                | CONTROL BITS OR SIGNALS <sup>(1)</sup> |          |          |       |
|-----------------------------|---|-------------------------|----------------------------------------|----------|----------|-------|
|                             |   |                         | P5DIR.x                                | P5SEL1.x | P5SEL0.x | LCDSz |
| P5.0/UCA2SIMO/UCA2TXD/LCDS8 | 0 | P5.0 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                             |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                             |   | Internally tied to DVSS | 1                                      |          |          |       |
|                             |   | UCA2SIMO/UCA2TXD        | X <sup>(2)</sup>                       | 1        | 0        | 0     |
|                             |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                             |   | Internally tied to DVSS | 1                                      |          |          |       |
|                             |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P5.1/UCA2SOMI/UCA2RXD/LCDS7 | 1 | P5.1 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                             |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                             |   | Internally tied to DVSS | 1                                      |          |          |       |
|                             |   | UCA2SOMI/UCA2RXD        | X <sup>(2)</sup>                       | 1        | 0        | 0     |
|                             |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                             |   | Internally tied to DVSS | 1                                      |          |          |       |
|                             |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |

**Table 9-31. Port P5 (P5.0 to P5.7) Pin Functions (continued)**

| PIN NAME (P5.x)                        | x | FUNCTION                | CONTROL BITS OR SIGNALS <sup>(1)</sup> |          |          |       |
|----------------------------------------|---|-------------------------|----------------------------------------|----------|----------|-------|
|                                        |   |                         | P5DIR.x                                | P5SEL1.x | P5SEL0.x | LCDSz |
| P5.2/UCA2CLK/LCDS6                     | 2 | P5.2 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                                        |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                                        |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                        |   | UCA2CLK                 | X <sup>(2)</sup>                       | 1        | 0        | 0     |
|                                        |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                                        |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                        |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P5.3/UCA2STE/LCDS5                     | 3 | P5.3 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                                        |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                                        |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                        |   | UCA2STE                 | X <sup>(2)</sup>                       | 1        | 0        | 0     |
|                                        |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                                        |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                        |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P5.4/UCB1CLK/LCDS4                     | 4 | P5.4 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                                        |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                                        |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                        |   | UCB1CLK                 | X <sup>(1)</sup>                       | 1        | 0        | 0     |
|                                        |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                                        |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                        |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P5.5/TA0CLK/UCB1SIMO/<br>UCB1SDA/LCDS3 | 5 | P5.5 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                                        |   | TA0CLK                  | 0                                      | 0        | 1        | 0     |
|                                        |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                        |   | UCB1SIMO/UCB1SDA        | X <sup>(1)</sup>                       | 1        | 0        | 0     |
|                                        |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                                        |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                        |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P5.6/UCB1SOMI/UCB1SCL/LCDS2            | 6 | P5.6 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                                        |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                                        |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                        |   | UCB1SOMI/UCB1SCL        | X <sup>(1)</sup>                       | 1        | 0        | 0     |
|                                        |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                                        |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                        |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P5.7/UCB1STE/LCDS1                     | 7 | P5.7 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                                        |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                                        |   | Internally tied to DVSS | 1                                      |          |          |       |
|                                        |   | UCB1STE                 | X <sup>(1)</sup>                       | 1        | 0        | 0     |
|                                        |   | N/A                     | 0                                      | 1        | 1        | 0     |

**Table 9-31. Port P5 (P5.0 to P5.7) Pin Functions (continued)**

| PIN NAME (P5.x) | x | FUNCTION                | CONTROL BITS OR SIGNALS <sup>(1)</sup> |          |          |       |
|-----------------|---|-------------------------|----------------------------------------|----------|----------|-------|
|                 |   |                         | P5DIR.x                                | P5SEL1.x | P5SEL0.x | LCDSz |
|                 |   | Internally tied to DVSS | 1                                      |          |          |       |
|                 |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |

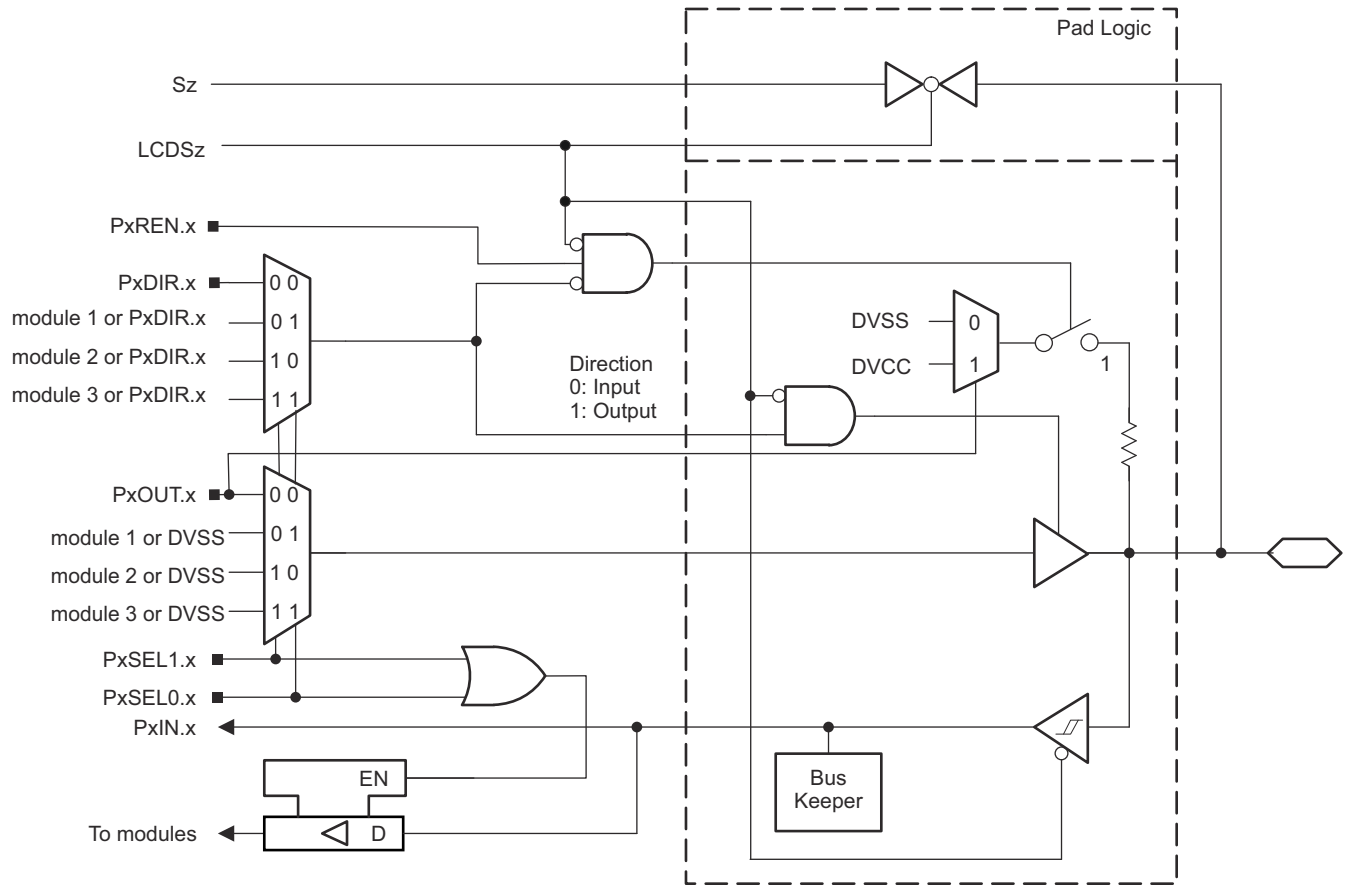
(1) Direction controlled by eUSCI\_B1 module.

(2) Direction controlled by eUSCI\_A2 module.



### 9.14.9 Port P6 (P6.0) Input/Output With Schmitt Trigger

图 9-10 shows the port diagram. 表 9-32 summarizes the selection of the pin function.



Functional representation only.

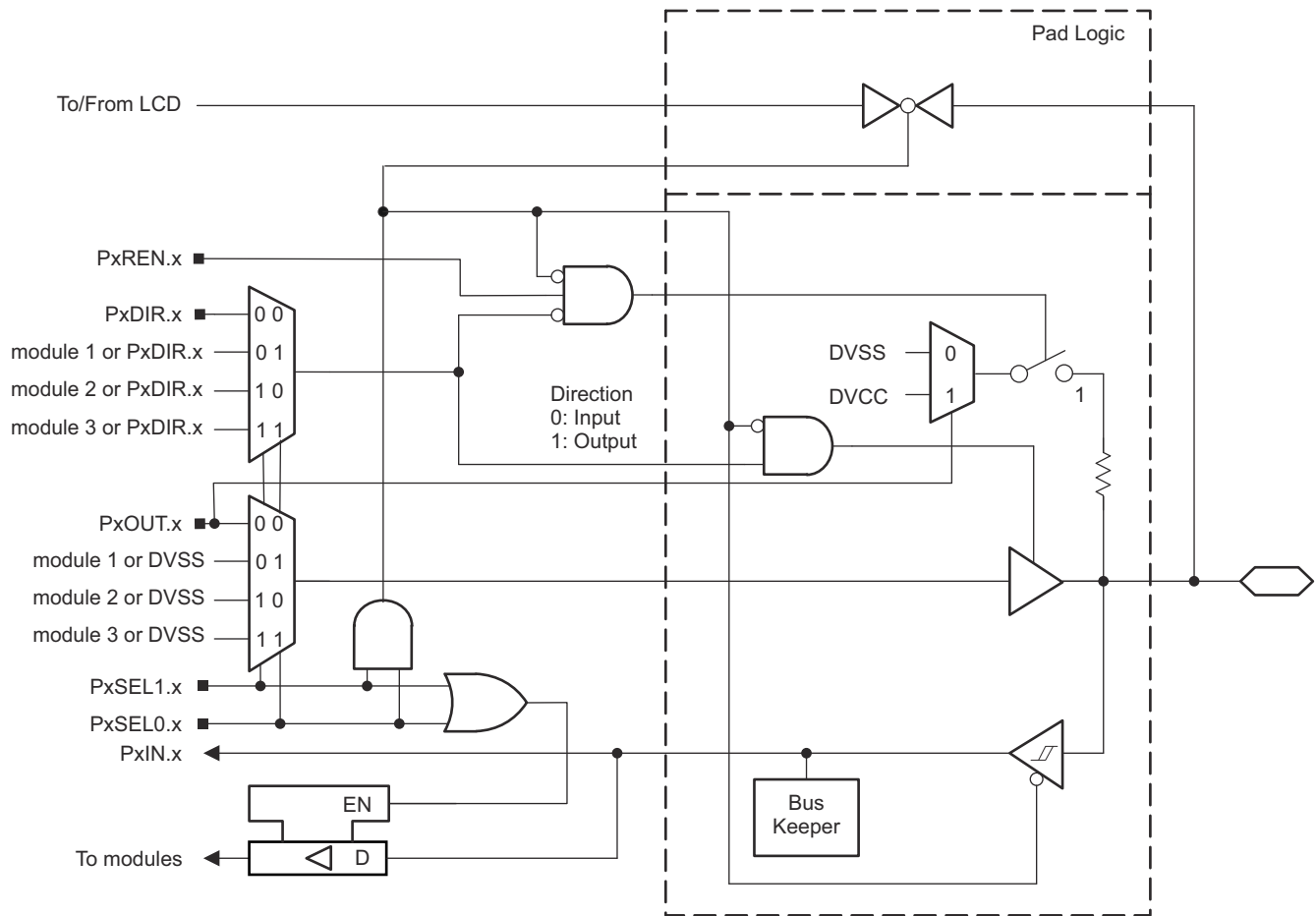
**图 9-10. Port P6 (P6.0) Diagram**

**Table 9-32. Port P6 (P6.0) Pin Functions**

| PIN NAME (P6.x) | x | FUNCTION                | CONTROL BITS OR SIGNALS <sup>(1)</sup> |          |          |       |
|-----------------|---|-------------------------|----------------------------------------|----------|----------|-------|
|                 |   |                         | P6DIR.x                                | P6SEL1.x | P6SEL0.x | LCDSz |
| P6.0/COUT/LCDS0 | 0 | P6.0 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                 |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                 |   | Internally tied to DVSS | 1                                      |          |          |       |
|                 |   | N/A                     | 0                                      | 1        | 0        | 0     |
|                 |   | COUT                    | 1                                      |          |          |       |
|                 |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                 |   | Internally tied to DVSS | 1                                      |          |          |       |
|                 |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |

#### 9.14.10 Port P6 (P6.1 to P6.5) Input/Output With Schmitt Trigger

图 9-11 shows the port diagram. 表 9-33 summarizes the selection of the pin function.



Functional representation only.

图 9-11. Port P6 (P6.1 to P6.5) Diagram

**Table 9-33. Port P6 (P6.1 to P6.5) Pin Functions**

| PIN NAME (P6.x) | x | FUNCTION                  | CONTROL BITS OR SIGNALS <sup>(1)</sup> |          |          |
|-----------------|---|---------------------------|----------------------------------------|----------|----------|
|                 |   |                           | P6DIR.x                                | P6SEL1.x | P6SEL0.x |
| P6.1/R03        | 1 | P6.1 (I/O)                | 0 = Input,<br>1 = Output               | 0        | 0        |
|                 |   | N/A                       | 0                                      | 0        | 1        |
|                 |   | Internally tied to DVSS   | 1                                      |          |          |
|                 |   | N/A                       | 0                                      | 1        | 0        |
|                 |   | Internally tied to DVSS   | 1                                      |          |          |
|                 |   | R03 <sup>(1)</sup>        | X                                      | 1        | 1        |
| P6.2/R13/LCDREF | 2 | P6.2 (I/O)                | 0 = Input,<br>1 = Output               | 0        | 0        |
|                 |   | N/A                       | 0                                      | 0        | 1        |
|                 |   | Internally tied to DVSS   | 1                                      |          |          |
|                 |   | N/A                       | 0                                      | 1        | 0        |
|                 |   | Internally tied to DVSS   | 1                                      |          |          |
|                 |   | R13/LCDREF <sup>(1)</sup> | X                                      | 1        | 1        |
| P6.3/R23        | 3 | P6.3 (I/O)                | 0 = Input,<br>1 = Output               | 0        | 0        |
|                 |   | N/A                       | 0                                      | 0        | 1        |
|                 |   | Internally tied to DVSS   | 1                                      |          |          |
|                 |   | N/A                       | 0                                      | 1        | 0        |
|                 |   | Internally tied to DVSS   | 1                                      |          |          |
|                 |   | R23 <sup>(1)</sup>        | X                                      | 1        | 1        |
| P6.4/COM0       | 4 | P6.4 (I/O)                | 0 = Input,<br>1 = Output               | 0        | 0        |
|                 |   | N/A                       | 0                                      | 0        | 1        |
|                 |   | Internally tied to DVSS   | 1                                      |          |          |
|                 |   | N/A                       | 0                                      | 1        | 0        |
|                 |   | Internally tied to DVSS   | 1                                      |          |          |
|                 |   | COM0 <sup>(1)</sup>       | X                                      | 1        | 1        |
| P6.5/COM1       | 5 | P6.5 (I/O)                | 0 = Input,<br>1 = Output               | 0        | 0        |
|                 |   | N/A                       | 0                                      | 0        | 1        |
|                 |   | Internally tied to DVSS   | 1                                      |          |          |
|                 |   | N/A                       | 0                                      | 1        | 0        |
|                 |   | Internally tied to DVSS   | 1                                      |          |          |
|                 |   | COM1 <sup>(1)</sup>       | X                                      | 1        | 1        |

(1) Setting P6SEL1.x and P6SEL0.x disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals.

#### 9.14.11 Port P6 (P6.6 and P6.7) Input/Output With Schmitt Trigger

图 9-12 shows the port diagram. 表 9-34 summarizes the selection of the pin function.

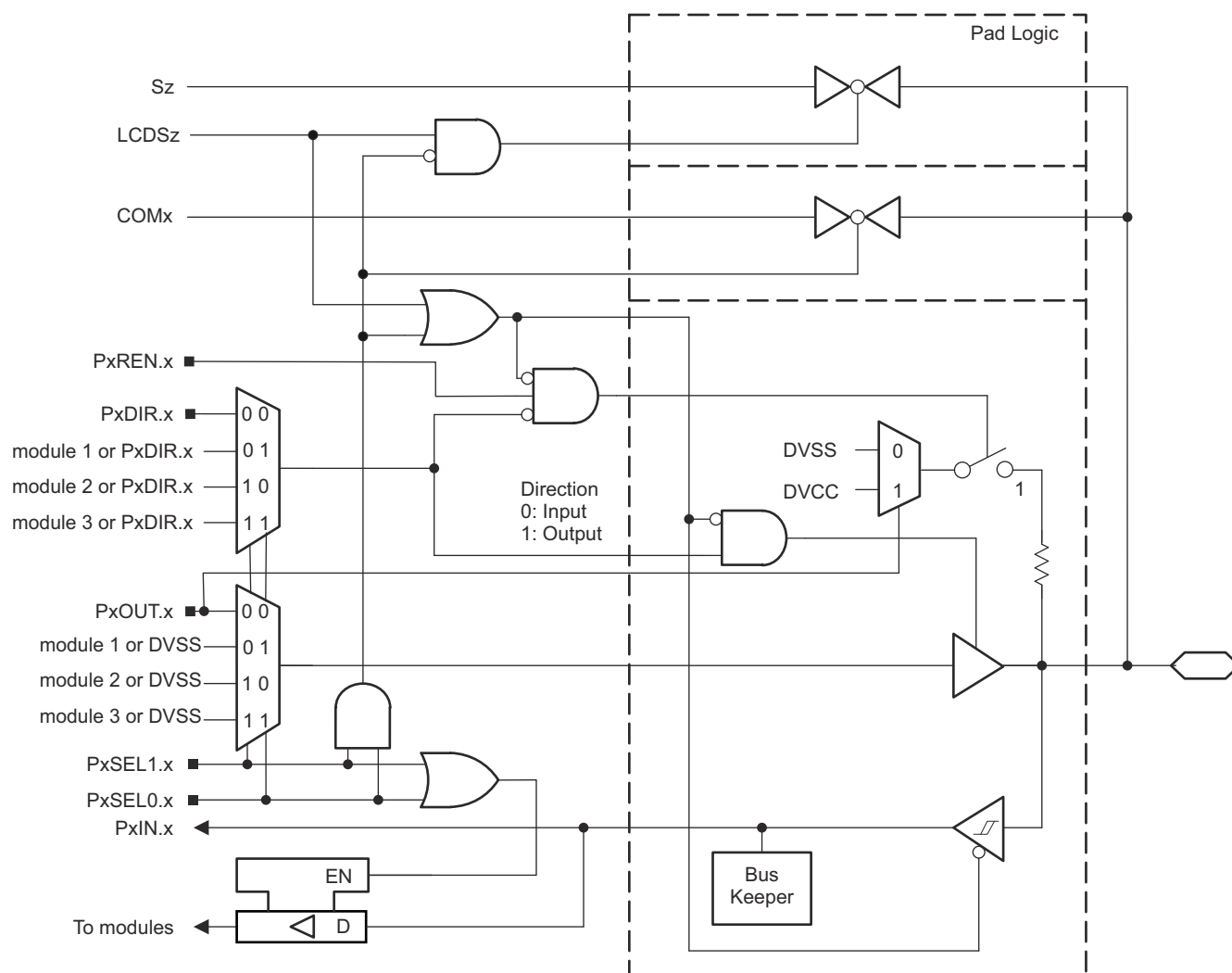


图 9-12. Port P6 (P6.6 and P6.7) Diagram

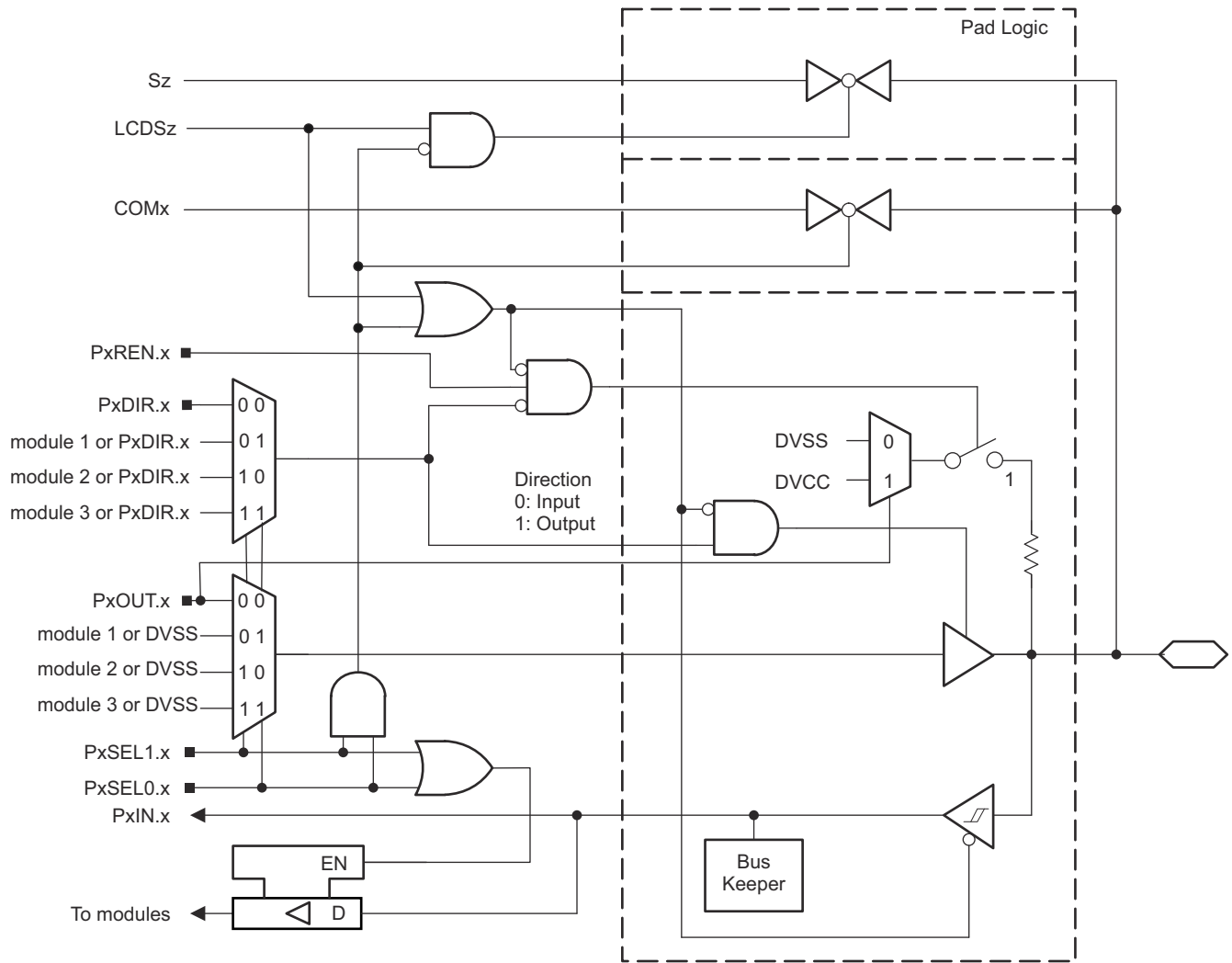
**Table 9-34. Port P6 (P6.6 to P6.7) Pin Functions**

| PIN NAME (P6.x)  | x | FUNCTION                | CONTROL BITS OR SIGNALS <sup>(1)</sup> |          |          |       |
|------------------|---|-------------------------|----------------------------------------|----------|----------|-------|
|                  |   |                         | P6DIR.x                                | P6SEL1.x | P6SEL0.x | LCDSz |
| P6.6/COM2/LCDS38 | 6 | P6.6(I/O)               | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                  |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                  |   | Internally tied to DVSS | 1                                      |          |          |       |
|                  |   | N/A                     | 0                                      | 1        | 0        | 0     |
|                  |   | Internally tied to DVSS | 1                                      |          |          |       |
|                  |   | COM2 <sup>(1)</sup>     | X                                      | 1        | 1        | 0     |
|                  |   | Sz <sup>(1)</sup>       | X                                      | X        | 0        | 1     |
|                  |   |                         |                                        | 0        | X        |       |
| P6.7/COM3/LCDS37 | 7 | P6.7(I/O)               | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                  |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                  |   | Internally tied to DVSS | 1                                      |          |          |       |
|                  |   | N/A                     | 0                                      | 1        | 0        | 0     |
|                  |   | Internally tied to DVSS | 1                                      |          |          |       |
|                  |   | COM3 <sup>(1)</sup>     | X                                      | 1        | 1        | 0     |
|                  |   | Sz <sup>(1)</sup>       | X                                      | X        | 0        | 1     |
|                  |   |                         |                                        | 0        | X        |       |

(1) X = Don't care

#### 9.14.12 Port P7 (P7.0 to P7.3) Input/Output With Schmitt Trigger

图 9-13 shows the port diagram. 表 9-35 summarizes the selection of the pin function.



Functional representation only.

图 9-13. Port P7 (P7.0 to P7.3) Diagram

**Table 9-35. Port P7 (P7.0 to P7.3) Pin Functions**

| PIN NAME (P7.x)                             | x | FUNCTION            | CONTROL BITS OR SIGNALS  |          |          |       |
|---------------------------------------------|---|---------------------|--------------------------|----------|----------|-------|
|                                             |   |                     | P7DIR.x                  | P7SEL1.x | P7SEL0.x | LCDSz |
| P7.0/UCA2SIMO/UCA2TXD/ ACLK/<br>COM4/LCDS36 | 0 | P7.0(I/O)           | 0 = Input,<br>1 = Output | 0        | 0        | 0     |
|                                             |   | UCA2SIMO/UCA2TXD    | X <sup>(1)</sup>         | 0        | 1        | 0     |
|                                             |   | N/A                 | 0                        | 1        | 0        | 0     |
|                                             |   | ACLK                | 1                        |          |          |       |
|                                             |   | COM4 <sup>(1)</sup> | X                        | 1        | 1        | 0     |
|                                             |   | Sz <sup>(1)</sup>   | X                        | X<br>0   | 0<br>X   | 1     |
| P7.1/UCA2SOMI/UCA2RXD/<br>SMCLK/COM5/LCDS35 | 1 | P7.1(I/O)           | 0 = Input,<br>1 = Output | 0        | 0        | 0     |
|                                             |   | UCA2SOMI/UCA2RXD    | X <sup>(1)</sup>         | 0        | 1        | 0     |
|                                             |   | N/A                 | 0                        | 1        | 0        | 0     |
|                                             |   | SMCLK               | 1                        |          |          |       |
|                                             |   | COM5 <sup>(1)</sup> | X                        | 1        | 1        | 0     |
|                                             |   | Sz <sup>(1)</sup>   | X                        | X<br>0   | 0<br>X   | 1     |
| P7.2/UCA2CLK/TB0.0/COM6/<br>LCDS34          | 2 | P7.2(I/O)           | 0 = Input,<br>1 = Output | 0        | 0        | 0     |
|                                             |   | UCA2CLK             | X <sup>(1)</sup>         | 0        | 1        | 0     |
|                                             |   | TB0.CCI0A           | 0                        | 1        | 0        | 0     |
|                                             |   | TB0.0               | 1                        |          |          |       |
|                                             |   | COM6 <sup>(1)</sup> | X                        | 1        | 1        | 0     |
|                                             |   | Sz <sup>(1)</sup>   | X                        | X<br>0   | 0<br>X   | 1     |
| P7.3/UCA2STE/TB0.1/COM7/<br>LCDS33          | 3 | P7.3(I/O)           | 0 = Input,<br>1 = Output | 0        | 0        | 0     |
|                                             |   | UCA2STE             | X <sup>(1)</sup>         | 0        | 1        | 0     |
|                                             |   | TB0.CCI1A           | 0                        | 1        | 0        | 0     |
|                                             |   | TB0.1               | 1                        |          |          |       |
|                                             |   | COM7 <sup>(1)</sup> | X                        | 1        | 1        | 0     |
|                                             |   | Sz <sup>(1)</sup>   | X                        | X<br>0   | 0<br>X   | 1     |

(1) Direction controlled by eUSCI\_A2 module.

### 9.14.13 Port P7 (P7.4 to P7.7) Input/Output With Schmitt Trigger

图 9-14 shows the port diagram. 表 9-36 summarizes the selection of the pin function.

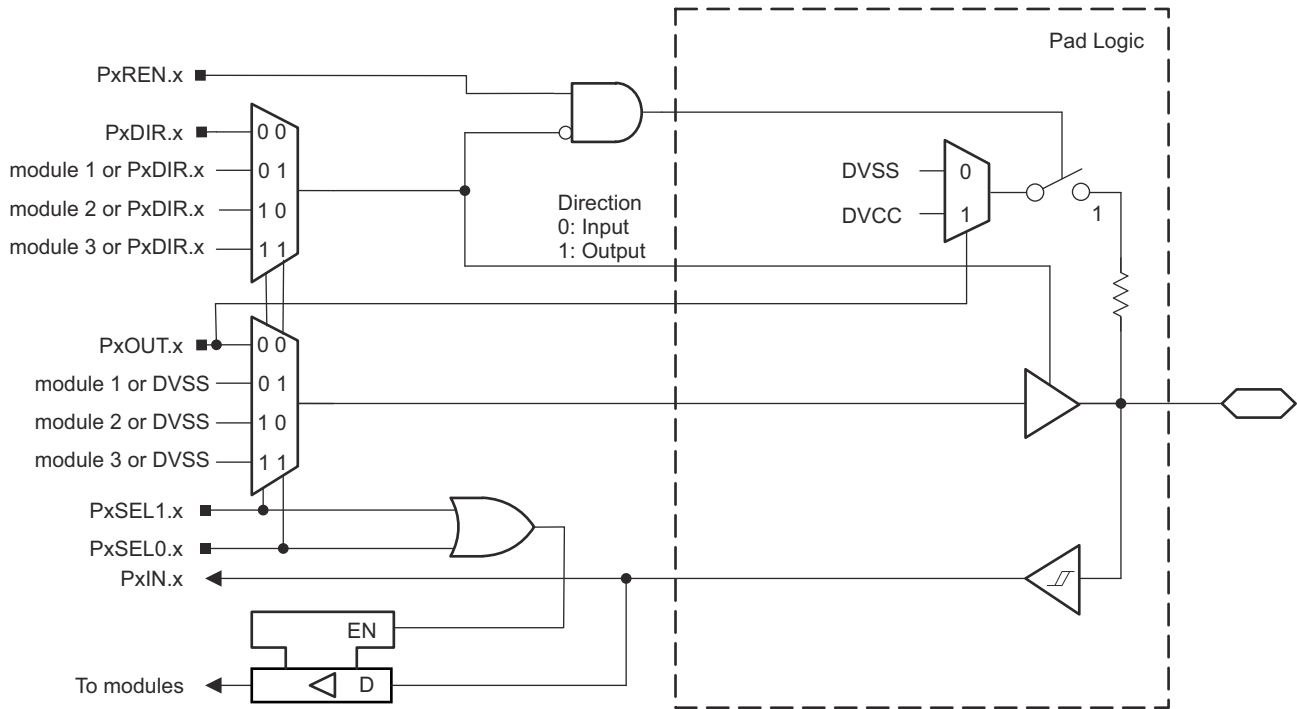


图 9-14. Port P7 (P7.6 and P7.7) Diagram

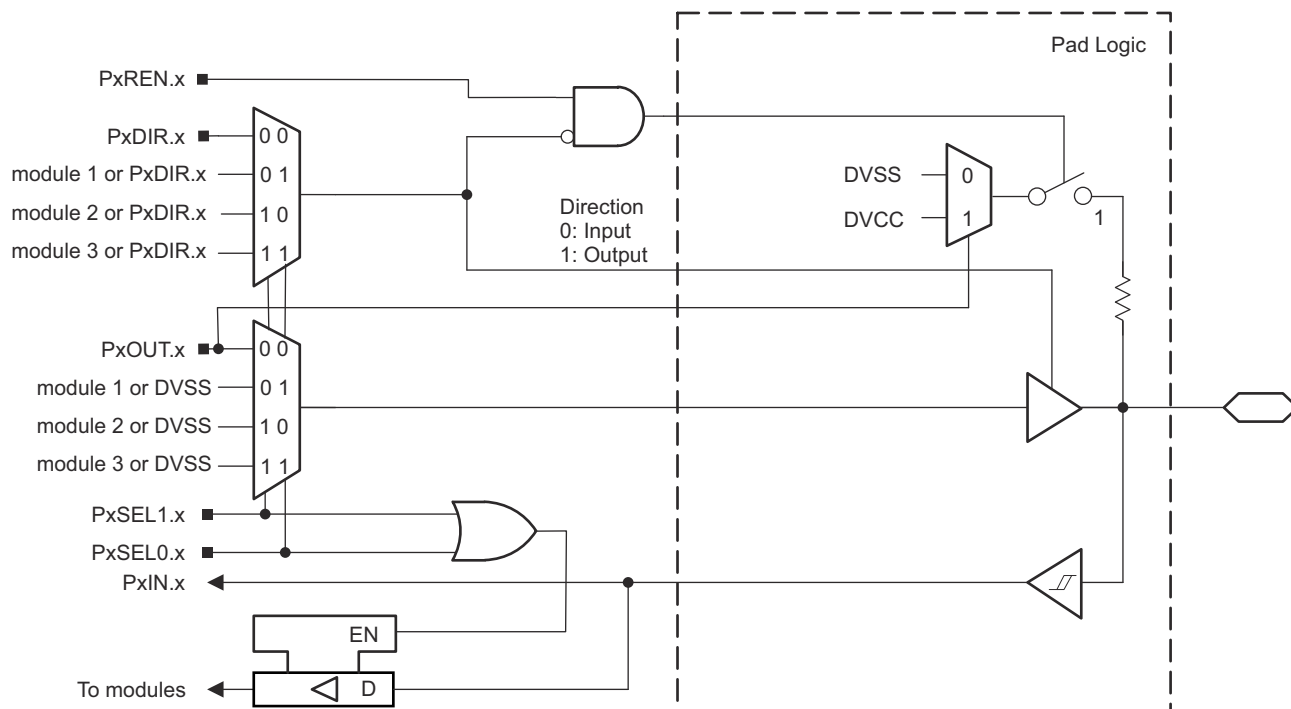


**Table 9-36. Port P7 (P7.6 to P7.7) Pin Functions**

| PIN NAME (P7.x)         | x | FUNCTION                | CONTROL BITS OR SIGNALS  |          |          |
|-------------------------|---|-------------------------|--------------------------|----------|----------|
|                         |   |                         | P7DIR.x                  | P7SEL1.x | P7SEL0.x |
| P7.4/TA0.1              | 4 | P7.4(I/O)               | 0 = Input,<br>1 = Output | 0        | 0        |
|                         |   | TA0.CCI1A               | 0                        | 0        | 1        |
|                         |   | TA0.1                   | 1                        |          |          |
|                         |   | N/A                     | 0                        | 1        | 0        |
|                         |   | Internally tied to DVSS | 1                        |          |          |
|                         |   | N/A                     | 0                        | 1        | 1        |
|                         |   | Internally tied to DVSS | 1                        |          |          |
| P7.5/TA1.1              | 5 | P7.5(I/O)               | 0 = Input,<br>1 = Output | 0        | 0        |
|                         |   | TA1.CCI1A               | 0                        | 0        | 1        |
|                         |   | TA1.1                   | 1                        |          |          |
|                         |   | N/A                     | 0                        | 1        | 0        |
|                         |   | Internally tied to DVSS | 1                        |          |          |
|                         |   | N/A                     | 0                        | 1        | 1        |
|                         |   | Internally tied to DVSS | 1                        |          |          |
| P7.6/TA4.1/DMAE0/COUT   | 6 | P7.6(I/O)               | 0 = Input,<br>1 = Output | 0        | 0        |
|                         |   | TA4.CCI1A               | 0                        | 0        | 1        |
|                         |   | TA4.1                   | 1                        |          |          |
|                         |   | DMAE0                   | 0                        | 1        | 0        |
|                         |   | Internally tied to DVSS | 1                        |          |          |
|                         |   | N/A                     | 0                        | 1        | 1        |
|                         |   | COUT                    | 1                        |          |          |
| P7.7/TA0.2/TB0OUTH/COUT | 7 | P7.7(I/O)               | 0 = Input,<br>1 = Output | 0        | 0        |
|                         |   | TA0.CCI2A               | 0                        | 0        | 1        |
|                         |   | TA0.2                   | 1                        |          |          |
|                         |   | TB0OUTH                 | 0                        | 1        | 0        |
|                         |   | Internally tied to DVSS | 1                        |          |          |
|                         |   | N/A                     | 0                        | 1        | 1        |
|                         |   | COUT                    | 1                        |          |          |

#### 9.14.14 Port P8 (P8.0 to P8.3) Input/Output With Schmitt Trigger

图 9-15 shows the port diagram. 表 9-37 summarizes the selection of the pin function.



Functional representation only.

图 9-15. Port P8 (P8.0 to P8.3) Diagram

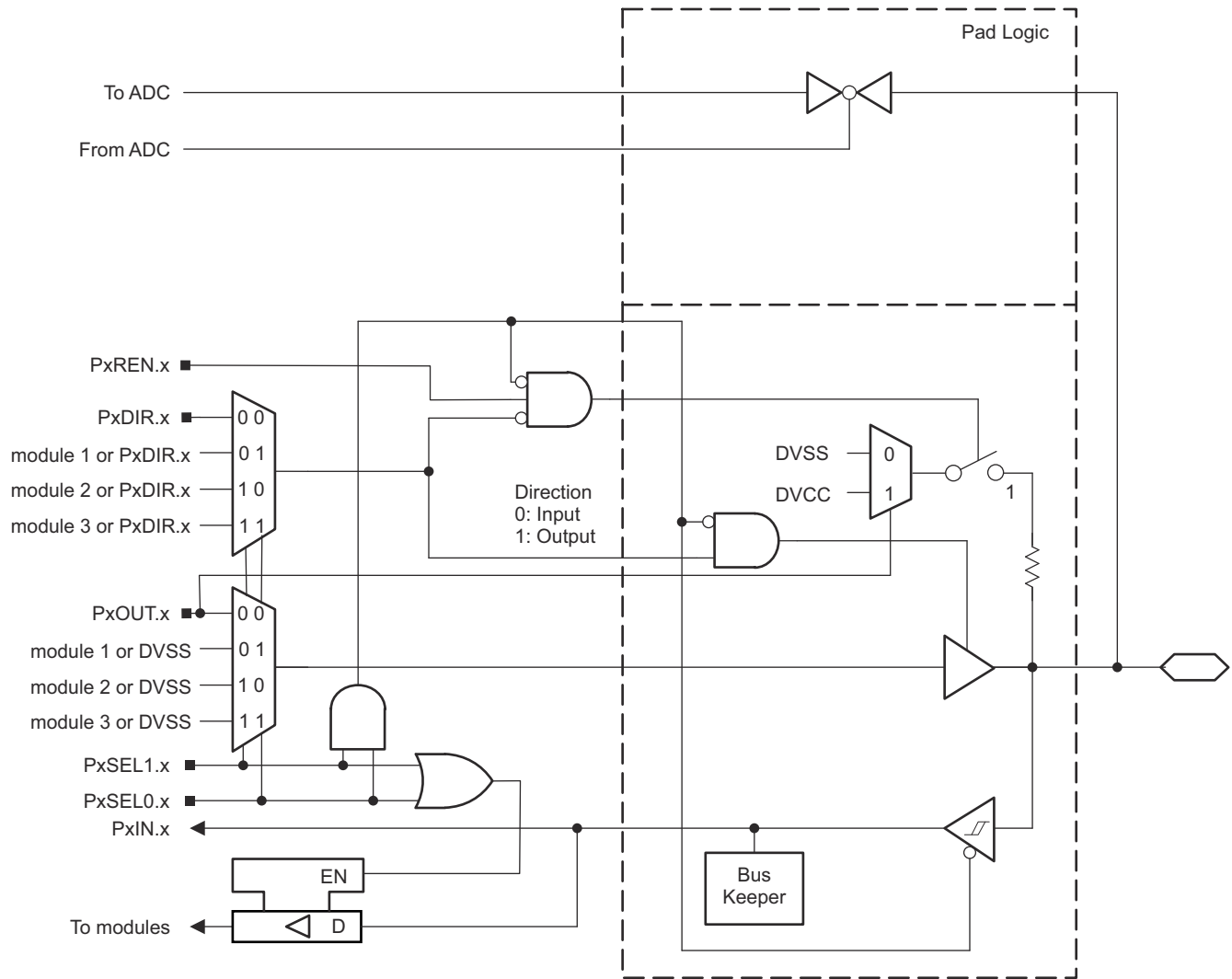
**Table 9-37. Port P8 (P8.0 to P8.3) Pin Functions**

| PIN NAME (P8.x)              | x | FUNCTION                | CONTROL BITS OR SIGNALS  |          |          |
|------------------------------|---|-------------------------|--------------------------|----------|----------|
|                              |   |                         | P8DIR.x                  | P8SEL1.x | P8SEL0.x |
| P8.0/UCA3STE/TB0.2/DMAE0     | 0 | P8.0(I/O)               | 0 = Input,<br>1 = Output | 0        | 0        |
|                              |   | UCA3STE                 | X <sup>(1)</sup>         | 0        | 1        |
|                              |   | TB0.CCI2A               | 0                        | 1        | 0        |
|                              |   | TB0.2                   | 1                        |          |          |
|                              |   | DMAE0                   | 0                        | 1        | 1        |
|                              |   | Internally tied to DVSS | 1                        |          |          |
| P8.1/UCA3CLK/TB0.3/TB0OUTH   | 1 | P8.1(I/O)               | 0 = Input,<br>1 = Output | 0        | 0        |
|                              |   | UCA3CLK                 | X <sup>(1)</sup>         | 0        | 1        |
|                              |   | TB0.CCI3A               | 0                        | 1        | 0        |
|                              |   | TB0.3                   | 1                        |          |          |
|                              |   | TB0OUTH                 | 0                        | 1        | 1        |
|                              |   | Internally tied to DVSS | 1                        |          |          |
| P8.2/UCA3SOMI/UCA3RXD/MCLK   | 2 | P8.2(I/O)               | 0 = Input,<br>1 = Output | 0        | 0        |
|                              |   | UCA3SOMI/UCA3RXD        | X <sup>(1)</sup>         | 0        | 1        |
|                              |   | N/A                     | 0                        | 1        | 0        |
|                              |   | MCLK                    | 1                        |          |          |
|                              |   | N/A                     | 0                        | 1        | 1        |
|                              |   | Internally tied to DVSS | 1                        |          |          |
| P8.3/UCA3SIMO/UCA3TXD/RTCCLK | 3 | P8.3(I/O)               | 0 = Input,<br>1 = Output | 0        | 0        |
|                              |   | UCA3SIMO/UCA3TXD        | X <sup>(1)</sup>         | 0        | 1        |
|                              |   | N/A                     | 0                        | 1        | 0        |
|                              |   | RTCCLK                  | 1                        |          |          |
|                              |   | N/A                     | 0                        | 1        | 1        |
|                              |   | Internally tied to DVSS | 1                        |          |          |

(1) Direction controlled by eUSCI\_A3 module.

#### 9.14.15 Port P8 (P8.4 to P8.7) Input/Output With Schmitt Trigger

图 9-16 shows the port diagram. 表 9-38 summarizes the selection of the pin function.



Functional representation only.

图 9-16. Port P8 (P8.4 to P8.7) Diagram

**Table 9-38. Port P8 (P8.4 to P8.7) Pin Functions**

| PIN NAME (P8.x)             | x | FUNCTION                  | CONTROL BITS OR SIGNALS  |          |          |
|-----------------------------|---|---------------------------|--------------------------|----------|----------|
|                             |   |                           | P8DIR.x                  | P8SEL1.x | P8SEL0.x |
| P8.4/UCB1CLK/TA1.2/A10      | 4 | P8.4(I/O)                 | 0 = Input,<br>1 = Output | 0        | 0        |
|                             |   | UCB1CLK                   | X <sup>(1)</sup>         | 0        | 1        |
|                             |   | TA1.CCI2A                 | 0                        | 1        | 0        |
|                             |   | TA1.2                     | 1                        |          |          |
|                             |   | A10 <sup>(2)</sup>        | X                        | 1        | 1        |
| P8.5/UCB1SIMO/UCB1SDA/A11   | 5 | P8.5(I/O)                 | 0 = Input,<br>1 = Output | 0        | 0        |
|                             |   | UCB1SIMO/UCB1SDA          | X <sup>(1)</sup>         | 0        | 1        |
|                             |   | N/A                       | 0                        | 1        | 0        |
|                             |   | Internally tied to DVSS   | 1                        |          |          |
|                             |   | A11 <sup>(2)</sup>        | X                        | 1        | 1        |
| P8.6/UCB1SOMI/UCB1SCL/A12   | 6 | P8.6(I/O)                 | 0 = Input,<br>1 = Output | 0        | 0        |
|                             |   | UCB1SOMI/UCB1SCL          | X <sup>(1)</sup>         | 0        | 1        |
|                             |   | N/A                       | 0                        | 1        | 0        |
|                             |   | Internally tied to DVSS   | 1                        |          |          |
|                             |   | A12 <sup>(2)</sup>        | X                        | 1        | 1        |
| P8.7/UCB1STE/USSXT_BOUT/A13 | 7 | P8.7(I/O)                 | 0 = Input,<br>1 = Output | 0        | 0        |
|                             |   | UCB1STE                   | X <sup>(1)</sup>         | 0        | 1        |
|                             |   | N/A                       | 0                        | 1        | 0        |
|                             |   | USSXT_BOUT <sup>(3)</sup> | 1                        |          |          |
|                             |   | A13 <sup>(2)</sup>        | X                        | 1        | 1        |

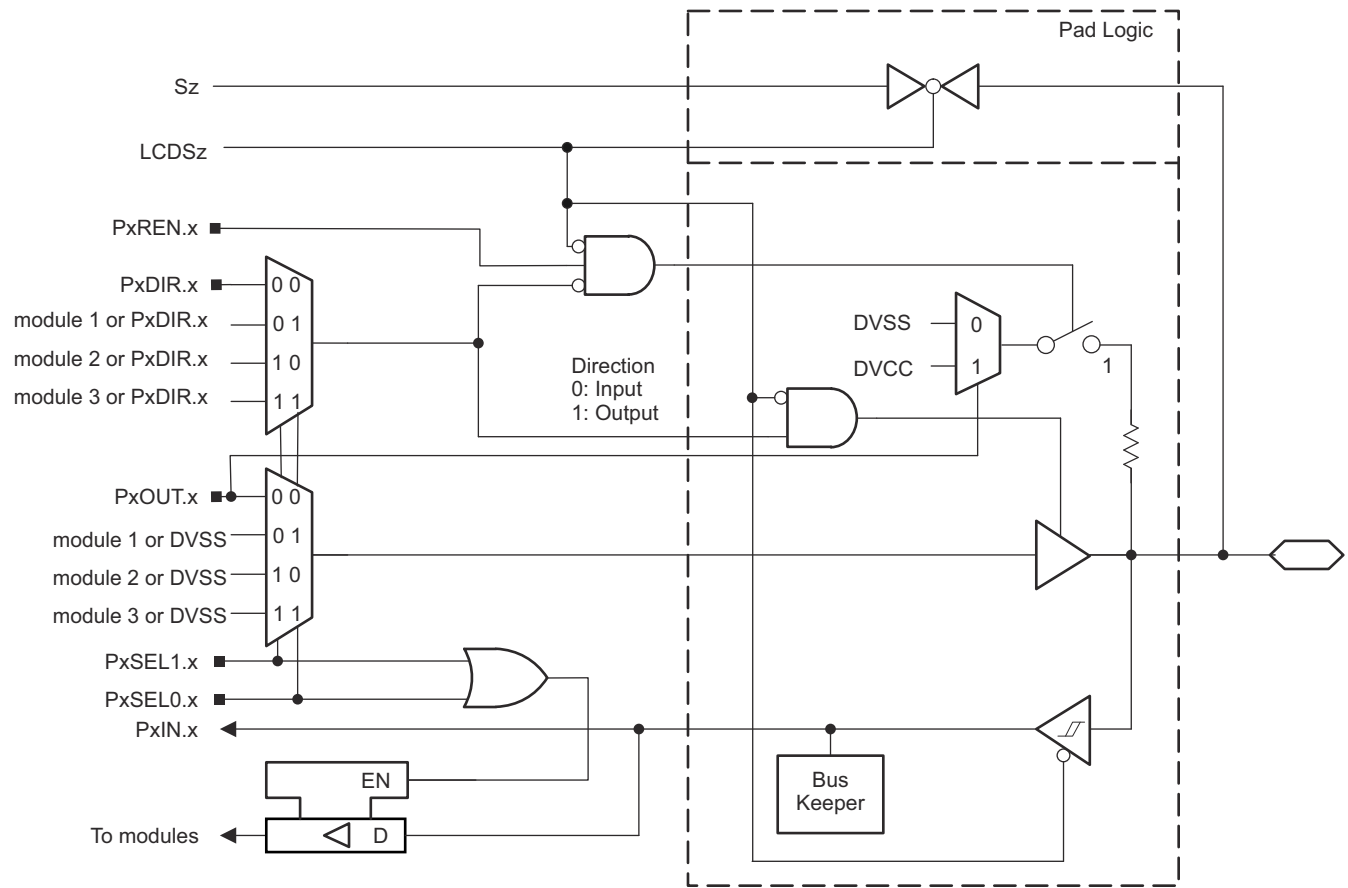
(1) Direction controlled by eUSCI\_B1 module.

(2) Setting P8SEL1.x and P8SEL0.x disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals.

(3) USSXTHSPLL.PLLXTLCTL.XTOUTOFF bit must also be set to 0.

#### 9.14.16 Port P9 (P9.0 to P9.3) Input/Output With Schmitt Trigger

图 9-17 shows the port diagram. 表 9-39 summarizes the selection of the pin function.



Functional representation only.

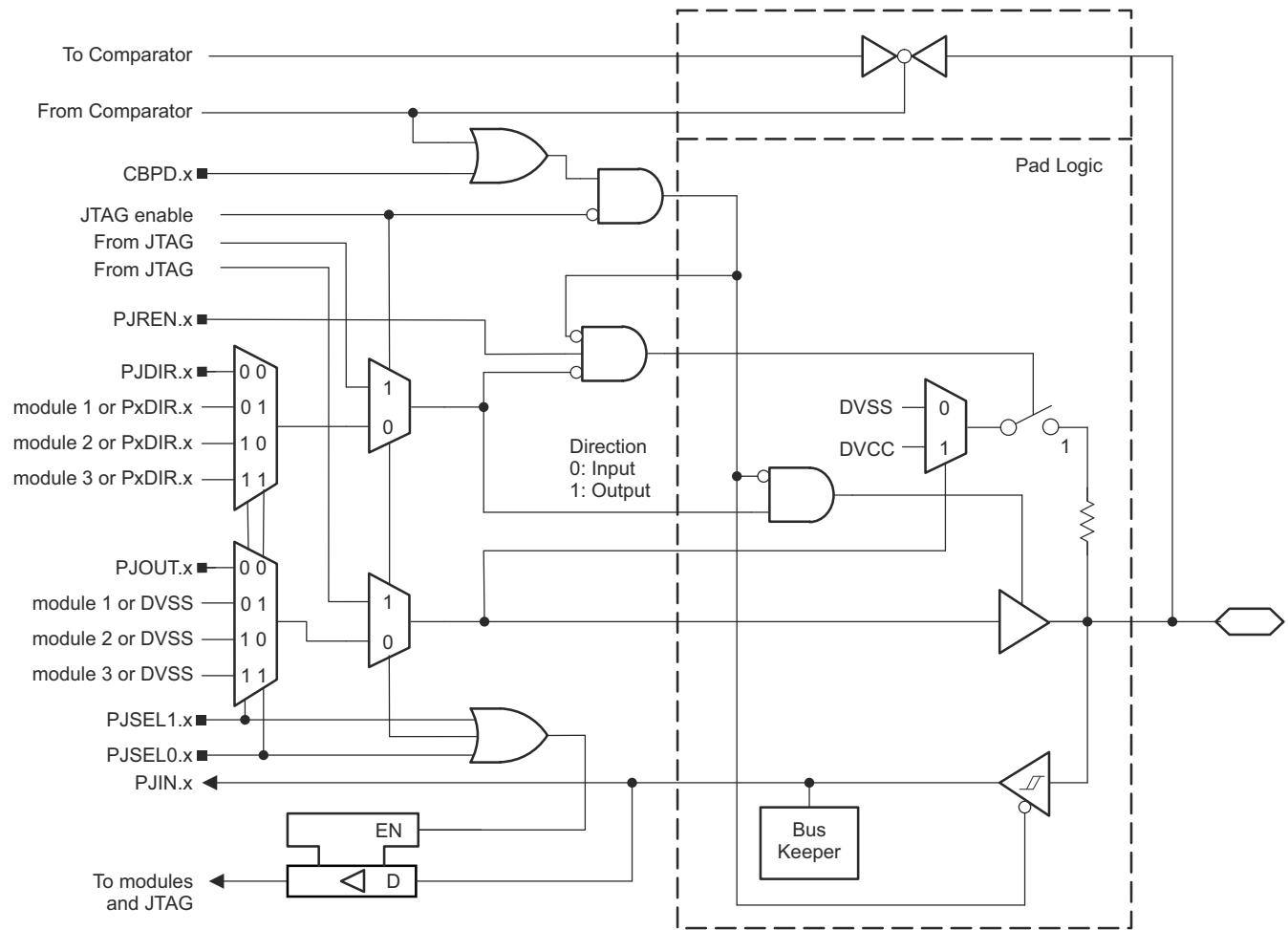
图 9-17. Port P9 (P9.0 to P9.3) Diagram

**Table 9-39. Port P9 (P9.0 to P9.3) Pin Functions**

| PIN NAME (P9.x)   | x | FUNCTION                | CONTROL BITS OR SIGNALS <sup>(1)</sup> |          |          |       |
|-------------------|---|-------------------------|----------------------------------------|----------|----------|-------|
|                   |   |                         | P9DIR.x                                | P9SEL1.x | P9SEL0.x | LCDSz |
| P9.0/TA1.0/LCDS20 | 0 | P9.0 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                   |   | TA1.CCI0B               | 0                                      | 0        | 1        | 0     |
|                   |   | TA1.0                   | 1                                      |          |          |       |
|                   |   | N/A                     | 0                                      | 1        | 0        | 0     |
|                   |   | Internally tied to DVSS | 1                                      |          |          |       |
|                   |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                   |   | Internally tied to DVSS | 1                                      |          |          |       |
|                   |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P9.1/SMCLK/LCDS19 | 1 | P9.1 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                   |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                   |   | Internally tied to DVSS | 1                                      |          |          |       |
|                   |   | N/A                     | 0                                      | 1        | 0        | 0     |
|                   |   | SMCLK                   | 1                                      |          |          |       |
|                   |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                   |   | Internally tied to DVSS | 1                                      |          |          |       |
|                   |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P9.2/MCLK/LCDS18  | 2 | P9.2 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                   |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                   |   | Internally tied to DVSS | 1                                      |          |          |       |
|                   |   | N/A                     | 0                                      | 1        | 0        | 0     |
|                   |   | MCLK                    | 1                                      |          |          |       |
|                   |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                   |   | Internally tied to DVSS | 1                                      |          |          |       |
|                   |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |
| P9.3/ACLK/LCDS17  | 3 | P9.3 (I/O)              | 0 = Input,<br>1 = Output               | 0        | 0        | 0     |
|                   |   | N/A                     | 0                                      | 0        | 1        | 0     |
|                   |   | Internally tied to DVSS | 1                                      |          |          |       |
|                   |   | N/A                     | 0                                      | 1        | 0        | 0     |
|                   |   | ACLK                    | 1                                      |          |          |       |
|                   |   | N/A                     | 0                                      | 1        | 1        | 0     |
|                   |   | Internally tied to DVSS | 1                                      |          |          |       |
|                   |   | Sz <sup>(1)</sup>       | X                                      | X        | X        | 1     |

### 9.14.17 Port PJ (PJ.0 to PJ.3) JTAG Pins TDO, TMS, TCK, TDI/TCLK, Input/Output With Schmitt Trigger

图 9-18 shows the port diagram. 表 9-40 summarizes the selection of the pin function.



Functional representation only.

图 9-18. Port PJ (PJ.0 to PJ.3) Diagram



**Table 9-40. Port PJ (PJ.0 to PJ.3) Pin Functions**

| PIN NAME (PJ.x)                           | x | FUNCTION                       | CONTROL BITS/ SIGNALS <sup>(1)</sup> |          |          |            |
|-------------------------------------------|---|--------------------------------|--------------------------------------|----------|----------|------------|
|                                           |   |                                | PJDIR.x                              | PJSEL1.x | PJSEL0.x | CEPDx (Cx) |
| PJ.0/TDO/ACLK/SRSCG1/<br>DMAE0/C10        | 0 | PJ.0 (I/O) <sup>(2)</sup>      | 0 = Input,<br>1 = Output             | 0        | 0        | 0          |
|                                           |   | TDO <sup>(3)</sup>             | X                                    | X        | X        | 0          |
|                                           |   | N/A                            | 0                                    | 0        | 1        | 0          |
|                                           |   | ACLK                           | 1                                    |          |          |            |
|                                           |   | N/A                            | 0                                    | 1        | 0        | 0          |
|                                           |   | CPU Status Register Bit SCG1   | 1                                    |          |          |            |
|                                           |   | DMAE0                          | 0                                    | 1        | 1        | 0          |
|                                           |   | Internally tied to DVSS        | 1                                    |          |          |            |
|                                           |   | C10 <sup>(5)</sup>             | X                                    | X        | X        | 1          |
| PJ.1/TDI/TCLK/SMCLK/<br>SRSCG0/TA4CLK/C11 | 1 | PJ.1 (I/O) <sup>(2)</sup>      | 0 = Input,<br>1 = Output             | 0        | 0        | 0          |
|                                           |   | TDI/TCLK <sup>(3) (4)</sup>    | X                                    | X        | X        | 0          |
|                                           |   | N/A                            | 0                                    | 0        | 1        | 0          |
|                                           |   | SMCLK                          | 1                                    |          |          |            |
|                                           |   | N/A                            | 0                                    | 1        | 0        | 0          |
|                                           |   | CPU Status Register Bit SCG0   | 1                                    |          |          |            |
|                                           |   | TA4CLK                         | 0                                    | 1        | 1        | 0          |
|                                           |   | Internally tied to DVSS        | 1                                    |          |          |            |
|                                           |   | C11 <sup>(5)</sup>             | X                                    | X        | X        | 1          |
| PJ.2/TMS/MCLK/<br>SROSCOFF/TB0OUTH/C12    | 2 | PJ.2 (I/O) <sup>(2)</sup>      | I: 0; O: 1                           | 0        | 0        | 0          |
|                                           |   | TMS <sup>(3) (4)</sup>         | X                                    | X        | X        | 0          |
|                                           |   | N/A                            | 0                                    | 0        | 1        | 0          |
|                                           |   | MCLK                           | 1                                    |          |          |            |
|                                           |   | N/A                            | 0                                    | 1        | 0        | 0          |
|                                           |   | CPU Status Register Bit OSCOFF | 1                                    |          |          |            |
|                                           |   | TB0OUTH                        | 0                                    | 1        | 1        | 0          |
|                                           |   | Internally tied to DVSS        | 1                                    |          |          |            |
|                                           |   | C12 <sup>(5)</sup>             | X                                    | X        | X        | 1          |
| PJ.3/TCK/RTCCLK/<br>SRCPUOFF/TB0.6/C13    | 3 | PJ.3 (I/O) <sup>(2)</sup>      | I: 0; O: 1                           | 0        | 0        | 0          |
|                                           |   | TCK <sup>(3) (4)</sup>         | X                                    | X        | X        | 0          |
|                                           |   | N/A                            | 0                                    | 0        | 1        | 0          |
|                                           |   | RTCCLK                         | 1                                    |          |          |            |
|                                           |   | N/A                            | 0                                    | 1        | 0        | 0          |
|                                           |   | CPU Status Register Bit CPUOFF | 1                                    |          |          |            |
|                                           |   | TB0.CCI6A                      | 0                                    | 1        | 1        | 0          |
|                                           |   | TB0.6                          | 1                                    |          |          |            |
|                                           |   | C13 <sup>(5)</sup>             | X                                    | X        | X        | 1          |

(1) X = Don't care

(2) Default condition

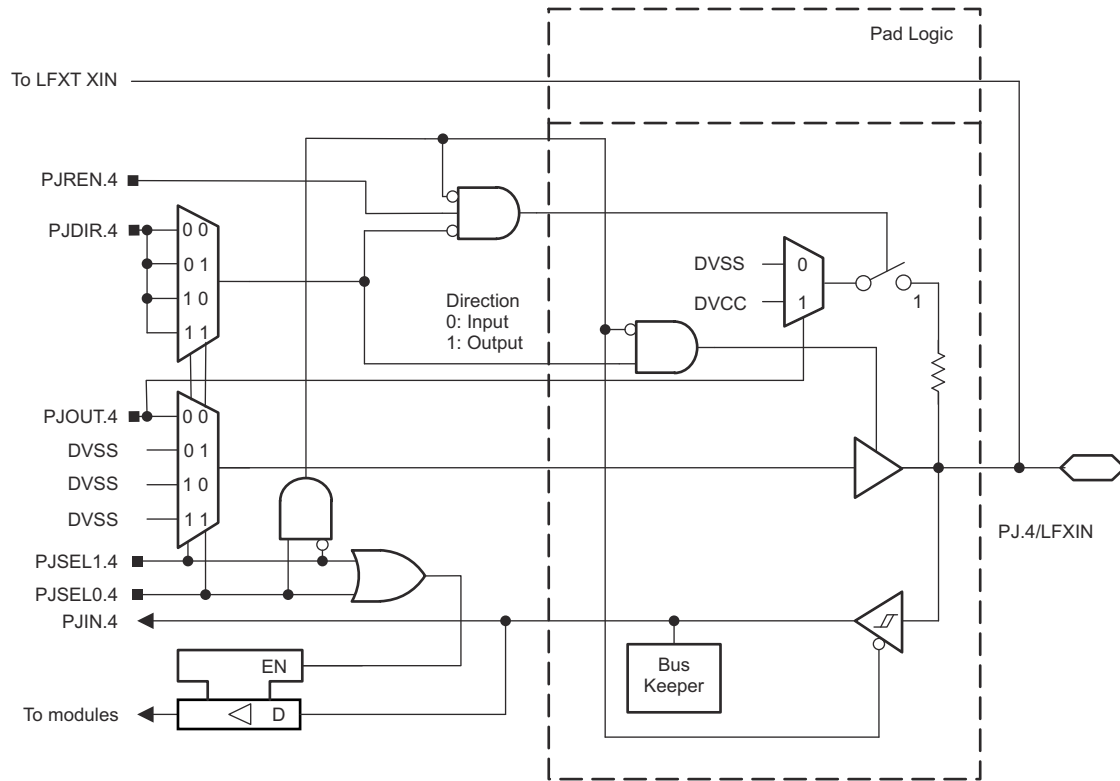
(3) The pin direction is controlled by the JTAG module. JTAG mode selection is made through the SYS module or by the Spy-Bi-Wire four-wire entry sequence. Neither PJSEL1.x and PJSEL0.x nor CEPDx bits have an effect in these cases.

(4) In JTAG mode, pullups are activated automatically on TMS, TCK, and TDI/TCLK. PJREN.x are don't care.

(5) Setting the CEPDx bit of the comparator disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals. Selecting the Cx input pin to the comparator multiplexer with the input select bits in the comparator module automatically disables the output driver and input buffer for that pin, regardless of the state of the associated CEPDx bit.

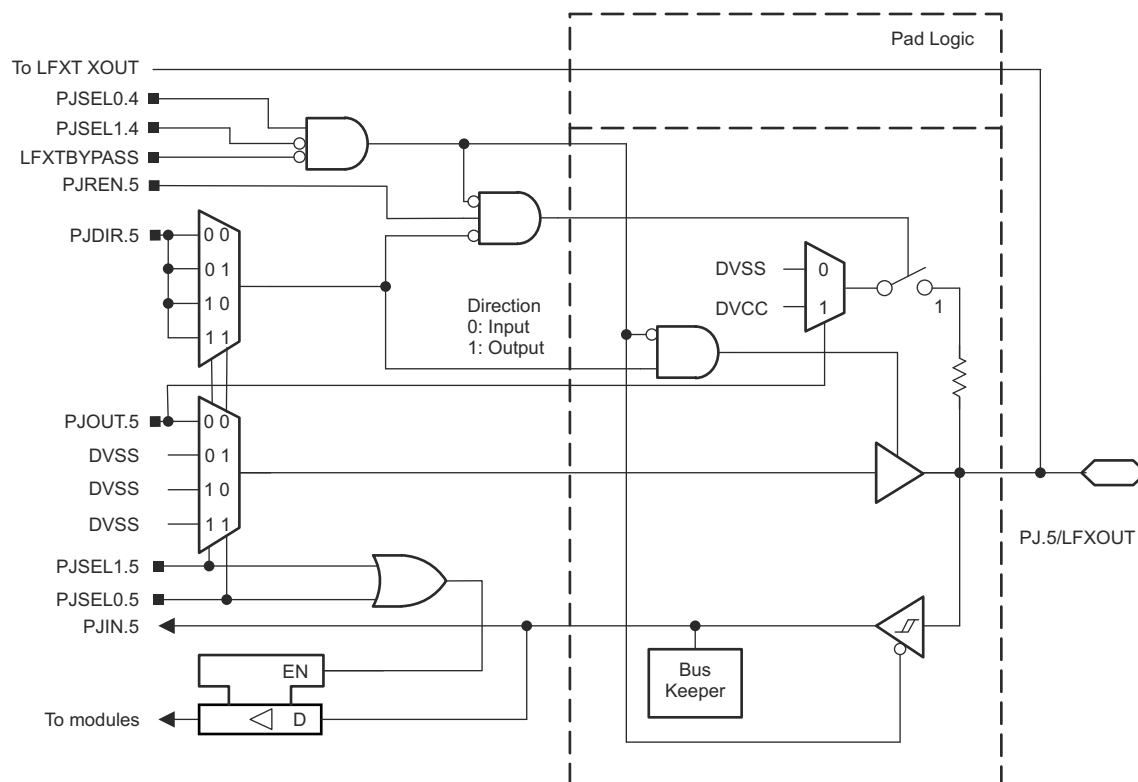
### 9.14.18 Port PJ (PJ.4 and PJ.5) Input/Output With Schmitt Trigger

图 9-19 和 图 9-20 show the port diagrams. 表 9-41 summarizes the selection of the pin function.



Functional representation only.

**图 9-19. Port PJ (PJ.4) Diagram**



Functional representation only.

**图 9-20. Port PJ (PJ.5) Diagram**

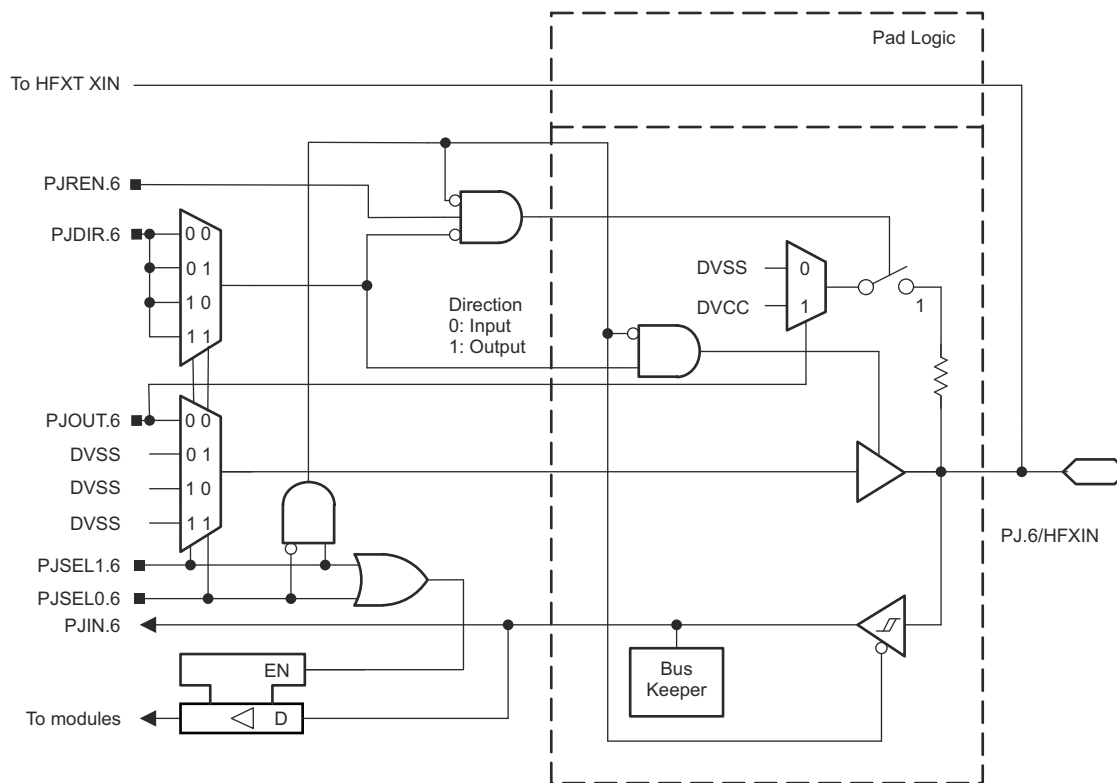
**Table 9-41. Port PJ (PJ.4 and PJ.5) Pin Functions**

| PIN NAME (PJ.x) | x | FUNCTION                           | CONTROL BITS AND SIGNALS <sup>(1)</sup> |                    |                    |          |          |                  |
|-----------------|---|------------------------------------|-----------------------------------------|--------------------|--------------------|----------|----------|------------------|
|                 |   |                                    | PJDIR.x                                 | PJSEL1.5           | PJSEL0.5           | PJSEL1.4 | PJSEL0.4 | LFXT BYPASS      |
| PJ.4/LFXIN      | 4 | PJ.4 (I/O)                         | I: 0; O: 1                              | X                  | X                  | 0        | 0        | X                |
|                 |   | N/A                                | 0                                       | X                  | X                  | 1        | X        | X                |
|                 |   | Internally tied to DVSS            | 1                                       |                    |                    |          |          |                  |
|                 |   | LFXIN crystal mode <sup>(2)</sup>  | X                                       | X                  | X                  | 0        | 1        | 0                |
|                 |   | LFXIN bypass mode <sup>(2)</sup>   | X                                       | X                  | X                  | 0        | 1        | 1                |
| PJ.5/LFXOUT     | 5 | PJ.5 (I/O)                         | I: 0; O: 1                              | 0                  | 0                  | 0        | 0        | 0                |
|                 |   |                                    |                                         |                    |                    | 1        | X        |                  |
|                 |   |                                    |                                         |                    |                    | X        | X        | 1 <sup>(3)</sup> |
|                 |   | N/A                                | 0                                       | see <sup>(1)</sup> | see <sup>(1)</sup> | 0        | 0        | 0                |
|                 |   |                                    |                                         |                    |                    | 1        | X        |                  |
|                 |   |                                    |                                         |                    |                    | X        | X        | 1 <sup>(3)</sup> |
|                 |   | Internally tied to DVSS            | 1                                       | see <sup>(1)</sup> | see <sup>(1)</sup> | 0        | 0        | 0                |
|                 |   |                                    |                                         |                    |                    | 1        | X        |                  |
|                 |   |                                    |                                         |                    |                    | X        | X        | 1 <sup>(3)</sup> |
|                 |   | LFXOUT crystal mode <sup>(2)</sup> | X                                       | X                  | X                  | 0        | 1        | 0                |

- (1) If PJSEL0.5 = 1 or PJSEL1.5 = 1, the general-purpose I/O functionality is disabled. No input function is available. Configured as output, the pin is actively pulled to zero.
- (2) If PJSEL1.4 = 0 and PJSEL0.4 = 1, the general-purpose I/O is disabled. When LFXTBYPASS = 0, PJ.4 and PJ.5 are configured for crystal operation and PJSEL1.5 and PJSEL0.5 are don't care. When LFXTBYPASS = 1, PJ.4 is configured for bypass operation and PJ.5 is configured as general-purpose I/O.
- (3) When PJ.4 is configured in bypass mode, PJ.5 is configured as general-purpose I/O.

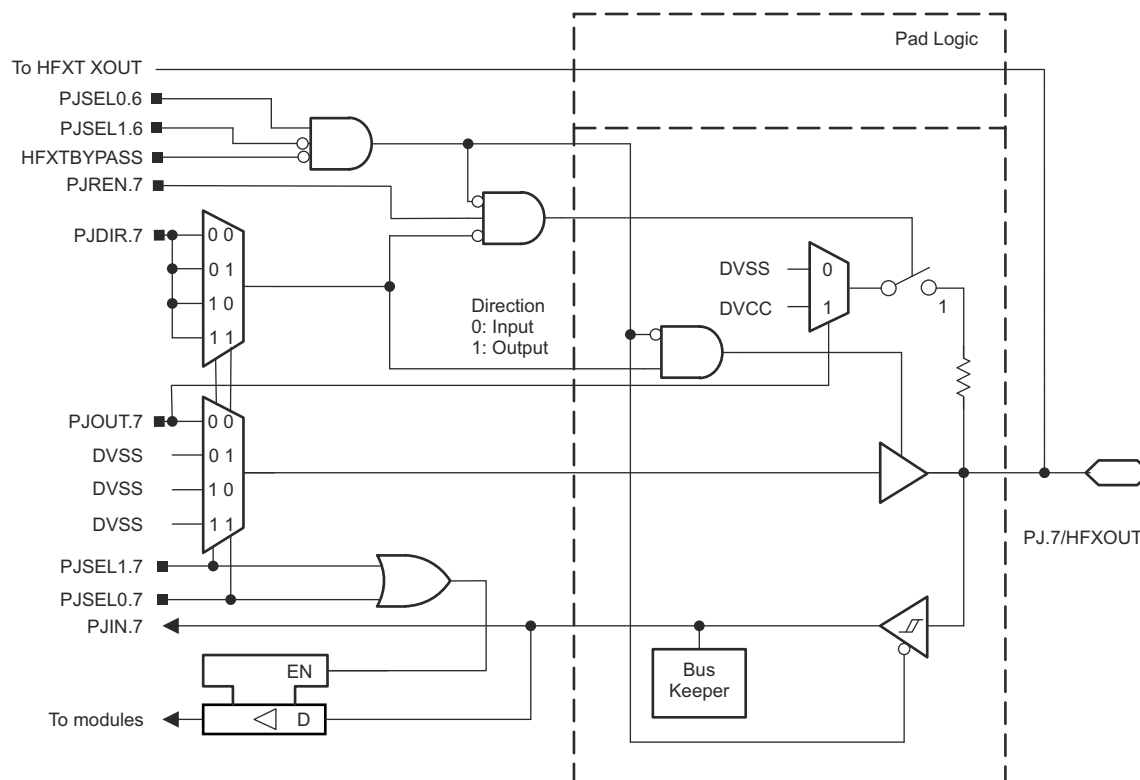
### 9.14.19 Port PJ (PJ.6 and PJ.7) Input/Output With Schmitt Trigger

图 9-21 和 图 9-22 show the port diagrams. 表 9-42 summarizes the selection of the pin function.



Functional representation only.

**图 9-21. Port PJ (PJ.6) Diagram**



Functional representation only.

图 9-22. Port PJ (PJ.7) Diagram

**Table 9-42. Port PJ (PJ.6 and PJ.7) Pin Functions**

| PIN NAME (PJ.x) | x | FUNCTION                           | CONTROL BITS AND SIGNALS <sup>(1)</sup> |                    |                    |          |          |                  |
|-----------------|---|------------------------------------|-----------------------------------------|--------------------|--------------------|----------|----------|------------------|
|                 |   |                                    | PJDIR.x                                 | PJSEL1.7           | PJSEL0.7           | PJSEL1.6 | PJSEL0.6 | HFXTBYPASS       |
| PJ.6/HFXIN      | 6 | PJ.6 (I/O)                         | I: 0; O: 1                              | X                  | X                  | 0        | 0        | X                |
|                 |   | N/A                                | 0                                       | X                  | X                  | 1        | X        | X                |
|                 |   | Internally tied to DVSS            | 1                                       |                    |                    |          |          |                  |
|                 |   | HFXIN crystal mode <sup>(2)</sup>  | X                                       | X                  | X                  | 0        | 1        | 0                |
|                 |   | HFXIN bypass mode <sup>(2)</sup>   | X                                       | X                  | X                  | 0        | 1        | 1                |
| PJ.7/HFXOUT     | 7 | PJ.7 (I/O) <sup>(1)</sup>          | I: 0; O: 1                              | 0                  | 0                  | 0        | 0        | 0                |
|                 |   |                                    |                                         |                    |                    | 1        | X        |                  |
|                 |   |                                    |                                         |                    |                    | X        | X        | 1 <sup>(3)</sup> |
|                 |   | N/A                                | 0                                       | see <sup>(1)</sup> | see <sup>(1)</sup> | 0        | 0        | 0                |
|                 |   |                                    |                                         |                    |                    | 1        | X        |                  |
|                 |   |                                    |                                         |                    |                    | X        | X        | 1 <sup>(3)</sup> |
|                 |   | Internally tied to DVSS            | 1                                       | see <sup>(1)</sup> | see <sup>(1)</sup> | 0        | 0        | 0                |
|                 |   |                                    |                                         |                    |                    | 1        | X        |                  |
|                 |   |                                    |                                         |                    |                    | X        | X        | 1 <sup>(3)</sup> |
|                 |   | HFXOUT crystal mode <sup>(2)</sup> | X                                       | X                  | X                  | 0        | 1        | 0                |

- (1) With PJSEL0.7 = 1 or PJSEL1.7 = 1 the general-purpose I/O functionality is disabled. No input function is available. Configured as output the pin is actively pulled to zero.
- (2) Setting PJSEL1.6 = 0 and PJSEL0.6 = 1 causes the general-purpose I/O to be disabled. When HFXTBYPASS = 0, PJ.6 and PJ.7 are configured for crystal operation and PJSEL1.6 and PJSEL0.7 are do not care. When HFXTBYPASS = 1, PJ.6 is configured for bypass operation and PJ.7 is configured as general-purpose I/O.
- (3) When PJ.6 is configured in bypass mode, PJ.7 is configured as general-purpose I/O.

## 9.15 Device Descriptors (TLV)

表 9-43 lists the Device IDs.

**Table 9-43. Device IDs**

| DEVICE       | PACKAGE | DEVICE ID |        |
|--------------|---------|-----------|--------|
|              |         | 01A05h    | 01A04h |
| MSP430FR6007 | PZ      | 83h       | 2Eh    |
| MSP430FR6005 | PZ      | 83h       | 2Fh    |

表 9-44 lists the contents of the device descriptor tag-length-value (TLV) structure.

**Table 9-44. Device Descriptors**

| (1)               | DESCRIPTION                                 | MSP430FR60xx (UART BSL) |             |
|-------------------|---------------------------------------------|-------------------------|-------------|
|                   |                                             | ADDRESS                 | VALUE       |
| Info Block        | Info length                                 | 01A00h                  | 06h         |
|                   | CRC length                                  | 01A01h                  | 06h         |
|                   | CRC value                                   | 01A02h                  | Per unit    |
|                   |                                             | 01A03h                  | Per unit    |
|                   | Device ID                                   | 01A04h                  | See 表 9-43. |
|                   |                                             | 01A05h                  |             |
|                   | Hardware revision                           | 01A06h                  | Per unit    |
|                   | Firmware revision                           | 01A07h                  | Per unit    |
| Die Record        | Die record tag                              | 01A08h                  | 08h         |
|                   | Die record length                           | 01A09h                  | 0Ah         |
|                   | Lot/wafer ID                                | 01A0Ah                  | Per unit    |
|                   |                                             | 01A0Bh                  | Per unit    |
|                   |                                             | 01A0Ch                  | Per unit    |
|                   |                                             | 01A0Dh                  | Per unit    |
|                   | Die X position                              | 01A0Eh                  | Per unit    |
|                   |                                             | 01A0Fh                  | Per unit    |
|                   | Die Y position                              | 01A10h                  | Per unit    |
|                   |                                             | 01A11h                  | Per unit    |
|                   | Test results                                | 01A12h                  | Per unit    |
|                   |                                             | 01A13h                  | Per unit    |
| ADC12 Calibration | ADC12 calibration tag                       | 01A14h                  | 11h         |
|                   | ADC12 calibration length                    | 01A15h                  | 10h         |
|                   | ADC gain factor <sup>(2)</sup>              | 01A16h                  | Per unit    |
|                   |                                             | 01A17h                  | Per unit    |
|                   | ADC offset <sup>(3)</sup>                   | 01A18h                  | Per unit    |
|                   |                                             | 01A19h                  | Per unit    |
|                   | ADC 1.2-V reference temperature sensor 30°C | 01A1Ah                  | Per unit    |
|                   |                                             | 01A1Bh                  | Per unit    |
|                   | ADC 1.2-V reference temperature sensor 85°C | 01A1Ch                  | Per unit    |
|                   |                                             | 01A1Dh                  | Per unit    |
|                   | ADC 2.0-V reference temperature sensor 30°C | 01A1Eh                  | Per unit    |
|                   |                                             | 01A1Fh                  | Per unit    |
|                   | ADC 2.0-V reference temperature sensor 85°C | 01A20h                  | Per unit    |
|                   |                                             | 01A21h                  | Per unit    |
|                   | ADC 2.5-V reference                         | 01A22h                  | Per unit    |



**Table 9-44. Device Descriptors (continued)**

| (1)               | DESCRIPTION                          | MSP430FR60xx (UART BSL) |          |
|-------------------|--------------------------------------|-------------------------|----------|
|                   |                                      | ADDRESS                 | VALUE    |
|                   | temperature sensor 30°C              | 01A23h                  | Per unit |
|                   | ADC 2.5-V reference                  | 01A24h                  | Per unit |
|                   | temperature sensor 85°C              | 01A25h                  | Per unit |
| REF Calibration   | REF calibration tag                  | 01A26h                  | 12h      |
|                   | REF calibration length               | 01A27h                  | 06h      |
|                   | REF 1.2-V reference                  | 01A28h                  | Per unit |
|                   |                                      | 01A29h                  | Per unit |
|                   | REF 2.0-V reference                  | 01A2Ah                  | Per unit |
|                   |                                      | 01A2Bh                  | Per unit |
|                   | REF 2.5-V reference                  | 01A2Ch                  | Per unit |
|                   |                                      | 01A2Dh                  | Per unit |
| Random Number     | 128-bit random number tag            | 01A2Eh                  | 15h      |
|                   | Random number length                 | 01A2Fh                  | 10h      |
|                   | 128-bit random number <sup>(4)</sup> | 01A30h                  | Per unit |
|                   |                                      | 01A31h                  | Per unit |
|                   |                                      | 01A32h                  | Per unit |
|                   |                                      | 01A33h                  | Per unit |
|                   |                                      | 01A34h                  | Per unit |
|                   |                                      | 01A35h                  | Per unit |
|                   |                                      | 01A36h                  | Per unit |
|                   |                                      | 01A37h                  | Per unit |
|                   |                                      | 01A38h                  | Per unit |
|                   |                                      | 01A39h                  | Per unit |
|                   |                                      | 01A3Ah                  | Per unit |
|                   |                                      | 01A3Bh                  | Per unit |
|                   |                                      | 01A3Ch                  | Per unit |
|                   |                                      | 01A3Dh                  | Per unit |
|                   |                                      | 01A3Eh                  | Per unit |
|                   |                                      | 01A3Fh                  | Per unit |
| BSL Configuration | BSL tag                              | 01A40h                  | 1Ch      |
|                   | BSL length                           | 01A41h                  | 02h      |
|                   | BSL interface                        | 01A42h                  | 00h      |
|                   | BSL interface configuration          | 01A43h                  | 00h      |

(1) NA = Not applicable, Per unit = content can differ from device to device

(2) ADC gain: The gain correction factor is measured at room temperature using a 2.5-V external voltage reference without internal buffer (ADC12VRSEL = 0x2, 0x4, or 0xE). Other settings (for example, using internal reference) can result in different correction factors.

(3) ADC offset: the offset correction factor is measured at room temperature using ADC12VRSEL= 0x2 or 0x4, an external reference,  $V_{R+}$  = external 2.5 V,  $V_{R-}$  = AVSS.

(4) 128-bit random number: The random number is generated during production test using the Microsoft® CryptGenRandom() function.

## 9.16 Memory Map

表 9-45 summarizes the memory organization for all device variants.

**Table 9-45. Memory Organization**

| (1)                                                                                      |            | MSP430FR6007                                                                                    | MSP430FR6005                                                                                    |
|------------------------------------------------------------------------------------------|------------|-------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------|
| Memory (FRAM)<br>Main: interrupt vectors and signatures<br>Main: code memory             | Total Size | 256KB<br>00FFFFh to 00FF80h<br>043FFFh to 004000h                                               | 128KB<br>00FFFFh to 00FF80h<br>0023FFFh to 004000h                                              |
| RAM (shared with LEA)<br>(Sector 2)<br>Block 0                                           | Size       | 4KB<br>(003BFFh to 002C00h)<br>003BFFh to 002C00h                                               | 4KB<br>(003BFFh to 002C00h)<br>003BFFh to 002C00h                                               |
| System RAM<br>(Sector 1)<br>(Sector 0)<br>Main: base location<br>Main: interrupt vectors | Size       | 4KB<br>(002BFFh to 002400h)<br>(0023FFh to 001C00h)<br>002BFFh to 001C00h<br>002BFFh to 002B80h | 4KB<br>(002BFFh to 002400h)<br>(0023FFh to 001C00h)<br>002BFFh to 001C00h<br>002BFFh to 002B80h |
| Device descriptor info (TLV)<br>(FRAM)                                                   | Size       | 256 bytes<br>001AFFh to 001A00h                                                                 | 256 bytes<br>001AFFh to 001A00h                                                                 |
| TI calibration and configuration<br>(FRAM)                                               | Size       | 256 bytes<br>0019FFh to 001900h                                                                 | 256 bytes<br>0019FFh to 001900h                                                                 |
| Bootloader (BSL) memory (ROM)                                                            | BSL 3      | 512 bytes<br>0017FFh to 001600h                                                                 | 512 bytes<br>0017FFh to 001600h                                                                 |
|                                                                                          | BSL 2      | 512 bytes<br>0015FFh to 001400h                                                                 | 512 bytes<br>0015FFh to 001400h                                                                 |
|                                                                                          | BSL 1      | 512 bytes<br>0013FFh to 001200h                                                                 | 512 bytes<br>0013FFh to 001200h                                                                 |
|                                                                                          | BSL 0      | 512 bytes<br>0011FFh to 001000h                                                                 | 512 bytes<br>0011FFh to 001000h                                                                 |
| Peripherals                                                                              | Size       | 4KB<br>000FFFh to 000020h                                                                       | 4KB<br>000FFFh to 000020h                                                                       |
| Tiny RAM                                                                                 | Size       | 22 bytes<br>000001Fh to 00000Ah                                                                 | 22 bytes<br>000001Fh to 00000Ah                                                                 |
| Reserved                                                                                 | Size       | 10 bytes<br>000009h to 000000h                                                                  | 10 bytes<br>000009h to 000000h                                                                  |

(1) All address space not listed is considered vacant memory.

### 9.16.1 Peripheral File Map

For complete module register descriptions, see the [MSP430FR58xx](#), [MSP430FR59xx](#), and [MSP430FR6xx Family User's Guide](#). Table 1-1 lists the base and end addresses of the registers for each peripheral.

**Table 9-46. Peripherals**

| MODULE NAME                                              | BASE ADDRESS | END ADDRESS |
|----------------------------------------------------------|--------------|-------------|
| Special Functions (see <a href="#">表 9-47</a> )          | 0100h        | 011Fh       |
| PMM (see <a href="#">表 9-48</a> )                        | 0120h        | 013Fh       |
| FRAM Control (see <a href="#">表 9-49</a> )               | 0140h        | 014Fh       |
| CRC (see <a href="#">表 9-50</a> )                        | 0150h        | 0157h       |
| RAM Control (see <a href="#">表 9-51</a> )                | 0158h        | 0159h       |
| Watchdog (see <a href="#">表 9-52</a> )                   | 015Ch        | 015Dh       |
| CS (see <a href="#">表 9-53</a> )                         | 0160h        | 016Fh       |
| SYS (see <a href="#">表 9-54</a> )                        | 0180h        | 019Fh       |
| Shared Reference (see <a href="#">表 9-55</a> )           | 01B0h        | 01B1h       |
| Digital I/O (see <a href="#">表 9-56</a> )                | 0200h        | 033Fh       |
| TA0 (see <a href="#">表 9-57</a> )                        | 0340h        | 036Fh       |
| TA1 (see <a href="#">表 9-58</a> )                        | 0380h        | 03AFh       |
| TB0 (see <a href="#">表 9-59</a> )                        | 03C0h        | 03EFh       |
| TA2 (see <a href="#">表 9-60</a> )                        | 0400h        | 042Fh       |
| TA3 (see <a href="#">表 9-61</a> )                        | 0440h        | 046Fh       |
| RTC_C (see <a href="#">表 9-62</a> )                      | 04A0h        | 04BFh       |
| 32-Bit Hardware Multiplier (see <a href="#">表 9-63</a> ) | 04C0h        | 04EFh       |
| DMA (see <a href="#">表 9-64</a> )                        | 0500h        | 056Fh       |
| MPU Control (see <a href="#">表 9-65</a> )                | 05A0h        | 05AFh       |
| eUSCI_A0 (see <a href="#">表 9-66</a> )                   | 05C0h        | 05DFh       |
| eUSCI_A1 (see <a href="#">表 9-67</a> )                   | 05E0h        | 05FFh       |
| eUSCI_A2 (see <a href="#">表 9-68</a> )                   | 0600h        | 061Fh       |
| eUSCI_A3 (see <a href="#">表 9-69</a> )                   | 0620h        | 063Fh       |
| eUSCI_B0 (see <a href="#">表 9-70</a> )                   | 0640h        | 066Fh       |
| eUSCI_B1 (see <a href="#">表 9-71</a> )                   | 0680h        | 06AFh       |
| TA4 (see <a href="#">表 9-72</a> )                        | 07C0h        | 07EFh       |
| ADC12_B (see <a href="#">表 9-73</a> )                    | 0800h        | 089Fh       |
| Comparator E (see <a href="#">表 9-74</a> )               | 08C0h        | 08CFh       |
| CRC32 (see <a href="#">表 9-75</a> )                      | 0980h        | 09AFh       |
| AES256 (see <a href="#">表 9-76</a> )                     | 09C0h        | 09CFh       |
| LCD_C (see <a href="#">表 9-77</a> )                      | 0A00h        | 0A5Fh       |
| LEA (see <a href="#">表 9-78</a> )                        | 0A80h        | 0AFFh       |
| SAPH (see <a href="#">表 9-79</a> )                       | 0E00h        | 0E7Fh       |
| SDHS (see <a href="#">表 9-80</a> )                       | 0E80h        | 0EBFh       |
| UUPS (see <a href="#">表 9-81</a> )                       | 0EC0h        | 0EDFh       |
| HSPLL (see <a href="#">表 9-82</a> )                      | 0EE0h        | 0EFFh       |

**Table 9-47. Special Functions Registers**

| REGISTER DESCRIPTION | ACRONYM | ADDRESS |
|----------------------|---------|---------|
| Interrupt Enable     | SFRIE1  | 0100h   |
| Interrupt Flag       | SFRIFG1 | 0102h   |
| Reset Pin Control    | SFRRPCR | 0104h   |

**Table 9-48. PMM Registers**

| REGISTER DESCRIPTION   | ACRONYM | ADDRESS |
|------------------------|---------|---------|
| PMM Control 0          | PMMCTL0 | 0120h   |
| PMM Interrupt Flag     | PMMIFG  | 012Ah   |
| Power Mode 5 Control 0 | PM5CTL0 | 0130h   |

**Table 9-49. FRAM Control Registers**

| REGISTER DESCRIPTION        | ACRONYM | ADDRESS |
|-----------------------------|---------|---------|
| FRAM Controller A Control 0 | FRCTL0  | 0140h   |
| General Control 0           | GCCTL0  | 0144h   |
| General Control 1           | GCCTL1  | 0146h   |

**Table 9-50. CRC Registers**

| REGISTER DESCRIPTION          | ACRONYM   | ADDRESS |
|-------------------------------|-----------|---------|
| CRC Data In                   | CRCDI     | 0150h   |
| CRC Data In Reverse Byte      | CRCDIRB   | 0152h   |
| CRC Initialization and Result | CRCINIRES | 0154h   |
| CRC Result Reverse            | CRCRESR   | 0156h   |

**Table 9-51. RAM Control Registers**

| REGISTER DESCRIPTION     | ACRONYM | ADDRESS |
|--------------------------|---------|---------|
| RAM Controller Control 0 | RCCTL0  | 0158h   |
| RAM Controller Control 1 | RCCTL1  | 015Ah   |

**Table 9-52. Watchdog Registers**

| REGISTER DESCRIPTION   | ACRONYM | ADDRESS |
|------------------------|---------|---------|
| Watchdog Timer Control | WDTCTL  | 015Ch   |

**Table 9-53. CS Registers**

| REGISTER DESCRIPTION   | ACRONYM | ADDRESS |
|------------------------|---------|---------|
| Clock System Control 0 | CSCTL0  | 0160h   |
| Clock System Control 1 | CSCTL1  | 0162h   |
| Clock System Control 2 | CSCTL2  | 0164h   |
| Clock System Control 3 | CSCTL3  | 0166h   |
| Clock System Control 4 | CSCTL4  | 0168h   |
| Clock System Control 5 | CSCTL5  | 016Ah   |
| Clock System Control 6 | CSCTL6  | 016Ch   |

**Table 9-54. SYS Registers**

| REGISTER DESCRIPTION        | ACRONYM  | ADDRESS |
|-----------------------------|----------|---------|
| System Control              | SYSCTL   | 0180h   |
| JTAG Mailbox Control        | SYSJMBC  | 0186h   |
| JTAG Mailbox Input          | SYSJMBI0 | 0188h   |
| JTAG Mailbox Input          | SYSJMBI1 | 018Ah   |
| JTAG Mailbox Output         | SYSJMBO0 | 018Ch   |
| JTAG Mailbox Output         | SYSJMBO1 | 018Eh   |
| User NMI Vector Generator   | SYSUNIV  | 019Ah   |
| System NMI Vector Generator | SYSSNIV  | 019Ch   |
| Reset Vector Generator      | SYSRSTIV | 019Eh   |

**Table 9-55. Shared Reference Registers**

| REGISTER DESCRIPTION | ACRONYM | ADDRESS |
|----------------------|---------|---------|
| REF Control 0        | REFCTL0 | 01B0h   |

**Table 9-56. Digital I/O Registers**

| REGISTER DESCRIPTION         | ACRONYM | ADDRESS |
|------------------------------|---------|---------|
| Port A Input                 | PAIN    | 0200h   |
| Port 1 Input                 | P1IN    | 0200h   |
| Port 2 Input                 | P2IN    | 0201h   |
| Port A Output                | PAOUT   | 0202h   |
| Port 1 Output                | P1OUT   | 0202h   |
| Port 2 Output                | P2OUT   | 0203h   |
| Port A Direction             | PADIR   | 0204h   |
| Port 1 Direction             | P1DIR   | 0204h   |
| Port 2 Direction             | P2DIR   | 0205h   |
| Port A Resistor Enable       | PAREN   | 0206h   |
| Port 1 Resistor Enable       | P1REN   | 0206h   |
| Port 2 Resistor Enable       | P2REN   | 0207h   |
| Port A Select 0              | PASEL0  | 020Ah   |
| Port 1 Select 0              | P1SEL0  | 020Ah   |
| Port 2 Select 0              | P2SEL0  | 020Bh   |
| Port A Select 1              | PASEL1  | 020Ch   |
| Port 1 Select 1              | P1SEL1  | 020Ch   |
| Port 2 Select 1              | P2SEL1  | 020Dh   |
| Port 1 Interrupt Vector      | P1IV    | 020Eh   |
| Port A Complement Select     | PASELC  | 0216h   |
| Port 1 Complement Select     | P1SELC  | 0216h   |
| Port 2 Complement Select     | P2SELC  | 0217h   |
| Port A Interrupt Edge Select | PAIES   | 0218h   |
| Port 1 Interrupt Edge Select | P1IES   | 0218h   |
| Port 2 Interrupt Edge Select | P2IES   | 0219h   |
| Port A Interrupt Enable      | PAIE    | 021Ah   |
| Port 1 Interrupt Enable      | P1IE    | 021Ah   |
| Port 2 Interrupt Enable      | P2IE    | 021Bh   |
| Port A Interrupt Flag        | PAIFG   | 021Ch   |
| Port 1 Interrupt Flag        | P1IFG   | 021Ch   |

**Table 9-56. Digital I/O Registers (continued)**

| REGISTER DESCRIPTION         | ACRONYM | ADDRESS |
|------------------------------|---------|---------|
| Port 2 Interrupt Flag        | P2IFG   | 021Dh   |
| Port 2 Interrupt Vector      | P2IV    | 021Eh   |
| Port B Input                 | PBIN    | 0220h   |
| Port 3 Input                 | P3IN    | 0220h   |
| Port 4 Input                 | P4IN    | 0221h   |
| Port B Output                | PBOUT   | 0222h   |
| Port 3 Output                | P3OUT   | 0222h   |
| Port 4 Output                | P4OUT   | 0223h   |
| Port B Direction             | PBDIR   | 0224h   |
| Port 3 Direction             | P3DIR   | 0224h   |
| Port 4 Direction             | P4DIR   | 0225h   |
| Port B Resistor Enable       | PBREN   | 0226h   |
| Port 3 Resistor Enable       | P3REN   | 0226h   |
| Port 4 Resistor Enable       | P4REN   | 0227h   |
| Port B Select 0              | PBSEL0  | 022Ah   |
| Port 3 Select 0              | P3SEL0  | 022Ah   |
| Port 4 Select 0              | P4SEL0  | 022Bh   |
| Port B Select 1              | PBSEL1  | 022Ch   |
| Port 3 Select 1              | P3SEL1  | 022Ch   |
| Port 4 Select 1              | P4SEL1  | 022Dh   |
| Port 3 Interrupt Vector      | P3IV    | 022Eh   |
| Port B Complement Select     | PBSELC  | 0236h   |
| Port 3 Complement Select     | P3SELC  | 0236h   |
| Port 4 Complement Select     | P4SELC  | 0237h   |
| Port B Interrupt Edge Select | PBIES   | 0238h   |
| Port 3 Interrupt Edge Select | P3IES   | 0238h   |
| Port 4 Interrupt Edge Select | P4IES   | 0239h   |
| Port B Interrupt Enable      | PBIE    | 023Ah   |
| Port 3 Interrupt Enable      | P3IE    | 023Ah   |
| Port 4 Interrupt Enable      | P4IE    | 023Bh   |
| Port B Interrupt Flag        | PBIFG   | 023Ch   |
| Port 3 Interrupt Flag        | P3IFG   | 023Ch   |
| Port 4 Interrupt Flag        | P4IFG   | 023Dh   |
| Port 4 Interrupt Vector      | P4IV    | 023Eh   |
| Port C Input                 | PCIN    | 0240h   |
| Port 5 Input                 | P5IN    | 0240h   |
| Port 6 Input                 | P6IN    | 0241h   |
| Port C Output                | PCOUT   | 0242h   |
| Port 5 Output                | P5OUT   | 0242h   |
| Port 6 Output                | P6OUT   | 0243h   |
| Port C Direction             | PCDIR   | 0244h   |
| Port 5 Direction             | P5DIR   | 0244h   |
| Port 6 Direction             | P6DIR   | 0245h   |
| Port C Resistor Enable       | PCREN   | 0246h   |
| Port 5 Resistor Enable       | P5REN   | 0246h   |

**Table 9-56. Digital I/O Registers (continued)**

| REGISTER DESCRIPTION         | ACRONYM | ADDRESS |
|------------------------------|---------|---------|
| Port 6 Resistor Enable       | P6REN   | 0247h   |
| Port C Select 0              | PCSEL0  | 024Ah   |
| Port 5 Select 0              | P5SEL0  | 024Ah   |
| Port 6 Select 0              | P6SEL0  | 024Bh   |
| Port C Select 1              | PCSEL1  | 024Ch   |
| Port 5 Select 1              | P5SEL1  | 024Ch   |
| Port 6 Select 1              | P6SEL1  | 024Dh   |
| Port 5 Interrupt Vector      | P5IV    | 024Eh   |
| Port C Complement Select     | PCSELC  | 0256h   |
| Port 5 Complement Select     | P5SELC  | 0256h   |
| Port 6 Complement Select     | P6SELC  | 0257h   |
| Port C Interrupt Edge Select | PCIES   | 0258h   |
| Port 5 Interrupt Edge Select | P5IES   | 0258h   |
| Port 6 Interrupt Edge Select | P6IES   | 0259h   |
| Port C Interrupt Enable      | PCIE    | 025Ah   |
| Port 5 Interrupt Enable      | P5IE    | 025Ah   |
| Port 6 Interrupt Enable      | P6IE    | 025Bh   |
| Port C Interrupt Flag        | PCIFG   | 025Ch   |
| Port 5 Interrupt Flag        | P5IFG   | 025Ch   |
| Port 6 Interrupt Flag        | P6IFG   | 025Dh   |
| Port 6 Interrupt Vector      | P6IV    | 025Eh   |
| Port D Input                 | PDIN    | 0260h   |
| Port 7 Input                 | P7IN    | 0260h   |
| Port 8 Input                 | P8IN    | 0261h   |
| Port D Output                | PDOUT   | 0262h   |
| Port 7 Output                | P7OUT   | 0262h   |
| Port 8 Output                | P8OUT   | 0263h   |
| Port D Direction             | PDDIR   | 0264h   |
| Port 7 Direction             | P7DIR   | 0264h   |
| Port 8 Direction             | P8DIR   | 0265h   |
| Port D Resistor Enable       | PDREN   | 0266h   |
| Port 7 Resistor Enable       | P7REN   | 0266h   |
| Port 8 Resistor Enable       | P8REN   | 0267h   |
| Port D Select 0              | PDSEL0  | 026Ah   |
| Port 7 Select 0              | P7SEL0  | 026Ah   |
| Port 8 Select 0              | P8SEL0  | 026Bh   |
| Port D Select 1              | PDSEL1  | 026Ch   |
| Port 7 Select 1              | P7SEL1  | 026Ch   |
| Port 8 Select 1              | P8SEL1  | 026Dh   |
| Port 7 Interrupt Vector      | P7IV    | 026Eh   |
| Port D Complement Select     | PDSELC  | 0276h   |
| Port 7 Complement Select     | P7SELC  | 0276h   |
| Port 8 Complement Select     | P8SELC  | 0277h   |
| Port D Interrupt Edge Select | PDIES   | 0278h   |
| Port 7 Interrupt Edge Select | P7IES   | 0278h   |

**Table 9-56. Digital I/O Registers (continued)**

| REGISTER DESCRIPTION         | ACRONYM | ADDRESS |
|------------------------------|---------|---------|
| Port 8 Interrupt Edge Select | P8IES   | 0279h   |
| Port D Interrupt Enable      | PDIE    | 027Ah   |
| Port 7 Interrupt Enable      | P7IE    | 027Ah   |
| Port 8 Interrupt Enable      | P8IE    | 027Bh   |
| Port D Interrupt Flag        | PDIFG   | 027Ch   |
| Port 7 Interrupt Flag        | P7IFG   | 027Ch   |
| Port 8 Interrupt Flag        | P8IFG   | 027Dh   |
| Port 8 Interrupt Vector      | P8IV    | 027Eh   |
| Port E Input                 | PEIN    | 0280h   |
| Port 9 Input                 | P9IN    | 0280h   |
| Port E Output                | PEOUT   | 0282h   |
| Port 9 Output                | P9OUT   | 0282h   |
| Port E Direction             | PEDIR   | 0284h   |
| Port 9 Direction             | P9DIR   | 0284h   |
| Port E Resistor Enable       | PEREN   | 0286h   |
| Port 9 Resistor Enable       | P9REN   | 0286h   |
| Port E Select 0              | PESEL0  | 028Ah   |
| Port 9 Select 0              | P9SEL0  | 028Ah   |
| Port E Select 1              | PESEL1  | 028Ch   |
| Port 9 Select 1              | P9SEL1  | 028Ch   |
| Port 9 Interrupt Vector      | P9IV    | 028Eh   |
| Port E Complement Select     | PESELC  | 0296h   |
| Port 9 Complement Select     | P9SELC  | 0296h   |
| Port E Interrupt Edge Select | PEIES   | 0298h   |
| Port 9 Interrupt Edge Select | P9IES   | 0298h   |
| Port E Interrupt Enable      | PEIE    | 029Ah   |
| Port 9 Interrupt Enable      | P9IE    | 029Ah   |
| Port E Interrupt Flag        | PEIFG   | 029Ch   |
| Port 9 Interrupt Flag        | P9IFG   | 029Ch   |
| Port J Input                 | PJIN    | 0320h   |
| Port J Output                | PJOUT   | 0322h   |
| Port J Direction             | PJDIR   | 0324h   |
| Port J Resistor Enable       | PJREN   | 0326h   |
| Port J Select 0              | PJSEL0  | 032Ah   |
| Port J Select 1              | PJSEL1  | 032Ch   |
| Port J Complement Select     | PJSELC  | 0336h   |



**Table 9-57. TA0 Registers**

| REGISTER DESCRIPTION             | ACRONYM  | ADDRESS |
|----------------------------------|----------|---------|
| Timer_A0 Control                 | TA0CTL   | 0340h   |
| Timer_A0 Capture/Compare Control | TA0CCTL0 | 0342h   |
| Timer_A0 Capture/Compare Control | TA0CCTL1 | 0344h   |
| Timer_A0 Capture/Compare Control | TA0CCTL2 | 0346h   |
| Timer_A0 Counter                 | TA0R     | 0350h   |
| Timer_A0 Capture/Compare         | TA0CCR0  | 0352h   |
| Timer_A0 Capture/Compare         | TA0CCR1  | 0354h   |
| Timer_A0 Capture/Compare         | TA0CCR2  | 0356h   |
| Timer_A0 Expansion 0             | TA0EX0   | 0360h   |
| Timer_A0 Interrupt Vector        | TA0IV    | 036Eh   |

**Table 9-58. TA1 Registers**

| REGISTER DESCRIPTION             | ACRONYM  | ADDRESS |
|----------------------------------|----------|---------|
| Timer_A1 Control                 | TA1CTL   | 0380h   |
| Timer_A1 Capture/Compare Control | TA1CCTL0 | 0382h   |
| Timer_A1 Capture/Compare Control | TA1CCTL1 | 0384h   |
| Timer_A1 Capture/Compare Control | TA1CCTL2 | 0386h   |
| Timer_A1 Counter                 | TA1R     | 0390h   |
| Timer_A1 Capture/Compare         | TA1CCR0  | 0392h   |
| Timer_A1 Capture/Compare         | TA1CCR1  | 0394h   |
| Timer_A1 Capture/Compare         | TA1CCR2  | 0396h   |
| Timer_A1 Expansion 0             | TA1EX0   | 03A0h   |
| Timer_A1 Interrupt Vector        | TA1IV    | 03AEh   |

**Table 9-59. TB0 Registers**

| REGISTER DESCRIPTION             | ACRONYM  | ADDRESS |
|----------------------------------|----------|---------|
| Timer_B0 Control                 | TB0CTL   | 03C0h   |
| Timer_B0 Capture/Compare Control | TB0CCTL0 | 03C2h   |
| Timer_B0 Capture/Compare Control | TB0CCTL1 | 03C4h   |
| Timer_B0 Capture/Compare Control | TB0CCTL2 | 03C6h   |
| Timer_B0 Capture/Compare Control | TB0CCTL3 | 03C8h   |
| Timer_B0 Capture/Compare Control | TB0CCTL4 | 03CAh   |
| Timer_B0 Capture/Compare Control | TB0CCTL5 | 03CCh   |
| Timer_B0 Capture/Compare Control | TB0CCTL6 | 03CEh   |
| Timer_B0 Counter                 | TB0R     | 03D0h   |
| Timer_B0 Capture/Compare         | TB0CCR0  | 03D2h   |
| Timer_B0 Capture/Compare         | TB0CCR1  | 03D4h   |
| Timer_B0 Capture/Compare         | TB0CCR2  | 03D6h   |
| Timer_B0 Capture/Compare         | TB0CCR3  | 03D8h   |
| Timer_B0 Capture/Compare         | TB0CCR4  | 03DAh   |
| Timer_B0 Capture/Compare         | TB0CCR5  | 03DCh   |
| Timer_B0 Capture/Compare         | TB0CCR6  | 03DEh   |
| Timer_B0 Expansion 0             | TB0EX0   | 03E0h   |
| Timer_B0 Interrupt Vector        | TB0IV    | 03EEh   |

**Table 9-60. TA2 Registers**

| REGISTER DESCRIPTION             | ACRONYM  | ADDRESS |
|----------------------------------|----------|---------|
| Timer_A2 Control                 | TA2CTL   | 0400h   |
| Timer_A2 Capture/Compare Control | TA2CCTL0 | 0402h   |
| Timer_A2 Capture/Compare Control | TA2CCTL1 | 0404h   |
| Timer_A2 Counter                 | TA2R     | 0410h   |
| Timer_A2 Capture/Compare         | TA2CCR0  | 0412h   |
| Timer_A2 Capture/Compare         | TA2CCR1  | 0414h   |
| Timer_A2 Expansion 0             | TA2EX0   | 0420h   |
| Timer_A2 Interrupt Vector        | TA2IV    | 042Eh   |

**Table 9-61. TA3 Registers**

| REGISTER DESCRIPTION             | ACRONYM  | ADDRESS |
|----------------------------------|----------|---------|
| Timer_A3 Control                 | TA3CTL   | 0440h   |
| Timer_A3 Capture/Compare Control | TA3CCTL0 | 0442h   |
| Timer_A3 Capture/Compare Control | TA3CCTL1 | 0444h   |
| Timer_A3 Counter                 | TA3R     | 0450h   |
| Timer_A3 Capture/Compare         | TA3CCR0  | 0452h   |
| Timer_A3 Capture/Compare         | TA3CCR1  | 0454h   |
| Timer_A3 Expansion 0             | TA3EX0   | 0460h   |
| Timer_A3 Interrupt Vector        | TA3IV    | 046Eh   |

**Table 9-62. RTC\_C Registers**

| REGISTER DESCRIPTION                      | ACRONYM    | ADDRESS |
|-------------------------------------------|------------|---------|
| Real-Time Clock Control 0                 | RTCCTL0    | 04A0h   |
| Real-Time Clock Control 1, 3              | RTCCTL13   | 04A2h   |
| Real-Time Clock Offset Calibration        | RTCOCAL    | 04A4h   |
| Real-Time Clock Temperature Compensation  | RTCTCMP    | 04A6h   |
| Real-Time Clock Prescale Timer 0 Control  | RTCPS0CTL  | 04A8h   |
| Real-Time Clock Prescale Timer 1 Control  | RTCPS1CTL  | 04AAh   |
| Real-Time Clock Prescale Timer Counter    | RTCPS      | 04ACh   |
| Prescale Timer 0 Counter Value            | RT0PS      | 04ACh   |
| Prescale Timer 1 Counter Value            | RT1PS      | 04ADh   |
| Real-Time Clock Interrupt Vector          | RTCIV      | 04AEh   |
| Real-Time Clock Seconds and Minutes       | RTCTIM0    | 04B0h   |
| Real-Time Clock Hour, Day of Week         | RTCTIM1    | 04B2h   |
| Real-Time Clock Date                      | RTCDATE    | 04B4h   |
| Real-Time Clock Year                      | RTCYEAR    | 04B6h   |
| Real-Time Clock Minute and Hour           | RTCAMINHR  | 04B8h   |
| Real-Time Clock Alarm Day of Week and Day | RTCADOWDAY | 04BAh   |
| Binary-to-BCD Conversion                  | BIN2BCD    | 04BCh   |
| BCD-to-Binary Conversion                  | BCD2BIN    | 04BEh   |

**Table 9-63. 32-Bit Hardware Multiplier Registers**

| REGISTER DESCRIPTION                                      | ACRONYM   | ADDRESS |
|-----------------------------------------------------------|-----------|---------|
| 16-bit operand one – multiply                             | MPY       | 04C0h   |
| 16-bit operand one – signed multiply                      | MPYS      | 04C2h   |
| 16-bit operand one – multiply accumulate                  | MAC       | 04C4h   |
| 16-bit operand one – signed multiply accumulate           | MACS      | 04C6h   |
| 16-bit operand two                                        | OP2       | 04C8h   |
| 16x16-bit result low word                                 | RESLO     | 04CAh   |
| 16x16-bit result high word                                | RESHI     | 04CCh   |
| 16x16-bit sum extension                                   | SUMEXT    | 04CEh   |
| 32-bit operand 1 – multiply – low word                    | MPY32L    | 04D0h   |
| 32-bit operand 1 – multiply – high word                   | MPY32H    | 04D2h   |
| 32-bit operand 1 – signed multiply – low word             | MPYS32L   | 04D4h   |
| 32-bit operand 1 – signed multiply – high word            | MPYS32H   | 04D6h   |
| 32-bit operand 1 – multiply accumulate – low word         | MAC32L    | 04D8h   |
| 32-bit operand 1 – multiply accumulate – high word        | MAC32H    | 04DAh   |
| 32-bit operand 1 – signed multiply accumulate – low word  | MACS32L   | 04DCh   |
| 32-bit operand 1 – signed multiply accumulate – high word | MACS32H   | 04DEh   |
| 32-bit operand 2 – low word                               | OP2L      | 04E0h   |
| 32-bit operand 2 – high word                              | OP2H      | 04E2h   |
| 32x32-bit result 0 – least significant word               | RES0      | 04E4h   |
| 32x32-bit result 1                                        | RES1      | 04E6h   |
| 32x32-bit result 2                                        | RES2      | 04E8h   |
| 32x32-bit result 3 – most significant word                | RES3      | 04EAh   |
| MPY32 control 0                                           | MPY32CTL0 | 04ECh   |

**Table 9-64. DMA Registers**

| REGISTER DESCRIPTION              | ACRONYM | ADDRESS |
|-----------------------------------|---------|---------|
| DMA Control 0                     | DMACTL0 | 0500h   |
| DMA Control 1                     | DMACTL1 | 0502h   |
| DMA Control 2                     | DMACTL2 | 0504h   |
| DMA Control 4                     | DMACTL4 | 0508h   |
| DMA Interrupt Vector              | DMAIV   | 050Eh   |
| DMA Channel 0 Control             | DMA0CTL | 0510h   |
| DMA Channel 0 Source Address      | DMA0SA  | 0512h   |
| DMA Channel 0 Destination Address | DMA0DA  | 0516h   |
| DMA Channel 0 Transfer Size       | DMA0SZ  | 051Ah   |
| DMA Channel 1 Control             | DMA1CTL | 0520h   |
| DMA Channel 1 Source Address      | DMA1SA  | 0522h   |
| DMA Channel 1 Destination Address | DMA1DA  | 0526h   |
| DMA Channel 1 Transfer Size       | DMA1SZ  | 052Ah   |
| DMA Channel 2 Control             | DMA2CTL | 0530h   |
| DMA Channel 2 Source Address      | DMA2SA  | 0532h   |
| DMA Channel 2 Destination Address | DMA2DA  | 0536h   |
| DMA Channel 2 Transfer Size       | DMA2SZ  | 053Ah   |
| DMA Channel 3 Control             | DMA3CTL | 0540h   |
| DMA Channel 3 Source Address      | DMA3SA  | 0542h   |
| DMA Channel 3 Destination Address | DMA3DA  | 0546h   |
| DMA Channel 3 Transfer Size       | DMA3SZ  | 054Ah   |
| DMA Channel 4 Control             | DMA4CTL | 0550h   |
| DMA Channel 4 Source Address      | DMA4SA  | 0552h   |
| DMA Channel 4 Destination Address | DMA4DA  | 0556h   |
| DMA Channel 4 Transfer Size       | DMA4SZ  | 055Ah   |
| DMA Channel 5 Control             | DMA5CTL | 0560h   |
| DMA Channel 5 Source Address      | DMA5SA  | 0562h   |
| DMA Channel 5 Destination Address | DMA5DA  | 0566h   |
| DMA Channel 5 Transfer Size       | DMA5SZ  | 056Ah   |

**Table 9-65. MPU Control Registers**

| REGISTER DESCRIPTION                                              | ACRONYM    | ADDRESS |
|-------------------------------------------------------------------|------------|---------|
| Memory Protection Unit Control 0                                  | MPUCTL0    | 05A0h   |
| Memory Protection Unit Control 1                                  | MPUCTL1    | 05A2h   |
| Memory Protection Unit Segmentation Border 2 Register             | MPUSEGB2   | 05A4h   |
| Memory Protection Unit Segmentation Border 1 Register             | MPUSEGB1   | 05A6h   |
| Memory Protection Unit Segmentation Access Management Register    | MPUSAM     | 05A8h   |
| Memory Protection Unit IP Control 0 Register                      | MPUIPC0    | 05AAh   |
| Memory Protection Unit IP Encapsulation Segment Border 2 Register | MPUIPSEGB2 | 05ACh   |
| Memory Protection Unit IP Encapsulation Segment Border 1 Register | MPUIPSEGB1 | 05AEh   |

**Table 9-66. eUSCI\_A0 Registers**

| REGISTER DESCRIPTION             | ACRONYM   | ADDRESS |
|----------------------------------|-----------|---------|
| eUSCI_A0 Control Word Register 0 | UCA0CTLW0 | 05C0h   |
| eUSCI_A0 Control Word Register 1 | UCA0CTLW1 | 05C2h   |
| eUSCI_A0 Baud Rate Control Word  | UCA0BRW   | 05C6h   |
| eUSCI_A0 Modulation Control Word | UCA0MCTLW | 05C8h   |
| eUSCI_A0 Status Register         | UCA0STATW | 05CAh   |
| eUSCI_A0 Receive Buffer          | UCA0RXBUF | 05CCh   |
| eUSCI_A0 Transmit Buffer         | UCA0TXBUF | 05CEh   |
| eUSCI_A0 Auto Baud Rate Control  | UCA0ABCTL | 05D0h   |
| eUSCI_A0 IrDA Control Word       | UCA0IRCTL | 05D2h   |
| eUSCI_A0 Interrupt Enable        | UCA0IE    | 05DAh   |
| eUSCI_A0 Interrupt Flag          | UCA0IFG   | 05DCh   |
| eUSCI_A0 Interrupt Vector        | UCA0IV    | 05DEh   |

**Table 9-67. eUSCI\_A1 Registers**

| REGISTER DESCRIPTION             | ACRONYM   | ADDRESS |
|----------------------------------|-----------|---------|
| eUSCI_A1 Control Word Register 0 | UCA1CTLW0 | 05E0h   |
| eUSCI_A1 Control Word Register 1 | UCA1CTLW1 | 05E2h   |
| eUSCI_A1 Baud Rate Control Word  | UCA1BRW   | 05E6h   |
| eUSCI_A1 Modulation Control Word | UCA1MCTLW | 05E8h   |
| eUSCI_A1 Status Register         | UCA1STATW | 05EAh   |
| eUSCI_A1 Receive Buffer          | UCA1RXBUF | 05ECh   |
| eUSCI_A1 Transmit Buffer         | UCA1TXBUF | 05EEh   |
| eUSCI_A1 Auto Baud Rate Control  | UCA1ABCTL | 05F0h   |
| eUSCI_A1 IrDA Control Word       | UCA1IRCTL | 05F2h   |
| eUSCI_A1 Interrupt Enable        | UCA1IE    | 05FAh   |
| eUSCI_A1 Interrupt Flag          | UCA1IFG   | 05FCh   |
| eUSCI_A1 Interrupt Vector        | UCA1IV    | 05FEh   |

**Table 9-68. eUSCI\_A2 Registers**

| REGISTER DESCRIPTION             | ACRONYM   | ADDRESS |
|----------------------------------|-----------|---------|
| eUSCI_A2 Control Word Register 0 | UCA2CTLW0 | 0600h   |
| eUSCI_A2 Control Word Register 1 | UCA2CTLW1 | 0602h   |
| eUSCI_A2 Baud Rate Control Word  | UCA2BRW   | 0606h   |
| eUSCI_A2 Modulation Control Word | UCA2MCTLW | 0608h   |
| eUSCI_A2 Status Register         | UCA2STATW | 060Ah   |
| eUSCI_A2 Receive Buffer          | UCA2RXBUF | 060Ch   |
| eUSCI_A2 Transmit Buffer         | UCA2TXBUF | 060Eh   |
| eUSCI_A2 Auto Baud Rate Control  | UCA2ABCTL | 0610h   |
| eUSCI_A2 IrDA Control Word       | UCA2IRCTL | 0612h   |
| eUSCI_A2 Interrupt Enable        | UCA2IE    | 061Ah   |
| eUSCI_A2 Interrupt Flag          | UCA2IFG   | 061Ch   |
| eUSCI_A2 Interrupt Vector        | UCA2IV    | 061Eh   |

**Table 9-69. eUSCI\_A3 Registers**

| REGISTER DESCRIPTION             | ACRONYM   | ADDRESS |
|----------------------------------|-----------|---------|
| eUSCI_A3 Control Word Register 0 | UCA3CTLW0 | 0620h   |
| eUSCI_A3 Control Word Register 1 | UCA3CTLW1 | 0622h   |
| eUSCI_A3 Baud Rate Control Word  | UCA3BRW   | 0626h   |
| eUSCI_A3 Modulation Control Word | UCA3MCTLW | 0628h   |
| eUSCI_A3 Status Register         | UCA3STATW | 062Ah   |
| eUSCI_A3 Receive Buffer          | UCA3RXBUF | 062Ch   |
| eUSCI_A3 Transmit Buffer         | UCA3TXBUF | 062Eh   |
| eUSCI_A3 Auto Baud Rate Control  | UCA3ABCTL | 0630h   |
| eUSCI_A3 IrDA Control Word       | UCA3IRCTL | 0632h   |
| eUSCI_A3 Interrupt Enable        | UCA3IE    | 063Ah   |
| eUSCI_A3 Interrupt Flag          | UCA3IFG   | 063Ch   |
| eUSCI_A3 Interrupt Vector        | UCA3IV    | 063Eh   |

**Table 9-70. eUSCI\_B0 Registers**

| REGISTER DESCRIPTION             | ACRONYM     | ADDRESS |
|----------------------------------|-------------|---------|
| eUSCI_B0 Control Word Register 0 | UCB0CTLW0   | 0640h   |
| eUSCI_B0 Control Word Register 1 | UCB0CTLW1   | 0642h   |
| eUSCI_B0 Baud Rate Control Word  | UCB0BRW     | 0646h   |
| eUSCI_B0 Status Register         | UCB0STATW   | 0648h   |
| eUSCI_B0 Byte Counter Threshold  | UCB0TBCNT   | 064Ah   |
| eUSCI_B0 Receive Buffer          | UCB0RXBUF   | 064Ch   |
| eUSCI_B0 Transmit Buffer         | UCB0TXBUF   | 064Eh   |
| eUSCI_B0 I2C Own Address 0       | UCB0I2COA0  | 0654h   |
| eUSCI_B0 I2C Own Address 1       | UCB0I2COA1  | 0656h   |
| eUSCI_B0 I2C Own Address 2       | UCB0I2COA2  | 0658h   |
| eUSCI_B0 I2C Own Address 3       | UCB0I2COA3  | 065Ah   |
| eUSCI_B0 I2C Received Address    | UCB0ADDRX   | 065Ch   |
| eUSCI_B0 I2C Address Mask        | UCB0ADDMASK | 065Eh   |
| eUSCI_B0 I2C Slave Address       | UCB0I2CSA   | 0660h   |
| eUSCI_B0 Interrupt Enable        | UCB0IE      | 066Ah   |
| eUSCI_B0 Interrupt Flag          | UCB0IFG     | 066Ch   |
| eUSCI_B0 Interrupt Vector        | UCB0IV      | 066Eh   |

**Table 9-71. eUSCI\_B1 Registers**

| REGISTER DESCRIPTION             | ACRONYM     | ADDRESS |
|----------------------------------|-------------|---------|
| eUSCI_B1 Control Word Register 0 | UCB1CTLW0   | 0680h   |
| eUSCI_B1 Control Word Register 1 | UCB1CTLW1   | 0682h   |
| eUSCI_B1 Baud Rate Control Word  | UCB1BRW     | 0686h   |
| eUSCI_B1 Status Register         | UCB1STATW   | 0688h   |
| eUSCI_B1 Byte Counter Threshold  | UCB1TBCNT   | 068Ah   |
| eUSCI_B1 Receive Buffer          | UCB1RXBUF   | 068Ch   |
| eUSCI_B1 Transmit Buffer         | UCB1TXBUF   | 068Eh   |
| eUSCI_B1 I2C Own Address 0       | UCB1I2COA0  | 0694h   |
| eUSCI_B1 I2C Own Address 1       | UCB1I2COA1  | 0696h   |
| eUSCI_B1 I2C Own Address 2       | UCB1I2COA2  | 0698h   |
| eUSCI_B1 I2C Own Address 3       | UCB1I2COA3  | 069Ah   |
| eUSCI_B1 I2C Received Address    | UCB1ADDRX   | 069Ch   |
| eUSCI_B1 I2C Address Mask        | UCB1ADDMASK | 069Eh   |
| eUSCI_B1 I2C Slave Address       | UCB1I2CSA   | 06A0h   |
| eUSCI_B1 Interrupt Enable        | UCB1IE      | 06AAh   |
| eUSCI_B1 Interrupt Flag          | UCB1IFG     | 06ACh   |
| eUSCI_B1 Interrupt Vector        | UCB1IV      | 06AEh   |

**Table 9-72. TA4 Registers**

| REGISTER DESCRIPTION             | ACRONYM  | ADDRESS |
|----------------------------------|----------|---------|
| Timer_A4 Control                 | TA4CTL   | 07C0h   |
| Timer_A4 Capture/Compare Control | TA4CCTL0 | 07C2h   |
| Timer_A4 Capture/Compare Control | TA4CCTL1 | 07C4h   |
| Timer_A4 Counter                 | TA4R     | 07D0h   |
| Timer_A4 Capture/Compare         | TA4CCR0  | 07D2h   |
| Timer_A4 Capture/Compare         | TA4CCR1  | 07D4h   |
| Timer_A4 Expansion 0             | TA4EX0   | 07E0h   |
| Timer_A4 Interrupt Vector        | TA4IV    | 07EEh   |

**Table 9-73. ADC12\_B Registers**

| REGISTER DESCRIPTION                              | ACRONYM     | ADDRESS |
|---------------------------------------------------|-------------|---------|
| ADC12_B Control 0                                 | ADC12CTL0   | 0800h   |
| ADC12_B Control 1                                 | ADC12CTL1   | 0802h   |
| ADC12_B Control 2                                 | ADC12CTL2   | 0804h   |
| ADC12_B Control 3                                 | ADC12CTL3   | 0806h   |
| ADC12_B Window Comparator Low Threshold Register  | ADC12LO     | 0808h   |
| ADC12_B Window Comparator High Threshold Register | ADC12HI     | 080Ah   |
| ADC12_B Interrupt Flag 0                          | ADC12IFGR0  | 080Ch   |
| ADC12_B Interrupt Flag 1                          | ADC12IFGR1  | 080Eh   |
| ADC12_B Interrupt Flag 2                          | ADC12IFGR2  | 0810h   |
| ADC12_B Interrupt Enable 0                        | ADC12IER0   | 0812h   |
| ADC12_B Interrupt Enable 1                        | ADC12IER1   | 0814h   |
| ADC12_B Interrupt Enable 2                        | ADC12IER2   | 0816h   |
| ADC12_B Interrupt Vector                          | ADC12IV     | 0818h   |
| ADC12_B Memory Control 0                          | ADC12MCTL0  | 0820h   |
| ADC12_B Memory Control 1                          | ADC12MCTL1  | 0822h   |
| ADC12_B Memory Control 2                          | ADC12MCTL2  | 0824h   |
| ADC12_B Memory Control 3                          | ADC12MCTL3  | 0826h   |
| ADC12_B Memory Control 4                          | ADC12MCTL4  | 0828h   |
| ADC12_B Memory Control 5                          | ADC12MCTL5  | 082Ah   |
| ADC12_B Memory Control 6                          | ADC12MCTL6  | 082Ch   |
| ADC12_B Memory Control 7                          | ADC12MCTL7  | 082Eh   |
| ADC12_B Memory Control 8                          | ADC12MCTL8  | 0830h   |
| ADC12_B Memory Control 9                          | ADC12MCTL9  | 0832h   |
| ADC12_B Memory Control 10                         | ADC12MCTL10 | 0834h   |
| ADC12_B Memory Control 11                         | ADC12MCTL11 | 0836h   |
| ADC12_B Memory Control 12                         | ADC12MCTL12 | 0838h   |
| ADC12_B Memory Control 13                         | ADC12MCTL13 | 083Ah   |
| ADC12_B Memory Control 14                         | ADC12MCTL14 | 083Ch   |
| ADC12_B Memory Control 15                         | ADC12MCTL15 | 083Eh   |
| ADC12_B Memory Control 16                         | ADC12MCTL16 | 0840h   |
| ADC12_B Memory Control 17                         | ADC12MCTL17 | 0842h   |
| ADC12_B Memory Control 18                         | ADC12MCTL18 | 0844h   |
| ADC12_B Memory Control 19                         | ADC12MCTL19 | 0846h   |
| ADC12_B Memory Control 20                         | ADC12MCTL20 | 0848h   |
| ADC12_B Memory Control 21                         | ADC12MCTL21 | 084Ah   |
| ADC12_B Memory Control 22                         | ADC12MCTL22 | 084Ch   |
| ADC12_B Memory Control 23                         | ADC12MCTL23 | 084Eh   |
| ADC12_B Memory Control 24                         | ADC12MCTL24 | 0850h   |
| ADC12_B Memory Control 25                         | ADC12MCTL25 | 0852h   |
| ADC12_B Memory Control 26                         | ADC12MCTL26 | 0854h   |
| ADC12_B Memory Control 27                         | ADC12MCTL27 | 0856h   |
| ADC12_B Memory Control 28                         | ADC12MCTL28 | 0858h   |
| ADC12_B Memory Control 29                         | ADC12MCTL29 | 085Ah   |
| ADC12_B Memory Control 30                         | ADC12MCTL30 | 085Ch   |
| ADC12_B Memory Control 31                         | ADC12MCTL31 | 085Eh   |



**Table 9-73. ADC12\_B Registers (continued)**

| REGISTER DESCRIPTION | ACRONYM    | ADDRESS |
|----------------------|------------|---------|
| ADC12_B Memory 0     | ADC12MEM0  | 0860h   |
| ADC12_B Memory 1     | ADC12MEM1  | 0862h   |
| ADC12_B Memory 2     | ADC12MEM2  | 0864h   |
| ADC12_B Memory 3     | ADC12MEM3  | 0866h   |
| ADC12_B Memory 4     | ADC12MEM4  | 0868h   |
| ADC12_B Memory 5     | ADC12MEM5  | 086Ah   |
| ADC12_B Memory 6     | ADC12MEM6  | 086Ch   |
| ADC12_B Memory 7     | ADC12MEM7  | 086Eh   |
| ADC12_B Memory 8     | ADC12MEM8  | 0870h   |
| ADC12_B Memory 9     | ADC12MEM9  | 0872h   |
| ADC12_B Memory 10    | ADC12MEM10 | 0874h   |
| ADC12_B Memory 11    | ADC12MEM11 | 0876h   |
| ADC12_B Memory 12    | ADC12MEM12 | 0878h   |
| ADC12_B Memory 13    | ADC12MEM13 | 087Ah   |
| ADC12_B Memory 14    | ADC12MEM14 | 087Ch   |
| ADC12_B Memory 15    | ADC12MEM15 | 087Eh   |
| ADC12_B Memory 16    | ADC12MEM16 | 0880h   |
| ADC12_B Memory 17    | ADC12MEM17 | 0882h   |
| ADC12_B Memory 18    | ADC12MEM18 | 0884h   |
| ADC12_B Memory 19    | ADC12MEM19 | 0886h   |
| ADC12_B Memory 20    | ADC12MEM20 | 0888h   |
| ADC12_B Memory 21    | ADC12MEM21 | 088Ah   |
| ADC12_B Memory 22    | ADC12MEM22 | 088Ch   |
| ADC12_B Memory 23    | ADC12MEM23 | 088Eh   |
| ADC12_B Memory 24    | ADC12MEM24 | 0890h   |
| ADC12_B Memory 25    | ADC12MEM25 | 0892h   |
| ADC12_B Memory 26    | ADC12MEM26 | 0894h   |
| ADC12_B Memory 27    | ADC12MEM27 | 0896h   |
| ADC12_B Memory 28    | ADC12MEM28 | 0898h   |
| ADC12_B Memory 29    | ADC12MEM29 | 089Ah   |
| ADC12_B Memory 30    | ADC12MEM30 | 089Ch   |
| ADC12_B Memory 31    | ADC12MEM31 | 089Eh   |

**Table 9-74. Comparator\_E Registers**

| REGISTER DESCRIPTION             | ACRONYM | ADDRESS |
|----------------------------------|---------|---------|
| Comparator Control Register 0    | CECTL0  | 08C0h   |
| Comparator Control Register 1    | CECTL1  | 08C2h   |
| Comparator Control Register 2    | CECTL2  | 08C4h   |
| Comparator Control Register 3    | CECTL3  | 08C6h   |
| Comparator Interrupt Control     | CEINT   | 08CCh   |
| Comparator Interrupt Vector Word | CEIV    | 08CEh   |

**Table 9-75. CRC32 Registers**

| REGISTER DESCRIPTION                   | ACRONYM      | ADDRESS |
|----------------------------------------|--------------|---------|
| CRC32 Data Input Word 0                | CRC32DIW0    | 0980h   |
| CRC32 Data Input Word 1                | CRC32DIW1    | 0982h   |
| CRC32 Data In Reverse Word 1           | CRC32DIRBW1  | 0984h   |
| CRC32 Data In Reverse Word 0           | CRC32DIRBW0  | 0986h   |
| CRC32 Initialization and Result Word 0 | CRC32NIRESW0 | 0988h   |
| CRC32 Initialization and Result Word 1 | CRC32NIRESW1 | 098Ah   |
| CRC32 Result Reverse Word 1            | CRC32RESRW1  | 098Ch   |
| CRC32 Result Reverse Word 0            | CRC32RESRW0  | 098Eh   |
| CRC16 Data Input                       | CRC16DIW0    | 0990h   |
| CRC16 Data In Reverse                  | CRC16DIRBW0  | 0996h   |
| CRC16 Init and Result                  | CRC16NIRESW0 | 0998h   |
| CRC16 Result Reverse                   | CRC16RESRW0  | 099Eh   |

**Table 9-76. AES256 Registers**

| REGISTER DESCRIPTION          | ACRONYM  | ADDRESS |
|-------------------------------|----------|---------|
| AES Accelerator Control 0     | AESACTL0 | 09C0h   |
| AES Accelerator Control 1     | AESACTL1 | 09C2h   |
| AES Accelerator Status        | AESASTAT | 09C4h   |
| AES Accelerator Key           | AESAKEY  | 09C6h   |
| AES Accelerator Data In       | AESADIN  | 09C8h   |
| AES Accelerator Data Out      | AESADOUT | 09CAh   |
| AES Accelerator XORed Data In | AESAXDIN | 09CCh   |
| AES Accelerator XORed Data In | AESAXIN  | 09CEh   |

**Table 9-77. LCD\_C Registers**

| REGISTER DESCRIPTION                 | ACRONYM        | ADDRESS |
|--------------------------------------|----------------|---------|
| LCD_C control 0                      | LCDCCTL0       | 0A00h   |
| LCD_C control 1                      | LCDCCTL1       | 0A02h   |
| LCD_C blinking control               | LCDCBLKCTL     | 0A04h   |
| LCD_C memory control                 | LCDCMEMCTL     | 0A06h   |
| LCD_C Voltage Control                | LCDCVCTL       | 0A08h   |
| LCD_C port control 0                 | LCDCPCTL0      | 0A0Ah   |
| LCD_C port control 1                 | LCDCPCTL1      | 0A0Ch   |
| LCD_C port control 2 (≥256 segments) | LCDCPCTL2      | 0A0Eh   |
| LCD_C port control 3 (384 segments)  | LCDCPCTL3      | 0A10h   |
| LCD_C charge pump control            | LCDCCPCTL      | 0A12h   |
| LCD_C interrupt vector               | LCDCIV         | 0A1Eh   |
| <b>LCDMX = 0 ... 4</b>               |                |         |
| LCD memory 1                         | LCDM1          | 0A20h   |
| LCD memory 2                         | LCDM2          | 0A21h   |
| LCD memory 3                         | LCDM3          | 0A22h   |
| LCD memory 4                         | LCDM4          | 0A23h   |
| LCD memory 5                         | LCDM5          | 0A24h   |
| LCD memory 6                         | LCDM6          | 0A25h   |
| LCD memory 7                         | LCDM7          | 0A26h   |
| LCD memory 8                         | LCDM8          | 0A27h   |
| LCD memory 9                         | LCDM9          | 0A28h   |
| LCD memory 10                        | LCDM10         | 0A29h   |
| LCD memory 11                        | LCDM11         | 0A2Ah   |
| LCD memory 12                        | LCDM12         | 0A2Bh   |
| LCD memory 13                        | LCDM13         | 0A2Ch   |
| LCD memory 14                        | LCDM14         | 0A2Dh   |
| LCD memory 15                        | LCDM15         | 0A2Eh   |
| LCD memory 16                        | LCDM16         | 0A2Fh   |
| LCD memory 17                        | LCDM17         | 0A30h   |
| LCD memory 18                        | LCDM18         | 0A31h   |
| LCD memory 19                        | LCDM19         | 0A32h   |
| LCD memory 20                        | LCDM20         | 0A33h   |
| LCD blinking memory 1                | LCDM33_LCDBM1  | 0A40h   |
| LCD blinking memory 2                | LCDM34_LCDBM2  | 0A41h   |
| LCD blinking memory 3                | LCDM35_LCDBM3  | 0A42h   |
| LCD blinking memory 4                | LCDM36_LCDBM4  | 0A43h   |
| LCD blinking memory 5                | LCDM37_LCDBM5  | 0A44h   |
| LCD blinking memory 6                | LCDM38_LCDBM6  | 0A45h   |
| LCD blinking memory 7                | LCDM39_LCDBM7  | 0A46h   |
| LCD blinking memory 8                | LCDM40_LCDBM8  | 0A47h   |
| LCD blinking memory 9                | LCDM41_LCDBM9  | 0A48h   |
| LCD blinking memory 10               | LCDM42_LCDBM10 | 0A49h   |
| LCD blinking memory 11               | LCDM43_LCDBM11 | 0A4Ah   |
| LCD blinking memory 11               | LCDM44_LCDBM12 | 0A4Bh   |
| LCD blinking memory 13               | LCDM45_LCDBM13 | 0A4Ch   |

Table 9-77. LCD\_C Registers (continued)

| REGISTER DESCRIPTION   | ACRONYM        | ADDRESS |
|------------------------|----------------|---------|
| LCD blinking memory 14 | LCDM46_LCDBM14 | 0A4Dh   |
| LCD blinking memory 15 | LCDM47_LCDBM15 | 0A4Eh   |
| LCD blinking memory 16 | LCDM48_LCDBM16 | 0A4Fh   |
| LCD blinking memory 17 | LCDM49_LCDBM17 | 0A50h   |
| LCD blinking memory 18 | LCDM50_LCDBM18 | 0A51h   |
| LCD blinking memory 19 | LCDM51_LCDBM19 | 0A52h   |
| LCD blinking memory 20 | LCDM52_LCDBM20 | 0A53h   |
| <b>LCDMX = 5 ... 8</b> |                |         |
| LCD memory 1           | LCDM1          | 0A20h   |
| LCD memory 2           | LCDM2          | 0A21h   |
| LCD memory 3           | LCDM3          | 0A22h   |
| LCD memory 4           | LCDM4          | 0A23h   |
| LCD memory 5           | LCDM5          | 0A24h   |
| LCD memory 6           | LCDM6          | 0A25h   |
| LCD memory 7           | LCDM7          | 0A26h   |
| LCD memory 8           | LCDM8          | 0A27h   |
| LCD memory 9           | LCDM9          | 0A28h   |
| LCD memory 10          | LCDM10         | 0A29h   |
| LCD memory 11          | LCDM11         | 0A2Ah   |
| LCD memory 12          | LCDM12         | 0A2Bh   |
| LCD memory 13          | LCDM13         | 0A2Ch   |
| LCD memory 14          | LCDM14         | 0A2Dh   |
| LCD memory 15          | LCDM15         | 0A2Eh   |
| LCD memory 16          | LCDM16         | 0A2Fh   |
| LCD memory 17          | LCDM17         | 0A30h   |
| LCD memory 18          | LCDM18         | 0A31h   |
| LCD memory 19          | LCDM19         | 0A32h   |
| LCD memory 20          | LCDM20         | 0A33h   |
| LCD memory 21          | LCDM21         | 0A34h   |
| LCD memory 22          | LCDM22         | 0A35h   |
| LCD memory 23          | LCDM23         | 0A36h   |
| LCD memory 24          | LCDM24         | 0A37h   |
| LCD memory 25          | LCDM25         | 0A38h   |
| LCD memory 26          | LCDM26         | 0A39h   |
| LCD memory 27          | LCDM27         | 0A3Ah   |
| LCD memory 28          | LCDM28         | 0A3Bh   |
| LCD memory 29          | LCDM29         | 0A3Ch   |
| LCD memory 30          | LCDM30         | 0A3Dh   |
| LCD memory 31          | LCDM31         | 0A3Eh   |
| LCD memory 32          | LCDM32         | 0A3Fh   |
| LCD memory 33          | LCDM33_LCDBM1  | 0A40h   |
| LCD memory 34          | LCDM34_LCDBM2  | 0A41h   |
| LCD memory 35          | LCDM35_LCDBM3  | 0A42h   |
| LCD memory 36          | LCDM36_LCDBM4  | 0A43h   |

**Table 9-78. LEA Registers**

| REGISTER DESCRIPTION     | ACRONYM    | ADDRESS |
|--------------------------|------------|---------|
| LEA Capability Register  | LEACAP     | 0A80h   |
| Configuration Register 0 | LEACNF0    | 0A84h   |
| Configuration Register 1 | LEACNF1    | 0A88h   |
| Configuration Register 2 | LEACNF2    | 0A8Ch   |
| Memory Bottom Register   | LEAMB      | 0A90h   |
| Memory Top Register      | LEAMT      | 0A94h   |
| Code Memory Access       | LEACMA     | 0A98h   |
| Code Memory Control      | LEACMCTL   | 0A9Ch   |
| LEA Command Status       | LEACMDSTAT | 0AA8h   |
| LEA Source 1 Status      | LEAS1STAT  | 0AACH   |
| LEA Source 0 Status      | LEAS0STAT  | 0AB0h   |
| LEA Result Status        | LEADSTSTAT | 0AB4h   |
| PM Control Register      | LEAPMCTL   | 0AC0h   |
| PM Result Register       | LEAPMDST   | 0AC4h   |
| PM Source 1 Register     | LEAPMS1    | 0AC8h   |
| PM Source 0 Register     | LEAPMS0    | 0ACCCh  |
| PM Command Buffer        | LEAPMCB    | 0AD0h   |
| Interrupt Flag and Set   | LEAIFGSET  | 0AF0h   |
| Interrupt Enable         | LEAIE      | 0AF4h   |
| Interrupt Flag and Clear | LEAIFG     | 0AF8h   |
| Interrupt Vector         | LEAIV      | 0AFCh   |

Table 9-79. SAPH Registers

| REGISTER DESCRIPTION                      | ACRONYM     | ADDRESS |
|-------------------------------------------|-------------|---------|
| Interrupt Index                           | SAPHIIDX    | 0E00h   |
| Masked Interrupt Satus                    | SAPHMIS     | 0E02h   |
| Raw Interrupt Status                      | SAPHRIS     | 0E04h   |
| Interrupt Mask                            | SAPHIMSC    | 0E06h   |
| Interrupt Clear                           | SAPHICR     | 0E08h   |
| Interrupt Set                             | SAPHISR     | 0E0Ah   |
| Module-Descriptor Low Word                | SAPHDESCLO  | 0E0Ch   |
| Module-Descriptor High Word               | SAPHDESCHI  | 0E0Eh   |
| Key                                       | SAPHKEY     | 0E10h   |
| Physical Interface Output Control #0      | SAPHOCTL0   | 0E12h   |
| Physical Interface Output Control #1      | SAPHOCTL1   | 0E14h   |
| Physical Interface Output Function Select | SAPHOSEL    | 0E16h   |
| Channel 0 Pull UpTrim                     | SAPHCH0PUT  | 0E20h   |
| Channel 0 Pull DownTrim                   | SAPHCH0PDT  | 0E22h   |
| Channel 0 Termination Trim                | SAPHCH0TT   | 0E24h   |
| Channel 1 Pull UpTrim                     | SAPHCH1PUT  | 0E26h   |
| Channel 1 Pull DownTrim                   | SAPHCH1PDT  | 0E28h   |
| Channel 1 Termination Trim                | SAPHCH1TT   | 0E2Ah   |
| Mode Configuration Register               | SAPHMCNF    | 0E2Ch   |
| Trim Access Control                       | SAPHTACTL   | 0E2Eh   |
| Physical Interface Input Control #0       | SAPHICTL0   | 0E30h   |
| Bias Control                              | SAPHBCTL    | 0E34h   |
| PPG Count                                 | SAPHPGC     | 0E40h   |
| Pulse Generator Low Period                | SAPHPGLPER  | 0E42h   |
| Pulse Generator High Period               | SAPHPGHPER  | 0E44h   |
| PPG Control                               | SAPHPGCTL   | 0E46h   |
| PPG Software Trigger                      | SAPHPPGTRIG | 0E48h   |
| A-SEQ control 0                           | SAPHASCTL0  | 0E60h   |
| A-SEQ control 1                           | SAPHASCTL1  | 0E62h   |
| ASQ Software Trigger                      | SAPHASQTRIG | 0E64h   |
| ASQ ping output polarity                  | SAPHAPOL    | 0E66h   |
| ASQ ping pause level                      | SAPHAPLEV   | 0E68h   |
| ASQ ping pause impedance                  | SAPHAPHIZ   | 0E6Ah   |
| A-SEQ start to 1st ping                   | SAPHATM_A   | 0E6Eh   |
| ASQ start to ADC arm                      | SAPHATM_B   | 0E70h   |
| Count for the TIMEMARK C Event            | SAPHATM_C   | 0E72h   |
| ASQ start to ADC trig                     | SAPHATM_D   | 0E74h   |
| ASQ start to restart                      | SAPHATM_E   | 0E76h   |
| ASQ start to time-out                     | SAPHATM_F   | 0E78h   |
| Time Base Control                         | SAPHTBCTL   | 0E7Ah   |
| Acquisition Timer Low Part                | SAPHATIMLO  | 0E7Ch   |
| Acquisition Timer High Part               | SAPHATIMHI  | 0E7Eh   |

**Table 9-80. SDHS Registers**

| REGISTER DESCRIPTION                           | ACRONYM     | ADDRESS |
|------------------------------------------------|-------------|---------|
| Interrupt Index Register                       | SDHSIIDX    | 0E80h   |
| Masked Interrupt Status and Clear Register     | SDHSMIS     | 0E82h   |
| Raw Interrupt Status                           | SDHSRIS     | 0E84h   |
| Interrupt Mask Register                        | SDHSIMSC    | 0E86h   |
| Interrupt Clear                                | SDHSICR     | 0E88h   |
| Interrupt Set Register                         | SDHSISR     | 0E8Ah   |
| SDHS Descriptor Register L                     | SDHSDESCLO  | 0E8Ch   |
| SDHS Descriptor Register H                     | SDHSDESCHI  | 0E8Eh   |
| SDHS Control Register 0                        | SDHSCTL0    | 0E90h   |
| SDHS Control Register 1                        | SDHSCTL1    | 0E92h   |
| SDHS Control Register 2                        | SDHSCTL2    | 0E94h   |
| SDHS Control Register 3                        | SDHSCTL3    | 0E96h   |
| SDHS Control Register 4                        | SDHSCTL4    | 0E98h   |
| SDHS Control Register 5                        | SDHSCTL5    | 0E9Ah   |
| SDHS Control Register 6                        | SDHSCTL6    | 0E9Ch   |
| SDHS Control Register 7                        | SDHSCTL7    | 0E9Eh   |
| SDHS Data Conversion Register                  | SDHSDT      | 0EA2h   |
| SDHS Window Comparator High Threshold Register | SDHSWINHITH | 0EA4h   |
| SDHS Window Comparator Low Threshold Register  | SDHSWINLOTH | 0EA6h   |
| DTC destination address                        | SDHSDTCDA   | 0EA8h   |

**Table 9-81. UUPS Registers**

| REGISTER DESCRIPTION       | ACRONYM    | ADDRESS |
|----------------------------|------------|---------|
| Interrupt Index Register   | UUPSIIDX   | 0EC0h   |
| Masked Interrupt Status    | UUPSMIS    | 0EC2h   |
| Raw Interrupt Status       | UUPSRIS    | 0EC4h   |
| Interrupt Mask Register    | UUPSIMSC   | 0EC6h   |
| Interrupt Clear            | UUPSICR    | 0EC8h   |
| Interrupt Flag Set         | UUPSISR    | 0ECAh   |
| UUPS Descriptor Register L | UUPSDESCLO | 0ECCh   |
| UUPS Descriptor Register H | UUPSDESCHI | 0ECEh   |
| UUPS Control               | UUPSCTL    | 0ED0h   |

**Table 9-82. HSPLL Registers**

| REGISTER DESCRIPTION        | ACRONYM        | ADDRESS |
|-----------------------------|----------------|---------|
| Interrupt Index Register    | HSPLLIIDX      | 0EE0h   |
| Masked Interrupt Status     | HSPLLMIS       | 0EE2h   |
| Raw Interrupt Status        | HSPLLRIS       | 0EE4h   |
| Interrupt Mask Register     | HSPLLMSC       | 0EE6h   |
| Interrupt Flag Clear        | HSPLLICR       | 0EE8h   |
| Interrupt Flag Set          | HSPLLISR       | 0EEAh   |
| HSPLL Descriptor Register L | HSPLLDESCLO    | 0EECh   |
| HSPLL Descriptor Register H | HSPLLDESCHI    | 0EEEh   |
| HSPLL Control Register      | HSPLLCTL       | 0EF0h   |
| USSXT Control Register      | HSPLLUSSXTLCTL | 0EF2h   |



## 9.17 Identification

### 9.17.1 Revision Identification

The device revision information is shown as part of the top-side marking on the device package. The device-specific errata sheet describes these markings. For links to the errata sheets for the devices in this data sheet, see [节 11.4](#).

The hardware revision is also stored in the Device Descriptor structure in the Info Block section. For details on this value, see the "Hardware Revision" entries in the Device Descriptor structure (see [节 9.15](#)).

### 9.17.2 Device Identification

The device type can be identified from the top-side marking on the device package. The device-specific errata sheet describes these markings. For links to the errata sheets for the devices in this data sheet, see [节 11.4](#).

A device identification value is also stored in the Device Descriptor structure in the Info Block section. For details on this value, see the "Device ID" entries in the Device Descriptor structure (see [节 9.15](#)).

### 9.17.3 JTAG Identification

Programming through the JTAG interface, including reading and identifying the JTAG ID, is described in [MSP430 Programming With the JTAG Interface](#).

## 10 Applications, Implementation, and Layout

### Note

Information in the following Applications section is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 10.1 Device Connection and Layout Fundamentals

This section describes the recommended guidelines when designing with the MSP MCU. These guidelines are to make sure that the device has proper connections for powering, programming, debugging, and optimum analog performance.

#### 10.1.1 Power Supply Decoupling and Bulk Capacitors

TI recommends connecting a combination of a 1- $\mu$ F plus a 100-nF low-ESR ceramic decoupling capacitor to each AVCC and DVCC pin (see [图 10-1](#)). Higher-value capacitors may be used but can affect supply rail ramp-up time. Decoupling capacitors must be placed as close as possible to the pins that they decouple (within a few millimeters). Additionally, TI recommends separated grounds with a single-point connection for better noise isolation from digital to analog circuits on the board and to achieve high analog accuracy.

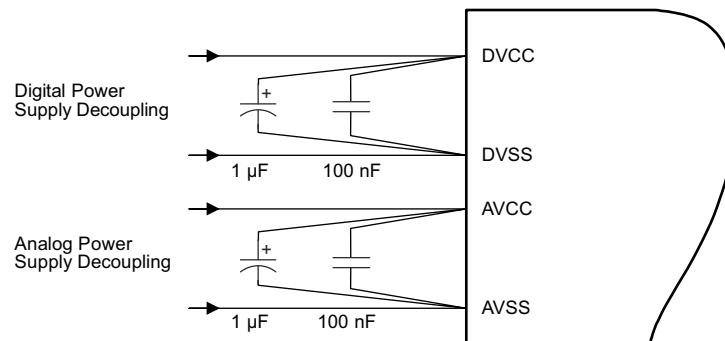


图 10-1. Power Supply Decoupling

For PVCC and PVSS, TI recommends connecting a combination of a 1- $\mu$ F plus a 22- $\mu$ F low-ESR ceramic decoupling capacitor between the PVCC and PVSS pins and a serial 22- $\Omega$  resistor to filter low-frequency noise on the supply line (see [图 10-2](#)).

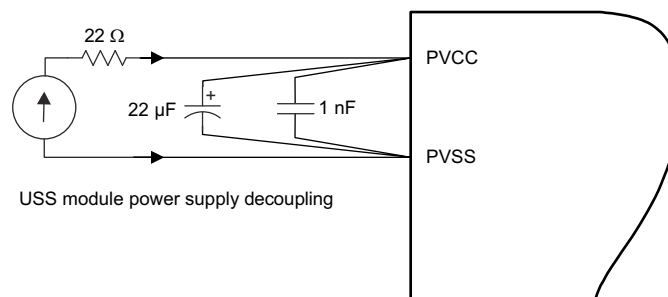


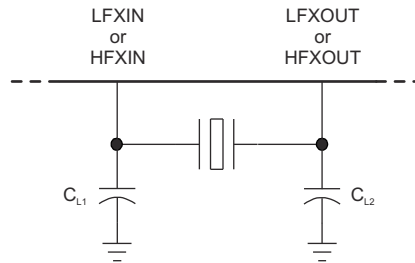
图 10-2. Power Supply Decoupling for PVCC and PVSS

#### 10.1.2 External Oscillator (HFXT and LFXT)

Depending on the device variant (see [节 6](#)), the device can support a low-frequency crystal (32 kHz) on the LFXT pins, a high-frequency crystal on the HFXT pins, or both. External bypass capacitors for the crystal oscillator pins are required.

It is also possible to apply digital clock signals to the LFXIN and HFXIN input pins that meet the specifications of the respective oscillator if the appropriate LFXTBYPASS or HFBXTBYPASS mode is selected. In this case, the associated LFXOUT and HFXOUT pins can be used for other purposes. If they are left unused, they must be terminated according to 节 7.6.

图 10-3 shows a typical connection diagram.



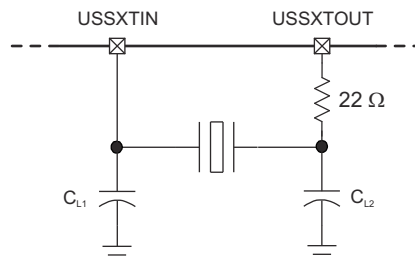
**图 10-3. Typical Crystal Connection**

See [MSP430 32-kHz Crystal Oscillators](#) for more information on selecting, testing, and designing a crystal oscillator with the MSP MCUs.

### 10.1.3 USS Oscillator (USSXT)

Depending on the device variant (see 节 6), the device with USS module supports a high-frequency crystal on the USSXT pins. External bypass capacitors for the crystal oscillator pins are required. Serially connect a 22-Ω resistor close to the USSXTOUT pin (see 图 10-4). The USSXT does not support bypass mode, so it is not possible to apply digital clock signals to the USSXTIN pin. Never connect the USSXTIN pin to a power supply line (AVCC, DVCC, or PVCC). If the USSXT pins are not used, terminate them according to 节 7.6.

图 10-4 shows a typical connection diagram.

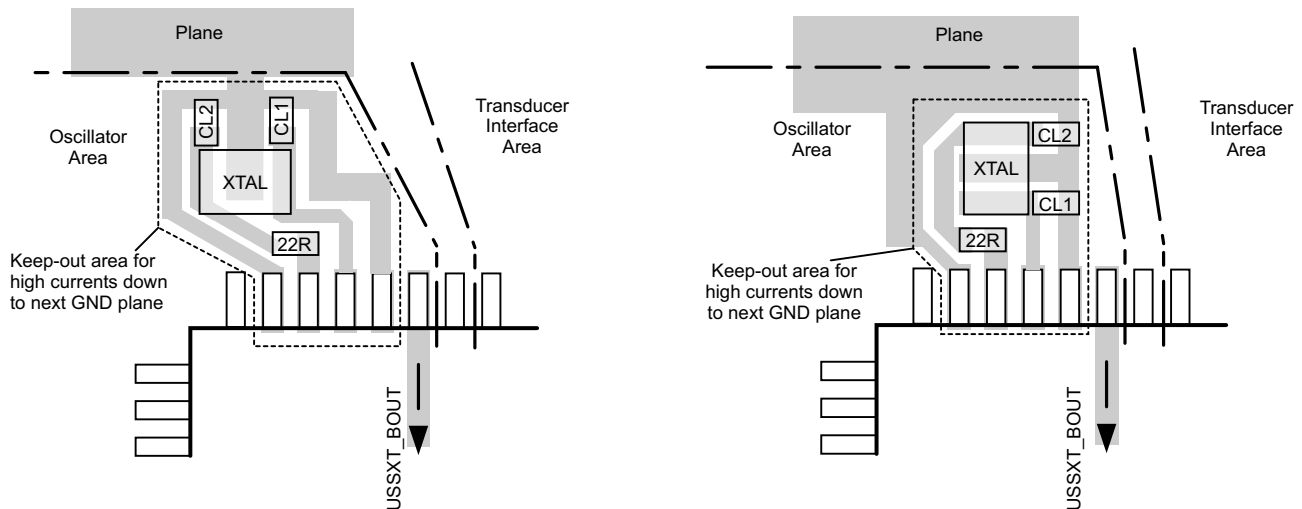


**图 10-4. Typical Crystal Connection**

Consider the following items for the USSXT layout:

- Keep the trace of USSXTIN and USSXTOUT as short as possible. If one must be longer than the other, keep USSXTIN shorter, because USSXTIN is more sensitive to EMI.
- Make the ground shield open ended without making a loop.
- Use a ground plane to reduce the impedance of the ground trace.
- If USSXT\_BOUT is used, keep coupling to USSXTIN and CH0\_IN to a minimum.
- If USSXT\_BOUT is feeding other clock or device inputs, apply a small capacitor (10 pF) as the line termination load at the end of the line. This avoids reflection artifacts on sensitive inputs (for example, HFBXTIN).

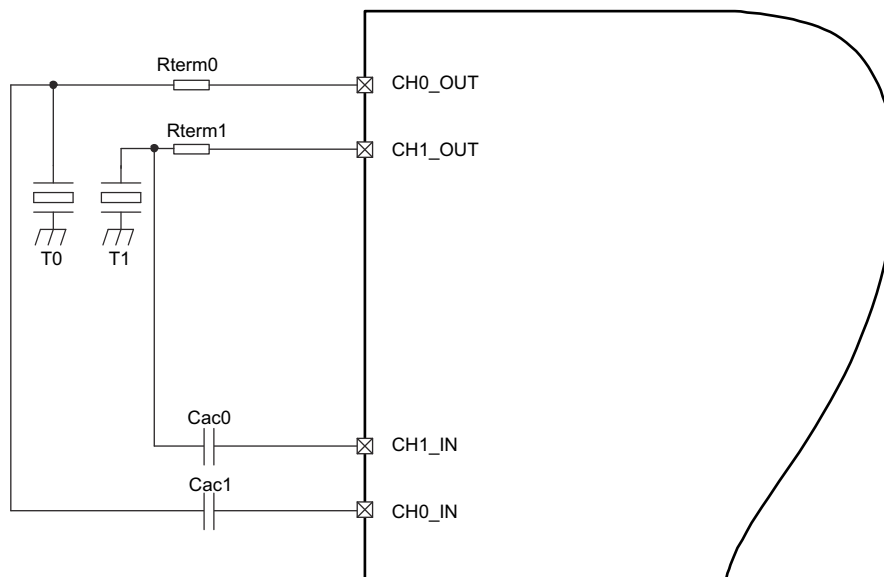
图 10-5 shows the recommended PCB layout.



**图 10-5. USSXT PCB Layout Recommendation**

#### 10.1.4 Transducer Connection to the USS Module

图 10-6 shows a typical connection of two transducers to the USS output and input pins. TI recommends 1% error tolerance for the external termination resistors ( $R_{term0}$  and  $R_{term1}$ ) and the AC coupling capacitors ( $C_{ac0}$  and  $C_{ac1}$ ). Typical value of the termination resistors is in the range of 150 to 400  $\Omega$ , the AC coupling capacitors are 1 to 2 nF. Actual values should be determined to meet the requirements of each application.



**图 10-6. Typical Transducer Connection**

#### 10.1.5 Charge Pump Control of Input Multiplexer

图 10-7 shows the control logic of the charge pump control of the input multiplexer of  $CHx\_IN$ . The charge pump is enabled as long the  $SAPH\_AMCNF.CPEO$  is high and during the arming of the SDHS. Use the CPDA bit to control the CP during data acquisition.

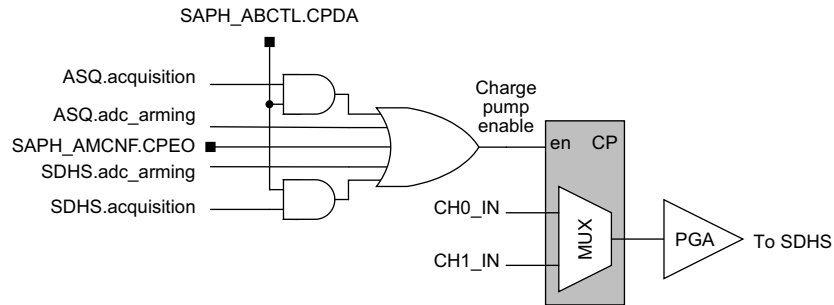


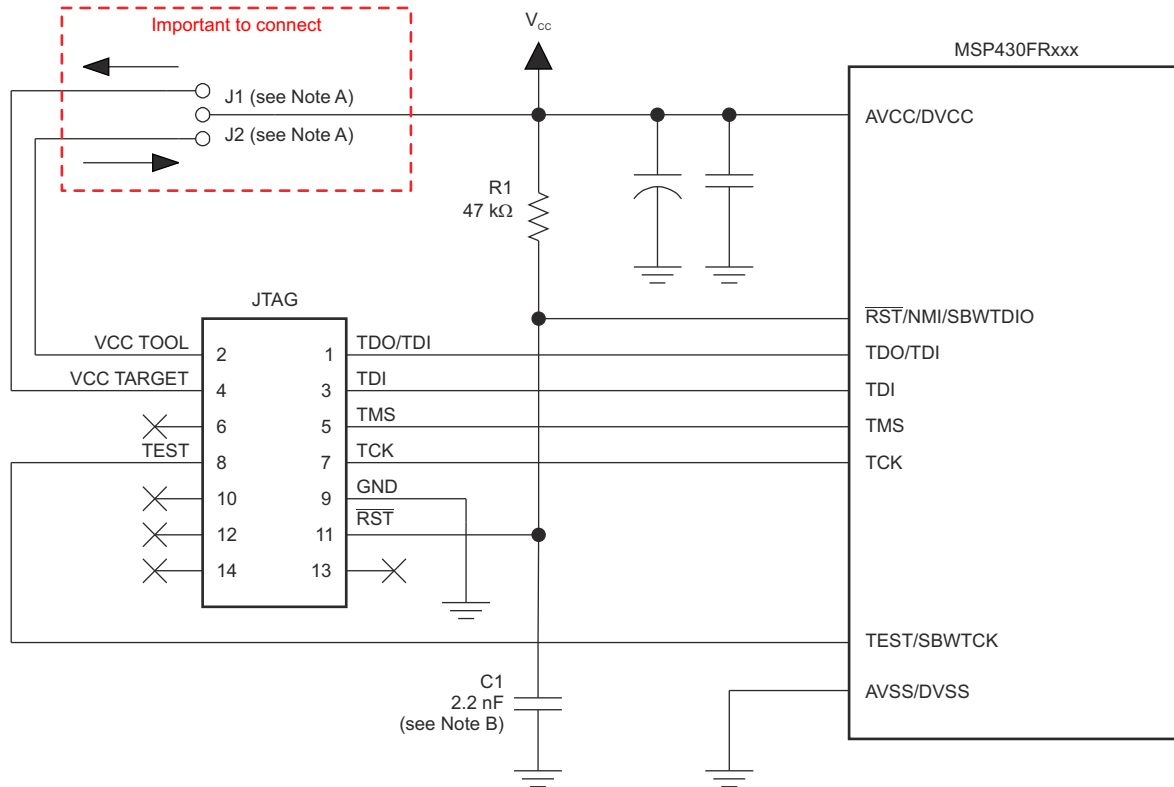
图 10-7. Control Of Input Multiplexer

### 10.1.6 JTAG

With the proper connections, the debugger and a hardware JTAG interface (such as the MSP-FET or MSP-FET430UIF) can be used to program and debug code on the target board. In addition, the connections also support the MSP-GANG production programmers, thus providing an easy way to program prototype boards, if desired. 图 10-8 shows the connections between the 14-pin JTAG connector and the target device required to support in-system programming and debugging for 4-wire JTAG communication. 图 10-9 shows the connections for 2-wire JTAG mode (Spy-Bi-Wire).

The connections for the MSP-FET and MSP-FET430UIF interface modules and the MSP-GANG are identical. Both can supply  $V_{CC}$  to the target board (through pin 2). In addition, the MSP-FET and MSP-FET430UIF interface modules and MSP-GANG have a  $V_{CC}$  sense feature that, if used, requires an alternate connection (pin 4 instead of pin 2). The  $V_{CC}$  sense feature senses the local  $V_{CC}$  present on the target board (that is, a battery or other local power supply) and adjusts the output signals accordingly. 图 10-8 and 图 10-9 show a jumper block that supports both scenarios of supplying  $V_{CC}$  to the target board. If this flexibility is not required, the desired  $V_{CC}$  connections may be hard-wired to eliminate the jumper block. Pins 2 and 4 must not be connected at the same time.

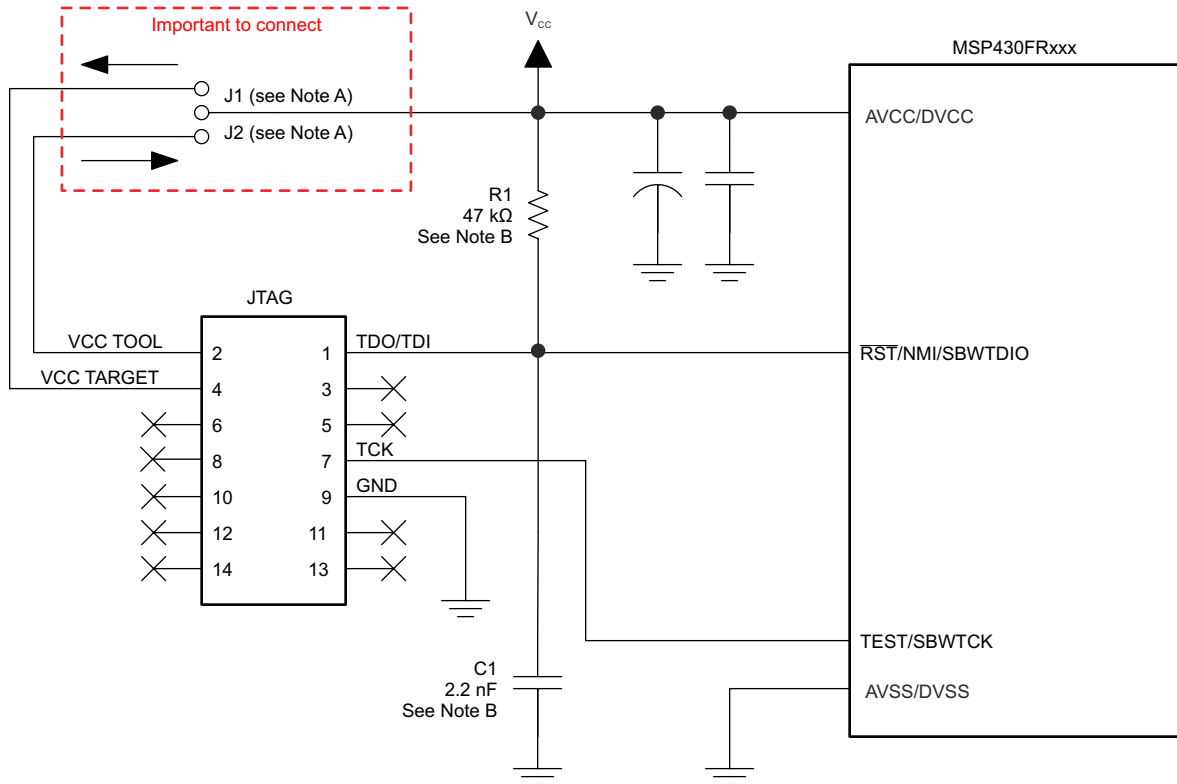
For additional design information regarding the JTAG interface, see the [MSP430 Hardware Tools User's Guide](#).



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- A. If a local target power supply is used, make connection J1. If power from the debug or programming adapter is used, make connection J2.
- B. The upper limit for C1 is 2.2 nF when using current TI tools.

**图 10-8. Signal Connections for 4-Wire JTAG Communication**



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- Make connection J1 if a local target power supply is used, or make connection J2 if the target is powered from the debug or programming adapter.
- The device  $\overline{\text{RST}}/\text{NMI}/\text{SBWTIO}$  pin is used in 2-wire mode for bidirectional communication with the device during JTAG access, and any capacitance that is attached to this signal may affect the ability to establish a connection with the device. The upper limit for C1 is 2.2 nF when using current TI tools.

**图 10-9. Signal Connections for 2-Wire JTAG Communication (Spy-Bi-Wire)**

### 10.1.7 Reset

The reset pin can be configured as a reset function (default) or as an NMI function in the SFRRPCR register.

In reset mode, the  $\overline{\text{RST}}/\text{NMI}$  pin is active low, and a pulse applied to this pin that meets the reset timing specifications generates a BOR-type device reset.

Setting SYSNMI causes the  $\overline{\text{RST}}/\text{NMI}$  pin to be configured as an external NMI source. The external NMI is edge sensitive, and its edge is selectable by SYSNMIIES. Setting the NMIIE enables the interrupt of the external NMI. When an external NMI event occurs, the NMIIFG is set.

The  $\overline{\text{RST}}/\text{NMI}$  pin can have either a pullup or pulldown that is enabled or not. SYSRSTUP selects either pullup or pulldown, and SYSRSTRE causes the pullup (default) or pulldown to be enabled (default) or not. If the  $\overline{\text{RST}}/\text{NMI}$  pin is unused, it is required either to select and enable the internal pullup or to connect an external 47-kΩ pullup resistor to the  $\overline{\text{RST}}/\text{NMI}$  pin with a 2.2-nF pulldown capacitor. The pulldown capacitor should not exceed 2.2 nF when using devices with Spy-Bi-Wire interface in Spy-Bi-Wire mode or in 4-wire JTAG mode with TI tools like FET interfaces or GANG programmers.

See the [MSP430FR58xx](#), [MSP430FR59xx](#), and [MSP430FR6xx Family User's Guide](#) for more information on the referenced control registers and bits.

### 10.1.8 Unused Pins

For details on the connection of unused pins, see [节 7.6](#).

### 10.1.9 General Layout Recommendations

- Proper grounding and short traces for external crystal to reduce parasitic capacitance. See [MSP430 32-kHz Crystal Oscillators](#) for recommended layout guidelines.
- Proper bypass capacitors on DVCC, AVCC, and reference pins if used.
- Avoid routing any high-frequency signal close to an analog signal line. For example, keep digital switching signals such as PWM or JTAG signals away from the oscillator circuit.
- Proper ESD level protection should be considered to protect the device from unintended high-voltage electrostatic discharge. See [MSP430 System-Level ESD Considerations](#) for guidelines.

### 10.1.10 Do's and Don'ts

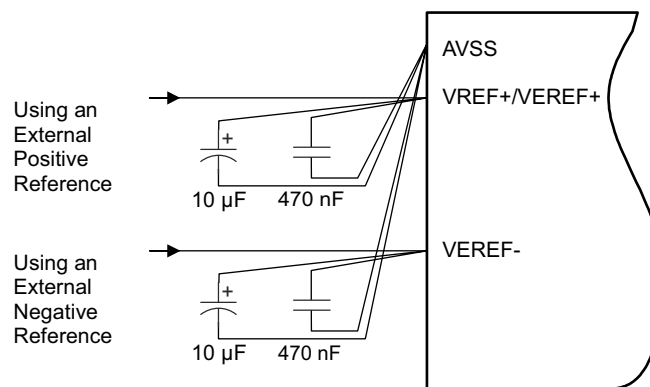
TI recommends powering AVCC and DVCC pins from the same source. At a minimum, during power up, power down, and device operation, the voltage difference between AVCC and DVCC must not exceed the limits specified in [§ 8.1](#). Exceeding the specified limits may cause malfunction of the device including erroneous writes to RAM and FRAM.

## 10.2 Peripheral- and Interface-Specific Design Information

### 10.2.1 ADC12\_B Peripheral

#### 10.2.1.1 Partial Schematic

[图 10-10](#) shows the recommended connections for the reference input pins.



**图 10-10. ADC12\_B Grounding and Noise Considerations**

#### 10.2.1.2 Design Requirements

As with any high-resolution ADC, appropriate printed-circuit-board layout and grounding techniques should be followed to eliminate ground loops, unwanted parasitic effects, and noise.

Ground loops are formed when return current from the ADC flows through paths that are common with other analog or digital circuitry. If care is not taken, this current can generate small unwanted offset voltages that can add to or subtract from the reference or input voltages of the ADC. The general guidelines in [§ 10.1.1](#) combined with the connections shown in [图 10-10](#) prevent these offsets.

In addition to grounding, ripple and noise spikes on the power-supply lines that are caused by digital switching or switching power supplies can corrupt the conversion result. A noise-free design using separate analog and digital ground planes with a single-point connection is recommended to achieve high accuracy.

[图 10-10](#) shows the recommended decoupling circuit when an external voltage reference is used. The internal reference module has a maximum drive current as specified in the  $I_{O(VREF+)}$  specification of the REF module.

The reference voltage must be a stable voltage for accurate measurements. The capacitor values that are selected in the general guidelines filter out the high- and low-frequency ripple before the reference voltage enters the device. In this case, the 10-µF capacitor buffers the reference pin and filter any low-frequency ripple. A 470-nF bypass capacitor filters out any high-frequency noise.



### 10.2.1.3 Detailed Design Procedure

For additional design information, see [Designing With the MSP430FR58xx, FR59xx, FR68xx, and FR69xx ADC](#).

### 10.2.1.4 Layout Guidelines

Component that are shown in the partial schematic (see [Figure 10-10](#)) should be placed as close as possible to the respective device pins. Avoid long traces, because they add additional parasitic capacitance, inductance, and resistance on the signal.

Avoid routing analog input signals close to a high-frequency pin (for example, a high-frequency PWM), because the high-frequency switching can be coupled into the analog signal.

If differential mode is used for the ADC12\_B, the analog differential input signals must be routed closely together to minimize the effect of noise on the resulting signal.

## 10.2.2 LCD\_C Peripheral

### 10.2.2.1 Partial Schematic

Required LCD connections greatly vary by the type of display that is used (static or multiplexed), whether external or internal biasing is used, and whether the on-chip charge pump is employed. Also, there is a fair amount of flexibility as to how the segment (Sx) and common (COMx) signals are connected to the MCU, which can provide unique benefits. Because LCD connections are application-specific, it is difficult to provide a single one-fits-all schematic. However, for examples and how-to circuit design guidance, see [Designing With MSP430™ MCUs and Segment LCDs](#).

### 10.2.2.2 Design Requirements

Due to the flexibility of the LCD\_C peripheral module to accommodate various segment-based LCDs, selecting the correct display for the application in combination with determining specific design requirements is often an iterative process. TI strongly recommends reviewing the LCD\_C peripheral module chapter in the [MSP430FR58xx, MSP430FR59xx, and MSP430FR6xx Family User's Guide](#) and [Designing With MSP430™ MCUs and Segment LCDs](#) during the initial design requirements and decision process.

### 10.2.2.3 Detailed Design Procedure

A major component in designing the LCD solution is determining the exact connections between the LCD\_C peripheral module and the display. Two basic design processes can be employed for this step, although in reality often a balanced co-design approach is recommended:

- PCB layout-driven design, optimizing signal routing
- Software-driven design, focusing on optimizing computational overhead

For a detailed discussion of the design procedure as well as for design information regarding the LCD controller input voltage selection including internal and external options, contrast control, and bias generation, see [Designing With MSP430™ MCUs and Segment LCDs](#) and the LCD\_C Controller chapter in the [MSP430FR58xx, MSP430FR59xx, and MSP430FR6xx Family User's Guide](#).

### 10.2.2.4 Layout Guidelines

LCD segment (Sx) and common (COMx) signal traces are continuously switching while the LCD is enabled and should, therefore, be kept away from sensitive analog signals such as ADC inputs to prevent any noise coupling. TI recommends keeping the LCD signal traces on one side of the PCB grouped together in a bus-like fashion. A ground plane beneath the LCD traces and guard traces alongside the LCD traces can provide shielding.

If the internal charge pump of the LCD module is used, place the externally provided capacitor on the LCDCAP pin as close as possible to the MCU. Connect the capacitor to the device using a short and direct trace and also have a solid connection to the ground plane that supplies the V<sub>SS</sub> pins of the MCU.

For an example layouts and a more in-depth discussion, see [Designing With MSP430™ MCUs and Segment LCDs](#).

## 11 Device and Documentation Support

### 11.1 Getting Started and Next Steps

For more information on the MSP family of microcontrollers and the tools and libraries that are available to help with your development, visit the [MSP430™ ultra-low-power sensing & measurement MCUs overview](#).

### 11.2 Device Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all MSP MCU devices. Each MSP MCU commercial family member has one of two prefixes: MSP or XMS. These prefixes represent evolutionary stages of product development from engineering prototypes (XMS) through fully qualified production devices (MSP).

**XMS** – Experimental device that is not necessarily representative of the final device's electrical specifications

**MSP** – Fully qualified production device

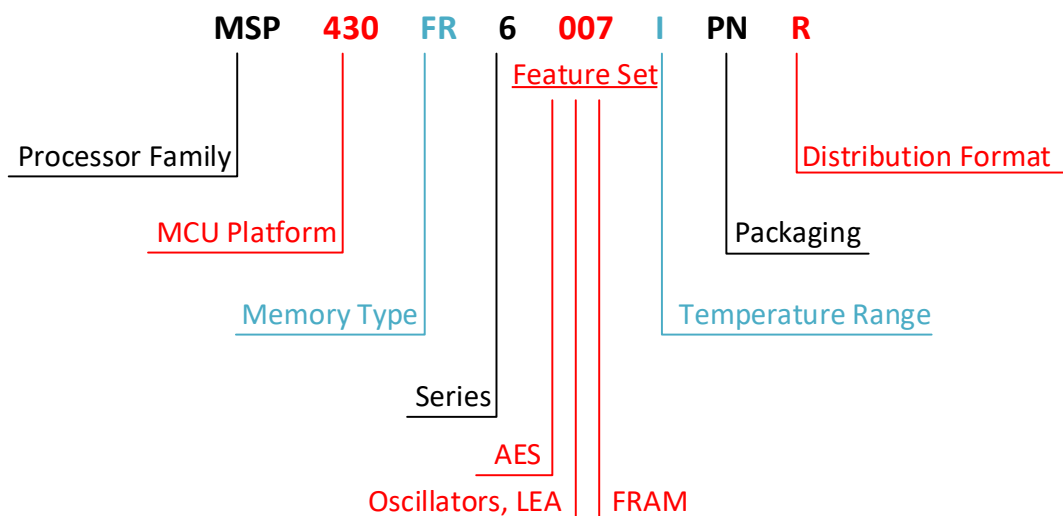
XMS devices are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes."

MSP devices have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies.

Predictions show that prototype devices (XMS) have a greater failure rate than the standard production devices. TI recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

TI device nomenclature also includes a suffix with the device family name. This suffix indicates the temperature range, package type, and distribution format. [图 11-1](#) provides a legend for reading the complete device name.



|                                      |                                                                       |                                                                      |                                                     |
|--------------------------------------|-----------------------------------------------------------------------|----------------------------------------------------------------------|-----------------------------------------------------|
| <b>Processor Family</b>              | MSP = Mixed-Signal Processor<br>XMS = Experimental Silicon            |                                                                      |                                                     |
| <b>Platform</b>                      | 430 = MSP430 16-Bit Low-Power Platform                                |                                                                      |                                                     |
| <b>Memory Type</b>                   | FR = FRAM                                                             |                                                                      |                                                     |
| <b>Series</b>                        | 6 = FRAM 6 Series Up to 16 MHz with LCD                               |                                                                      |                                                     |
| <b>Feature Sets</b>                  | <b>First Digit: Feature</b><br>0 = AES                                | <b>Second Digit: Oscillators, LEA</b><br>0 = HFXT + LFXT + LEA + USS | <b>Third Digit: FRAM (KB)</b><br>7 = 256<br>5 = 128 |
| <b>Temperature Range</b>             | I = -40°C to 85°C                                                     |                                                                      |                                                     |
| <b>Packaging</b>                     | <a href="http://www.ti.com/packaging">http://www.ti.com/packaging</a> |                                                                      |                                                     |
| <b>Optional: Distribution Format</b> | T = Small reel<br>R = Large reel<br>No Marking = Tube or Tray         |                                                                      |                                                     |

**图 11-1. Device Nomenclature**

## 11.3 Tools and Software

表 11-1 lists the debug features supported by these microcontrollers. See the [Code Composer Studio™ IDE for MSP430 User's Guide](#) for details on the available features. For further usage information, see the following documents:

[Advanced Debugging Using the Enhanced Emulation Module \(EEM\) With Code Composer Studio™ IDE](#)

[MSP430™ Advanced Power Optimizations: ULP Advisor™ Software and EnergyTrace™ Technology](#)

**Table 11-1. Hardware Features**

| MSP ARCHITECTURE | 4-WIRE JTAG | 2-WIRE JTAG | BREAK-POINTS (N) | RANGE BREAK-POINTS | CLOCK CONTROL | STATE SEQUENCER | TRACE BUFFER | LPMx.5 DEBUGGING SUPPORT | EnergyTrace++ |
|------------------|-------------|-------------|------------------|--------------------|---------------|-----------------|--------------|--------------------------|---------------|
| MSP430Xv2        | Yes         | Yes         | 3                | Yes                | Yes           | No              | No           | Yes                      | Yes           |

## Design Kits and Evaluation Modules

### [MSP430FR6047 Ultrasonic Sensing Evaluation Module](#)

The EVM430-FR6047 evaluation kit is a development platform that can be used to evaluate the performance of the MSP430FR6007 for ultrasonic sensing applications (for example, smart water meters).

### [MSP-TS430PZ100E 100-pin Target Development Board](#)

The MSP-TS430PZ100E is a stand-alone 100-pin ZIF socket target board used to program and debug the MSP430 MCU in-system through the JTAG interface or the Spy Bi-Wire (2-wire JTAG) protocol.

## Software

### [MSP430Ware™ Software](#)

MSP430Ware software is a collection of code examples, data sheets, and other design resources for all MSP430 devices delivered in a convenient package. In addition to providing a complete collection of existing MSP430 design resources, MSP430Ware software also includes a high-level API called MSP430 Driver Library. This library makes it easy to program MSP430 hardware. MSP430Ware software is available as a component of Code Composer Studio IDE or as a stand-alone package.

### [MSP430FR604x\(1\), MSP430FR603x\(1\) Code Examples](#)

C Code examples are available for every MSP device that configures each of the integrated peripherals for various application needs.

### [MSP Driver Library](#)

Driver Library's abstracted API keeps you above the bits and bytes of the MSP430 hardware by providing easy-to-use function calls. Thorough documentation is delivered through a helpful API Guide, which includes details on each function call and the recognized parameters. Developers can use Driver Library functions to write complete projects with minimal overhead.

### [MSP EnergyTrace™ Technology](#)

EnergyTrace technology for MSP430 microcontrollers is an energy-based code analysis tool that measures and displays the energy profile of the application and helps to optimize it for ultra-low-power consumption.

### [ULP \(Ultra-Low Power\) Advisor](#)

ULP Advisor™ software is a tool for guiding developers to write more efficient code to fully use the unique ultra-low power features of MSP430 and MSP432 microcontrollers. Aimed at both experienced and new microcontroller developers, ULP Advisor checks your code against a thorough ULP checklist to squeeze every last nano amp out of your application. At build time, ULP Advisor provides notifications and remarks on areas of your code that can be further optimized for lower power.

## Fixed-Point Math Library for MSP MCUs

The MSP IQmath and Qmath Libraries are a collection of highly optimized and high-precision mathematical functions for C programmers to seamlessly port a floating-point algorithm into fixed-point code on MSP430 and MSP432 devices. These routines are typically used in computationally intensive real-time applications where optimal execution speed, high accuracy, and ultra-low energy are critical. By using the IQmath and Qmath libraries, it is possible to achieve execution speeds considerably faster and energy consumption considerably lower than equivalent code written using floating-point math.

## Floating-Point Math Library for MSP430™ MCUs

Continuing to innovate in the low power and low cost microcontroller space, TI brings you MSPMATHLIB. Leveraging the intelligent peripherals of our devices, this floating point math library of scalar functions brings you up to 26x better performance. Mathlib is easy to integrate into your designs. This library is free and is integrated in both Code Composer Studio and IAR IDEs. Read the user's guide for an in depth look at the math library and relevant benchmarks.

## Development Tools

### Code Composer Studio™ Integrated Development Environment for MSP Microcontrollers

The Code Composer Studio integrated development environment (IDE) supports TI's Microcontroller and Embedded Processors portfolio. The Code Composer Studio IDE comprises a suite of tools used to develop and debug embedded applications. It includes an optimizing C/C++ compiler, source code editor, project build environment, debugger, profiler, and many other features. The intuitive IDE provides a single user interface taking you through each step of the application development flow. Familiar tools and interfaces allow users to get started faster than ever before. The Code Composer Studio IDE combines the advantages of the Eclipse software framework with advanced embedded debug capabilities from TI resulting in a compelling feature-rich development environment for embedded developers.

### Command-Line Programmer

MSP Flasher is an open-source shell-based interface for programming MSP microcontrollers through a FET programmer or eZ430 using JTAG or Spy-Bi-Wire (SBW) communication. MSP Flasher can download binary files (.txt or .hex) files directly to the MSP microcontroller without an IDE.

### MSP MCU Programmer and Debugger

The MSP-FET is a powerful emulation development tool – often called a debug probe – which allows users to quickly begin application development on MSP low-power microcontrollers (MCU). Creating MCU software usually requires downloading the resulting binary program to the MSP device for validation and debugging. The MSP-FET provides a debug communication pathway between a host computer and the target MSP. Furthermore, the MSP-FET also provides a Backchannel UART connection between the computer's USB interface and the MSP UART. This affords the MSP programmer a convenient method for communicating serially between the MSP and a terminal running on the computer. The MSP-FET also supports loading programs (often called firmware) to the MSP target using the BSL through the UART and I<sup>2</sup>C communication protocols.

### MSP-GANG Production Programmer

The MSP Gang Programmer is an MSP430 or MSP432 device programmer that can program up to eight identical MSP430 or MSP432 Flash or FRAM devices at the same time. The MSP Gang Programmer connects to a host PC using a standard RS-232 or USB connection and provides flexible programming options that allow the user to fully customize the process. The MSP Gang Programmer is provided with an expansion board, called the Gang Splitter, that implements the interconnections between the MSP Gang Programmer and multiple target devices. Eight cables are provided that connect the expansion board to eight target devices (through JTAG or Spy-Bi-Wire connectors). The programming can be done with a PC or as a stand-alone device. A PC-side graphical user interface is also available and is DLL-based.

## 11.4 Documentation Support

The following documents describe the MSP430FR600x MCUs. Copies of these documents are available on the Internet at [www.ti.com](http://www.ti.com).

### Receiving Notification of Document Updates

To receive notification of documentation updates—including silicon errata—go to the product folder for your device on [ti.com](http://ti.com) (for links to the product folders, see [节 11.5](#)). In the upper-right corner, click the "Alert me" button. This registers you to receive a weekly digest of product information that has changed (if any). For change details, check the revision history of any revised document.

### Errata

#### [MSP430FR6007 Device Erratasheet](#)

Describes the known exceptions to the functional specifications.

#### [MSP430FR6005 Device Erratasheet](#)

Describes the known exceptions to the functional specifications.

### User's Guides

#### [MSP430FR58xx, MSP430FR59xx, and MSP430FR6xx Family User's Guide](#)

Detailed description of all modules and peripherals available in this device family.

#### [MSP430™ FRAM Devices Bootloader \(BSL\) User's Guide](#)

The bootloader (BSL) on MSP430 microcontrollers (MCUs) lets users communicate with embedded memory in the MSP430 MCU during the prototyping phase, final production, and in service. Both the programmable memory (FRAM memory) and the data memory (RAM) can be modified as required.

#### [MSP430™ Programming With the JTAG Interface](#)

This document describes the functions that are required to erase, program, and verify the memory module of the MSP430 flash-based and FRAM-based microcontroller families using the JTAG communication port. In addition, it describes how to program the JTAG access security fuse that is available on all MSP430 devices. This document describes device access using both the standard 4-wire JTAG interface and the 2-wire JTAG interface, which is also referred to as Spy-Bi-Wire (SBW).

#### [MSP430™ Hardware Tools User's Guide](#)

This manual describes the hardware of the TI MSP-FET430 Flash Emulation Tool (FET). The FET is the program development tool for the MSP430 ultra-low-power microcontroller.

## Application Reports

### MSP430™ 32-kHz Crystal Oscillators

Selection of the correct crystal, correct load circuit, and proper board layout are important for a stable crystal oscillator. This application report summarizes crystal oscillator function and explains the parameters to select the correct crystal for MSP430 ultra-low-power operation. In addition, hints and examples for correct board layout are given. The document also contains detailed information on the possible oscillator tests to ensure stable oscillator operation in mass production.

### MSP430™ System-Level ESD Considerations

System-level ESD has become increasingly demanding with silicon technology scaling towards lower voltages and the need for designing cost-effective and ultra-low-power components. This application report addresses different ESD topics to help board designers and OEMs understand and design robust system-level designs. A few real-world system-level ESD protection design examples and their results are also discussed.

## 11.5 Related Links

表 11-2 lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to order now.

**Table 11-2. Related Links**

| PARTS        | PRODUCT FOLDER             | ORDER NOW                  | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|--------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| MSP430FR6007 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| MSP430FR6005 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

## 11.6 Trademarks

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## 11.7 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## 11.8 Export Control Notice

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## 11.9 Glossary

**Ti Glossary** This glossary lists and explains terms, acronyms, and definitions.

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



## PACKAGING INFORMATION

| Orderable part number            | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier  | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|----------------------------------|---------------|----------------------|-----------------|------------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">MSP430FR6005IPZ</a>  | Active        | Production           | LQFP (PZ)   100 | 90   JEDEC TRAY (10+1) | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | FR6005              |
| MSP430FR6005IPZ.A                | Active        | Production           | LQFP (PZ)   100 | 90   JEDEC TRAY (10+1) | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | FR6005              |
| <a href="#">MSP430FR6005IPZR</a> | Active        | Production           | LQFP (PZ)   100 | 1000   LARGE T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | FR6005              |
| MSP430FR6005IPZR.A               | Active        | Production           | LQFP (PZ)   100 | 1000   LARGE T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | FR6005              |
| <a href="#">MSP430FR6007IPZ</a>  | Active        | Production           | LQFP (PZ)   100 | 90   JEDEC TRAY (10+1) | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | FR6007              |
| MSP430FR6007IPZ.A                | Active        | Production           | LQFP (PZ)   100 | 90   JEDEC TRAY (10+1) | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | FR6007              |
| <a href="#">MSP430FR6007IPZR</a> | Active        | Production           | LQFP (PZ)   100 | 1000   LARGE T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | FR6007              |
| MSP430FR6007IPZR.A               | Active        | Production           | LQFP (PZ)   100 | 1000   LARGE T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | FR6007              |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

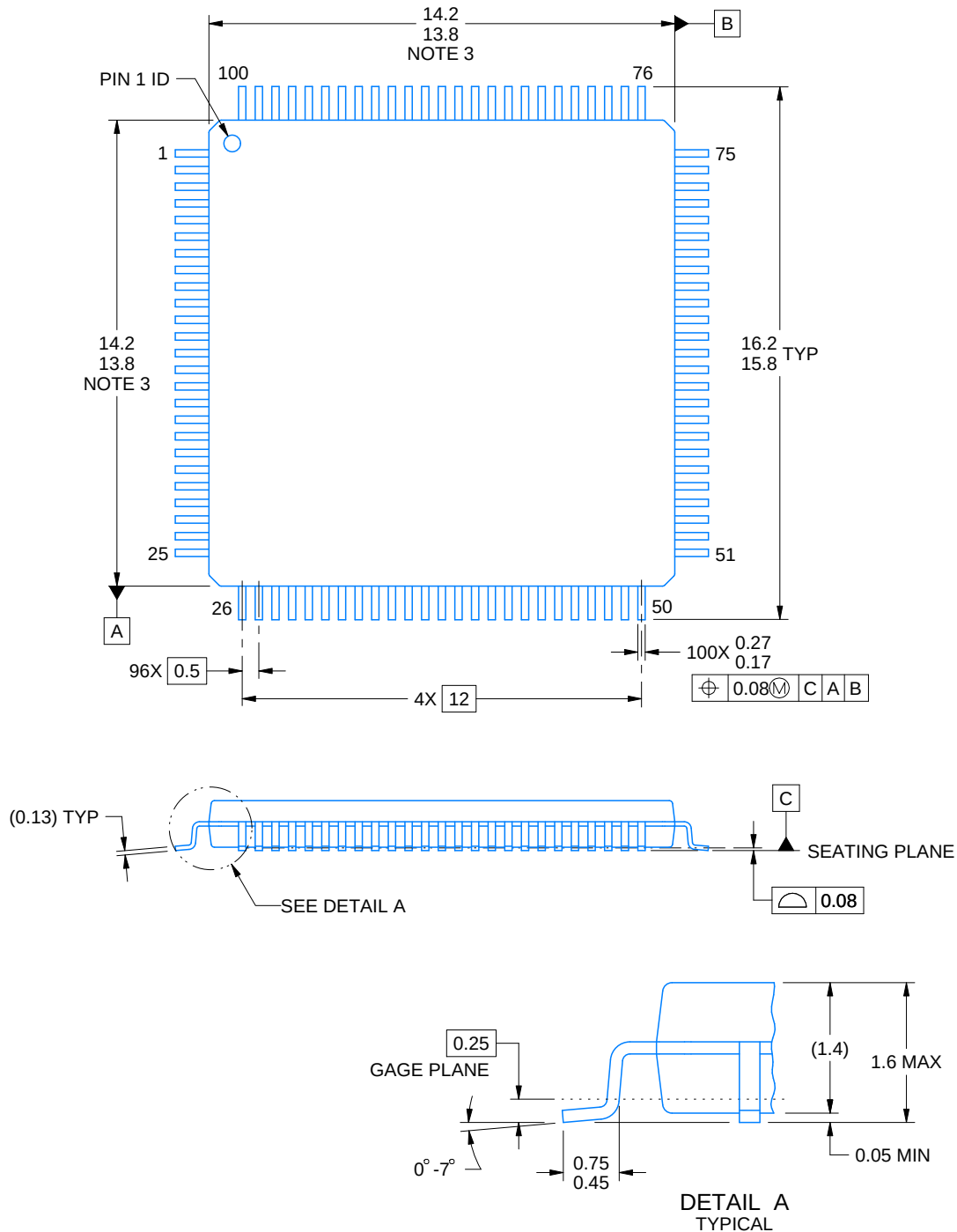
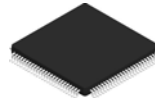
<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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4215169/A 03/2017

NOTES:

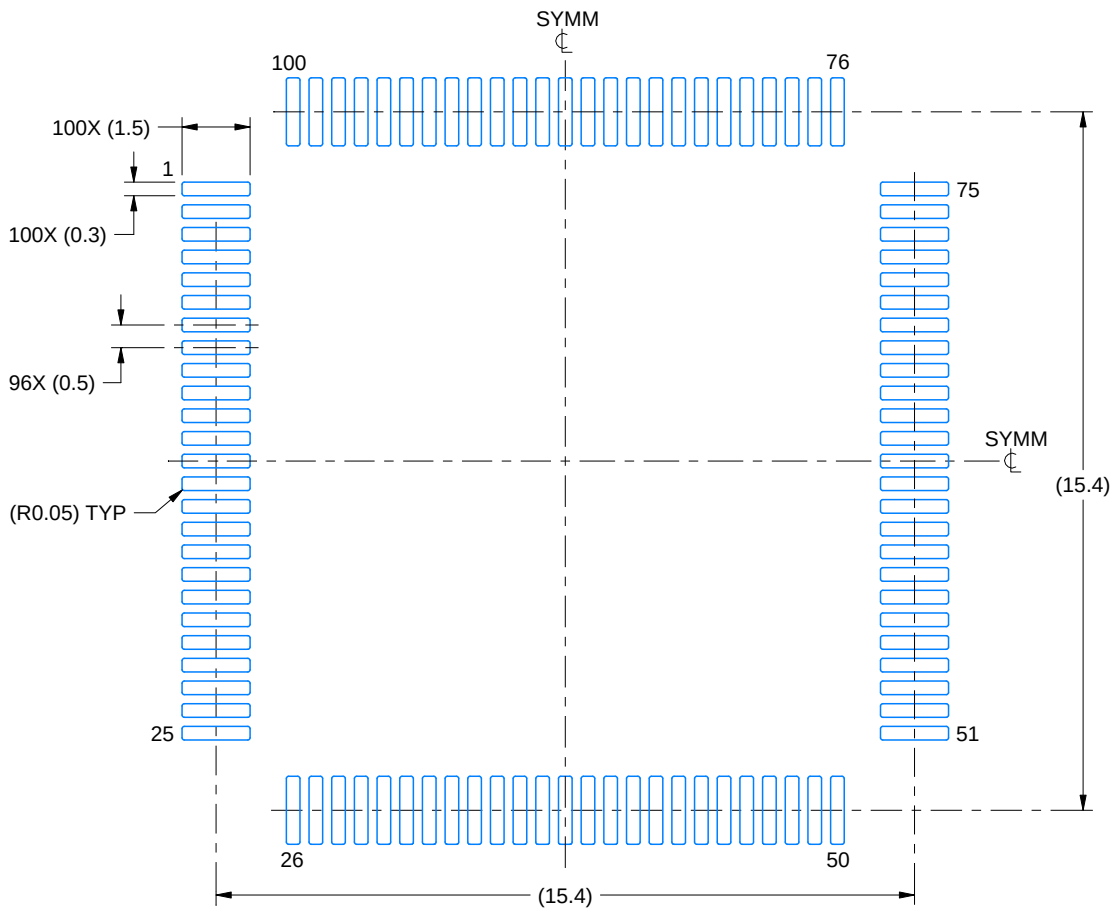
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MS-026.

# EXAMPLE BOARD LAYOUT

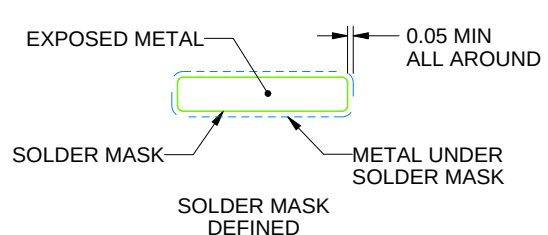
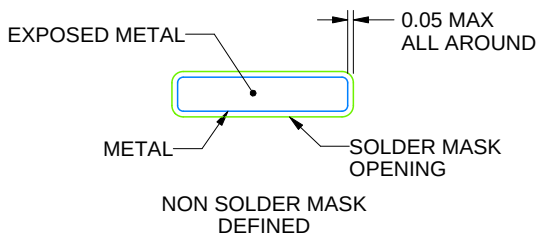
PZ0100A

LQFP - 1.6 mm max height

PLASTIC QUAD FLATPACK



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:6X



SOLDER MASK DETAILS

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NOTES: (continued)

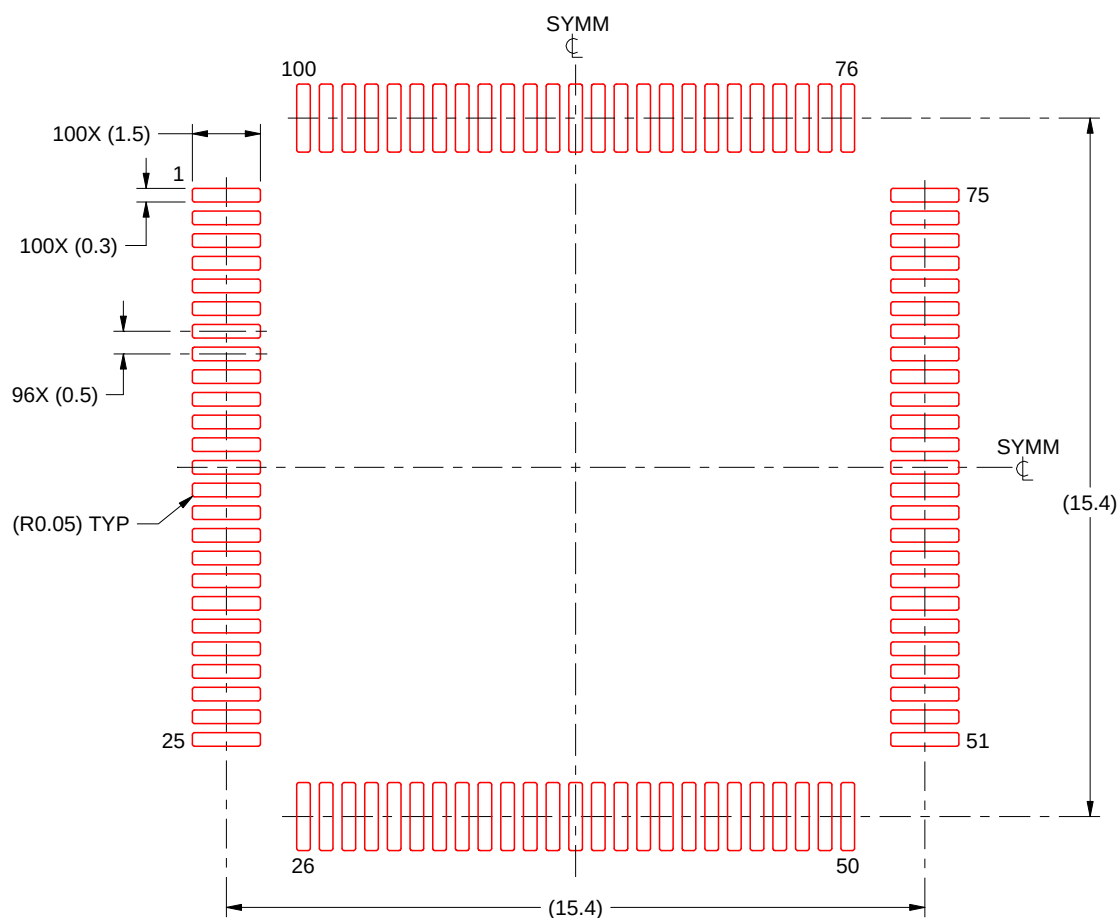
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
7. For more information, see Texas Instruments literature number SLMA004 ([www.ti.com/lit/slma004](http://www.ti.com/lit/slma004)).

# EXAMPLE STENCIL DESIGN

PZ0100A

LQFP - 1.6 mm max height

PLASTIC QUAD FLATPACK



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## 重要通知和免责声明

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